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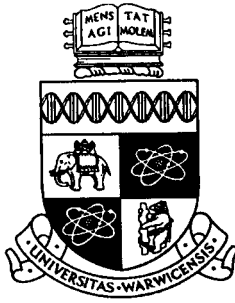
**A Thesis Submitted for the Degree of PhD at the University of Warwick**

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**Super-precision programmable current source  
for coil/magnet actuators**

by

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**BSc(Hons) CPhys MInstP CEng MIEE MBCS**

**Submitted for the award of PhD**

at

**The University of Warwick**

**Department of Engineering**

**May 1995**

## **Dedicated to**

My wife

for her kindness, patience and encouragement

My children

who have missed me for several years

My parents

for the education that underpins all that follows

## **Exhortation**

Awake! - brave scholar and resume the fight,

Work all day and then most of each night.

With rigour and method decide what's right,

And then with luck, you'll see a great light

## **Acknowledgement**

I should like to pay special thanks to Dr. D. G. Chetwynd, who provided excellent advice on how a thesis should be written and presented; and also for achieving a happy balance between colleague and mentor.

## S u m m a r y

This thesis describes the design and development of a super-precision programmable current source that can deliver up to about  $\pm 100$  mA to an inductive load. The load is intended typically to be a coil in a coil/magnet actuator that provides a force which is proportional to the current, and results in a linear and well defined movement of an elastic flexure mechanism. The particularly demanding application of long-range x-ray interferometry required two tracking current sources that offered a resolution to better than 1 part in 500,000 and this could not be satisfied by commercially available instruments. Consequently it was necessary to design, construct and test two identical supplies (or *drives*); a non-trivial and very demanding task since exceptionally slow drives scans needed to be accommodated. Temporal stability is therefore critical. Although the operational bandwidth can be kept small, noise up to over 1 kHz must be rigorously suppressed to avoid exciting resonances in the system being driven. Commercial 20-bit digital-to-analogue converters could not be utilised to provide a resolution of 1 part per million, because they are invariably designed for audio applications and have unacceptable drifts with temperature and time. The integral non-linearity had to be less than  $\pm 0.0007\%$  (15 ppm) and the design actually achieves  $\pm 0.5$  ppm by using an embedded precision analogue-to-digital converter to form a servo-loop within each drive. A desk-top computer (PC) accepts setpoints via a serial communications channel, and simultaneously controls the servo-loops for two drives by the exchange of simple messages via optically isolated links. The major components within each drive are, an embedded 8-bit micro-controller, two DAC's providing coarse and fine voltage settings, a precision voltage-to-current converter, a precision ADC and an ADC which monitors critical nodes, all of which are discussed in considerable detail together with the algorithms and software in the PC and microcontroller. Circuit simulations were an important part of preliminary studies and are presented along with measures of actual performance. It is shown that the drives achieve not only a resolution of 1 ppm but that all other operational parameters are of a similar order. A number of proposals are made for alternative methods which represent the foundations for future work.

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## Abbreviations

ADC	Analogue to digital converter
BCD	Binary coded decimal
cps	counts per second
DAC	Digital to analogue converter
dc	Direct current
DNL	Differential non-linearity
DTI	Department of trade and industry
EEPROM	Electrically erasable programmable read only memory
FSO	Full scale output
IEEE	Institution of Electrical and Electronic engineers
INL	Integral nonlinearity
LSB	Least significant bit
MSB	Most significant bit
NPL	National physical laboratory
NS	National semiconductor corporation
PCB	Printed circuit board
ppm	parts per million
PTB	Physikalisch-Technische Bundesanstalt
PWM	Pulse width modulation
PZT	Piezo-electric transducer
RAM	Random access memory
RF	Radio frequency
rms	Root mean square
THD	Total harmonic distortion

## Chapter 1 Application of precision coil/magnet actuators

*"The first experimental investigation of the interaction between coils carrying electric currents was performed by Ampère during the years 1820-5, and the work was continued by Oersted, Biot and Savart. ... Both a magnet and a current-carrying coil are said to produce a magnetic field described by a flux density  $\mathbf{B}$ , which exerts forces on other coils or magnets". [1.1]*

It seems unlikely that these scientists could have foreseen the far reaching consequences of the discoveries which underpin the present work. It would probably have been beyond their belief that it is now possible to control current flow so finely that, through the subsequent minute variations in forces between coils and magnets, movements smaller than the atomic spacing of silicon can be made and measured. But such is now the case and the remainder of this thesis is devoted to an explanation of a technique which does just this, and in particular the design, construction and testing of a super-precision programmable current source. Such sources can have many applications but the current work arose from the need for a technology breakthrough to control adequately low-speed nanometric movements using electromagnetic actuators and the thesis addresses issues in this context.

### 1.1 Coil/magnet geometries and actuators

In regard to the relationship between forces due to current carrying conductors the simplest 'mathematical object' to be analyzed was the force between two infinitely long parallel conductors. Of course this arrangement cannot be realised in practice and further analysis was performed on closed loops, ideal coils and solenoids in order to determine the variation of magnetic field strength,  $\mathbf{H}$ , with position. Probably the most notable early achievement was by Helmholtz (1821-1894) who showed that if two identical circular coils of radius  $a$ , are placed parallel and co-axial a distance  $r$  apart, the field near their geometric centre is uniform over a significant region when  $r=a$ . This is because at the centre  $d\mathbf{H}/dr$ ,  $d^2\mathbf{H}/dr^2$  and  $d^3\mathbf{H}/dr^3$  are all zero. (actually Helmholtz made a more notable contribution to science in 1847 when he put forward the 'Law of conservation of energy'. But it was rejected for publication by the editor of *Annalen der Physik!* [1.2])

For real coils, which use wire of finite diameter, with subsequent limits on packing density, expressions for  $\mathbf{H}$  in terms of some orthogonal co-ordinate system  $(x,y,z)$

may involve integrals which have no analytic solution. Alternatively expressions may be so complicated that it is difficult to plot graphs of  $H(x,y,z)$  by hand. However with the advent of digital computers numerical modelling became easier and new expressions were developed.[1.3]

If a bar magnet is positioned near or within a coil, it experiences a force which is proportional to the current in the coil. If it is fixed to an elastic support, it will move until the force due to the current (driving force) equals the elastic restoring force. A simple arrangement is depicted in Figure 1.1.

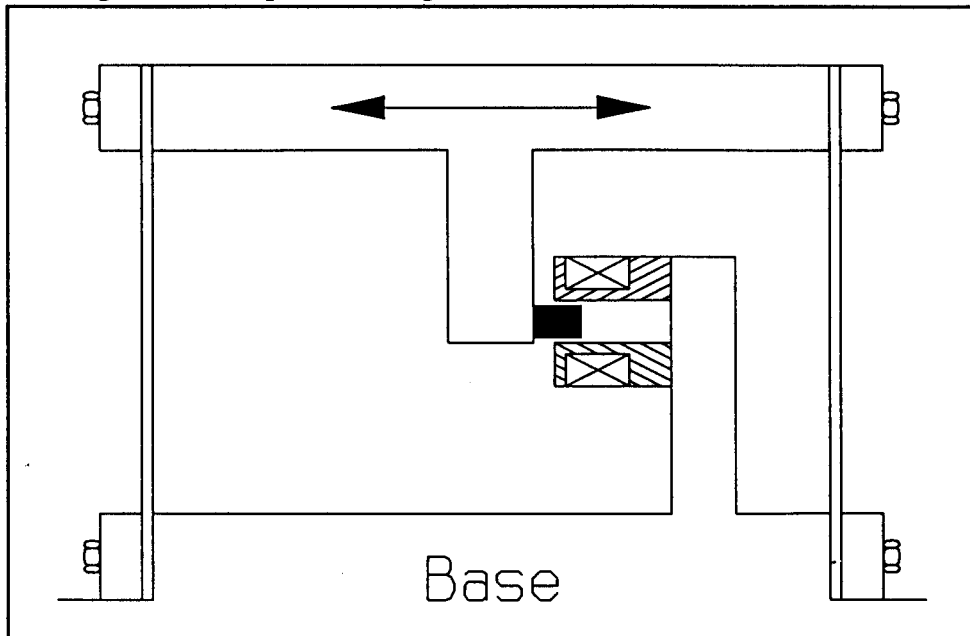


Figure 1.1 - Flexure mechanism with coil/magnet actuator

Even if the restoring force varies linearly with displacement, the net movement is usually not linear because the driving force varies with absolute position. However work done by Smith and Chetwynd [1.4] shows there to be a optimised design of coil such that the driving force is essentially independent of position over a certain region. The significance of this is not in the design of large coils with constant fields over millimetres, but rather small coils which provide a useful range of several micrometres. Such coil/magnet combination can then be used in a wide range of applications under the general heading of *nanotechnology*. For example, in the design of high precision translation mechanisms [1.5] and the control of instruments for the measurement of surface profile [1.6]. Of course coil/magnet combinations have been used for moving-coil motors; e.g. in loudspeakers, and for the head positioning in some disc drives; as well as force balancing techniques for weighing [1.7]. In trying to scale moving-coil devices to provide small movements the problems associated with mechanical coupling become increasingly severe. Consequently moving-coil systems are considered as macroscopic applications and not discussed again. Instead the

emphasis is on systems using moving-magnets to achieve microscopic displacements.

In moving to ever smaller currents, forces and therefore displacements, it becomes increasingly difficult to measure the actual displacement and thereby characterise the behaviour of precision actuators. It should be noted that there is a difference between the detection of small movements and the measurement of absolute position. For example capacitive gauges [1.8] can detect picometre movements and, by a servo-loop, maintain the relative position of two components, but are not so useful for long range absolute measurements. Optical laser interferometers can be used to measure displacements down to about 10 nm relatively easily [1.9], but this is still large compared with the potential resolution afforded by magnet/coil actuators which may better 10 pm [1.10]. Consequently an alternative method of measurement is needed which is reliable, accurate and above all traceable to the international definition of the metre.

## 1.2 X-ray interferometry

To provide a traceable measurement an internationally recognised scale is needed, and this may be provided by the lattice parameter for silicon, which has been referenced to the absolute length scale at PTB in Germany [1.11] and is characterised to a precision of better than 1 part in  $10^7$ . In 1965 Bonse and Hart [1.12] showed how an X-ray interferometer could be built, and subsequently Hart suggested that it be used to create an 'Ångstrom ruler' [1.13]. However, according to Chetwynd [1.14] it was not until 1983 that the application as a ruler was seriously pursued with the demonstration of its use as a microdisplacement calibrator by Chetwynd *et al* [1.15].

The operation of an x-ray interferometer is theoretically complex (see cited references) and is not directly of concern to the work here. Suffice it to say that scanning one thin 'blade' of a single crystal of silicon past other parallel blades causes a modulation in the intensity of a transmitted x-ray beam that varies sinusoidally with the pitch of the lattice. In effect, the system behaves as an incremental grating of pitch equal to the lattice parameter.

Other work in this area includes that by Becker and Seyfried in 1989 [1.16] who used Piezoelectric (PZT) drives, and Bowen *et al* in 1990 [1.17] who used a silicon monolith and coil/magnet actuator to produce controlled displacements of less than 0.01 nm. A significant advantage of using a coil/magnet actuator over PZT stacks is

that small unwanted movements of the coil caused by vibrations in the ground, do not result in such vibrations in the magnet attached to the monolith, because the force is almost independent of position [1.4].

Bowen, Chetwynd and Smith were all established members of the Centre for Microengineering and Metrology (renamed in 1994 as the Centre for Nanotechnology and Microengineering) at the University of Warwick, when the Department of Trade and Industry (DTI) invited tenders for the design and manufacture of a "Traceable secondary standard displacement facility with sub-nanometre resolution - DTI reference MPU 8/0.13". Their collective experience led to a proposal for an instrument which used a silicon monolithic x-ray interferometer, which in principle could meet the required resolution of 0.02 nm over a range of 10  $\mu\text{m}$ . That is to say the mechanical properties of a suitable monolith were sufficiently well understood that together with a coil/magnet actuator the required movements could be obtained if the current in the coil could be controlled sufficiently well. In fact two programmable current sources were needed because, in order to obtain fringes over the desired range, there must be active compensation for twisting caused by a variety of secondary and parasitic effects which may be ignored over shorter ranges. At this time the author became involved with the project and defended the view that the design of a programmable current source with a resolution of 1 part in 500,000 was feasible, although a non-trivial and potentially very difficult task. The intended mode of operation of the instrument meant that not only was the resolution to approach 1 part per million (ppm), but also the noise, integral non-linearity and stability over long periods needed to be of the same order.

Figure 1.2 shows the general construction of a silicon monolith for use as an x-ray interferometer, while Figure 1.3 gives the arrangement of the drive proposed to the DTI. It has a cross bar and two magnets and coils in order to provide a trim torque to compensate for parasitic motion. Also, the use of two coils results in a lower total power dissipation for a given force.

Although much of the discussion for the requirements of a precision programmable current source which follow refer to x-ray interferometry, it would be wrong to conclude that this is the only application. Many other applications come to mind including atomic force microscopy, x and y translation for surface measurements, magnetic lensing in electron microscopes and movement of mirrors in optical metrology. The requirements for long-range x-ray interferometry are particularly demanding and are regarded as a sensible vehicle for developments and discussions.

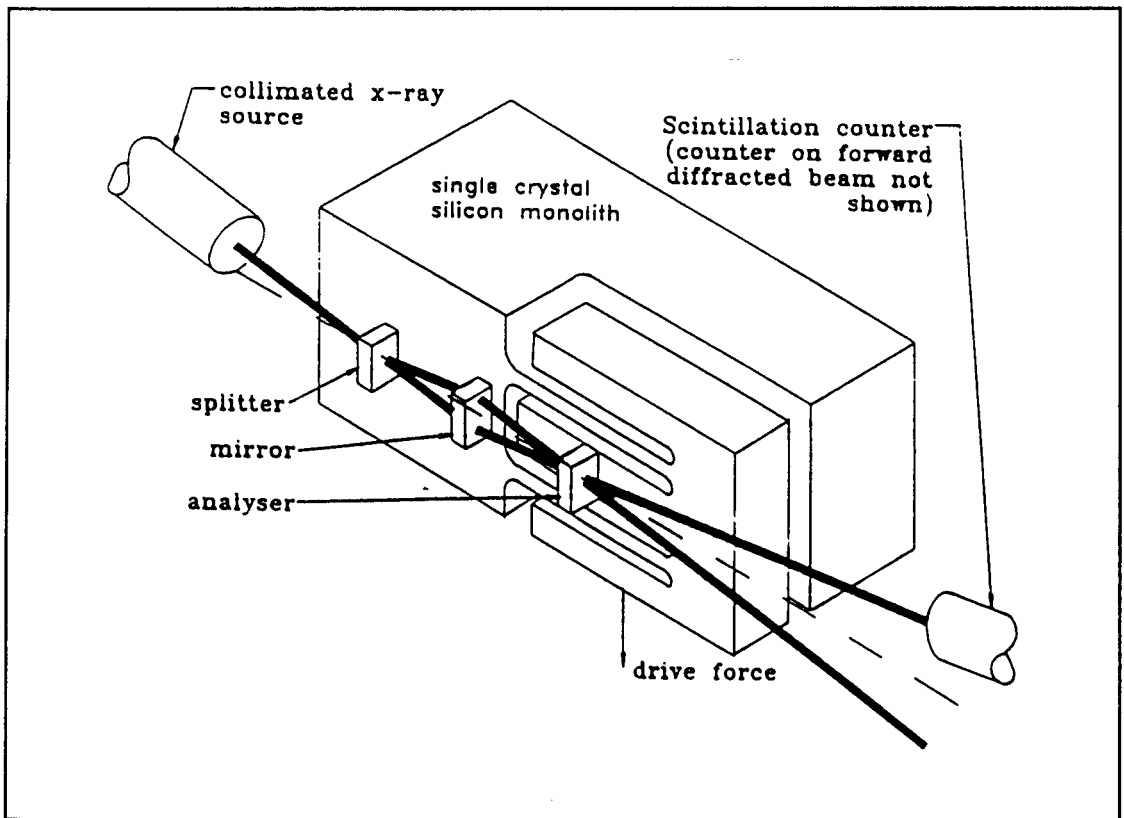


Figure 1.2 - Silicon monolith [1.14]

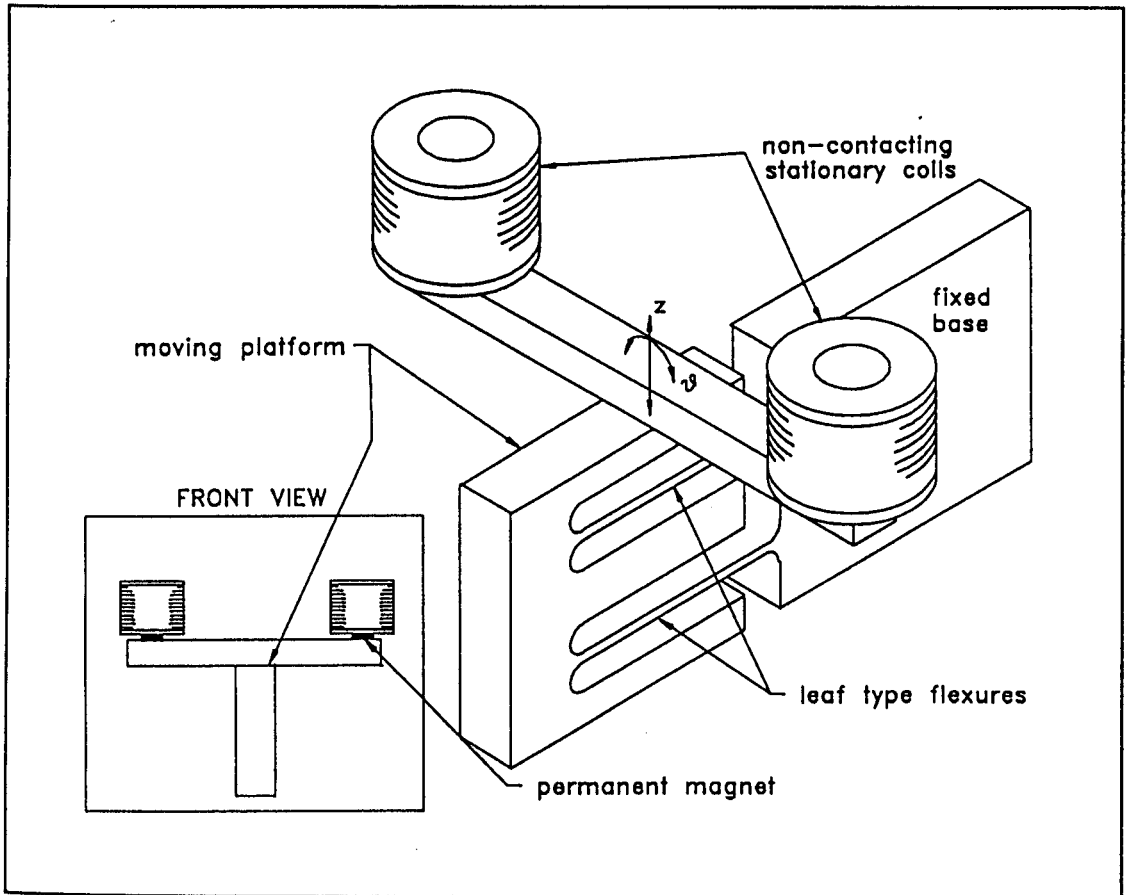


Figure 1.3 - Silicon monolith with two magnets [1.18]

### 1.3 Coil arrangements for translation and twist

For a given monolith there may be an axis along which a force can be applied that will result in translation without any rotation. However imperfections in the machining of the leaf-springs and the inability to define the exact position of the magnet make it such that a torque, and therefore rotation or twist, is expected. For long-range interferometers the problems associated with unwanted rotation cannot be ignored as they degrade the contrast of the fringes and active compensation schemes must be used to ensure optimum performance.

In order to provide independent control over linear force (for translation) as well as torque (for twist compensation), at least two current sources are needed, and Figure 1.4 shows three topologically different, yet symmetrical, coil arrangements which provide this.

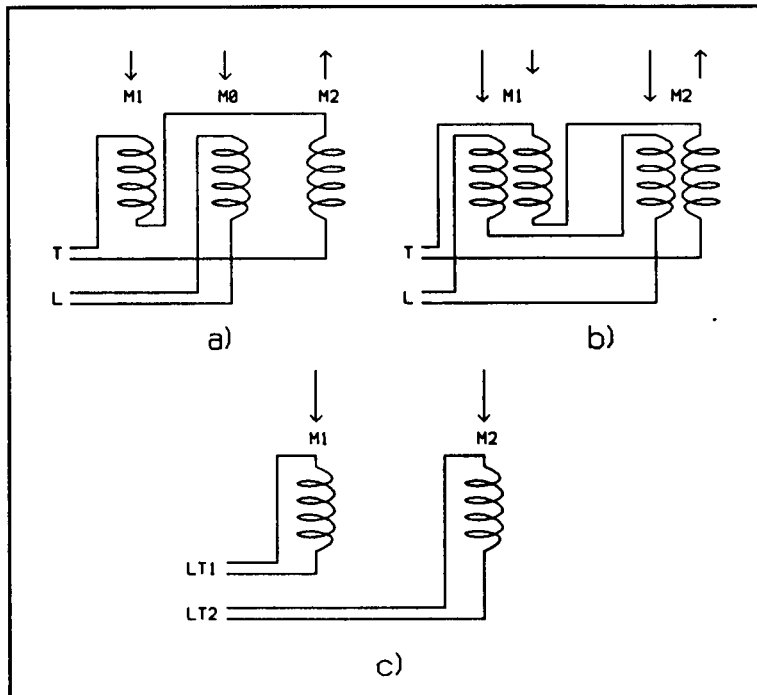


Figure 1.4 - Coil Arrangements

The arrangement shown in Figure 1.4a) is the most obvious extension from previous work. It shows a main linear drive, L, associated with the centre coil and magnet M0, and a torque drive, T, with the outer two magnets M1 and M2. The outer coils are wound in opposite directions so they can induce a torque with no net linear force. Unfortunately, magnets M1 and M2 will not be identical, nor for that matter will be the geometry of the coils or the distances from the main axis of the platform, and this will result in a linear displacement whenever a simple torque is required.



A refinement is shown in Figure 1.4b) which uses only two magnets with over-wound coils. Once again the intention is to be able to trim any twist of the platform by careful control of a torque. There are numerous sources of error which can result in either an undesirable torque or linear force. However the arrangement is better than a) because the force required for linear movement of the platform is now split between two coils. This means that the current in each coil need be only half that using one coil, and the power per coil will be reduced to one quarter. In turn this means the effects of local heating are reduced.

In both a) and b) the current for the linear drive, L, will be orders of magnitude greater than the torque drive, T. This difference is easy to accommodate by using similar drive circuits acting on coils with a differing number of turns.

The arrangement in Figure 1.4c) is easier to build and understand than b) but necessitates two drive circuits with exactly the same performance if both coils are to produce the same forces for the same control codes. In fact this is the ideal situation and differences between M1 and M2, as well asymmetries in the geometry of the coils will require the offsets and gains of the two drives to be different, but maintained at a fixed ratio. The names of the drive signals are changed from L and T, to LT1 and LT2, to reflect the change in use; suitable increases in common to them both will cause a linear movement, while differential changes will cause a rotation.

Two coils may be used to achieve control of translation and twist in one plane but it may be advantageous for some mechanisms to allow controlled movements in several planes. The application of forces at a number of positions may cause direct and desirable movement, or may compensate for unwanted parasitic effects. The designs for flexure mechanisms, possibly using multiple webbed hinges, are beyond the present work, but it is possible that design rules may be reconsidered if programmable current sources are sufficiently cheap and accurate, that numerous coil/magnet actuators may be employed.

#### **1.4 Requirements for a programmable current source**

The requirements for the current source depend upon the exact nature of the application but the needs of the x-ray interferometer are considered so severe that they place an upper limit on the performance a source must achieve. Consequently

if a source may be used for the interferometer it will necessarily be capable of numerous other applications, although perhaps limited by economic considerations.

To satisfy the requirements of the DTI project the resolution must be at least 1 part in 500,000, and it is practical to try and better this by aiming for 1 part in  $10^6$ , or 1 ppm. It is reasonable to assume that, whatever means is used to determine the current, it will rely on digital components, which form a binary scale. This binary scale needs 20 bits since 1 ppm most closely maps to 1 bit in  $2^{20}$ , (where  $2^{20}=1048576$ ). Furthermore, given a range of  $10\ \mu\text{m}$  and that the  $\langle 111 \rangle$  lattice parameter for silicon is about  $0.313\ \text{nm}$ , there will be  $(10 \times 10^{-6})/(0.313 \times 10^{-9}) = 31949$  fringes.

It is now important to mention that during operation of the x-ray interferometer as a calibration facility, other position sensors will measure the displacement of the monolith and, to test their accuracy in different absolute positions, it is convenient to move several micrometres in a single 'jump'. Without this facility it is necessary to track the movement across every (intermediate) fringe, and to do so requires photon counting to take place at two points in each fringe. The x-ray energy is kept low to avoid unwanted heating; consequently the count rates are low, and it takes many ( $> 10$ ) seconds to determine the position within a fringe. For example, a  $1\ \mu\text{m}$  movement corresponds with about 3000 fringes, which implies a scan takes 30000 seconds (say), or over 8 hours. Jumping over fringes relies on being confident that the actuator, and indirectly the current source, has indeed placed the monolith to within half a fringe width of the expected fringe. So long as the correct fringe has been found, the exact position  $\pm 10\ \text{pm}$  may be found by making small additional movements and monitoring of changes in photon count rates. Alternatively full determination of the position within a fringe may be obtained without further movement if a phase-stepping technique is incorporated [1.19]. If a binary scale is perfectly matched to the position of the fringes, then  $N$  binary counts will correspond to exactly  $N$  fringes. Unfortunately, whatever digital-to-analogue conversion process is used will be inaccurate and even if it offers monotonic performance and resolution to 1 ppm a lower bound can be calculated for its integral non-linearity if 'jumping' is to be achieved. The permissible uncertainty can be explained with the aid of Figure 1.5. Consider a jump from fringe  $x$  to fringe  $x+n$ , and that, in the first instance, the position is bounded by points  $p$  and  $q$  ( $\pm \frac{1}{2}$  fringe). A small increase moves these bounds to  $p'$  and  $q'$ , but the interpretation about absolute position is ambiguous because a fringe boundary has been crossed. Suppose, instead, that the position is bounded by the points  $a$  and  $b$  ( $\pm \frac{1}{4}$  fringe). Then a small increase bounds

the position by  $a'$  and  $b'$  which is within the same fringe and allows determination of the absolute position by interpolation. In fact the constraint of  $\pm \frac{1}{4}$  fringe is unnecessarily tight, but on a binary scale it is the next best range when  $\pm \frac{1}{2}$  fringe is rejected.

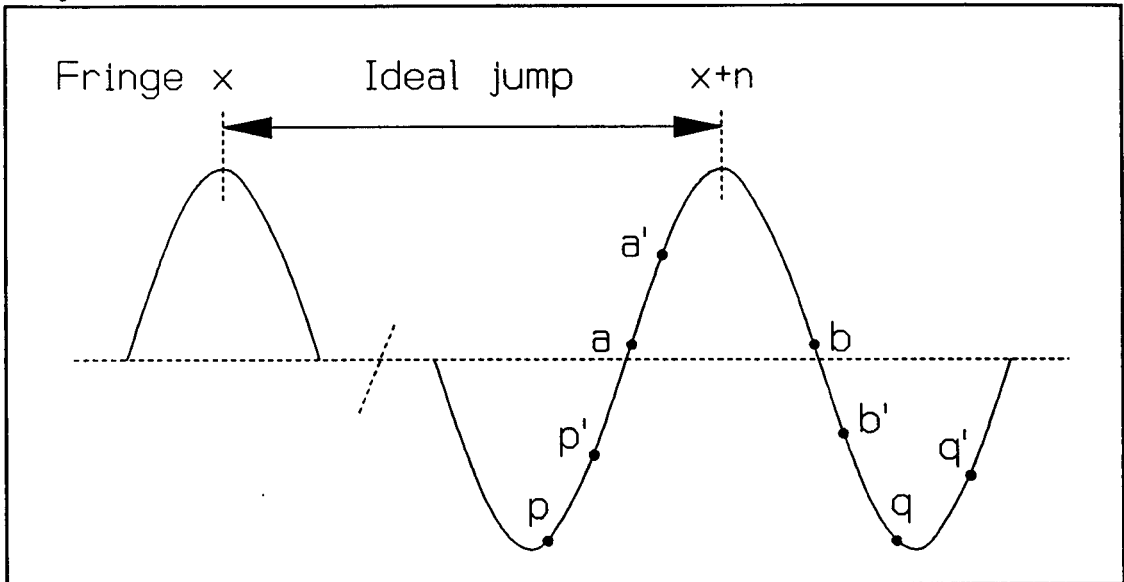


Figure 1.5 - Jumping fringes

Since the range of  $10 \mu\text{m}$  contains 31949 fringes, which maps closely to a 15-bit scale with 32768 intervals, the corresponding required integral non-linearity (INL) is  $\pm \frac{1}{4}$  of the least significant bit (LSB). Expressed as a percentage of full scale this is  $\pm 0.0007\%$ , and if it were not for the need for 20-bit resolution a practical realisation of this bound can be achieved using a 16-bit DAC with an INL of  $\pm \frac{1}{2}$  LSB, such as part DAC729KH by Burr Brown.

The lower bound of  $\pm 0.0007\%$  of full scale for INL is actually optimistic since it assumes no other sources of error exist. In general any DAC will experience a drift with time and temperature of both the span and the zero point. Although this may not cause problems for movements throughout fringes, it could cause a fringe to be missed when 'jumping' over many fringes. Chetwynd *et al* in [1.14] propose that running calibrations may be performed which help to track slow changes in the performance of the current source(s), and this may be a practical approach to overcome some of the problems. However it is only made possible because the interferometer provides an accurate ruler, and for other applications it is advantageous to use a programmable current source to provide open-loop positional control. To this end a design target was set to achieve not only a resolution of 1 ppm, but for all parameters to be of this order; including INL, DNL, drift/ $^{\circ}\text{C}$  and noise.

Based on previous work with coil/magnet actuators within the Centre for Nanotechnology and Microengineering, an upper bound of  $\pm 100$  mA was placed on the current requirements for a single coil. Two identical sources were needed for this application and a thorough survey revealed that no commercial supplies had the necessary performance.

### 1.5 (Un)suitability of commercial programmable current sources

There are many manufacturers that make programmable voltage and current sources which are designed to deliver power to a load and not intended as reference sources for calibration. In studying the catalogues for companies such as Hewlett Packard, Fluke and Philips, a pattern emerges as to the general characteristics of the supplies. Firstly, there are very many more supplies with voltage outputs than with current outputs, and the maximum output power may be between 50 and 2000 watts. Secondly, the resolution is often stated in such a way as to suggest the use of a N-bit DAC, where N is typically 12 to 14. Figure 1.6 shows the 'best' of what was available in 1992, and only Marconi model 103A comes close to the required performance. Even though it offers a resolution of about 1 ppm the linearity is quoted at only 0.005% (50 ppm) on the +100mA range.

Make	Model	Range	Step	Res. bits	Temp.Co /°C	Linearity	Noise	Comments
Keithley	224	$\pm 100$ mA	50 $\mu$ A	12	12 $\mu$ A	?	100ppm	Non-Inductive load
Fluke	PM2831	$\pm 1$ A		12	?	?	2mA	
HP	6625A	500mA	100 $\mu$ A	14	?	?	0.1mA	
Marconi	103A	$\pm 110$ mA	100nA	20	?	0.005%	?	DC Reference

? = parameter not available

Figure 1.6 - Commercial current sources [1.20 to 1.23]

Although every effort was made to identify all commercial sources at the start of this research work, model 103A by Marconi was not found until after the design ideas based on pulse width modulation discussed in this thesis had already been established independently. It is therefore interesting to note that an entry in a Marconi catalogue [1.20] describes the instrument as " .. a dc voltage and current reference source .. based on a unique pulse width modulation digital/analogue conversion principle..". The resolution is quoted as 100 nA from  $\pm 100$  nA to  $\pm 109.9999$  mA, which supports the view that internally 6 decades of binary coded decimal (BCD) counters are used to create a digital controlled PWM signal. Detailed study of the specifications shows the linearity for the voltage output to be 0.001%, which is 5

times better than the current output. Perhaps a voltage-to-current converter is employed with inherent non-linearities that limits the performance. Unfortunately no specification is provided for current noise, and with limited linearity the instrument would not have been good enough for the intended application.

The unsuitability of commercial programmable current sources meant that a dedicated supply had to be designed. The rest of the thesis discusses the issues raised in trying create a suitable supply, specific problems and solutions, as well as construction details, performance characteristics and suggestions for future work.

## **Chapter 2 Design ideas, problems and constraints**

The suitability of driving flexure mechanisms by high-compliance coil/magnet force actuators to provide smooth precision movements was discussed in section 1.1. The resolution may be as good as  $\pm 5$  pm over  $10 \mu\text{m}$  if the drive current(s) can be controlled sufficiently well, but this is difficult because it represents a range to resolution of 2,000,000:1. Since a typical operating voltage is 2 volts the uncertainty must be less than  $1 \mu\text{V}$ , and at this level electronic noise becomes the limiting factor. Operating the coil at constant voltage was acceptable for the original experiments but since the force depends on current it is much better to operate the coil at constant current, and thereby eliminate changes due to fluctuations in the coil resistance which occur as the temperature changes.

As a design goal, and because of the constraints of a particular application in X-ray interferometry, it was necessary to design a programmable current source with a resolution of 1 part in 1 million (or 1 part in  $2^{20}$ ), with correspondingly small drift, noise and non-linearities. This specification is extremely challenging as problems rapidly escalate in trying to go beyond about 17 bits. This chapter discusses these problems and culminates in the proposal for a specific approach and design.

### **2.1 Generic problems in high-precision electronic instrumentation**

To many people the design of electronic circuits is considered as something of an Art [2.1], perhaps because the union of components to make a meaningful whole is seen in much the same way as an artist blending colours and textures to create a pleasing effect. Even in more informed circles this notion is given some credence as the inventiveness needed to design an elegant circuit for a specific function is not commonplace, and the designer is perceived to have a talent akin to that of an artist. However the analogy is deficient and misleading for the electronic design engineer will invariably use models of the real components during the design process, whereas the artist will use real components (pigments) almost straight away. If the object of electronic design is to produce a circuit diagram that has aesthetic appeal then perhaps it is an art form, but unlike a painting the circuit diagram is merely an intermediate stage. What the designer really seeks to create is a physical working circuit, which can only operate as expected if there is a strong correspondence between the meaning attributed to the symbols on the circuit diagram and the behaviour of physical components. Unfortunately the models of analogue circuits become increasingly

simplistic and inaccurate as the desired resolution increases, and very much more effort and understanding is needed to predict the overall performance of each circuit element.

For super-precision current sources where the resolution and linearity are to be about 1 part per million of full scale output (ppm FSO) there is the implied requirement that long term drift, noise and variations with temperature be correspondingly small. This necessitates models of components to hold true for six orders of magnitude, which is often not the case. Models are developed either by theoretical analysis of the physical principles by which a component works, by experimental observations, or more usually by studying data sheets published by a manufacturer. For an individual component it may be possible to characterise its operation to better than 1 ppm under all anticipated operating conditions in the near future, but this does not cater for hitherto undiscovered mechanisms of aging due to, say, background cosmic radiation. It is most unlikely that information such as this is in a data sheet, but that may not be sufficient reason to ignore the possibility.

Very often a circuit diagram shows a line that represents zero volts, and is generally considered as an ideal conductor with no voltage drops along it. Of course at high frequencies this 'ideal' conductor has a significant inductive component which designers of Radio Frequency (RF) circuits are taught to model. At low frequencies and down to direct current (dc) the resistive component of a track on a printed circuit board is very often ignored. Voltage drops of several millivolts are commonplace, and must be considered in precision instruments where a potential difference of even  $10\mu\text{V}$  may be undesirable. This kind of effect is often static and may be compensated, but it does show an obvious source of difficulty when designing precision circuits.

Four areas which cause dynamic problems are of sufficient importance that they are now mentioned individually. The intention is to highlight specific difficulties so they may be considered appropriately during the description of various designs in later pages.

### 2.1.1 Drift with temperature

The idea that the behaviour of a component varies with absolute temperature is intuitive and obvious, and in the case of components such as voltage references manufacturers quote a drift in terms of ppm/°C. Careful inspection of data sheets

reveals that the drift figure is obtained by dividing the change in voltage output by the change in temperature, when the temperature changes from 0°C to 70°C. The drift is the mean rate of change and may be much higher at a particular temperature if the response is non linear, see [2.2]. On the other hand, manufacturers quote the maximum drift that may be expected of, say, 10 ppm/°C with the implication that most components will be significantly less. Is a Gaussian distribution assumed with  $3\sigma$  limits at 0 and 10 ppm/°C, or is some other distribution assumed ? What percentage of components will have a drift of less than 4 ppm/°C ? These are typical and reasonable questions that are not readily answered, but affect greatly the expected performance of a particular instrument built from such components.

Specifications for the drift of input or output voltage with temperature are available for most components, and these often show the effect to be positive or negative. The distribution is usually Normal with a mean of zero and the limits given are derived from  $\pm 3$  standard deviations. A naïve approach is to characterise the worst case drift of an instrument by adding together all of the worst case drifts given in the data sheets for each of the components in use. This approach is flawed because

- a) It assumes the contribution to overall drift from each component is additive with the same weighting, and in general this will not be so. The very least that should be done for a particular circuit is to consider a weighted sum.
- b) The changes with temperature may be non-linear so that for a particular temperature the drift may be much better/worse than expected. For example, in the Schlumberger digital voltmeter type 7081 an extensive number of components are used to compensate for the 'curved' voltage drift of the reference diode [2.3].
- c) There are sources of drift with temperature other than active components. Passive components also have temperature coefficients and in critical sections of the circuits these must be considered. However what is often forgotten are thermoelectric potentials caused by junctions of dissimilar metals, and these may be several  $\mu\text{V}/^\circ\text{C}$  [2.4]. Some precision amplifiers have drifts which are several orders of magnitude lower than thermoelectric effects so the latter will dominate.
- d) Self-heating may cause unexpected local temperature gradients and changes in ambient temperature may not be of such importance.



It is clear that drifts caused by temperature changes need to be considered most carefully.

### 2.1.2 Drift with time

Drift with time, when the temperature is held constant, is another type of drift that is often ignored because it is so small. This may well be true for many applications but for precision measuring/controlling instruments long term drift may be a significant concern. Manufacturers do not provide such specifications except for components which have to respond to d.c. conditions. For example chopper-stabilised amplifiers, precision voltage references, and high resolution ADCs and DACs. Chopper-stabilised amplifiers, by their very design, have extremely low drifts with time; typically less than 0.01 ppm/month. For the others, drifts of about 10 ppm/1000 hours are often quoted, and since slow 'runs' of 10 hours are possible a change of 0.1 ppm may not be insignificant. Also over a period of several months the drift may be more significant than that caused by changes in operating temperature.

### 2.1.3 Noise

The effect of random fluctuations of current in electronic components have been studied extensively and characterised [2.5]. Many physical processes are present in real semiconductor devices which result in noise with frequency components that vary throughout the spectrum. For a circuit with many components, noise at its output may usually be considered as a combination of incoherent voltage (or current) sources. In data sheets values for noise in particular frequency bands may be given, but for a specific band it is usual to compute the noise based on the graphs provided showing the noise power spectral density in  $\mu\text{V}/\sqrt{\text{Hz}}$  versus frequency. Idealised models of components [2.6] often assume that flicker ( $1/f$ ) noise is dominant below some critical frequency  $f_c$ , while above that white noise is present. This leads to equations which may not model a real device. For example the low frequency noise spectrum of bipolar operational amplifiers may be close to  $1/f$  but for amplifiers with JFET inputs  $1/f^2$  is more likely, and many real amplifiers have  $1/f^n$  where  $n$  is between 1 and 2. Consequently for precision instruments it is important to model noise using published graphs of spectral density. This may result in numerical integration using data points and/or non-linear regression analysis to obtain equations for definite integration.

Noise is also presented in data sheets in terms of a peak-to-peak (pk-pk) value which is usually in  $\mu\text{V}$  over some frequency band. Such figures may be combined in a weighted sum to provide an estimate for the maximum pk-pk value for a compound circuit, but this is not the same as the rms value. If the peaks are short-lived they may have a significant amplitude but negligible energy, and care is needed in the prediction of the overall effect(s).

#### 2.1.4 Interference in mixed digital/analogue circuits

The functionality of many instruments can be increased by the inclusion of a local or embedded microprocessor, which may be programmed to perform a wide range of useful operations. All microprocessors require additional memory and input/output devices to operate, and due to the high speed of execution a complex digital waveform is generated on all interconnecting buses. The waveforms have high frequency components of the order of Megahertz, but may also have low frequency components of the order of 10-100 Hz, because of the cyclic nature of many control programs. When precision analogue components share the same power supply, or even just a common ground line, these frequency components are seen as unwanted disturbances on the analogue output. The method of coupling is not usually by electromagnetic interference but rather by changes in the potential of the shared wire(s) due to transient currents caused by changes in digital outputs. With the advent of optical-couplers, which allow the exchange of digital information without direct connection of electrical circuits, isolated sub-systems can be formed. Only the minimum of data is passed across the coupler(s) to control the analogue circuits, and interference is kept to a minimum. Unfortunately, in the case of an analogue subsystem which uses multiple digital-to-analogue circuits it is necessary either to use numerous couplers in parallel, or to employ digital circuits to decode a serial data stream passed via one coupler. The former choice is expensive while the latter becomes self-defeating as digital logic is needed in the supposedly analogue-only circuit.

An alternative approach now exists because complete low-power microcontrollers are available where the microprocessor, memory and input/output ports are all integrated into one device. Consequently all interconnections are kept 'on-chip' and signals on the output ports may be connected directly to analogue subsystems without causing undue interference. There is still the possibility of unwanted coupling but separate power supplies for digital and analogue subsystem joined at only one star point and

with suitable decoupling capacitors minimises the effect of digital transients. It is also necessary to arrange for digital control signals to be routed on the printed circuit board (PCB) so that they are kept clear of analogue components.

For reasons of safety all mains-operated instruments in metal chassis should have the metalwork connected to the earth of the supply. Many instruments also connect the zero volt rail to the chassis and therefore to the local earth. But if a microcontroller has a serial port for communication with a remote computer which itself is joined to a local earth it is possible to create an earth loop with one connection via a cable between the two ports and another via the mains earth wiring. Unfortunately mains earth points around a building are not always at the same potential and unwanted interference is generated within 'ground' loops. It is not essential to have the zero volt rail(s) of the instrument joined to its chassis, and this removes the ground loop, however this may lead to undesirable potentials between 0 volts and the chassis. Isolation may also be provided using opto-couplers, and in particular with an optically coupled serial link which is now available in integrated form.

## **2.2 Applicability of published designs for programmable current sources**

About a 12 papers from the last 10 years were found using the BIDS [2.7] computer database services, but not all were appropriate because of differences in interpretation of the term 'programmable'. Four different categories of current sources were identified which were programmable

- a) at the time of manufacture
- b) by selection of suitable resistors or switches
- c) by digital codes but for high voltages  $>200$  V
- d) by digital codes and for use in instrumentation

Only 3 papers were found in category d) and each of these is discussed in more detail to gain insight into what has been achieved, and to highlight good and bad features. This style of presentation and comparison is a little unusual but appropriate because of the lack of published work in this area. All three papers have the common feature that the DACs used do not have sufficient resolution and there is no real likelihood of using a basic design with a 'better' DAC.

### 2.2.1 Review of - Programmable current supply for inductive load (1986) [2.8]

The circuit diagram is difficult to follow because all the elements shown as operational amplifiers have unrecognised (Russian) part codes. However it is clear that the voltage output of a 12-bit digital-to-analogue converter feeds a power amplifier using discrete transistors, which achieves voltage-to-current conversion with current gain. A 2-terminal reference resistor driven by an ungrounded inductive load provides voltage feedback. The DAC is controlled by digital latches which are connected directly to the data bus of an Elektronika NTs-80-20/1 microcomputer. The age and tone of the paper suggest this to be a desk-top computer with a microprocessor and auxiliary components rather than a single-chip device. The text also states "The preamplifier has a Goldberg circuit; the high-frequency circuit is regulated by a low-frequency modem channel. This ensures an output current instability of  $\leq 0.1$  mA over the temperature range 20-50°C" The exact meaning of these words is unclear but it is apparent from the circuit that there are both ac and dc signal paths around the power amplifier.

There are four aspects of the design which limit its application as a high precision current source.

- a) The digital logic is not isolated from the analogue components and there may be ground 'loops' and/or other interference effects.
- b) The DAC is only 12 bits giving a resolution of 1 part in 4096
- c) There is no analysis about noise contribution of the components
- d) End effects at the 2-terminal reference resistor will be significant at higher precision.

### 2.2.2 Review of - Microcomputer-controlled, programmable current source for NMR measurements at very low temperature (1991) [2.9]

This paper describes a circuit which is intended to offer 16-bit resolution. Serious attention is given to the problems encountered in the design of precision electronic instruments. A complete circuit is not presented but the general description is of a microprocessor-based (Z80) instrument with an IEEE-488 interface, and an analogue sub-system that is optically isolated. The needs for low-noise operational amplifiers and a reference resistor with a low thermal coefficient of resistance are mentioned, as is the problem with glitches from the DAC. The usefulness of monitoring the state

of the power amplifier is also explained and provision is made for appropriate components. There are graphs which show the change in current divided by the mean current taken over several hours to be less than  $5 \times 10^{-5}$ . This corresponds to about 1 part in  $2^{14}$ , which is large considering a 16 bit DAC is used. There are two areas of weakness which limit the resolution and accuracy of the design.

- a) The DAC is stated to be a 16-bit DAC703JP by Burr-Brown; however inspection of the data sheet shows the 'J' part to guarantee monotonicity to only 13 bits. Also there is no guarantee on the maximum temperature coefficient for the internal voltage reference, although  $\pm 10$  ppm/ $^{\circ}\text{C}$  is given as typical. Selection of the 'C' grade part would have offered monotonicity to 15 bits and a maximum temperature coefficient of  $\pm 15$  ppm/ $^{\circ}\text{C}$ .
- b) The text states "...The reference resistor  $R_N$  made from manganin has a nominal value of  $0.2 \Omega$ ...", and the circuit diagram shows a 2 terminal device. There will be end effects caused by the connection of copper wires or printed circuit board traces to the manganin and a 4 terminal resistor is preferable, where the current sensing connections are not the same as the current forcing connections.

### 2.2.3 Review of - Development of a programmable current source (1993) [2.10]

The programmable current source described here once again uses a voltage to current converter, where the voltage is derived from a DAC. A 12-bit DAC provides 4096 steps over 6 different ranges selected by relay contacts. A great deal is said about the IEEE-488 interface but relatively little about the analogue components. It is stated that the stability of the output current depends mainly on the stability of the voltage references (plural) whose temperature coefficient is less than 50 ppm/ $^{\circ}\text{C}$ . This implies that the coefficient of the reference resistors and DAC are much lower, but this is not clear. There is no consideration of long-term drift or the nature of any noise, and while it is true that chopper-stabilised amplifiers provide very low d.c. drift they are prone to clock feed-through and nothing is said of this or anything done to compensate for the effect. There is no isolation between digital and analogue grounds, but a 4.5 digit meter measures what voltage the DAC actually generates rather than what it is supposed to. This meter may have its own imperfections but potentially it is better than the DAC. Also significant is the description that the design is for a "...high precision..." current source, as in the context of the present work the circuit is considered to provide only modest precision.

### 2.3 Design ideas for a suitable 1 ppm DAC

Beginning with the assumption that the current source to be designed would contain a DAC to generate a reference voltage followed by a near perfect voltage-to-current converter, it was thought appropriate to investigate further commercial DACs.

There are many semiconductor manufacturers who supply digital-to-analogue converters but after a thorough study of the parts available none was considered able to meet the design target, which requires resolution and monotonicity to 20-bits. Figure 2.1 shows the best of the parts that were studied together with important operational parameters and general comments.

Device	Res.	Mono.	Gain $\pm$ ppm /°C	Power mW	Manufacturer	Comments
DAC-HP16B	16	14	15	675	Date1	Resolution too low
AD1145BG	16	16	0.1	2.5	Analog Devices	Lowest power and drift
AD1139J	18	18	4	825	Analog Devices	'Best' DAC found
AD1860	18	15	25	110	Analog Devices	PCM Audio DAC
DAC1138K	18	NA	0.8	900	Analog Devices	Requires external reference to achieve quoted drift.
DAC729KH	18	16	5	1200	Burr Brown	Monotonic to 16 bits, but high power
PCM63P	20	16/17	25	225	Burr Brown	PCM Audio DAC
Texas Instruments, Motorola, National Semiconductor, Plessey - No suitable DACs						

**Figure 2.1 - Commercial DACs**

Burr Brown describes its PCM63P device as a 20-bit monolithic Audio DAC, but careful inspection of the text reveals a statement which says "... the extremely low Total Harmonic Distortion (THD) performance is typically indicative of 16-bit to 17-bit integral linearity, ... the relationship between THD and linearity, however, is not such that an absolute linearity specification for every individual output code can be guaranteed". These comments are typical of DACs designed for use in Compact Disc audio systems where THD is more important than absolute linearity, and therefore such DACs should be avoided. It is also worth noting that the PCM63P has a full-scale current output of 2.00 mA, which means that a precision current (rather than voltage) amplifier is needed in order to maintain accuracy whilst providing a nominal 100 mA of coil current.

Although the AD1139J offers monotonic performance to 18 bits it is obviously not capable of 20-bit performance and is therefore not sufficiently 'accurate', where 'accurate' is used to mean that

- resolution and non-linearity are  $< 1$  ppm
- temperature coefficient is  $< 1$  ppm/ $^{\circ}\text{C}$
- long-temp drift is below 1 ppm / 100 hours , (say)

What was required is an almost ideal 20-bit DAC, and no commercial source can supply it. Instead a special system must be built. Three different techniques were considered which might achieve this and these are discussed in turn.

### 2.3.1 Pulse width modulation ( $1:10^6$ )

It is well known that digitally controlled pulse-width-modulated signals may, in principle, be filtered to produce analogue signals whose level can be increased linearly with respect to digital control signals. An arrangement for a 20-bit converter is shown in Figure 2.2 where the digital demand is continually compared with the output of a 20-bit counter. When  $a$  is greater than  $b$  the  $a > b$  output becomes a logic 1 and causes the analogue switch to connect the resistor to a reference voltage rather than ground. When  $\text{REF} = 2^{19}$  a square wave is produced with a 1:1 mark to space ratio, and a mean value of  $V_{\text{ref}}/2$  appears after the filter along with unfiltered ripple.

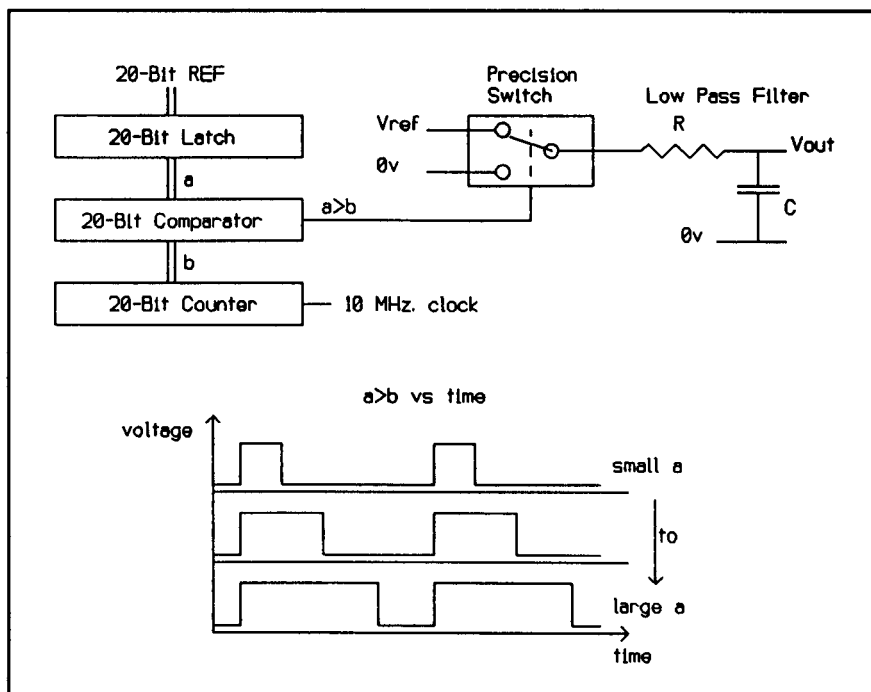


Figure 2.2 - Pulse-width-modulated DAC

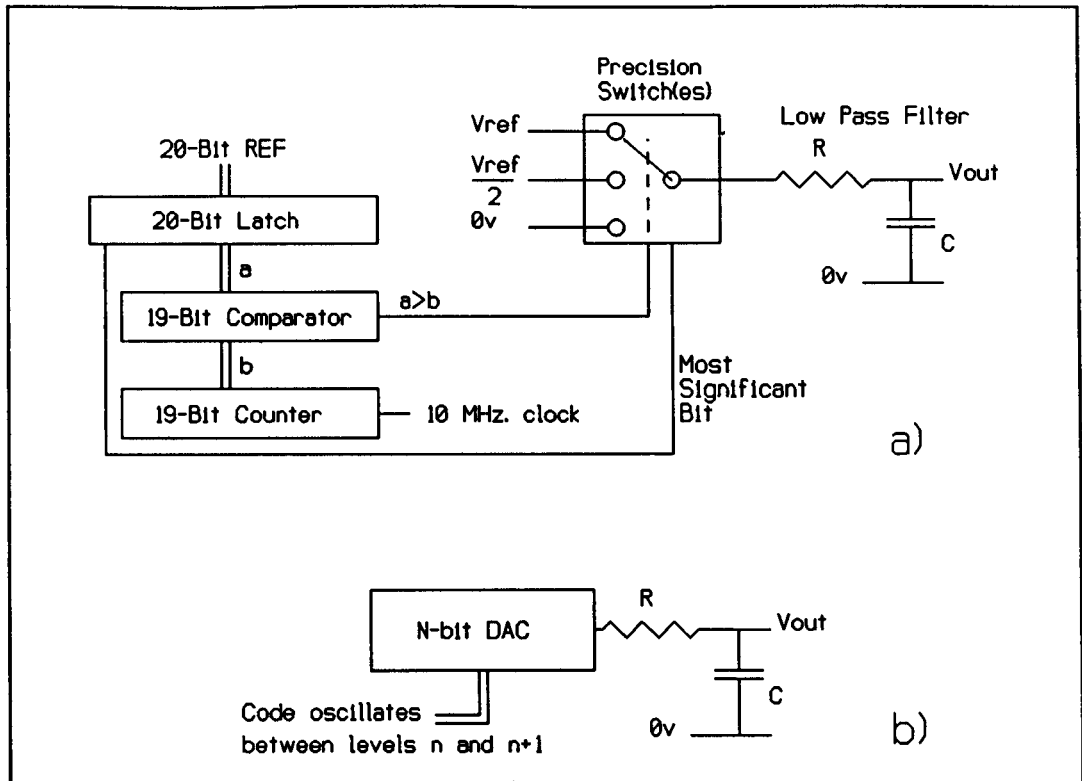
With present technologies there are two practical limits to this approach. Firstly the time for the comparison to be performed, and secondly the response time of the analogue switch. If the counter is clocked at 10 MHz, the comparator has only 100 ns to perform its function, and in the worst case, a delay of less than 5 ns per bit is needed. Unfortunately even at 10 MHz, the cycle time is about 0.1 s and requires low-pass filters with long time constants to extract the d.c. component of the waveform. Active filters may reduce the settling time but they introduce their own drifts. Digital circuits may operate at more than 100 MHz and the period  $T$  may be reduced, but there is still the requirement for an analogue switch with sufficiently fast response times, and this is not available. Even at 10 MHz, when  $REF=1$  only one pulse of 100 ns duration results and the analogue switch must respond within a negligible time of say 5 ns. Charge injection from the digital control line to the filter is also a major limitation. Consequently the technique was considered infeasible.

### 2.3.2 Multiple level pulse-width-modulated DAC (1:64)

In the previous approach the clock rate is limited by delays in the comparator and temporal characteristics of the analogue switch. It is advantageous to reduce the number of bits in the comparator, so that the cycle time may be decreased without increasing any frequency components. This may be achieved by splitting the range, and Figure 2.3a shows the arrangement when two references are used, together with a three-way analogue switch. The most significant bit (msb) of the latched input is used to decide *which* reference voltage is used, while the  $a > b$  output still determines *when* it is used. When  $msb=0$ ,  $V_{ref}/2$  and  $0v$  are used, and when  $msb=1$ ,  $V_{ref}$  and  $V_{ref}/2$  are used. Saving only one bit in the comparator is not very significant but the idea may be extended in principle to use  $2^n$  reference levels. Unfortunately an analogue switch with  $2^n+1$  inputs is not very practical when  $n$  is greater than about four. However the same effect will be achieved by using an ideal  $N$ -bit DAC and modulating its output between levels  $n$  and  $n+1$ , as shown in Figure 2.3b. With more analogue levels the number of time zones for pulse-width-modulation may be reduced and a higher repetition frequency obtained. The higher the frequency the more easily the signal may be filtered to remove ripple in the 0 to 1000 Hz band to which many precision mechanism can respond.

The idea of modulating the output of a DAC is intuitively correct but requires formal analysis. Consider a converter with a 20-bit overall performance where  $N$ -bits are devoted to a normal DAC and  $M$ -bits to the control of its output. In particular the  $M$ -





**Figure 2.3 - Multiple-level PWM N-Bit DAC**

bits determine the ratio of time the DAC spends at its  $n$  and  $n+1$  levels.

Let any 20-bit code be  $n:m$  where  $0 \leq n \leq (2^N - 1)$  and  $0 \leq m \leq (2^M - 1)$  and suppose

$$V_{dac} = f(n) = \frac{n}{2^N} \times V_{ref}$$

then average output =  $V_{out}$  is given by

$$V_{out} = \frac{f(n) \cdot (2^M - m) + f(n+1) \cdot m}{2^M}$$

$$V_{out} = \frac{V_{ref}}{2^N} \left[ \frac{n \cdot (2^M - m) + (n+1) \cdot m}{2^M} \right] = \frac{V_{ref}}{2^N} \left[ n + \frac{m}{2^M} \right]$$

then when

$$m = 0 \quad V_{out} = \frac{n \cdot V_{ref}}{2^N}$$

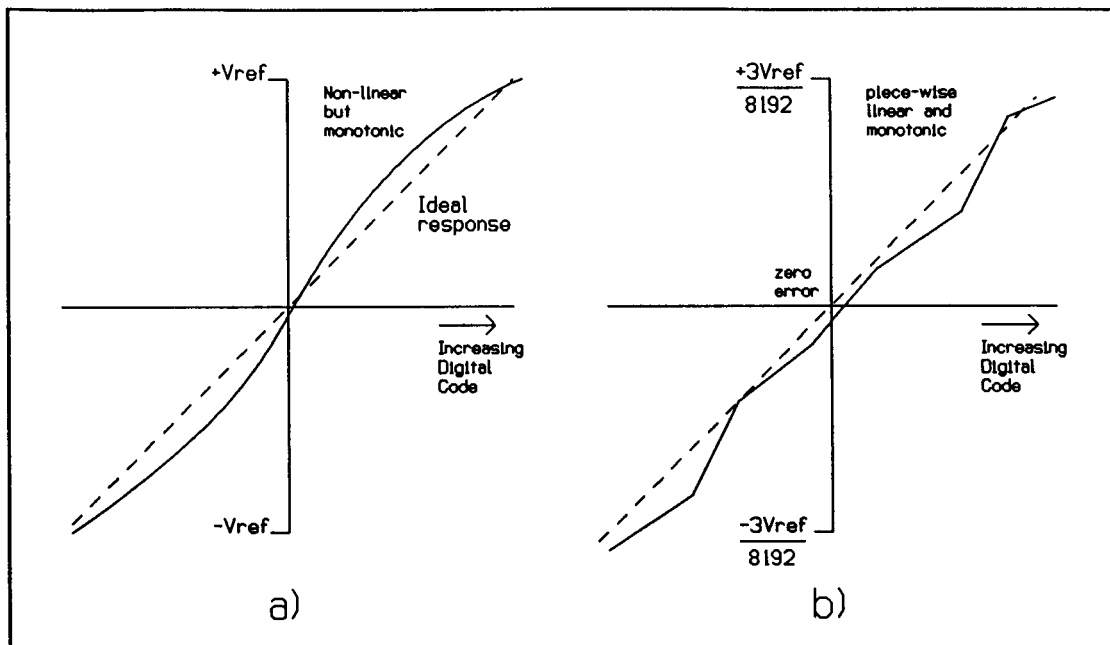
$$m = 2^M - 1 \quad V_{out} = \frac{V_{ref}}{2^N} \left[ n + \frac{2^M - 1}{2^M} \right] = \frac{V_{ref}}{2^N} \left[ n + 1 - \frac{1}{2^{N+M}} \right]$$

It can be seen that, for any  $n$ , held constant, the output voltage varies linearly with  $m$  from the  $n$ th DAC level to just below the  $(n+1)$ th, and a resolution of 1 part in  $2^{N+M}$  is obtained.

There are conflicting requirements for the values of N and M. On the one hand a small value for M is desirable because this would allow a high repetition rate for the pulse-level-and-width-modulated signal, which could then be filtered more quickly. However, because  $N+M=20$ , a small value for M implies that a high precision N-bit DAC is needed, which is precisely what is not available. With current technology a sensible compromise is achieved when  $M=6$  and  $N=14$ . By switching between levels n and n+1 in the ratio 0:64 to 64:0 and filtering the output, a piece-wise linear interpolation is obtained. The settling time for the DAC limits the maximum frequency but in principle the output may be filtered much more readily and have a settling time which is only 10 s of milli-seconds. Unfortunately the output of most DACs have a characteristic 'glitch' when switching between levels, which is worst for a majority change. For a 14-bit DAC this occurs at code levels of 8191 to 8192, but still occurs at all other levels to a greater or lesser extent. Consequently the output of the filter will not be an interpolation between levels. Even in the absence of 'glitches' the net output may not have the desired integral non-linearity which is limited by the linearity of the 14-bit DAC. Figure 2.4a shows a typical response of a 14-bit DAC where, for the sake of explanation, the non-linearity appears greatly exaggerated, while Figure 2.4b shows the interpolation between levels around zero, but is representative of the response throughout the range. If the interpolation is exact there is a piece-wise linear fit between adjacent DAC levels, which themselves have a deviation from a straight line. Stated another way, it is clear that the local gains vary and that the integral non-linearity over the entire range is determined by the 14-bit converter and is therefore no better than  $\frac{1}{2}$  least significant bit, or 1 part in  $2^{15}$ . The values of N and M may be changed but the nature of the response will remain the same. Once again the technique was considered infeasible. (In fact it is infeasible in its basic form, although it may form the basis of a more subtle approach, see chapter 7.)

### 2.3.3 Coarse and fine DACs

A well known measurement technique is to use coarse and fine scales. The same principle may be applied to two DAC in order to create a DAC with greater resolution. However it is naïve to believe that two 8-bit DACs may be used to create a single 16-bit DAC simply by summing the two DACs with relative weightings of 1 and  $\frac{1}{256}$ . The difficulty lies in the fact that the output levels of the coarse DAC are not evenly spaced and the fine DAC needs to have a different gain factor associated with it for every pair of adjacent levels from the coarse DAC. In this way the full-



**Figure 2.4 - Piecewise linear DAC**

range output of the fine DAC may be made to fit between all levels of the coarse DAC. In the case of 8-bit DACs if the weighting of the fine DAC is fixed at  $1/128$  then in principle it may trim the output by  $\pm 1$  bit of the coarse DAC. If the differential non-linearity of the coarse DAC is less than  $\pm 0.5$  bit, it is possible to create a 15-bit DAC by measuring the actual output of each level of the coarse DAC, and defining the coarse and fine codes so as to achieve any desired value. The overall linearity then depends not on the DACs but on the ADC used to measure the composite voltage. A self-contained DAC does not result, but with a suitable high resolution Analogue-to-Digital Converter (ADC) a subsystem may be formed with the required linearity and resolution. Most 6-digit voltmeters are too slow but an acceptably fast ADC module [2.11] is made by Analogue Devices, see Appendix [A]. It achieves integral non-linearity of  $\pm 1$  ppm, and gain drift of  $\pm 1$  ppm/ $^{\circ}$ C.

## 2.4 Minimising risk in the NPL/DTI project

Some of this research work was carried out in order to satisfy the requirements of a contract between the Department of Trade and Industry (DTI), and the University of Warwick (UW) [2.12]. The DTI wanted a measuring facility to be provided for the National Physical Laboratory (NPL) which would give a resolution of 20 pm over a range of 10  $\mu$ m. After a competitive tender a design based on an X-ray interferometer using a silicon monolith was accepted, with constraints on time and budget. The capital cost of the programmable current sources was expected to be no more than about £10k in a project worth £390k. Development time and costs for one-off designs

are critical and dominate over small cost-saving, changes to the hardware. The economic decision involves taking a secure route in the design strategy which is believed most likely to get close to the full specification even if full compliance is not achieved. This mediates to some extent against introducing newly developed devices for which little practical evidence of exact behaviour. Also, in a private communication with Mr. P. Cooke of Cooke Consulting, who had experience in this kind of project work and detailed circuit design, concerns were expressed about various kinds of pulse modulated techniques when compared with closed-loop methods using coarse/fine DACs and a precision ADC. Consequently maximising the chance of success of the electronic circuits was considered more important than minimising the cost.(In other applications cost may be a significant issue and is discussed further in chapter 7.).

The project required the use of 2 coils to provide forces for translation and rotation. The latter needed to compensate for the effects of parasitic torques introduced by inaccurate machining and/or misalignment of the monolith. Therefore, 2 programmable current sources, or drives, were needed that could be controlled simultaneously. Two particular concerns were identified and given extra consideration. Each is discussed below.

#### 2.4.1 Coil self-heating effects and cures

Each coil operates at near room temperature and the fine copper or silver wire used to form it has a finite electrical resistance. When a current passes through a coil there is local heating and the temperature rises. This results in thermal expansion of the coil, and may reduce the field strength of the permanent magnet which lies within it. Based on the ideas presented in [1.4], if the pole of the magnet lies near the centre of the coil and expansion is symmetric about this point there is negligible change in the force exerted on the magnet. However it is not clear what the local temperature rise might be and how this affects the strength of the field. In discussions with one of the authors, Dr. D.G.Chetwynd, it was thought unlikely that local heating would be a problem, because a) the coil was usually wound on a brass former and bolted to baseplate, both with good thermal conductivity, and b) the optimally designed coils have a resistance of less than  $20\Omega$  and operate at 70 mA maximum, giving a power of less than 0.1 W. The magnet does not touch the coil and its temperature is dominated by ambient conditions. However some doubt still existed and in any event the design was to be suitable for other environments.

Consequently it was considered worthwhile to provide a means of regulating the temperature near the coil. One technique considered was to try and maintain the coil at ambient temperature by use of a Peltier heat pump, but the inherent inefficiencies would mean some other part of the apparatus would have a local temperature rise, and it would be necessary to screen against additional periodic electrical noise. Another, and preferred technique, relied on surrounding the

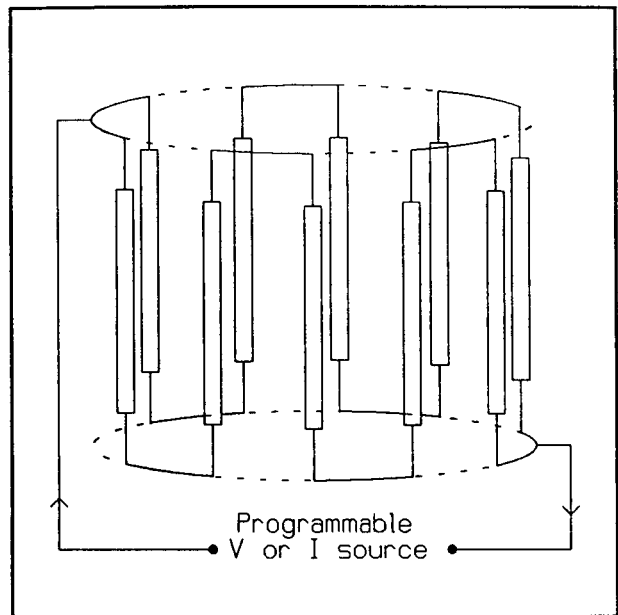


Figure 2.5 - Proposed heating jacket

coil with a resistive heating 'jacket' as depicted in Figure 2.5, and controlling the current in the resistors such that as the current in the coil was varied, the total power dissipation remained the same. Once in equilibrium, constant power dissipation gives a constant temperature. Rare-earth magnets, based on samarium/cobalt alloys, have a negative temperature coefficient of about  $-0.025\%/^{\circ}\text{C}$  (as for Incor 30HB) for their intrinsic field strength at room temperature. Therefore it is necessary to stabilise the operating temperature to  $0.004^{\circ}\text{C}$  to achieve a stability of 1 ppm. Based on practical experience it is sensible to put an upper bound on the temperature rise in a coil at  $10^{\circ}\text{C}$ , which means the temperature regulation is at most 1 part in 2500. This suggests the use of a 12-bit DAC driving a jacket of equal resistance to the coil, and with similar voltage swings, is sufficient. It is important that changes in current in the jacket do not cause any change in the magnetic field, and the possibility of cross-effects may be minimised. This may be achieved by using a combination of series and parallel resistors in order to achieve current flows in opposite directions.

#### 2.4.2 Embedded versus sub-system controllers

Embedded systems are often tedious to develop because it is difficult to programme microprocessors which interact with real-time events and perform extensive calculations. Initially it was thought that each drive should be self-contained, but upon further consideration it was decided advantageous to introduce a desk-top computer between the (expected) host computer and each of the drives. This 'slave' computer could be programmed much more easily in a high-level language than the assembly

language needed by the embedded microcontroller. Also with the addition of another display, diagnostic information about the performance of the drives could be provided. In this way the program in each of the drives performs the real-time control activities associated with the DACs and ADCs as well as dealing with primitive communications, while the 'slave' PC implements the closed loop control algorithms. Although this approach increases the cost by that of a desk-top PC at the time this was only about £1k and well within the budget. The price was considered small when compared with the increased flexibility. The arrangement is shown in Figure 2.6, where interrupt driven communication buffers simplify passing messages whilst allowing critical foreground activities to continue.

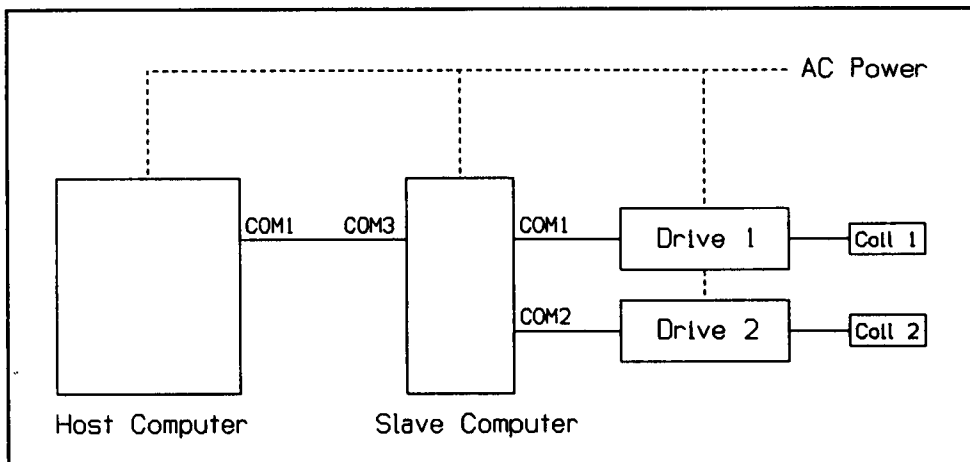


Figure 2.6 - General arrangement of equipment

For 'volume' production there is a significant potential advantage if the cost of the desk-top PC can be saved by making the embedded software perform the control function. In this regard it is appropriate to suppose the design will incorporate an embedded micro-controller with sufficient memory and data-processing capability, so the PC is not needed.

## 2.5 Proposed design

An elegant and very worthwhile modification to the basic idea of using two DACs and a precision ADC as described in section 2.3.3, is for the ADC to measure the voltage across the voltage-sensing contacts of the reference resistor in a voltage-to-current converter (VtoI). This single modification (innovation) has the effect of making the whole design insensitive to errors and drifts in the performance of the VtoI, since these will be detected by the ADC and the control strategy can modify the DAC levels to provide the required output. So long as the resistance of the precision

reference resistor does not vary, the current in the coil is directly proportional to the measured voltage, and hereafter discussions are based upon voltage levels which are quite reasonably assumed to have a linear relationship to current in the coil. A suitable 4 terminal resistor is available commercially with a nominal drift of 0.0 ppm/°C at 25°C, see Appendix [B]

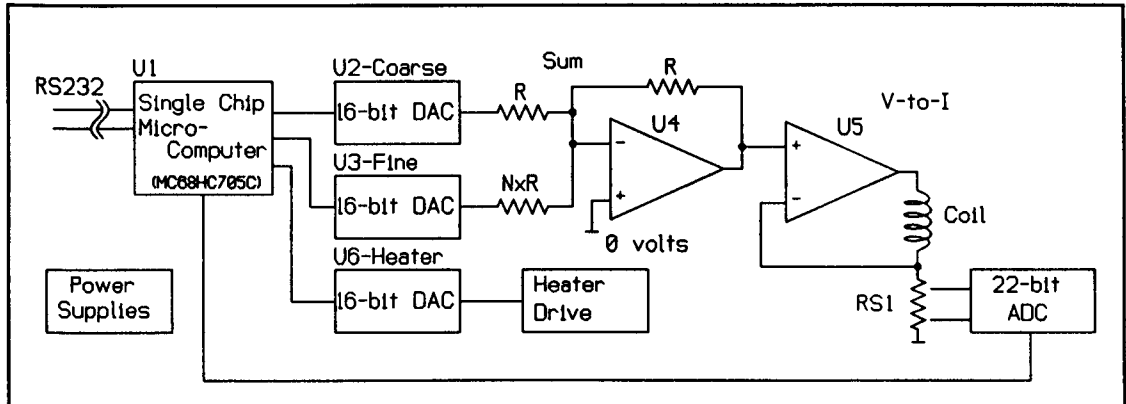


Figure 2.7 - Block diagram of drive

The major components of the proposed drive circuit are shown in the Figure 2.7. Two 16-bit DACs and a 22-bit ADC are combined together to create a 22-bit subsystem. The output of the DACs is summed by U4 but with significantly different weightings (1:N) such that U2 represents a coarse setting, and U3 a fine setting, of the reference voltage seen at the non-inverting input of U5. The feedback around U5 creates a voltage-to-current converter, by ensuring that the voltage across RS1, is very close to that generated by U4. It will not be the exact current that is expected because of the offset voltages in, and finite gain of, U5, as well as errors caused by the end effects of the forcing terminals of RS1. However all these effects are deterministic and repeatable, so by measuring the voltage across the sensing terminals of RS1 with the ADC, the actual current may be calculated. By suitable modification of the DAC codes any required current may be obtained, subject to limits imposed by considerations of the power dissipated by real components. The exact values of the components and the voltage swings depend upon the devices actually employed and are discussed in detail in section 3.4. There it is shown that there are conflicting requirements, but that a useful set of values may be obtained. (In particular N is given a value of 64).

Although U2 is a 16-bit DAC the intention is that only about 2N equally spaced levels will ever be used, and that the ADC can provide an accurate measure of the voltage associated with every one. A preliminary and relatively brief calibration cycle will allow the voltage level associated with each coarse DAC code to be known and held

in a look-up table. Subsequently, for any desired level, the look-up table may be used to identify the exact value of the nearest level, which in turn permits the contribution of the fine DAC to be calculated. The transfer function of the U3 may be assumed from published specifications, but more likely determined by linear regression analysis on the changes measured by the ADC as U3 is varied over its range during an extended calibration cycle. See page 69 for further details.

Figure 2.7 also shows an embedded single-chip microcontroller (U1) whose main function is to decode messages sent from a controlling computer via an optically isolated RS232 serial link. These messages include requests for the DAC levels to be changed and for the reading of the ADC to be passed back. A 16-bit DAC (U6) may be used to determine the power dissipated by an electrical heater surrounding the coil, so it may be operated at constant temperature. The heater driver could be a simple voltage power amplifier but it is relatively simple to replicate the voltage-to-current converter and provide a secondary programmable current source of lower resolution, if temperature compensation is unnecessary. The simplicity of this block diagram belies the complexity of the real design which is discussed in the next chapter. Subtle issues such as multiple power supplies with star points, and techniques to avoid aliasing in chopper-stabilised amplifiers are introduced.



## Chapter 3 Drive circuits in detail

In various parts of this thesis the word 'drive' is used and there is the possibility of some confusion when reading the text in isolated sections. To clarify the situation the reader is asked to remember that in each of two chassis there are two driver circuits; one connected to a coil and the other connected to a resistive heating element. Depending upon the context, 'drive' may mean one of the two sub-chassis, or one of the two current sources within a particular chassis. Since the two sub-chassis, or drives, are identical descriptions given in terms of one drive apply to both.

The following detailed descriptions relate to various circuit diagrams which appear in Annex [1]. A total of 6 circuit diagrams were produced with the aid of a computer-aided design package called OrCAD SDT [3.1]. A block diagram on sheet 1 shows the main interconnections between the remaining 5 sheets. For the sake of clarity the circuit elements described below are ordered by function rather than sheet number, and several important parts of the circuit have been copied from the Annex and appear along with the descriptions. Also provided in the Annex is a complete listing of components showing the reference name, part code, suppliers order number, function and cross-reference to sheet number.

### 3.1 Power supplies - *Circuit sheet 2*

The unit is mains powered, with a conventional approach to safety issues. The supply of 240v 50Hz ac enters the drive via a 3-terminal IEC chassis-mounting plug with an integral fuse and filter. The Live and Neutral signals are switched via the double pole switch connected to JP2, while the Earth line is taken to the chassis and shield within each toroidal transformer. The Earth is not taken to the 0v of the circuit and this means the whole circuit is floating. If for some reason it is considered necessary to join the Earth to the 0v of the circuit this may be achieved by joining points on the Printed Circuit Board - J2A (near mains inlet JP1) to J2B (near C14 and REG5). Large voltage transients which pass through the filter are absorbed by a transient voltage suppressor, VAR1.

Three transformers are used to provide power for different parts of the circuit. Each is of the toroidal type in order to minimise magnetic and mechanical interference, and reduce internal heating when compared with conventional transformers on a standard soft iron E-core. One transformer provides an independent supply for the ADC

module, so that a 'star point' may be created within it. This is necessary to avoid unwanted earth loops.

T1 is used to provide +15v and -15v supplies for the precision Analogue-to-Digital Converter module, via regulators REG1 and REG2 respectively. Although these appear to be of a popular generic type, they were selected after careful inspection of the data sheets associated with several similar voltage regulators. Specifically a comparison was made between regulators from Motorola and National Semiconductors (NS). The NS parts have significantly better specifications for line and load regulation, and consequently NS parts were used. During the design stages the importance of the stability of the supply voltages was considered in order to decide if it was necessary to build discrete regulator stages with better characteristics than simple 3-terminal regulators. The supply rejection ratios for the precision ADC and the high current power operational amplifiers in the output stages are so high that precision regulation was deemed unnecessary. However, since so much depends on the 'quality' of the overall design, and component cost was not a significant constraint, the general decision was taken to use higher-grade parts wherever the opportunity existed. This philosophy is shown in the choice of all smoothing and decoupling capacitors. It is important to note that the port labelled 0vADC is connected directly to the power supply input of the precision ADC and that a star point exists within this ADC which joins 0vADC to 0vDRV. Originally it was anticipated that the whole design would be on a single PCB, but the foot-print of the ADC module made this impractical and a daughter-board was created during the PCB design phase. The connections between the main PCB and the daughter PCB are made with a ribbon-cable via JP8.

T2 is used to provide +15v and -15v supplies for all other analogue circuits via regulators REG3 and REG4 respectively. The design is identical to that described above, with the exception that a star point is created between the 0v pins of REG3, REG4 and REG5, where REG5 supplies +5v for the digital circuits. The circuit diagram shows jumpers J1A and J1B with an optional link but they are overlaid on the PCB, thereby creating a permanent connection.

T3 has separate full-wave rectifiers on each of its secondary windings. The choice of a 9v transformer was so that approximately +12v unregulated is available for a miniature dc fan, while an independent +12v supply may be regulated by REG5 to provide +5v. In this way the +5v supply has a high immunity to dips in the mains input because the voltage drop across REG5 is relatively large at about 7v. The

digital circuits require only tens of milli-amps so the power dissipation of REG5 is quite acceptable at about 0.35W. At this level a heatsink is not essential but one had to be provided for the other regulators so it was little trouble to mount REG5 on this heatsink in case modifications and/or additions at a later stage resulted in a much larger current. If modifications are made, up to 100mA may be taken from the +5v rail without concern. The value of C17 is unnecessarily large if the only load is the ventilation fan, however it was easy to incorporate the same value as C13 in the +5v supply and provide another well smoothed power source if needed later.

All supplies incorporate tantalum and ceramic decoupling capacitors to minimise high frequency noise. In particular C2 and C3 for +15vADC; C5 and C6 for -15vADC; C8 and C9 for +15vDRV; C11 and C12 for -15vDRV; and finally C15 and C16 for +5vDIG.

When the completed drives were running it was found that when the switch on the front panel is rocked from the on position to the off position by hand as fast as possible, there is a break in the supply for about 0.25 seconds. During this time there is no significant change in the overall operation of drive circuits.

### 3.2 Microcomputer - *Circuit sheet 3*

At the outset of the design there was concern over the effect of interference between any microprocessor controlled digital subsystem and analogue circuits. The use of a traditional approach using a microprocessor with external ROM/RAM and I/O etc. was considered but with the required resolution of 1 part in 500,000 undesirable interference effects from high frequency data and address buses were thought quite likely. A number of single-chip microcontrollers offered the facilities to control the various peripheral components with an input/output port programmed to behave as a data-bus. The availability of a low-cost in-circuit emulator, as well as previous personal experience lead to the use of a Motorola MC68HC705C8S microcontroller [3.2] as the digital controlling element U1. It has a power supply requirement of less than 10 mA at 5v, and using I/O ports means that all high frequency signals remain on-chip. The resulting external digital signals have high frequency components of much lower energy than bused systems. A 4MHz quartz crystal connected directly to U1 provides a reference for the asynchronous communications link, as well as local data transfers.

### 3.3 Precision analogue-to-digital converter module - Circuit sheet 3

An analogue-to-digital converter module (ADC) which has a 22-bit resolution is used to measure the voltage drop across the sensing contacts of a precision power reference resistor. This voltage is proportional to the current flowing in the coil and is used to provide a means of calibration and closed loop control. The ADC is made by Analogue Devices with part number AD1175K, and is referred to as a High Accuracy Integrating A/D Converter . A copy of the data sheet appears in Appendix [A] and provides complete information about its characteristics. It was selected because of a number of important features, which include:-

- Low Integral nonlinearity of  $\pm 1$  ppm
- Gain stability of  $\pm 1$  ppm/ $^{\circ}$ C
- Internal voltage reference stability  $\pm 0.4$  ppm/ $^{\circ}$ C
- 16 conversions per second
- Bus orientated interface

In an attempt to minimise 'earth currents' the AD1175K has an internal star point where the digital, analogue and power grounds are joined together. This is the only place where the 0vADC signal is joined to the other 0v rails and shown in Figure 3.1. Consequently when the PCB daughter board containing the ADC module is not plugged into the main PCB the +15vADC and -15vADC signals are floating.

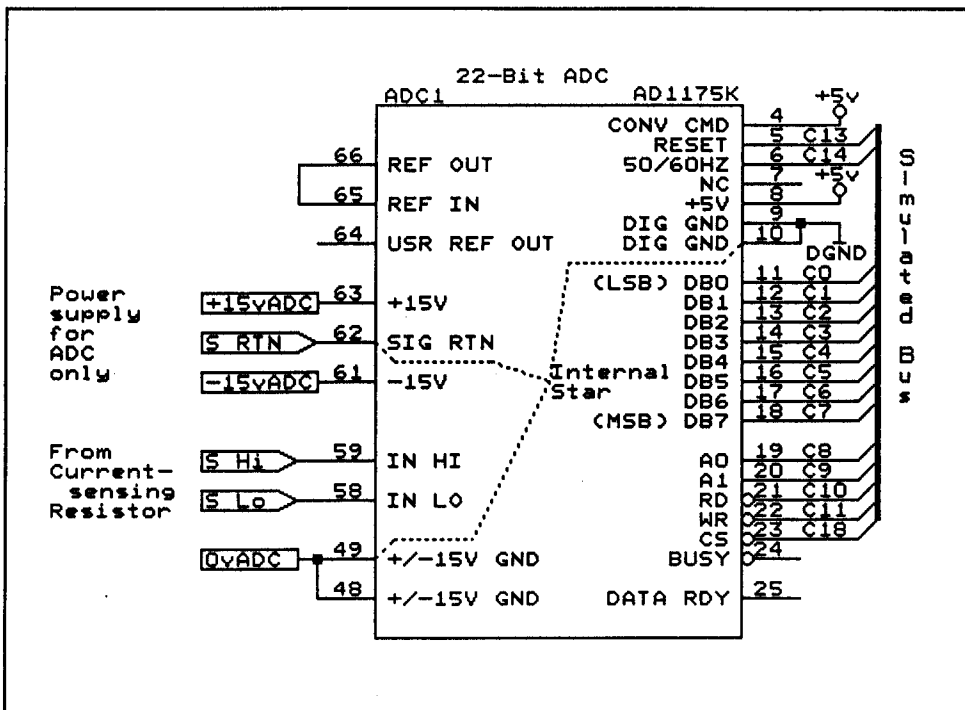


Figure 3.1 - Connections to Precision ADC Module

The ADC is normally connected via address and data lines to a microprocessor, and appears as four byte-wide locations, some of which may be read and written. In this design the address and data lines are simulated by ports on the microcontroller. The program within the microcontroller uses its internal timer to create an interrupt-driven interface which tries to communicate with the ADC every 2.5 milli-seconds. This communication may be to determine the current status, read the previous conversion or start a new one.

In order to obtain maximal rejection of mains/line interference the microcontroller can alter the level on the 50/60Hz pin to suit the operating environment. The present configuration is for 50Hz, but this may be altered by changing the configuration tables within the microcontroller when it is programmed.

### 3.4 Coil drive circuit - *Circuit sheet 4*

The coil drive circuit was the subject of considerable design effort and was built up by hand prior to the design of a printed circuit board. In principle it consists of a digital-to-analogue voltage converter (DAC) followed by a voltage-to-current converter, however the required resolution necessitates the use of two DACs, a summing amplifier, numerous filters, and a high-precision voltage-to-current converter.

The DACs were selected because of their low power requirements, monotonicity to 16-bits, low temperature coefficient and long-term stability. The data-sheet for the AD1145BG [3.3] shows the gain temperature coefficient to be  $\pm 0.1$  ppm/ $^{\circ}$ C and long-term stability to be  $\pm 0.1$  ppm/1000 hours. Two similar DACs are used together to implement a control strategy which uses U6 as a primary voltage reference, with U7 acting as a secondary reference, such that the contribution of U7 to the output of summing amplifier U10 is  $1/64^{\text{th}}$  that of U6. See Figure 3.2. The nominal range of U6 is  $\pm 5$ v and this is scaled via the drive coil and monolith to a movement of  $\pm 5$  micrometres. U6 alone cannot achieve the required resolution of 1 part in 500,000 and U7 is used to 'trim' the output of U6. In this way the DAC combination is considered together as a coarse and fine control. See sections 5.3 and 5.5 for complete description of the programmed use of the DACs.

The ratio of resistors R9 and R10 is 1:64, but this is somewhat arbitrary and not critical, although whatever the ratio is it should not change with temperature or time.

It is vitally important that changes in secondary DAC can always exceed the change between adjacent measured levels used for the primary DAC, so that it can always 'fill-in' between the gaps. The greater the ratio the greater the resolution, but the more the number of measurements during the calibration cycle. Also a lower limit of 5 kΩ is placed on the value of R9 because of the current drive capabilities of the chopper-stabilised amplifier. Using Bulk Metal Film resistors from Vishay Resistive Products [3.10] with temperature coefficients of nominally 0 ppm/°C at room temperature placed an upper limit of 500 kΩ on what was available. A value of 320kΩ represents an acceptable compromise, and results in a ratio of 1:64.

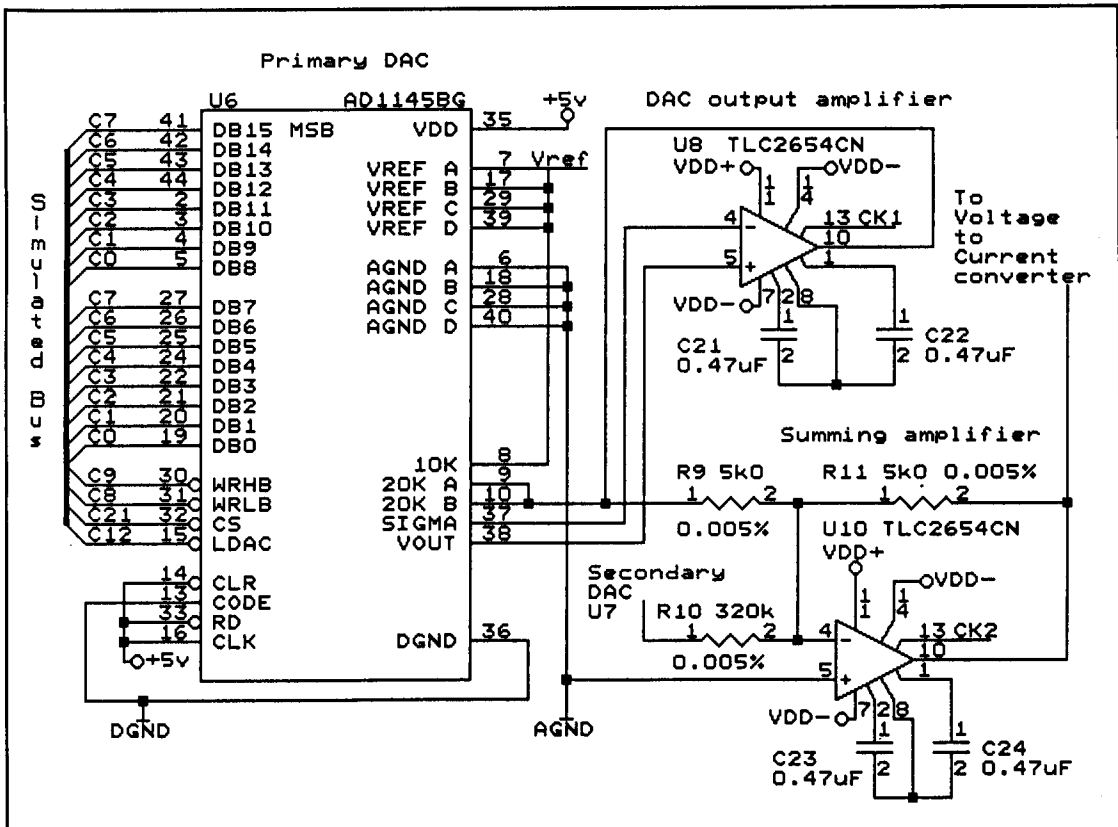


Figure 3.2 - DAC(s) and summing amplifier

To match the stability of the DACs, chopper-stabilised amplifiers are used throughout the circuit in order to achieve very low drift. The actual devices are all type TLC2654AC [3.4], which have a drift with temperature of 0.05 μV(max)/°C, and a long-term drift of 0.02 μV(max)/month. The stability of the voltage reference is 5ppm/°C [3.5] and when considered in conjunction with the nominal operating range of ±5 volts the drifts of the DACs and the chopper-stabilised amplifiers are negligible. At first sight the drift of the voltage reference seems unacceptable but the figure relates to the open-loop drift characteristics and the overall performance depends not on the stability of individual components but on the stability of the current sensing resistor and precision ADC. However it is worth using components

with a good stability as this improves the ability to predict settings for various setpoints, and thereby minimises the time needed to trim dynamic offsets.

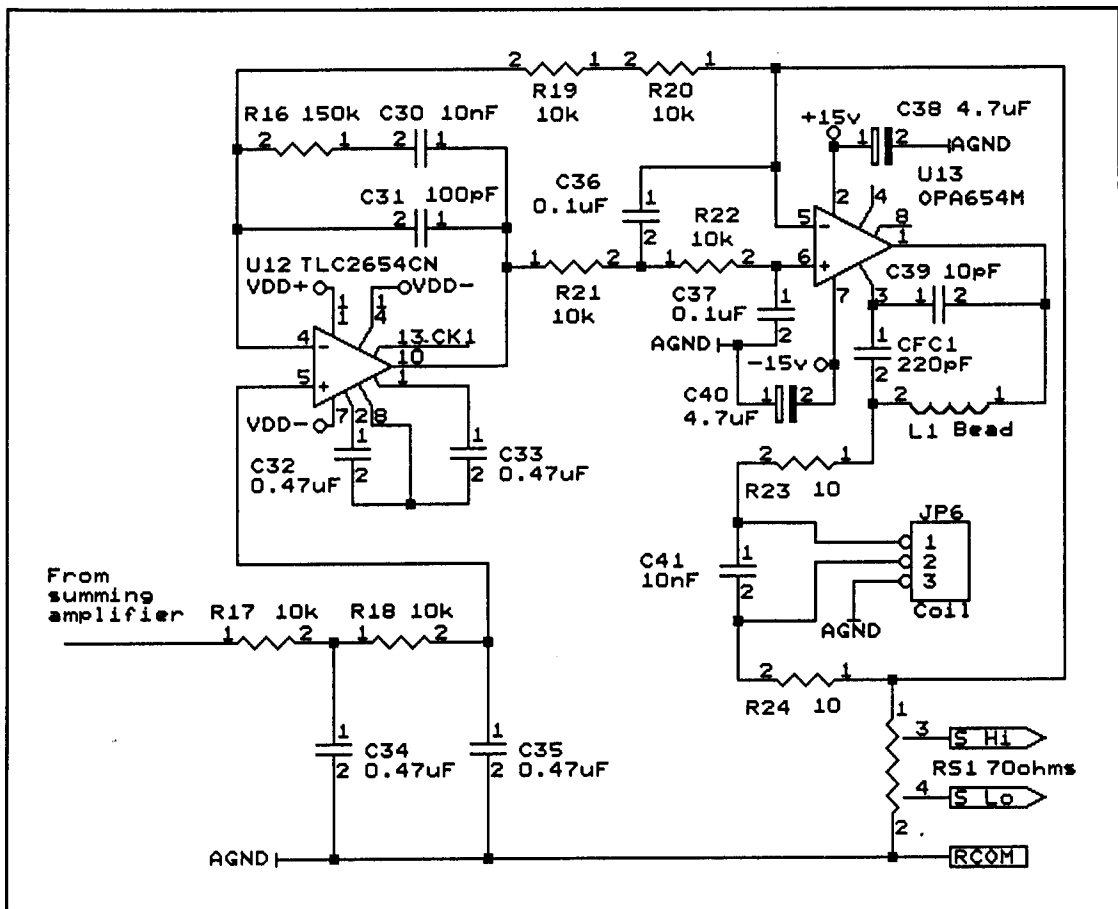


Figure 3.3 - Circuit for voltage-to-current converter

With reference to Figure 3.3, the output of U10 is filtered by R17,C34 and R18,C35 to provide a reference voltage at the non-inverting input of U12. Since the input current of this amplifier is 20 pA (typical) the voltage drop across the resistors is only 0.4 $\mu$ V. Filtering the output of U10 was found to be essential so that fast-rising transients are not seen by the voltage-to-current converter formed by U12, U13 and associated components. Prior to assembly on a PCB, a prototype circuit was built up on the bench and the output of U13 could be made to saturate and latch-up if the input to U12 was changed too quickly. A single-stage delay at the input with a time constant of about 2 ms was sufficient to stop this effect, but a two-stage filter with individual time constants of 4.7 ms was incorporated into the final design. A pragmatic view suggested the resulting rise-time is more than long enough to stop U13 going into saturation. Two analogue feedback loops exist; one directly from the current sensing resistor RS1 to the inverting input of U13; the other from RS1 to the inverting input of U12 via R19 and R20. Two resistors are used here to complement the parasitic effects of R17 and R18. RS1 is a 4-terminal device and the voltage

across the sensing pins must be used as a measure of the current flowing through it. The analogue servo loops ensure that the voltage across the forcing pins equals that derived from the DACs, and this leads to an error caused by end-effects within RS1. However the effects are repeatable and the calibration process using the 22-bit ADC effectively removes them. The gain of U12 is very high at 135dB and C31 provides a high frequency roll-off, while R21,C36,R22,C37,U13 create a second-order low-pass filter which reduces the chopping noise at 10kHz which appears at the output of U12. R16 and C30 were included when the prototype circuit oscillated at several hundred Hertz; similarly C39,L1,CFC1 are needed to stop radio frequency oscillation of U13 and were found empirically. The input bias current of U13 is only 3 pA [3.6], and may be neglected, and although its offset voltage and drift with temperature are unacceptably large the overall performance depends on the characteristics of U12 and not U13. Thermal protection is provided within U13 but R23,C41 and R24 attempt to provide additional protection in the event that the external coil is shorted out, or shorted to 0v. The frequency response, transient response and noise characteristics, of the voltage-to-current converter were extensively studied using computer aided simulation, as well as direct measurement. The analysis may be found in chapter 6.

### 3.5 Heater/Drive 2 circuit - *Circuit sheet 5*

The required resolution of 1 part in 500,000 prompted concern about the effect of local heating near the coil. It was decided to allow for constant power dissipation, and by implication constant operating temperature, in the vicinity of the coil by the use of a resistive heating element. The idea was to construct a small 'jacket' of resistors around the coil and adjust the applied voltage so that the power dissipated in total by the heater and the coil was a constant. This requires a non-linear decrease in heater current as the current in the coil is increased. To this end an additional 16-bit DAC together with a voltage-to-current converter of exactly the same design to that describe above was built. This allows the flexibility of providing either a heater controller or another coil-drive.

In practice the heat dissipated by the coil is only about 0.3 watts and undesirable effects of local heating have not been apparent. Consequently no heater was actually provided but the controlling program still attempts to modulate the current in the second drive circuit so as to keep the total power constant. To ensure closed loop stability of the output amplifier, the load for the heater is currently a short-circuit; effected by a link in the push connector at the rear panel. When the current in either



drive changes there are small changes in the voltage level of the 0v tracks on the PCB. Although every effort has been made to minimise cross-talk between the two drives by the use of copper planes and star-points, some cross-effects are inevitable. In the final version of the software (named cc1v15fp) the currents flowing in drive 2 are altered synchronously with changes in drive 1, and the calibration procedure compensates for any cross-effects, however if the software is altered to provide two independent drives it may be necessary to compensate for cross-effects in a more sophisticated way.

### 3.6 Auxiliary devices

There are a number of supporting circuits which together represent auxiliary devices and these are described in turn below.

#### 3.6.1 Power supply for chopper-stabilised amplifiers - *Circuit sheet 4*

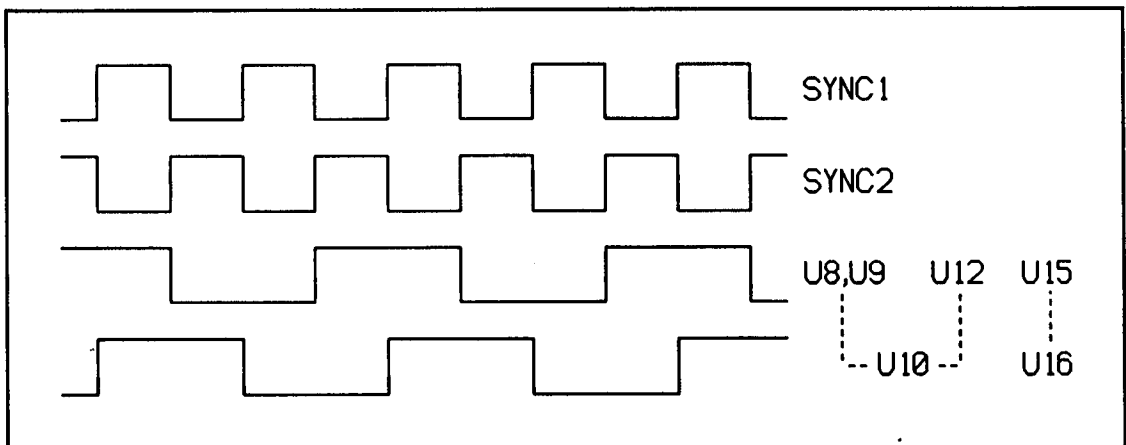
The CMOS chopper-stabilised amplifiers are specified at a maximum supply of  $\pm 8\text{v}$ , and two linear regulators were build from a dual op-amp and bipolar pass transistors. It was decided to make this supply as stable as possible even though the amplifiers have a high power supply ripple rejection ration of 120dB. The 5v output of REF1 is taken to a non-inverting amplifier U11A, with a gain of 1.59 determined by R12 and R13, which creates via Q2, a voltage of +7.95v. This is inverted with U11B, R14, R15 and Q3 to create -7.95v, which tracks any changes in the +7.95v supply. C28 and C29 provide local decoupling.

#### 3.6.2 Clock generator for chopper-stabilised amplifiers - *Circuit sheet 5*

The chopper-stabilised amplifiers were chosen because the typical chopping frequency is much higher than any mechanical resonances of the monolith and associated mechanical components. This is in contrast with all other commercial chopper-stabilised available at the time (August 1992) which have chopping frequencies of the order of 250 to 450 Hz. Unfortunately their use is complicated by the possibility of 'beat' frequencies and aliasing caused by un-synchronised clocks of similar frequency. Consequently a clock generator was built which provides clocks at the correct frequency, phase and amplitude to synchronise all chopper-stabilised amplifiers. Each

amplifier incorporates a divide-by-two circuit at its clock input which is edged-triggered, and by supplying adjacent amplifiers with anti-phase clocks there can be no 'beat' frequencies, and aliasing is removed because the transient outputs of one stage appear at the input of the next during a time when that stage is not being switched.

Figure 3.4 shows the two SYNC signals which cause amplifiers U8,U9,U12 and U15 to operate synchronously but phase shifted with respect to U10 and U16. The signal flow is such that when the output of any amplifier goes to the input of the next it is operating with a different phase.



**Figure 3.4 - Clock timing for chopper-stabilised amplifiers**

The amplifiers require a clock signal which switches from their negative supply to +5v above it, and so U18 is used as a voltage regulator with -7.95v as the 0v reference! The normal 0v is effectively regulated down to about -3v, which creates a supply at +5v with respect to -7.95v. The exact voltage is determined by R25 and R26, and provides current for the high-frequency clock-generator U19, as well as counter U20 and inverter/buffer U21. U19 incorporates a 20MHz crystal-based oscillator and a divider chain which gives 78.125kHz at pin 2, which is further divided by 4 to give 19.53125 kHz for each of the anti-phase clock signals from the inverters in U21. Local division by 2 in each amplifier means that they operate at 9.795625kHz, which is just below their nominal operating frequency of 10kHz.

### 3.6.3 Monitor ADC and temperature sensors - *Circuit sheet 6*

It is possible for the loads of either drive output to become open circuit and thereby cause incorrect operation of the entire system. If there is no load the output becomes

saturated at about  $\pm 13.5$  volts and this may be used as an indication that all is not well. U25 is an integrating ADC with 18 bit resolution and is used to monitor the voltage at the output of the power amplifier for each drive. The embedded software passes a number to the slave computer which is related to the measured voltages, and this is multiplied by appropriate constants to give true voltage levels. These constants were found empirically so that the computed voltage agreed with that measured by a Hewlett Packard 5-digit voltmeter. Resistors R36,R37,R38 and R39 attenuate the main drive voltages to provide levels which are in the range of U25, which is about  $\pm 1.2$ v.

The ADC has four programmable digital outputs, of which three are used to control a low-leakage analogue multiplexer,U26. The embedded software uses a timer to create interrupts every 2.5ms and the service routine controls the ADC via dedicated serial communication facilities, called the serial peripheral interface (SPI).

Apart from the drive voltages, the outputs of two linear temperature sensors are also monitored, to determine the temperature of the air at the inlet and the exhaust. If the exhaust temperature is more that about 3°C higher than the inlet temperature there is cause for concern as the internal power dissipation is too high. In fact the absolute accuracy of the sensors means that there is an offset in the measured temperature and the true difference may not be presented. It is therefore better to note the readings when the drive is operating correctly and become concerned if the readings change in the future.

The ADC requires +5v and -5v power supplies and these are obtained locally by REG6 and REG7 respectively, with decoupling provided by capacitors C73,C74,C75 and C76. The stability of the measurements made by the ADC is limited by the voltage reference D3, which has a temperature coefficient of about 20ppm/°C.

#### 3.6.4 Isolated serial link - *Circuit sheet 3*

The drive is controlled by messages which are passed via an RS232 compatible interface. In order to provide isolation of the ground-rail the interface circuitry is optically coupled, via U5. This is a dedicated interface circuit [3.7] which allows for handshake control lines as well as serial data lines. The Request to Send output level may be controlled, or the Clear-to-Send input read, by the microcontroller U1; although in the present software they are not actively used.

### 3.6.5 Non-volatile memory - *Circuit sheet 3*

At the start of the design it was thought that messages would be sent directly from the host computer to the drive(s) and it would be necessary for control functions to be implemented internally. Since calibration tables are needed to implement the proposed control strategy some form of non-volatile storage had to be included to avoid re-calibration at every power-on. Battery backed Random Access Memory (RAM) could have been used but using an Electrically Erasable Programmable Read Only Memory (EEPROM) obviated the need for a battery and was a practical proposition because many milli-seconds are available for each write cycle during the calibration process. The memory requirement is dependent on the control strategy and for that proposed only a few hundred bytes were needed. Consequently a small 1kByte EEPROM could have been used but the additional cost of providing a much larger memory was negligible when considered with respect to the cost of other components. U4, a 32k Byte EEPROM, [3.8], derives its address from U2 and U3, which are serial-in/parallel-out shift registers connected to the serial peripheral interface of U1. Data is supplied in parallel directly from port A of U1, with three control functions from other ports. Reading and writing is controlled by U1, which uses the internal timer interrupt service routine to synchronise access to U4, so as not to disturb the timing of accesses to the precision ADC (ADC1) or the monitor ADC (U25). When the decision was taken to include a slave PC between the host computer and the coil-drivers it was realised that all calibration information could be held on the hard-disc of the slave PC. This means that the non-volatile memory is not actually used and serves no active purpose, however instructions may be sent over the serial link to write or read any location. See commands T,U and V in section 4.4

### 3.6.6 Configuration switches - *Circuit sheet 3*

Extensive experience with the design and construction of a number of other embedded control systems has shown that it is useful to be able to alter the performance and/or characteristics by the movement of a few small switches. Consequently an 8-way dual-in-line switch bank was included together with pull-up resistor pack R41, and interface buffer U22. In fact U22 is an octal latch with tri-state outputs, but the latch is wired to be transparent. Once again, when the decision was taken to include a slave PC, changes in performance can be brought about by revisions to the software running on the slave PC. Consequently in the present implementation the switches have no active function, but may be read by appropriate commands if required.

### **3.7 Component layout and Printed Circuit Board**

A substantial amount of time was spent considering the relative positions of the components as a printed circuit board was designed using a software package called CADSTAR [3.9]. A number of constraints had to be satisfied, including:-

- Use of a standard 19 inch rack-mounting chassis.
- Separation/spacing of power supply, digital and analogue components.
- Allowing forced air flow over all precision analogue components, especially sensing resistors and the voltage reference(s).

Figure 3.5 shows clearly the relative positions of the components, and in particular the section on the right containing the analogue components which is separated from the power supplies and digital components with an internal baffle. The precision ADC is mounted above the digital components but is shielded by its own casing. Figure 3.6 shows this and the direction of the fins on the heatsinks for the power amplifiers and the current sensing-resistors. The heatsinks were machined from blocks of aluminium so that the fins would be in line with the air flow which is from front to back. It is not clear from the photographs that other holes were drilled at appropriate positions so that air is forced over the power supply and ADC module, to the exhaust fan, without passing over the precision analogue components in the baffled section.

The Printed Circuit Board (PCB) took over 100 hours to design even with the CAD tools and extensive previous experience. The apparent simplicity of the finished layout, shown in centre-line form at 70% of true size in Annex [2], belies the numerous layouts that had to be abandoned because they would not route satisfactorily. A number of important features are either not obvious or not shown, and attention is drawn to the following:-

- The board has 4 layers. Routing top, inner and bottom, with an inner copper layer acting as a shield between critical analogue routes on other layers. The shield is not the same as a ground plane and there are no steady currents within it. It is joined to analogue ground at only one place near J1A.
- All digital signals are kept well away from analogue signal conditioning done by the chopper-stabilised amplifiers.
- All power-supply routes and critical signal routes use a single layer. Consequently there are no changes in layer using via-holes, and therefore no undesirable parasitic series resistances.

- Where possible signals that pass on different layers without the shield layer between them, do so at right-angles, so as to minimise coupling.
- The digital components, monitor ADC, precision drive and heater drive have 0v rails that are 'starred' out from the voltage regulators, so as to minimise cross-effects.
- Where possible, and useful, the analogue 0v routes have sheet copper overlays to minimise voltage drops.
- The RS232 signals are well away from all other routes.
- Mains 240v ac. is carried on wide routes on the bottom side of the board, underneath the toroidal transformers, but there is no shield in this region, and therefore no possibility of electrical breakthrough.

Technician support was sought for the layout, but it was soon apparent that it is only with a critical understanding of the whole circuit that necessary constraints may be identified and accommodated. Initial layouts were not optimal, and eventually the whole layout was done personally.

To complete this chapter, Figure 3.7 shows the appearance of the complete system.

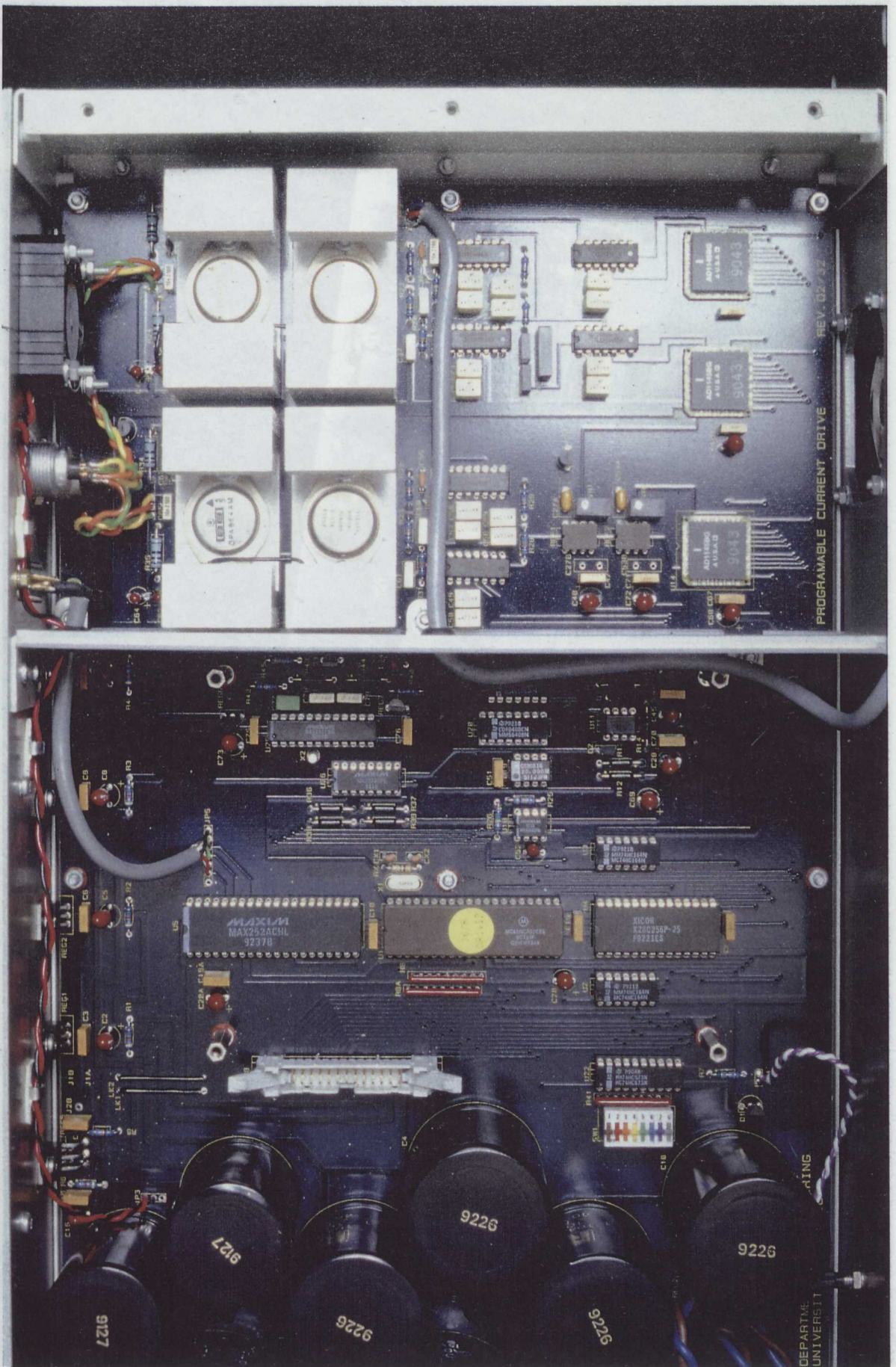


Figure 3.5 - Top-view of assembled PCB



Figure 3.6 - Oblique-view of chassis and PCB



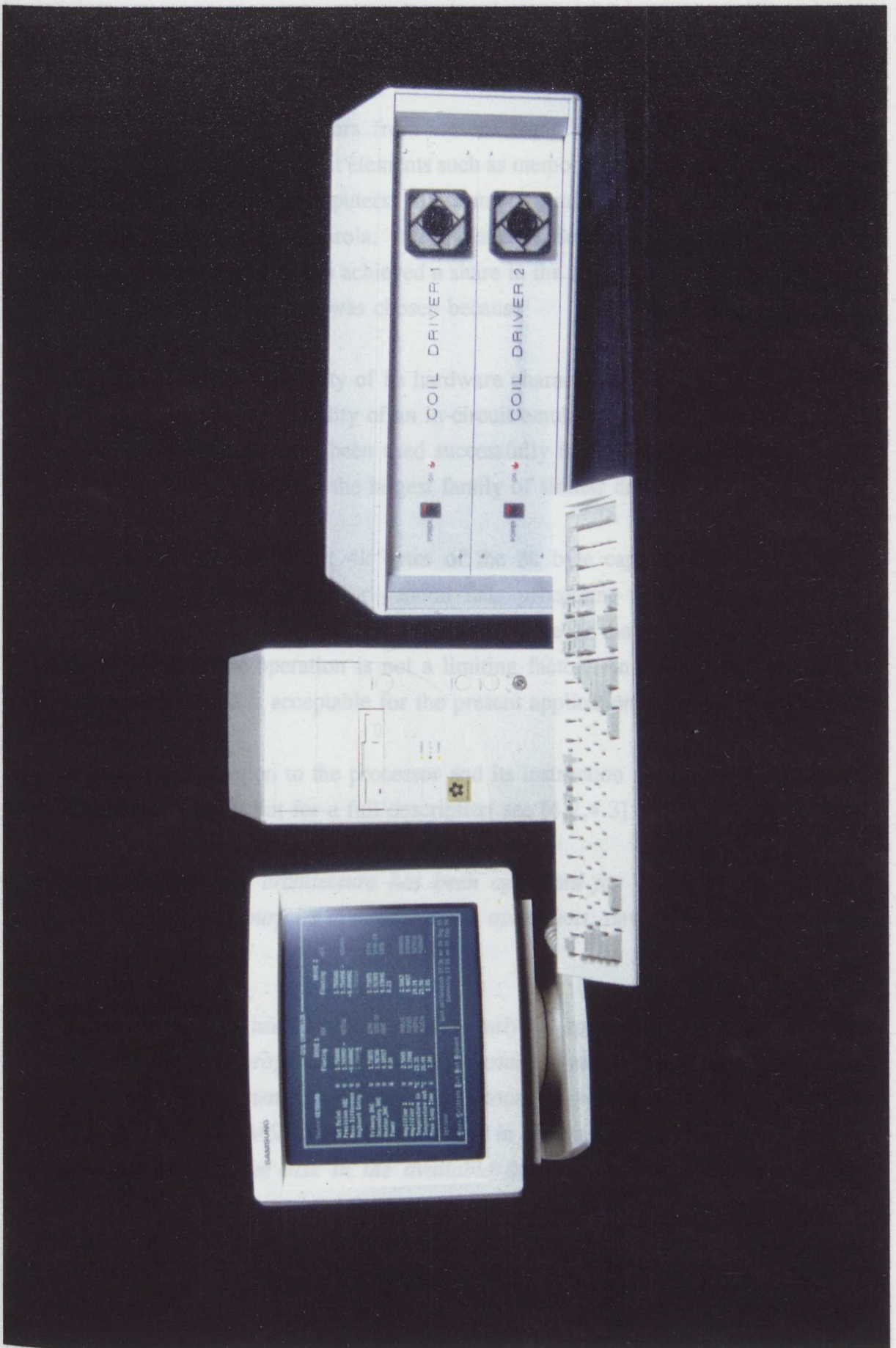


Figure 3.7 - Appearance of completed system

## Chapter 4 Embedded Software

Many different microprocessors from various manufacturers have been integrated together with peripheral circuit elements such as memory, parallel ports and counters, to form single-chip microcomputers. All the major semiconductor manufacturers such as Texas Instruments, Motorola, Intel, National Semiconductor etc. now make microcontrollers and each has achieved a share in the market with niche products. A microcomputer by Motorola was chosen because

- a) of the suitability of its hardware characteristics
- b) of the availability of an in-circuit emulator
- c) it had already been used successfully in other applications
- d) it comes from the largest family of similar devices.

The software occupies about 4k bytes of the 8k byte capacity and although the processor was not designed for general data processing it manipulates numeric variables faster than either the ADC conversion-rate or the serial communications-rate, so its speed of operation is not a limiting factor. An up-date rate of several readings per second is acceptable for the present application.

For a brief introduction to the processor and its instruction set the following text is included from [4.1], but for a full description see [4.2,4.3]

*"The M6805 Family architecture has been optimized for controller applications, rather than general purpose data processing operations. Several features contribute to this optimisation.*

*The instruction set, used in the M6805 Family, is specifically designed for byte-efficient program storage. Byte efficiency permits a maximum amount of program function to be implemented within a finite amount of on-chip ROM. Improved ROM efficiency allows the M6805 Family to be used in applications where other processors might not perform the task in the available ROM space. More features may be included in applications where the ROM space is more than adequate. In some cases the user may wish to include programs for more than one application. In such cases the appropriate program could be selected by the power-up initialization program. The ability to nest subroutines, the addition of true bit test and manipulation instructions, the multi-function instructions, and the versatile addressing modes all contribute to the byte efficiency"*

In 1980 when this was written, program storage space was at a premium, but now there are family members with 32k bytes of program memory, and byte efficiency is not such a key issue in the design process. However the fact that the family dates back over 14 years means that the parts available today have been greatly refined and are the result of considerable research effort and development. In particular, in the MC68HC705C8S the processor core has been integrated onto a single chip with 8k bytes of EPROM, 304 bytes of RAM, an asynchronous communications controller, 24 bi-directional Input/Output lines, a 16-bit timer, and a synchronous serial peripheral interface (SPI).

It is not practical to describe in exhaustive detail the purpose of every instruction in the embedded software, since this may be inferred by reading the annotated listing which appears in Annex [3]. However it is appropriate to describe some of the more important features, and these appear below. In order to refer to various parts of the listing label names are shown in *italics*, line numbers a 5-digit decimal strings, and addresses as 4 hexadecimal characters preceded by '\$'. A cross-reference table for all labels is shown at the end of the listing.

#### 4.1 Initialisation

After a hardware reset when power is first applied the software configures the microcontroller for operation in the particular hardware environment by setting up a number of special locations (see *cfg* at line 02076) and then waits for a command to be received via the serial link from the controlling computer. Port A is manipulated so that it appears like a data bus in an ordinary microprocessor based system, but it changes only when necessary so as to minimise the electrical noise produced by its output stage. Port B is a collection of control lines for enabling read/write functions in other devices, and Port C acts as individual 'chip select' lines. The pins associated with port D are used for specific dedicated functions such as serial input and output.

All pins of the microcontroller are used except for -IRQ, PC0 and TCMP. The allocation of each pin is summarised in Figure 4.1.

MC68HC705C8S Pin No.	Circuit Label	Port ID Name	Function
11	C0	PA0	DB0 (Data Bus LSB)
10	C1	PA1	DB1
9	C2	PA2	DB2
8	C3	PA3	DB3
7	C4	PA4	DB4
6	C5	PA5	DB5
5	C6	PA6	DB6
4	C7	PA7	DB7 (Data Bus MSB)
12	C8	PB0	NWRLB/A0
13	C9	PB1	NWRHB/A1
14	C10	PB2	NRD/NOE
15	C11	PB3	NWR
16	C12	PB4	NLDAC
17	C13	PB5	RESET of AD1175K
18	C14	PB6	50/60Hz select of AD1175K
19	C15	PB7	RTS auxiliary RS232 output
28	C16	PC0	not used
27	C17	PC1	-CS switch input select
26	C18	PC2	-CS AD1175 select
25	C19	PC3	-CS AD1145BG Heater select
24	C20	PC4	-CS AD1145BG Secondary DAC select
23	C21	PC5	-CS AD1145BG Primary DAC select
22	C22	PC6	-CS MAX132CNG ADC select
21	C23	PC7	-CS RAM/Flash EEPROM select
29	C24	PD0	RS232 input
30	C25	PD1	RS232 output
31	C26	PD2	MISO from MAX132CNG
32	C27	PD3	MOSI to MAX132CNG and Address Generator
33	C28	PD4	SCLK to MAX132CNG and Address Generator
34	C29	PD5	-SS tied to +5v
-	C30	PD6	Does not exist - preserves numbering
36	C31	PD7	CTS auxiliary RS232 input
37	C32	TCAP	unused capture input tied to +5v
35	C33	TCMP	output to LED via driver
2	C34	-IRQ	-Interrupt tied to +5v
1	C35	-RESET	-Reset from LM2925T regulator

Figure 4.1 - Port allocation

## 4.2 Serial interface and command structure

The microcontroller incorporates an asynchronous serial interface and this is configured to transmit and receive at 9600 baud, with 1 start bit, 8-data bits and 1 stop bit. As individual characters are received and assembled by the *rdl* routine at 00461 the most significant bit (msb) is forced to zero. During transmission the msb is always zero.

Commands take the form of a command letter, which may be either upper or lower case, optionally followed by parameters which depend upon the actual command. If the command is recognised a reply is generated which terminates in the sequence 'Y' <CR> <LF>, however if the command is not recognised or the parameters are in some way invalid the reply consists of 'N' <CR> <LF>. These sequences are

thought of as 'ack' and 'nack'. When a command line has been received its *execution* may take many milli-seconds, and it is important for the controlling computer to wait for an acknowledgement sequence before sending a further command. This is necessary because received characters are not buffered.

Commands are provided for many functions which include reading the Precision ADC and setting the levels of the DACs. Some of the commands are included for diagnostic purposes and were used during the development of the drives and are of little general use. Commands 'X', 'Y' and 'Z' are used for normal operation and are described in detail later.

### 4.3 Timer interrupt and service routines

The hardware timer, its related registers, and service routine, create an interrupt every 2.5 milli-seconds which is independent of all other activity. Within the service routine *tims* at 02135 are calls to *padcs* at 02172, and *adcs* at 02297, which read the precision ADC and the monitor ADC respectively. The precision ADC is used to measure the voltage across the current-sensing resistor, while the monitor ADC provides measures of such things as the air inlet temperature, and the voltage at the output of the power amplifiers. The overall effect is to access the ADC's at a regular rate and provide the user with the most recently read values in specific memory locations. Not every interrupt causes an ADC value to be copied to memory, as both ADCs take 62.5ms for each conversion.

A cyclic buffer is used to store the most recent 16 samples from the precision ADC so that a moving average may be calculated. Every timer interrupt routine *padcs* at 02172 first calls *getst* at 02183 to discover if the ADC is busy. To do this the simulated address select lines PB0 and PB1 are both cleared to gain access to the status register. When the select line PC2 (also called N1175) is put low together with PB2 (also called NRD) the status register drives port A, which is read by the microcontroller. Only one in twenty-five calls to *getst* will show the ADC to be ready, and when this happens *getr* at 02195 is called to read the latest conversion, followed by *putcm* at 02210 to output the DEFCON command to the ADC which starts another conversion. Once the ADC has been restarted, the last reading is buffered to allow the average of the last 16 readings to be found. 16 was chosen because the average corresponds to the mean of the readings taken over the last second, and division by 16 is easily implemented in binary as 4 right shifts. Buffering

and averaging is done by a call to *sampb* at 02223. For more information on controlling the precision ADC see the data sheet for Analogue Devices part AD1175K in Appendix [A].

Control of the monitor ADC is complicated and determined by a *STATE* counter which increments every timer interrupt (see *adcs* at 02297), and only when this counter has certain values does additional activity take place. Since 8 inputs are monitored a new block of readings is available every  $8 \times 0.0625$  seconds or 0.5s. The monitor ADC is Maxim part MAX132CNW. Unfortunately some of the technical descriptions in its data sheet [4.4] are confusing and much time was spent making the service routine work correctly, and efficiently. When a reading has been made the parallel output bits of U25 are altered to agree with the *CHAN* counter, so that a new analogue channel is selected with the multiplexer U26.

The routine *tims* also manages variable *TOUT* which is decremented if non-zero every 2.5ms, as well as controlling the blinking of the light emitting diode on the front panel. The blinking action is accomplished by co-ordinating the overflow flag, the *OLVL* bit in the Timer Control Register, and the values of *BLSTAT*, *BLCNT*, *BLIVL*. See lines 02136 to 02155.

#### 4.4 Command decoder and command execution

There is provision for up to 26 commands, each beginning with a single letter from the alphabet. *rdl* at 00461, and *cmd* at 00491 are called in sequence near *main1* at 00450, to read a line from the serial interface and then decode it. The line is terminated by <CR>. Use is made of a command table, *cmdtb* at 00509, which defines the start address of each routine. Unallocated commands are all associated with a 'nul' routine, while all others have a label which includes the command letter to allow for easy identification. The table is shown in Figure 4.2.

For a detailed understanding of the operation of each command the listing in Annex [3] may be studied at the relevant address. A brief description of the more important commands follows. All commands were used during the development of the drives, but only commands X, Y and Z are currently used by the software in the slave PC.

00508				* a list of command from A..Z
00509	0288	033D	cmdtb	fdb cmdA
				synchronises ADC then outputs 8 numbers
00510	028A	035F		fdb cmdB
				repeated cmdA
00511	028C	0367		fdb cmdC
				repeatedly outputs PADC, averaged PADC
00512	028E	0388		fdb cmdD
				repeatedly outputs averaged PADC
00513	0290	02BC		fdb nul
				E
00514	0292	02BC		fdb nul
				F
00515	0294	02BC		fdb nul
				G
00516	0296	03DA		fdb cmdH
				Prepare Heater DAC
00517	0298	03A7		fdb cmdI
				Output a ramp to Heater DAC
00518	029A	02BC		fdb nul
				J
00519	029C	02BC		fdb nul
				K
00520	029E	0404		fdb cmdL
				Load all DACs - pulses -LDAC line
00521	02A0	0410		fdb cmdM
				set MODE byte
00522	02A2	02BC		fdb nul
				N
00523	02A4	02BC		fdb nul
				O
00524	02A6	041A		fdb cmdP
				Prepare Primary DAC
00525	02A8	0461		fdb cmdQ
				Read precision ADC 20 times
00526	02AA	0471		fdb cmdR
				Read precision ADC as 6+2 hex
				characters
00527	02AC	0495		fdb cmdS
				Prepare Secondary DAC
00528	02AE	04C2		fdb cmdT
				Enable/Disable software protection of
				EEPROM
00529	02B0	057B		fdb cmdU
				Read DIL switches as hex pair
00530	02B2	05C3		fdb cmdV
				Read bytes from EEPROM
00531	02B4	05EA		fdb cmdW
				Write a byte to EEPROM
00532	02B6	0615		fdb cmdX
				Read moving average of precision ADC in
				Hex
00533	02B8	063B		fdb cmdY
				Read all MAX132 channels in hex
00534	02BA	064C		fdb cmdZ
				Set some/all DACs
00536				* nothing to do
00537	02BC	81		nul rts

**Figure 4.2 - Command address table**

### COMMANDS H,P,S,L,Z:

In order to change the level on a DAC output it is necessary to write to the high- and low-order bytes of its input latch, and then pulse the Load-DAC pin. Bytes may be written in any order to each of the three DACs without altering the voltage outputs. It is only when -LDAC is put low that the input buffers are copied to the main DAC latch. In this way all DACs may be made to update their outputs simultaneously. Command H,P and S prepare the Heater, Primary and Secondary DACs respectively, and command L pulses -LDAC. In order to provide the expected interpretation to the parameters it is necessary to use the 16-bit two's-complement value of each parameter, so that a positive parameter produces a positive voltage at the output of power amplifiers. Each parameter should be a sequence of 4 Hexadecimal characters, where \$8000 corresponds to -5 volts and \$7FFF with almost +5 volts. For example 'P0000' will prepare the primary DAC for zero volts next time command L is received.

The assembly language code associated with command P is shown in Figure 4.3, and is identical in structure with that for commands H and S.

00774	* write to Primary DAC buffer, 2's complement of input parameter			
00775	041A CD 042D	cmdP	jsr	getpw get word parameter
00776	041D 24 0D		bcc	cmdPz part is missing
00777	041F CD 043C		jsr	paneg
00778	0422 B6 BE		lda	PARH output high part
00779	0424 AD 21		bsr	cmdPh
00780	0426 B6 BF		lda	PARL
00781	0428 AD 2A		bsr	cmdP1
00782	042A 1E B9		bset	ACK,MODE acknowledge
00783	042C 81	cmdPz	rts	
.....				
00804	0447 9B	cmdPh	sei	protect sequence
00805	0448 B7 00		sta	PA output high byte to Primary DAC
00806	044A 13 01		bclr	NWRHB,PB select high byte
00807	044C 10 01		bset	NWRLB,PB but not low byte
00808	044E 1B 02		bclr	N1145P,PC
00809	0450 1A 02		bset	N1145P,PC
00810	0452 9A		cli	allow interrupts again
00811	0453 81		rts	
00813	0454 9B	cmdP1	sei	protect sequence
00814	0455 B7 00		sta	PA output low byte to Primary DAC
00815	0457 11 01		bclr	NWRLB,PB select low byte
00816	0459 12 01		bset	NWRHB,PB but not high byte
00817	045B 1B 02		bclr	N1145P,PC
00818	045D 1A 02		bset	N1145P,PC
00819	045F 9A		cli	allow interrupts again
00820	0460 81		rts	

Figure 4.3 - Preparing primary DAC

The parameter is negated by a call to *paneg* at 00777 to compensate for the signal inversion caused by summing amplifier U10. Notice the inclusion of the instruction *sei* at 00804 (and 00813) which disables interrupts until *cli* at 00811 (and 00819), so that the value output to port A, cannot be disturbed by the timer interrupt service routine which has also to manipulate the contents of port A to control the precision ADC. These regions of code were not originally protected in this way and the result was for the DACs to be updated with spurious values occasionally.

Command Z calls *cmdZ* at 01088 which then calls the routines corresponding with commands S, P and H in turn. Each accepts one parameter and prepares its own DAC, and so long as there is at least one parameter -LDAC is pulsed. This command was included to reduce (slightly) the time delay associated with sending three separate commands. Also, it is possible to change just the secondary DAC if only one parameter is present. For example 'Z7FFF', puts the secondary DAC to its maximum positive value without altering either of the other DAC's. Similarly 'Z00000000', will clear the secondary and primary DACs, but leaves the heater DAC unchanged. The order S,P,H, was chosen deliberately, based on the frequency with which the various DACs may need to be updated.



In the examples below of commands Y and X the following command had been previously sent

z200040006000

which places the secondary DAC at 1.25v, primary DAC at 2.5v, and heater DAC at 3.75v

**COMMAND X:**

Results in a reply of 6 hexadecimal characters corresponding to the average of the most recent 16 readings obtained from the precision ADC. Since the conversion rate is 16 per second, this corresponds to an average of the readings taken in the last second. The reading is a 22-bit number placed in a 24-bit field biased by \$400000, such that positive full scale = 5volts = \$600000, and negative full scale = -5volts = -\$200000. For more information on the coding scheme see the data sheet for Analogue Devices part AD1175K in Appendix [A]

With the previous Z command active command X gave the reply

502079Y

In an ideal system with no offsets the reply should be

$$(\$2000/64+\$4000)*64+\$400000 = \$502000$$

Which shows there to be an offset of

$$(\$502079-\$502000)/\$200000*5 = 0.000288V = 288\mu V$$

**COMMAND Y:**

The software in the intermediate computer (slave PC) makes use of command Y to access the conversions made by the monitor ADC. Study of *cmdY* at 01077 shows that readings from all 8 channels are first copied to a buffer area which is not corrupted while further readings are made during the timer interrupt service routine. This area of 24 bytes is output as 48 hexadecimal characters. Each reading is represented by 6 characters, with a somewhat obscure coding structure, but which may be manipulated relatively easily by the Pascal program in the slave PC. See function *max132\_hex\_to\_fp* at line 320 of listing in Appendix [4]. The order of the readings corresponds with the order of the signals on the analogue multiplexer, U26. That is to say, Agnd, Slo, Drive1, Drive2, Temp\_In, Temp\_Out, Agnd, Agnd. See circuit diagram sheet 6 in Annex[1].

A typical reply is

0000BD00048A01359A01A78901D08601F1700000D50000D4Y

which is split as

0000BD 00048A 01359A 01A789 01D086 01F170 0000D5 0000D4 Y

and for drive 1 with  $v_{ref}=0.61772$  V these correspond to voltages at the monitor ADC of

0.00035	0.00214	0.14599	0.19971	0.21904	0.23456	0.00039	0.00039
Agnd	Slo	Amp1	Amp2	Temp_In	Temp_Out	Agnd	Agnd

with interpretation after shifting and scaling of

0.0v	0.00179V	3.52454V	4.82466V	21.87°C	23.42°C
Agnd	Slo	Amp1	Amp2	Temp_In	Temp_Out

#### COMMANDS T,U,V:

The non-volatile memory, is an Electrically Erasable Read Only Memory (EEPROM), and is accessed by commands T, V, and W. Sending 'TP' will protect the EEPROM from further write cycles until 'TU' is sent to un-protect the device. The protection scheme is internal to the EEPROM and will remain in effect even if the power is removed. That is to say the protection scheme is itself non-volatile. When unprotected, command W may be used to write a byte at a given address. The format is 'Waaaadd', where aaaa is the address in hexadecimal from \$0000 to \$7FFF, and dd is the data byte also in Hexadecimal. Once written, the data is read back and checked locally; if the data is not as expected the ACKnowledge bit in the MODE byte is not set and the reply to the command is 'N' <CR> <LF> rather than 'Y' <CR> <LF> for a successful write operation. The most likely cause for a negative reply is that the memory is still protected. It is always possible to read the memory by using the V command, where the format is 'Vaaaann'. Again aaaa represents the starting address, but nn is a count, in hexadecimal, of the number of bytes to be read. For example 'V010020' will read and send back 32 (decimal) hexadecimal pairs starting at address \$0100.

Non-volatile memory is included to allow important calibration data to be stored locally and thereby permit stand-alone operation. A capacity of 32k bytes far exceeded the needs of any control algorithm that was considered, but it was cost-effective to include this amount of memory.

## 4.5 Floating-point interpreter

In the belief that local (or embedded) closed-loop control was to be performed by the software, many routines were written for floating-point arithmetic. However when it was decided that an intermediate computer would perform the control function these routines were no longer needed. (See section 2.4.2 for comment on this decision). Considerable time was spent developing these routines, which were tested extensively. A brief description is included for completeness and in case future developments warrant the use of embedded arithmetic functions.

An electronic Bulletin Board run by Motorola [4.5] and containing software for the MC6805 family of microprocessors was accessed during a search for floating-point routines, but unfortunately only simple integer routines for 16-bit numbers were found. Further investigation revealed a source-code listing for a Stack Orientated Arithmetic Processor [4.6] for the 6800 microprocessor. Unfortunately there are no instructions in the 6805 processor for stack-relative addressing and direct translation was not possible. However the source-code did provide a valuable insight to several techniques; notably the use of unsigned arithmetic operations to support signed floating-point operations.

In the interests of speed of operation a floating-point format was used which makes use of an 8-bit biased exponent with a normalised, signed, msb suppressed, 24-bit mantissa. Each floating-point number occupies four bytes and allows numbers to be expressed to about 7 decimal places over 76 orders of magnitude. An exponent of zero means the number is zero. For examples of the encoding scheme see the predefined constants at 02062.

Storage has been allocated for 8 floating-point accumulators starting at \$0030. These accumulators are numbered from 0 to 7, of which FP0..3, may be used implicitly by various routines, and in particular FP1 and FP2 have special significance. For example *fpmul* at \$0882 multiplies the number in FP1 with that in FP2 and the result replaces FP1, with FP2 left undefined.

It is possible to call various floating-point routines directly in the order they are required but to simplify the process of writing sequences of floating-point operations an interpreter was written which calls floating-point routines depending on the value of a code byte which is taken from a table of code bytes, at an address given by the programmer. Code bytes are divided into left-hand and right-hand nibbles, and each

	Code	Time us	xxx	Operation
Main Group	0		nop	no operation, used to complete a byte
	1	90	sld1	short load of FP1 using low nibble as address
	2	90	sst1	short store of FP1 using low nibble as address
	3	90	sld2	short load of FP2 using low nibble as address
	4	70	ld1	load FP1 - using next byte as address
	5	70	st1	store FP1 - using next byte as address
	6	70	ld2	load FP2 - using next byte as address
	7	260	add	FP1=FP1+FP2
	8	260	sub	FP1=FP1-FP2
	9	350	mul	FP1=FP1*FP2
	A	1850	div	FP1=FP1/FP2
	B		br	branch group
	C		fun	function group
	D		cnt	load/dec and branch counter group
	E		adc	load FP1 with ADC conversion; low-nibble=channel
F		undefined		
Branch group	0		bra	branch always
	1		beq	branch if FP1=0
	2		bne	branch if FP1<>0
	3		bpl	branch if FP1 sign bit = 0
	4		bmi	branch if FP1 sign bit = 1
	5		call	reserved
	6		ret	reserved
	7		exit	leave interpreter
	8		wt	wait if keyboard activity
	9		syn	synchronise with CHAN counter
	A		bc	branch if bits clear
	B		bs	branch if bits set
	C		dly	delay in 0.1 sec intervals
D,E,F		undefined		
Function group	0		clr	FP1=0
	1		abs	FP1=abs(FP1)
	2		neg	FP1=-FP1
	3		sgn	FP1=-1,0,+1 matching sign of FP1
	4	4800	sqrt	FP1=square root(FP1) [4.6] - uses FP0,1,2,3
	5		sqrr	FP1=FP1*FP1
	6		swp	FP1<->FP2
	7		fix	fix FP1
	8		flt	float FP1
	9		int	find integer nearer zero
	A		frac	remove integer part
	B		out	output FP1 in fixed point format to RS232
	C		crlf	output CRLF to RS232
D		spac	output a space to RS232	
E,F		undefined		

**Figure 4.4 - Interpreter operations**

nibble is associated with a particular function or sub function. It is not necessary for the programmer to remember the actual value of each nibble because macro definitions were written which achieve the translation automatically. The programmer types 'fxxx' and the assembler creates references to 'fpxxx' where xxx is one of the operations listed in Figure 4.4. When an address is needed for an operand it is encoded in a special way and may cause access to the microcontroller's internal RAM, ROM or external EEPROM. See routines *compx*, *cstol* at \$07E0 and \$07E7 respectively.

As an example in the use of the interpreter, consider the calculation needed to determine the correct setting for the heater drive circuit in order to maintain constant total power dissipation. Since the power in the drive coil is proportional to the square of the voltage across the current-sensing resistor, which in turn is proportional to reading of monitor ADC channel 2, the voltage setting for the heater drive is given by:

$$\text{Heater voltage} = K_1 \sqrt{K_2 - \text{ADC}^2}$$

$K_1$  is a function of coil, heater and reference resistances, and ADC reference voltage; and  $K_2$  is desired total power.

Figure 4.5 shows how this formula may be evaluated using the interpreter.

* call interpreter						
00608	032D	AE 03	CL	ldx	#L/256	pointer high
00609	032F	A6 3D		lda	#L%256	pointer low
00610	0331	CD 06BD		jsr	fintp	interpret
...						
0061x	0334	1E B9		bset	ACK,MODE	acknowledge
0061x	0336	81		rts		
* Formula = K1 * SQRT(K2- (ADC 2)^2)						
00619	033D	B9	L	fc	fbr,fsyn	<u>fpsyn</u> creates a 'snap-shot' of all 8 channels by copying the readings from <u>ADCR</u> at \$0070 to <u>ADCC</u> at \$0088
00620	033E	E2		fc	fadc,2	<u>fpadc</u> accesses current copy
00621	033F	C5		fc	ffun,fsqr	<u>fpsqr</u> multiplies FP1 by itself
00622	0340	C2		fc	ffun,fneg	<u>fpneg</u> negated FP1
00623	0341	67		fc	fld2,fadd	FP2=K2, then FP1=FP1+K2
00624	0342	82		fc	fc	
00625	0343	C4		fc	ffun,fsqt	<u>fpsqt</u> finds square root of FP1 by iteration. see [4.7]
00626	0344	69		fc	fld2,fmul	FP2=K1, then FP1=FP1*K1
00627	0345	81		fc	fc	
00628	0346	85		fc	fbr,fexit	leave interpreter

Figure 4.5 - Example of using interpreter

## Chapter 5 Slave PC Software

The software in the PC was written in Pascal to suit the Turbo Pascal compiler version 5.0 by Borland International [5.1]. Annex [4] contains a listing of the program named *cc1v15fp*, along with a supporting unit named *ccsup*. All of the main program was written specifically for this project but most of the supporting unit already existed as a result of previous personal work. Additional units to support interrupt-driven buffered asynchronous communications have also been used, and these were purchased from Blaise Computing Inc. [5.2]. Pascal was chosen in preference to other languages such as C or C++ for a number of reasons, including familiarity and subsequent readability and maintainability by others. In the descriptions that follow all line numbers refer to lines in listing *cc1v15fp*.

### 5.1 Main program

The purpose of the software is to accept messages sent from a host computer via channel COM3: and provide continuous close-loop control of two coil-drivers connected via channels COM1: and COM2:; where all channels use serial asynchronous communications. (Figure 2.6 shows the interconnection of equipment). The control involves interpreting messages from the host (computer) which represent requests for particular set-points, and sending the appropriate low-level commands to each coil-driver. This task is complicated by the need to allow keyboard entry of set-points at the slave PC, while maintaining closed-loop control. The set-points are the readings which should be obtained by the precision ADCs, and therefore represent the voltage across the sensing pins of the precision resistors. The currents in the coils are linearly related to these voltages, with a range of  $\pm 71$  mA. There is an additional requirement for calibration of the DAC's within each drive, which means that at any moment the slave PC may be in one of three modes of operation; *host*, *keyboard* or *calibration*.

A full understanding of the operation of the software may be deduced by studying the listing but it is helpful here to describe the operation of the main sections so as to appreciate better the overall operation. Referring to the listing in Figure 5.1, the program section called {main} begins with initialisation of general variables and then of variables specific to drive 1, drive 2 and the host. An attempt is then made to restore the previous set of calibration parameters and tables, but if the relevant files do not exist the mode is changed to force a calibration cycle, before switching back

```

1557     begin {main}
1558         general_initialise;
1559         initialise_drive(drive[1],1);
1560         initialise_drive(drive[2],2);
1561         initialise_host(host,3);
1562         restore_all_parameters;
1563         if drive[1].p.valid and drive[2].p.valid then
1564             set_source(host_pc)
1565         else
1566             set_source(calibrate);
1567         repeat
1568             keyboard_activity;
1569             case source of
1570                 host_pc : begin
1571                     get_host_command(host);
1572                     execute_host_command(host);
1573                 end;
1574                 calibrate : begin
1575                     if (drive[1].cal.state=cal_finished) and
1576                         (drive[2].cal.state=cal_finished) then
1577                         begin
1578                             drive[1].p.valid := true;
1579                             drive[2].p.valid := true;
1580                             write_all_parameters;
1581                             set_source(host_pc);
1582                         end
1583                     else
1584                         calibrate_cycle
1585                     end;
1586                 end;
1587             control_loop;
1588             inc(tries);
1589             { gotoxy(10,21); write(loop_count:6,reply_count:6,tries:8); }
1590             report_current_time;
1591             until done;
1592             clrscr;
1593             halt; {close files/coms via MyExit}
1594     end. {main}

```

Figure 5.1 - Main program listing

to host-mode. During normal operation the repeat..until structure at 1567-1591, loops through four procedures; *keyboard\_activity*, *get\_host\_command*, *execute\_host\_command*, and *control\_loop*. At no time does execution get 'stuck' in any of these procedures, and all activity appears to be concurrent. Within *keyboard\_activity* at 1353-1434 the mode may be changed using key letters which start the words in the Options box at the lower left corner of the display; these are Abort, Calibrate, Exit, Host, Keyboard. Selecting C, H or K causes a call to *set\_source* at 1323 which updates the screen where necessary and alters the value of various control variables to indicate the change of state. Wherever possible enumerated data-types have been used whose names reflect the intended state or activity. If a complete and valid message has arrived from the host computer, as determined by *get\_host\_command* at 813-850, this fact is flagged to *execute\_host\_command* via the variable *host.com.state*.

It is the function of *control\_loop* at 1027-1100 to send commands to each drive which depend on the corresponding set-point, which itself may have been defined by either

host messages, local keyboard entry, or the calibration procedure. Use is made of the drive commands X, Y and Z which read the precision ADC, all channels of the monitor ADC, and set the levels of the DACs respectively. The behaviour of the control-loop is determined by the value of the variable named *loop\_state* associated with each drive. Not all calls to this procedure result in commands being sent or replies received; indeed the speed of operation of the computer is very much faster than the rate of transfer of characters via the serial link and the procedure may be called many times before a complete message is sent or received via the interrupt driven buffers. Timing is co-ordinated by using the real-time counter within the slave PC, which is accessed by the *ticks* function at 246-249. The value returned increments at a rate of about 18.2 per second. Constants whose names begin with *ticks\_* at 82-84 determine various important intervals. Currently the values are such that the monitor ADC is accessed every 5 seconds; there is a time-out of 3 seconds for a reply from a drive and the control loop is started every second. As there is not an integer number of ticks per second the timings are approximate.

Also as part of the main program loop is a call to *report\_current\_time* which updates the displayed time once per second. This provides a visual indication to the user that the software is 'working' even if all other displayed parameters appear static. Considerable time was spent on the creation of clear and sensible displays that were of use during both the development phases and actual use in a commercial metrology laboratory, such as that at the National Physical Laboratory (NPL). The next section describes the screen presentations in more detail.

## 5.2 Screen presentations

When the PC is turned on, program *cc1v15fp* is run automatically via a call in the AUTOEXEC.BAT file of the PC, and the screen appears very similar to the photograph shown in Figure 5.2. The source is set to HOST PC and the set-point for each drive to 0.0 volts. The screen is divided into three main areas, showing the status of the drives, the options available and the date of the last calibration. Each area is now described in more detail, beginning with the status of each drive, in terms of one drive.



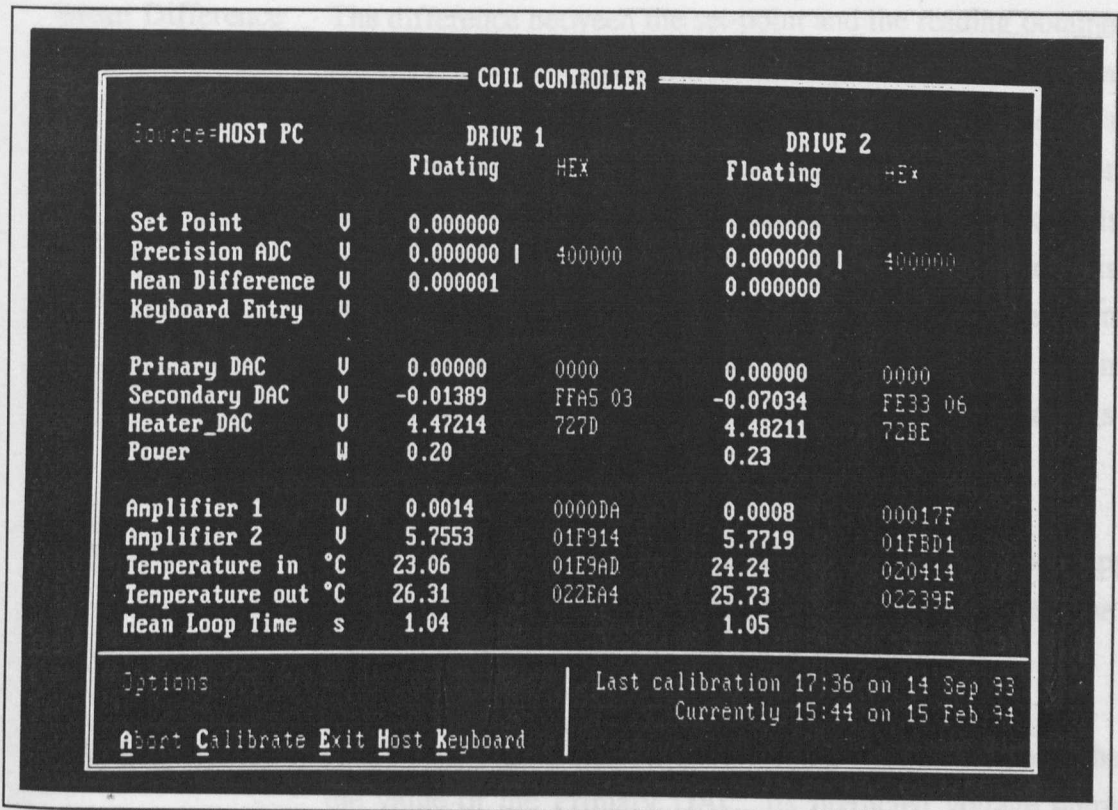


Figure 5.2 - Screen when Source = HOST PC

**Set-Point**

This represents the voltage that is to appear across the sensing wires of the precision resistor, as read by the precision ADC. It may be defined by a message from the host, or the keyboard, or the calibration procedure. The value should be between -5.0 and +5.0.

**Precision ADC**

This is the reading from the precision, 22-bit ADC, and should be very close to the set-point, except when the set-point is changed and there is a characteristic settling time. There is an oscillating bar to the right of the number to show when a new reading has been made, and this provides an indication that the control loop is operating in the event that the actual readings are stable.

- Mean Difference**      The difference between the set-point and the reading obtained by the precision ADC is used as the input to a moving window filter, and the effect is to display the average of the 12 most recent differences. Consequently when the value of either the primary or secondary DAC is altered the mean difference is not valid until 12 readings have been made. When the window is full the display is in white, otherwise it is grey. So long as the mean difference is less than 0.000005 in absolute value no automatic corrective action (trimming) takes place and the readings are continuously shown in white.
- Keyboard Entry**      When keyboard entry is selected by pressing K, numbers appear in the fourth row and may be edited by pressing keys on the keyboard. See section 5.6 for a full description.
- Primary DAC**          When the set-point is altered the control algorithm may change the value of the Primary DAC. Its predicted voltage output is shown as well as the associated Hexadecimal code.
- Secondary DAC**        When the set-point is altered the control algorithm will change the value of the Secondary DAC. Its predicted voltage output is shown as well as the associated Hexadecimal code. The contribution to the net output voltage is  $1/64^{\text{th}}$  of the displayed voltage. Also shown are two hexadecimal characters which represents the value of a trim factor needed to compensate for changes since the most recent calibration.
- Heater\_DAC**          This entry shows the voltage setting for the resistive heater if present. During the design it was thought prudent to include a way of operating the region near the coil at constant power, and therefore constant temperature. However there is no evidence that a heater is necessary and this reading may be ignored. If no heating element is present the plug in the heater output socket on the rear panel should contain a shorting link.

Power	This entry shows the total power dissipated by the coil and resistive heater if present (see Heater_DAC). It should always appear as the same value for a given coil resistance, which is defined during the calibration process.
Amplifier 1	The voltage from the power amplifier associated with the coil output is always larger than the set-point because of the resistance of the coil, but if the coil is open circuit the amplifier will saturate at about $\pm 13.5$ volts.
Amplifier 2	The voltage from the power amplifier associated with the heater output is always larger than the heater DAC value but if the heater is open circuit the amplifier will saturate at about $\pm 13.5$ volts. (see Heater_DAC)
Temperature In	A linear integrated temperature sensor is used to measure the temperature of the air which is taken into each drive unit near the inlet on the front panel. The absolute accuracy is only about $\pm 1^\circ\text{C}$ .
Temperature Out	A linear integrated temperature sensor is used to measure the temperature of the air as it is exhausted from each drive unit near the rear panel. The absolute accuracy is only about $\pm 1^\circ\text{C}$ . The exhaust temperature is higher than the inlet temperature because the air passes over the power amplifiers and the power supplies, and a difference of up to 3 degrees may be expected. More than 5 degrees is an indication that something is wrong.
Mean Loop Time	The control loop may alter the DAC values approximately once per second, and this entry shows the exact loop-time (1.04s). It provides an indication that the system all is functioning normally.

### 5.3 Calibration

When the operating environment is changed it is necessary to recalibrate the drives to ensure optimum performance. This should be done after the system has been

powered-up for 2 hours, and is simply initiated by pressing the letter C on the keyboard. After a warning prompt the screen appears similar to the one in Figure 5.3. This particular figure shows the screen for the very first calibration, and more entries are seen if there has been a previous calibration. It is necessary to enter (or edit) the values of the resistances for the coil and heater for both drives. If the heater does not exist its value should be irrelevant, but for the software control algorithm to function satisfactorily the heater resistance must be larger than the coil resistance, by about 10%. In fact without the heater, the whole concept of maintaining constant power dissipation near the coil is not possible and the resistance of the coil is not needed. However a non-zero entry of say 20, must be made for the software to function correctly. The entry of values in this way allows a heater to be added without additional modifications to the software. When all entries are correct, C should be pressed to continue the calibration process.

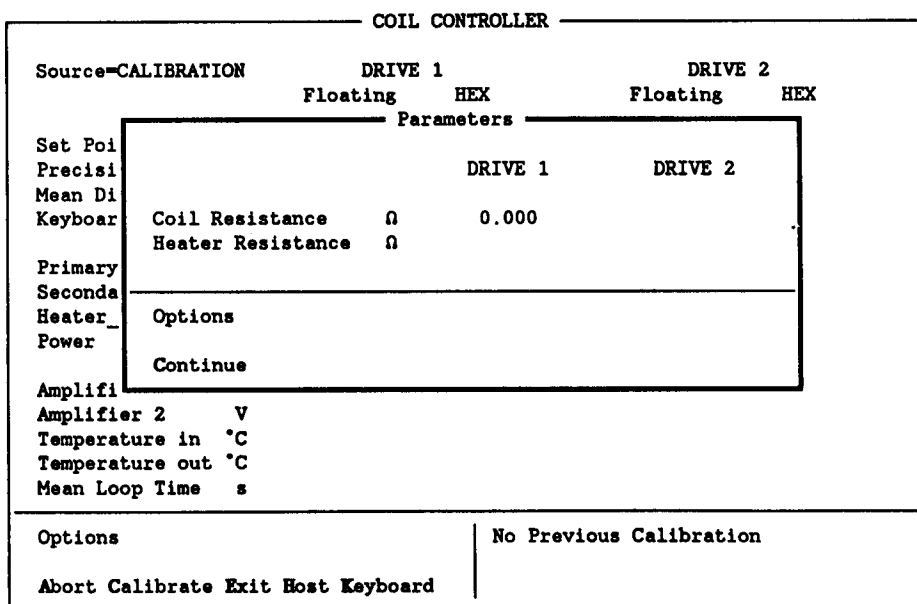


Figure 5.3 - Screen when entering CALIBRATION

#### IN SUMMARY

During the calibration process a number of set-points are defined and the response of the precision ADC is recorded for future use. Two files are created called *cc1v15f.db* and *cc1v15f.dt*, which represent the same data but the former is in a machine-readable binary format, whereas the latter appears as a printable text file. An abbreviated and rearranged example of a typical text file is appears in Figure 5.4. It shows a record of the voltages produced by the primary and secondary DACs across the sensing wires of the precision reference resistor, for a number of control codes, and for both drive units. From these readings a least-squares linear regression transfer function is

calculated. Since the calibration process is deterministic it is possible to calculate the time needed for completion, and this is added to the current time to provide an estimate of the time of completion. This time is shown at the bottom right-hand side of the display. During calibration both coils experience currents from minus full-range to plus full-range, at approximately the same time. Consequently the monolith will experience full translation but only modest twist, however if there is concern about any movement it may be removed prior to calibration.

Edited and annotated contents of the ascii data file cc1v15f.dt obtained during testing of the calibration techniques.

<pre> Drive= 1 Coil Resistance = 22.000 Heater Resistance= 22.000 Primary DAC statistics Temperature (in) = 23.9600 Number= 127 Index Code      Voltage      Error   1 -32256.0 -4.92171597 -0.00004635   2 -31744.0 -4.84356380 -0.00002003 ..  63 -512.0 -0.07792139 -0.00005528  64  0.0  0.00018167 -0.00007808 .. 127 32256.0  4.92212224 -0.00006690 mean x = 0.0  mean_y = 0.00025976 a= 2.59756103275333E-0004 b= 1.52589576521978E-0004 r= 9.9999999924512E-0001  Secondary DAC statistics Temperature (in) = 24.1393 Number= 63   1 -31744.0 -0.07546997  0.00001644   2 -30720.0 -0.07303190  0.00001282 ..  31 -1024.0 -0.00226164 -0.00002596  32  0.0  0.00018215 -0.00002386 ..  63 31744.0  0.07591248  0.00001403 mean x = 0.0  mean_y = 0.00020602 a= 2.06016358875072E-0004 b= 2.38446421095551E-0006 r= 9.99999922838470E-0001 </pre>	<pre> Drive= 2 Coil Resistance = 22.000 Heater Resistance= 22.000 Primary DAC statistics Temperature (in) = 24.7569 Number= 127 Index Code      Voltage      Error   1 -32256.0 -4.92238855 -0.00004427   2 -31744.0 -4.84419298  0.00000088 ..  63 -512.0 -0.07709622 -0.00007802  64  0.0  0.00105834 -0.00007387 .. 127 32256.0  4.92461419  0.00000548 mean x = 0.0  mean_y = 0.00113221 a= 1.13221416323128E-0003 b= 1.52637540139278E-0004 r= 9.9999999858119E-0001  Secondary DAC statistics Temperature (in) = 24.8809 Number= 63   1 -31744.0 -0.07461846  0.00001557   2 -30720.0 -0.07218027  0.00001155 ..  31 -1024.0 -0.00139141 -0.00002361  32  0.0  0.00105715 -0.00001726 ..  63 31744.0  0.07679677  0.00001392 mean x = 0.0  mean_y = 0.00107441 a= 1.07441062018943E-0003 b= 2.38496859352594E-0006 r= 9.99999937323992E-0001 </pre>
---	---

Figure 5.4 - Typical recorded calibration data

#### IN DETAIL

The general operation of the software is to interleave the control of both drives so quickly that they appear to be controlled concurrently. The following description is in terms of one drive but the strategy is applied to both drives simultaneously. When the calibration process is started *source = CALIBRATE* and *cal.state = cal\_start*,

```

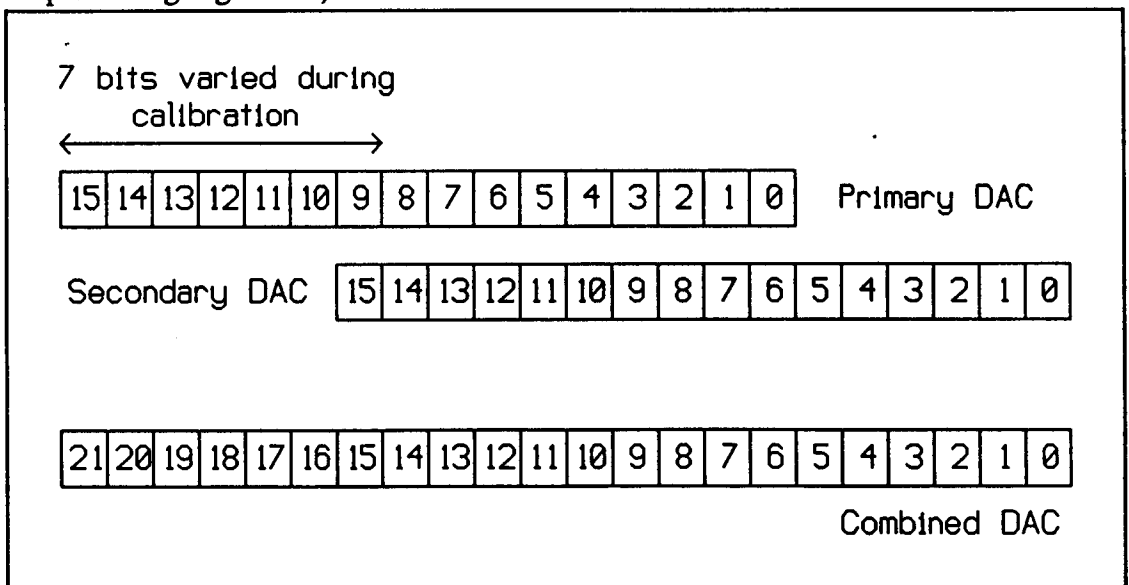
1484 begin {calibrate_cycle}
1485   for i := 1 to max_drive do
1486     with drive[i].cal do
1487       case state of
1488         cal_idle : ;
1489         cal_start :
1490           begin
1491             set_stats(p_stats);
1492             state := cal_p;
1493             define_setpoint(drive[i],2);
1494             drive[i].s_trim := 0;
1495             if i=1 then
1496               display_finish_time;
1497             end;
1498             cal_p :
1499             begin
1500               if drive[i].padc_filter.valid then
1501                 begin
1502                   enter_stats(p_stats,drive[i].p_code,
1503                     drive[i].padc_filter.mean);
1504                   if p_stats.n=p_limit/2 then { record in middle of run }
1505                     p_stats.temperature_in := drive[i].fp_temperature_in;
1506                   if p_stats.n<=p_limit then
1507                     define_setpoint(drive[i],1)
1508                   else
1509                     begin
1510                       apply_stats(p_stats);
1511                       set_stats(s_stats);
1512                       state := cal_s;
1513                       define_setpoint(drive[i],2);
1514                     end;
1515                   end;
1516                 end;
1517                 cal_s :
1518                 begin
1519                   if drive[i].padc_filter.valid then
1520                     begin
1521                       enter_stats(s_stats,drive[i].s_code,
1522                         drive[i].padc_filter.mean);
1523                       if s_stats.n=s_limit/2 then { record in middle of run }
1524                         s_stats.temperature_in := drive[i].fp_temperature_in;
1525                       if s_stats.n<=s_limit then
1526                         define_setpoint(drive[i],1)
1527                       else
1528                         begin
1529                           apply_stats(s_stats);
1530                           state := cal_finished;
1531                           with drive[i] do
1532                             begin
1533                               drive[i].fp_setpoint := 0;
1534                               set_filter(padc_filter,fp_setpoint,
1535                                 precision_adc_filter_length,3);
1536                             end;
1537                           end;
1538                         end;
1539                       end;
1540                     end;
1541                   cal_finished : ;
1542                 end;
1543             end;
1544           end;
1545         end;
1546       end;
1547     end;
1548   end;
1549 end; {calibrate_cycle}

```

**Figure 5.5** - Coding for *calibrate-cycle*

which forces the main program loop to call repeatedly the procedure *calibrate\_cycle* at 1484-1542. See Figure 5.5 for a partial listing and Annex [4] for a full listing. The behaviour of *set\_dacs* at 984-1026 is modified so that calls from within *control\_loop* 1027-1100, no longer force the DACs to track changes in the set-point. This has to

be so, since the purpose of the calibration is to create look-up tables which are used to permit the DACs to track the set-point. The first task of *calibrate-cycle* is to clear the variables associated with the impending linear regression analysis by a call to *set\_stats* at 464-476, and then make *cal.state = cal\_p*, which makes *set\_dacs* calculate the setting of the primary DAC based solely on the *set\_point*, with the secondary DAC set to zero. The set-point is altered by calls to *define\_setpoint* at 1442-1458 so that the most significant 7 bits of the primary DAC are cycled through 127 possible values from 1 to 127. For each setting the average value of the precision ADC during a 20 second period is stored, and used to compute regression parameters. When all settings have been tried a call to *apply\_stats* at 491-516 computes the coefficients of linear regression in the form  $V_{\text{padc}} = a + b \times \text{DAC}_p$ , where  $\text{DAC}_p$  varied from -32256 to +32256. Values calculated during one calibration cycle were  $a = 2.5975 \times 10^{-4}$ , and  $b = 1.52589 \times 10^{-4}$ , which represents an offset of 0.26mV and near ideal scaling of  $5/32768 = 0.000152587$ . These coefficients provide confidence in the performance of the drive and are stored but not used by the closed-loop tracking algorithm, which uses the table of stored values.



**Figure 5.6 - Combined DACs during calibration**

The behaviour of the secondary DAC is now determined when *cal.state = cal\_s*, which makes *set\_dacs* calculate the setting of the secondary DAC based solely on the set-point, with the primary DAC set to zero. The set-point is altered by calls to *define\_setpoint* so that the most significant 6 bits of the secondary DAC are cycled through 63 possible values from 1 to 63. Once again averaged readings of the precision ADC are taken, stored and used to compute the effect on the net output voltage of the secondary DAC code again in the form  $V_{\text{padc}} = a + b \times \text{DAC}_s$ , where  $\text{DAC}_s$  varied from -31744 to +31744. Values calculated during one calibration cycle were  $a = 2.0601 \times 10^{-4}$ , and  $b = 2.384464 \times 10^{-6}$  which represents an offset of 0.206mV

and scaling which is close to the theoretical value of  $5/32768/64=2.384185 \times 10^{-6}$ . The error was attributed to the tolerances of resistors R10 and R11. Coefficients a and b are stored and used in the form  $DAC_s = (\text{Offset\_voltage}-a)/b$  by the closed-loop tracking algorithm in order to compute the control code for the secondary DAC.

When both drives enter the *cal\_finished* state all readings and parameters derived by the calibration process are written to two data files, one in binary which is readily recovered the next time the Slave PC is turned on, and one in text form which may be printed and studied for interest.

#### 5.4 Communication ports and interrupt driven buffers

Three serial communication ports are used by the slave PC, and each is associated with a interrupt driven handler with reserved memory areas for transmit and receive buffers. The use of buffers greatly simplifies the interface and improves operational speed, as the main procedures can initiate messages and gather responses without continuously monitoring the communication channels. The handlers were purchased from Grey Matter, Devon, England, but originally came from Blaise Computing in Berkley, California USA, and packaged under the name Asynch Plus. The associated manual [5.2] describes a number of levels of implementation and the highest level interface is used to create a file variable within Turbo Pascal that actually relates to a physical communications channel. Consequently all serial input and output is then performed via statements such as `read(f,ch)`, where f has been previously assigned to a communications port via `__assignDD` at line 635 in the procedure *prepare\_com\_file* at 622-658. Also in this procedure the data rate is defined as 9600 baud, with no parity, 8 data-bits, 1 stop bit, and no hardware handshake. When the buffer is empty character code 26 is returned, so it is not possible to receive this character, which corresponds to ASCII control-Z. The input and output queue sizes are set to 1024 characters, which are unnecessarily large as the longest reply from a drive is only about 70 characters, but memory is not at a premium and there is room for expansion!

The assignment of channels is shown in Figure 5.7

Channel	PC I/O	PC IRQ	Connection
COM1	\$3F8	4	Drive 1
COM2	\$2F8	3	Drive 2
COM3	\$3E8	5	Host PC

Figure 5.7 - Assignment of communication channels



## 5.5 Closed-loop control strategy

The program is written in such a way that messages are sent to, and replies received from, each of the two drives in an interleaved manner. Consequently both drives may be controlled as soon the messages are communicated via the serial links. State variables for each drive determine the action to be taken the next time a reply is received from a drive. Stated another way the program spends time repeatedly calling *control\_loop* rather than being stuck within it.

With reference to the main part of the control loop at 1027-1110 it will be seen that the real-time clock within the PC is sampled, via the *ticks* function, at various parts of the control loop to ensure messages are sent at certain time intervals. Command X, which reads the moving average of the precision ADC, is issued every second, as is command Z, which updates the DACs. Command Y is issued less frequently every 5 seconds to obtain information from the auxiliary/monitor ADC about the drive voltages and temperatures. When data is received in response to the X and Y commands the display is updated with calls to *calc\_and\_disp\_precision\_adc* at 905-925, and *calc\_and\_disp\_aux\_adc* at 884-904 respectively. Each of these procedures uses utility functions to obtain floating point numbers from the different and obscure hexadecimal code structures. When a reply has been obtained from the X command, (delayed by data from command Y if the timing is appropriate), the reading is used by *set\_dacs* at 984-1026 to compute revised values for the primary, secondary and heater DACs. The set-point is used in different ways depending whether the control strategy is to track the set-point automatically, calibrate the primary DAC, or calibrate the secondary DAC. In normal operation the set-point is tracked by setting the DACs to minimise the difference between the set-point and the mean reading of the precision ADC. This is achieved in a three stage process. Firstly the setting of the primary DAC which gives the nearest value is obtained from the table created during calibration; secondly the code for the secondary DAC is calculated using the inverse transfer function on the difference between the set-point and the nearest point; finally, a trim is added to compensate for errors in the previous two steps, and/or drift due to time and temperature. The trim called *s\_trim* is calculated by *auto\_trim* at 954-970, and incremented or decremented each time the filter for the precision ADC holds a valid mean and the absolute value of the difference between the set-point and the mean is greater than *max\_error*, which is set at 81 to 0.000005, or 1 ppm.

## 5.6 Keyboard operation

When keyboard entry is selected by pressing K, the text in the top left-hand corner of the display will show `Source=KEYBOARD` and numbers appear in the row labelled Keyboard Entry. These may be edited by pressing keys on the keyboard; acceptable keys being any of 0 to 9, decimal point, +, -, back-space, left arrow, right arrow or home. A cursor shows the current location of insertion of a digit and when the entry for drive 1 is complete, pressing carriage return (CR) causes the keyboard entry for drive 2 to be available for editing. When both are acceptable pressing CR causes both values to be copied to the set-point variables. If the difference is greater than 2.0, the values are not copied as this would cause too great a twist to be placed on the monolith. If an entry is incorrect TAB or shift-TAB may be used to toggle between entries, without causing alteration of the set-points. Individual characters are accepted by the keyboard routine and all editing operations are performed by the program, and the cursor is not part of the operating system. This ensures that the control loop may operate during keyboard entry, with timing disrupted only by the time it takes to process an individual key-stroke.

When host control is required, H should be pressed, and when calibration is required, C should be pressed. If E is pressed the program may exit after a warning prompt, and return control to the operating system. If H is pressed, all characters in the input buffer are removed and the set-point is put at 0.0 for both drives before any new message is accepted from the host.

## 5.7 Messages from and to host computer

Characters from the host computer may arrive at any time and are buffered in an input queue until they are read during `get_host_command` at 813-850 called at 1571 in the main loop. They are copied into `hs.com.last_command` until the terminator character (ASCII 4) is received. The characters in the message are then tested to ensure they conform to a certain pattern and that all implied numbers have certain ranges, see 832-846. If the command is deemed valid, it is executed at 1304-1322 which involves copying the received set-point to the set-point of the identified drive, and sending the letter E back to the host as an acknowledgement. The unusual code structure is part of the commercial software running on the host computer and had to be accommodated. Unlike keyboard entry which traps for a difference between drive set-points which is larger than 2.0, values from the host are not tested or trapped.

## 5.8 Utility functions and procedures

A number of functions and procedures are used throughout the software but have not been described individually. These appear in the listing between lines 200-618, and are sufficiently short to be followed by reading the listing without additional comment here. In addition, use was made of a support unit which was already under development. In particular this unit, called *ccsup*, incorporates primitives which support the windows which appear for various prompts. Some of the line drawing routines have been used but there are several procedures which are not referenced. However the 'smart' linker within Turbo Pascal 5.0. ensures the executable file does not include any unnecessary code. References occur to a unit called *win* which was copied from Turbo Pascal 5.5's applications disc.

## Chapter 6 Performance Measures

The performance of the system may be discussed in terms of macroscopic and microscopic behaviour. The former are concerned with such questions as 'Are messages passed correctly from the host PC to the slave PC?' or 'Do the voltage regulators deliver  $\pm 15$  volts where expected?'. These are relatively easy to answer by performing tests in software or making simple voltage measurements. Similarly it is easy to see that the cooling fan is rotating. However it is much harder to determine the microscopic behaviour because this involves the measurement of small currents and voltages, with a resolution-to-range which is below the limits of most common voltmeters. Of particular interest are the effects of electronic noise, and settling time after a step change in the set-point. The internal precision ADC guarantees a resolution to 22-bits or about 1 part in 4.5 million, and was used to measure dc conditions, but transient effects could not be measured to sufficient accuracy. Consequently extensive computer simulations were performed on the voltage-to-current converter stage, as its response dominates that of the digital-to-analogue converters. Much quantitative analysis was done during the design process and prior to design of the printed circuit board (PCB). The analysis provided evidence that a particular approach was feasible, and in many cases involved computer simulations of circuits.

At the beginning of the design process the goal was to provide a programmable current source capable of delivering  $\pm 70$ mA to an inductive load with a nominal resistance of 20 ohms. The range was to be divided into 500,000 steps of equal spacing to achieve the resolution required by the X-ray interferometer. At an early stage it was decided to use Digital-to-Analogue converters with a range of  $\pm 5$  volts followed by a precision voltage-to-current converter. Using a particular circuit topology only one precision resistor was needed, across which 5v must be generated for 70 mA. The problem was thus transformed into the need to generate  $\pm 5$ v with 500,000 intermediate steps, each of which corresponds to  $20 \mu\text{V}$ . The actual design goal was to better this requirement and provide steps of  $10 \mu\text{V}$  with noise of no more than  $\pm 5 \mu\text{V}$  pk-pk. Because of the electro-mechanical nature of the coil driver fixed to the silicon monolith there is mechanical damping, and electronic noise above a frequency of about 1 kHz is quickly attenuated. Mechanical resonances are known to exist below this frequency, and electronic noise may cause unwanted vibration of the monolith. Assuming the precision ADC provides a sufficiently accurate reading every second, then noise below about 0.5 Hz may be reduced/removed by the closed-loop control algorithm implemented in the slave PC. Therefore noise in the band from 1Hz

to 1kHz is of particular interest and importance, together with the behaviour of the circuits in this part of the frequency spectrum. Also of importance are the characteristics of the voltage-to-current converter at the chopping frequency of the chopper-stabilised amplifier within the analogue servo-loop, which is just below 10kHz. (All component references relate to circuit diagrams in Annex [1])

## 6.1 Noise sources and predicted performance

All electronic components exhibit random variations in their behaviour, due to a number of different phenomena. For a comprehensive introduction to the sources associated with resistors and operational amplifiers see [6.1].

The circuit may be divided in two parts as far as noise-analysis is concerned. Firstly from the voltage reference, via the DACs to the voltage-to-current converter (V-to-I), and then within the V-to-I. This separation is appropriate because the noise sources up to the V-to-I are additive, while those within the V-to-I, are removed or at least significantly reduced because of the closed servo-loop around U12, a chopper-stabilised amplifier.

### 6.1.1 Noise in voltage reference and DAC's

Noise from REF1 will pass through, and add to, noise in DACs U6 and U7, amplifiers U8 and U9, before reaching the passive filter at the input to the V-to-I. The noise of these sources is summarised in Figure 6.1

Component Number	Component Type	Noise $\mu\text{V pk-pk}$	Bandwidth Hz
REF1	AD586LQ	4	0.1 to 10
U6,U7	AD1145BG	5	0.1 to 10
U8,U10	TLC2654ACN	1.5	0 to 10
R9,R11	5k ohms	0.45	0 to 100
R10	320k	3.6	0 to 100
R17,R18	10k ohms	0.64	0 to 100

Noise for integrated circuit was obtained from manufacturers data sheets.  
 Noise for resistors was calculated using  $E_R^2 = 4kTRdf$  integrated from 0.1 to 100. See [6.1]

Figure 6.1 - Component noise

The contribution of the thermal noise in the resistors is small compared with the noise from the voltage reference and the DAC. The worst case pk-pk deviation is the sum of the noise from each component, thus  $4+5+1.5+1.5+0.45+0.45+0.64+0.64 = 14.18\mu\text{V}$ . The contribution from DAC U7 is attenuated by the ratio of R11 to R10 (1:64), as is the contribution from R10 itself, and these terms have been neglected. In the  $\pm 5\text{V}$  range this noise represents 1.4 ppm, which is slightly more than the 1ppm which was aimed for but is still with the specification of 1 part in 500,000 or 2 ppm. The figure may be unduly pessimistic as pk-pk values are usually quoted to ensure a 99% or 99.9% confidence by multiplying the rms value by 5 or 6.6 respectively [6.1]. Consequently much of the time the noise peaks will be lower than the quoted figures.

### 6.1.2 Response of Voltage-to-Current converter

The operation of the voltage-to-current converter was described in section 3.4, but little was said about the precise performance that could be expected in terms of stability and noise. To quantify the performance a number of computer aided simulations were carried out using PSPICE [6.2]. The relevant part of the circuit diagram titled 'dr1drv1.sch' was annotated with node numbers to allow entry into PSPICE as a netlist. The circuit diagram appears in Figure 6.2 and the corresponding PSPICE definition in Annex [5].

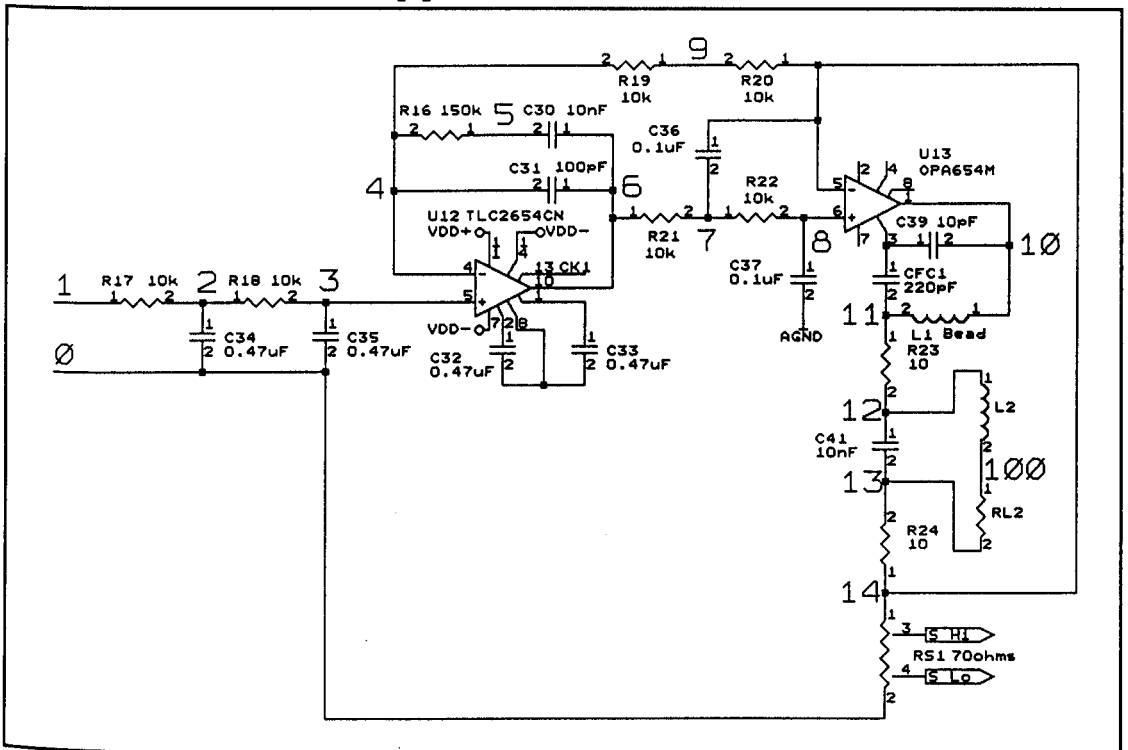


Figure 6.2 - Voltage-to-Current converter simulated by PSPICE

The integrated circuit amplifiers were modelled by voltage-controlled voltage sources, with appropriate gains, and consequently introduce none of the undesirable effects associated with the real amplifiers, such as input offset voltages. This is not an unreasonable approach because the chopper-stabilised amplifier has almost no offset effects and is the main component affecting the level to which the output current settles. The high frequency compensation components, C39 and CFC1, associated with U13 were not modelled as their function is to suppress radio frequency oscillations in the real power amplifier.

The change in the coil current when the input voltage changes from 0 to 1 volt at time  $t=0$  is shown in Figure 6.3. The loop is settled when the voltage across the

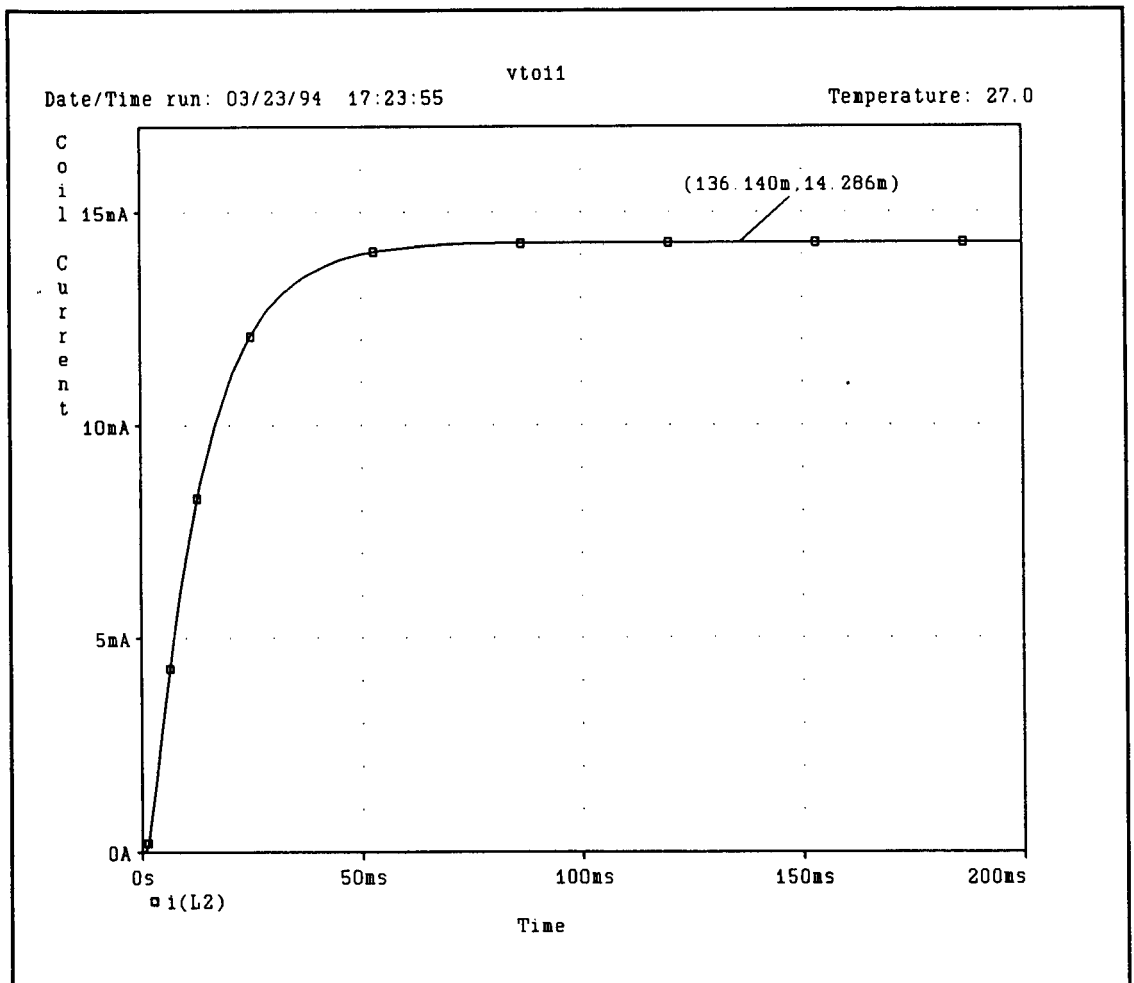


Figure 6.3 - vto11 Transient response

precision reference resistor, RS1, is also 1 volt. Since it has a value of 70 ohms (ignoring end effects as it is a 4 terminal device), the final current should be  $1/70 = 14.2857$  mA. According to the simulation this occurs at about 140 ms, however the results are rounded to the nearest micro-amp, whereas the minimum step in current is  $0.14 \mu\text{A}$  (for 1 ppm). Considering that the current changes by 14 mA in 140 ms it is reasonable to assume that a further change of less than  $1 \mu\text{A}$  will occur in less

than a few more milliseconds. Consequently, by inspection, an upper bound for the settling time due to a 1v step in the DACs is placed at 150 ms.

Figure 6.4 shows the gain of the circuit at various nodes. In particular the voltage at node 14 which corresponds with the voltage across the precision current-sensing resistor RS1, shows a progressive attenuation from 10 Hz to 400 Hz at 10dB/decade and thereafter at 80dB/decade. This suggests that noise above 1 kHz at the input,

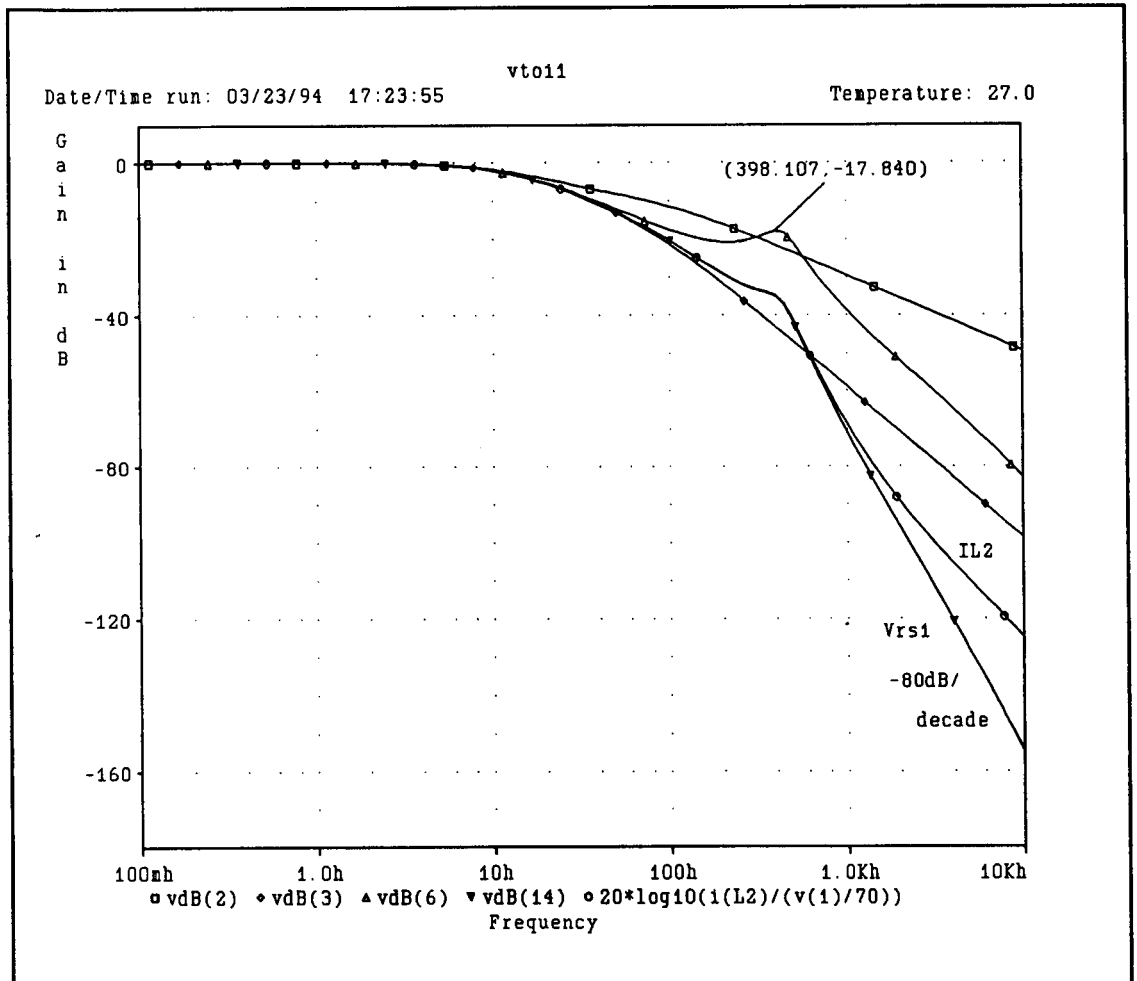
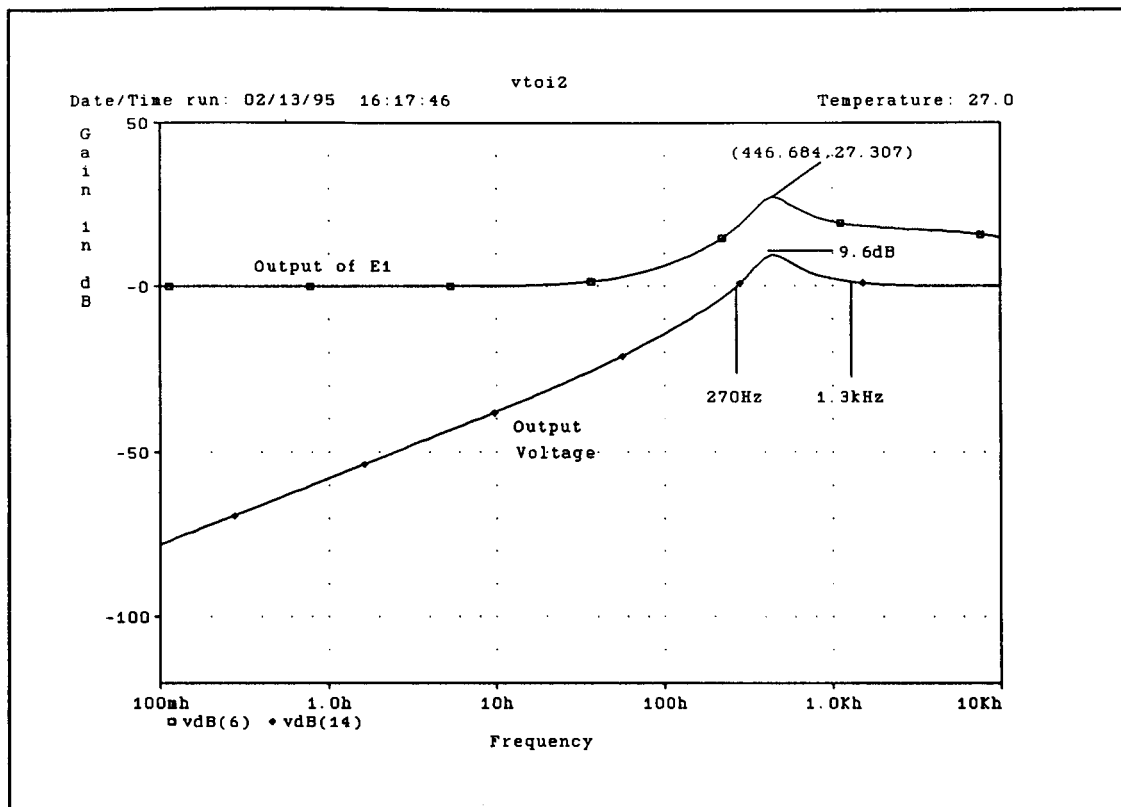


Figure 6.4 - vto11 Frequency response

which comes from the DACs in the real circuit, is of insignificant contribution to the output current. The trace labelled 'IL2' is included to show that the response of the current in the coil follows the same shape as the voltage across RS1 until about 1kHz when it does not fall as quickly. This occurs because the impedance of C36 falls and a more significant proportion of the current which should flow through RS1 flows through C36.

Using circuits similar to the one already described, the effects of noise in various parts of the design have been studied extensively. In particular further voltage sources were added to the circuit in Figure 6.2 to investigate the effects of noise at the input





**Figure 6.5 - vtoi2 Frequency response**

of U13 and the output of U12. The resulting circuits appear in Annex [5] as vtoi2 and vtoi3 respectively. One of the graphs associated with vtoi2 is shown in Figure 6.5. It indicates that for frequencies below 100 Hz the servo action of U12, as modelled by E1, provides considerable attenuation, but noise generated at the input of amplifier U13, between 270 Hz and 1.3 kHz will be amplified with a peak gain of 9.6 dB at 446 Hz. This is potentially undesirable and may be significant depending on the noise in this band for the real device. The data sheet for the OPA654 [3.6] provides only a wide-band noise figure but does include a plot of input voltage noise spectral density versus frequency. Using this plot, which shows a progression from flicker-like noise at 0.01 Hz to white noise at about 1 kHz, it was possible to determine an explicit relationship between voltage noise spectral density ( $y$ ) and frequency ( $x$ ) for the region between 0.01 Hz and 100 Hz. This relationship was expected to be of the form  $y=A/x^n$ , and non-linear regression analysis shows there to be an excellent 'fit' when  $A=393.7$  and  $n=0.6309$ . According to [6.1] many semiconductor devices exhibit noise with  $n=0.5$  to 2, so  $n=0.6309$  is not unexpected. For  $1/f$ , or pink noise  $n=1$ . The rms value in a narrower region is given by the square-root of the definite integral of  $y^2$  over that region. The noise in several bands was calculated and is shown in Figure 6.6

Frequency Hz		rms (nV)	pk to pk ( $\mu\text{V}$ ) =
from	to		$5 \times \text{rms} @ 99\% \text{ confidence}$
0.01	0.10	946.4	4.73
0.10	1.00	700.0	3.50
1.00	10.00	517.8	2.58
10.00	100.00	383.0	1.91
100.00	1000.00	283.3	1.42

**Figure 6.6 - Noise of OPA654**

Between 1 kHz and 10 kHz white noise is dominant and the rms noise is given by  $12 \times 10^{-9} \times (10^4 - 10^3)^{0.5} = 1.14 \mu\text{V}$ , which suggests a pk-pk value of  $5.7 \mu\text{V}$  with 99% confidence. When all these noise figures are considered in conjunction with the simulated gain vs frequency plot of vtoi2, there is no region where the noise in the coil will exceed about 1.1 ppm due to noise generated within the power amplifier, U13.

The real chopper-stabilised amplifier used for U12 has a very low input offset voltage of  $5 \mu\text{V}$ , and an input voltage noise of  $1.5 \mu\text{V}$  pk-pk from 0 Hz to 10 Hz. However it also has a very narrow-band noise output at its internal clocking frequency of 9.795 kHz. Consequently vtoi3 sets out to investigate the effects of signals added to the output of U12. The results show a flat response from dc to 100 Hz and an attenuation of about 70 dB at 10 kHz. This means that noise spikes of up to 15 mV at the chopping frequency will be attenuated to below  $5 \mu\text{V}$  across RS1, and represent less than 1 ppm of full range.

### 6.1.3 Precision current sensing resistor RS1

The stability of the voltage-to-current converter relies upon the stability of the current-sensing resistor RS1. This is a power resistor made by Vishay Resistive Systems, and is capable of dissipating 10 watts. However in this circuit it dissipates a maximum of 0.35 Watts and is bolted to a heatsink which has a forced air flow over it. There is negligible local heating and the device remains essentially at ambient temperature. According to the data sheet for the resistor shown in Appendix [B], the maximum temperature coefficient at  $+25^\circ\text{C}$  is  $\pm 2.5 \text{ ppm}$ , with a nominal of 0 ppm! Assuming the drives are operated in a precision metrology laboratory with a temperature stability of  $\pm 0.1^\circ\text{C}$  the drift of RS1 is negligible. Actually it is the resistance across the sensing elements that exhibits the quoted stability and end-effects may cause greater drift. Although the analogue servo-loop cannot remove the end

effects, the calibration procedure, together with the closed-loop tracking behaviour of the control algorithm, eliminates them.

## 6.2 Measured responses

The electrical behaviour of the drives was assessed by making measurements of various selected parameters under a number of operating conditions. The sections that follow describe these measurements in detail and show that the behaviour is as expected in all but one aspect; this being the existence of a (large) transient current in the coil when mains power is removed.

### 6.2.1 Precision ADC

The stability of the drive was first assessed by setting the digital control codes of the primary and secondary DACs to zero and recording the readings made by the precision ADC. Command Q in the embedded software outputs 20 sequential readings via the serial link in Hexadecimal notation. A typical list appears in Figure 6.7 and shows there is dc offset, which is made up from offsets in the DACs and precision ADC, as well as some variation due to noise. Also shown is the computed standard deviation of the readings from their mean value. Assuming the distribution to be Gaussian in nature, about 95% of readings may be expected to fall within 3 standard deviations, or  $\pm 8.1$ . This means that 4 bits of the 22 may vary, and that if a particular reading is used in any simple control strategy the resolution may only be 1 part in  $2^{18}$  ( $262144_{10}$ ), which does not meet the required specification. Fortunately if a moving average is taken of 16 readings the variation in the mean value is much lower and may be used in the closed loop control strategy. The standard deviation of these moving averages is about 0.12 with a corresponding confidence interval of less than  $\pm 1$  bit. However this statistic is based on only 5 samples and therefore must be interpreted with care. The variation in readings comes from noise associated with all components including the precision ADC itself. Close inspection of the data sheet for this device reveals a specification of noise in the voltage reference, in the band from 0.01 Hz to 10 Hz, of 1 ppm pk-pk, or equivalent to  $\pm 2$  counts in 22 bits. After inspection of these results a moving average window filter was implemented in the embedded software, and the output of command X gives the average of the most recent 16 readings.

Reading in Hex	Decimal - Bias	Deviation	Moving Averages				
40005F	95	-2.8	95				
400062	98	.2	98	98			
400060	96	-1.8	96	96	96		
400062	98	.2	98	98	98	98	
40005F	95	-2.8	95	95	95	95	95
400060	96	-1.8	96	96	96	96	96
400064	100	2.2	100	100	100	100	100
40005F	95	-2.8	95	95	95	95	95
400066	102	4.2	102	102	102	102	102
40005E	94	-3.8	94	94	94	94	94
400064	100	2.2	100	100	100	100	100
400064	100	2.2	100	100	100	100	100
400061	97	-.8	97	97	97	97	97
400067	103	5.2	103	103	103	103	103
400060	96	-1.8	96	96	96	96	96
400064	100	2.2	100	100	100	100	100
400062	98	.2		98	98	98	98
400062	98	.2			98	98	98
400063	99	1.2				99	99
400060	96	-1.8					96
Mean	97.8		97.81	98.00	98.00	98.19	98.06
Std. Dev.		2.42					

**Figure 6.7 - Precision ADC readings**

Using a simple terminal emulation program on the slave PC with the ability to log received characters to a file, command Q was repeatedly executed and the readings of the precision ADC recorded, with the primary DAC set to half range. A list of hexadecimal characters was obtained that was changed into scaled floating-point format before being imported to a 'spread-sheet' package [6.3] for analysis. Figure 6.8 shows a polynomial fit to the readings and the moving mean of the most recent 16 readings, together with the expected output of the X command, which is truncated to  $\pm 21$  bits. The vertical axis is biased by the mean of all the readings which is 2.5198245, and expressed in parts per million. The deviation of the truncated mean is within  $\pm 0.5$  ppm for the duration of these readings but extended monitoring of the readings provided by the X command during normal operation over tens of minutes shows the peak deviation is  $\pm 3$  counts in 22 bits or about 1.5 ppm. Software in the slave PC averages these readings so as to obtain an even better estimate of the mean voltage across the precision resistor. It is this estimate that is used by the closed-loop control algorithm. Figure 6.9 shows the spectrum of the low frequency noise with the control algorithm functioning.

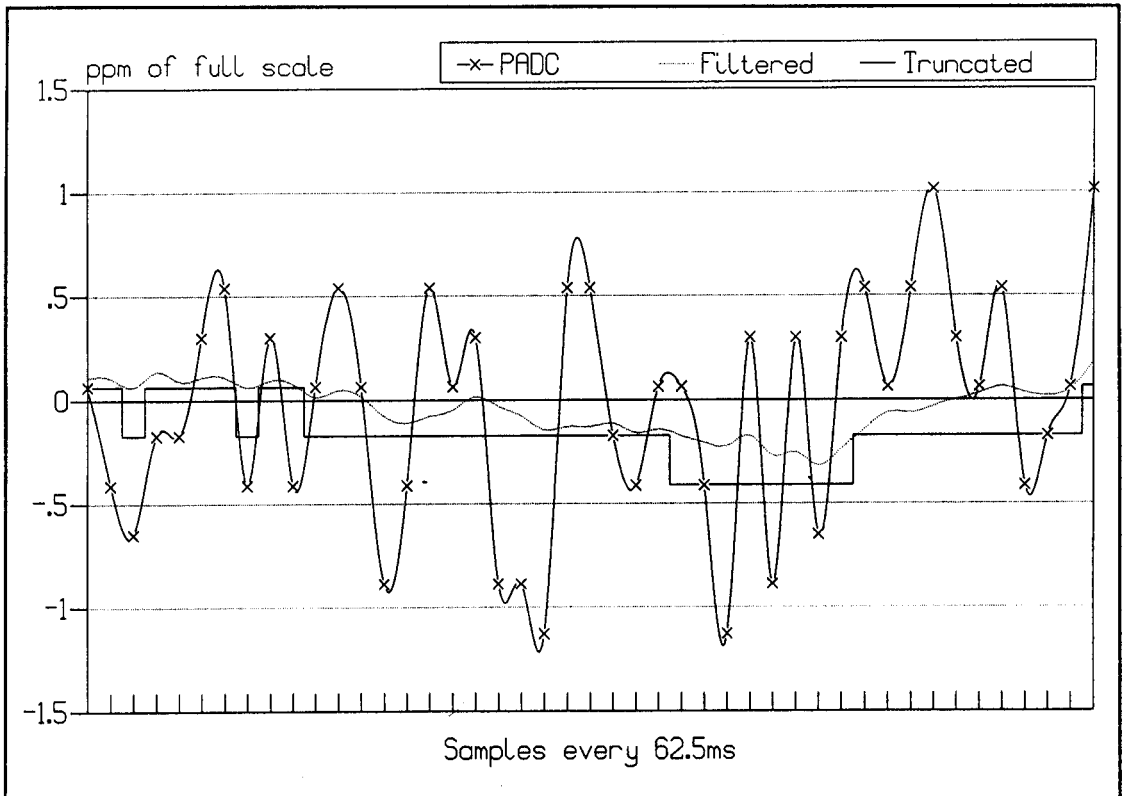


Figure 6.8 - Precision ADC readings and filtered values

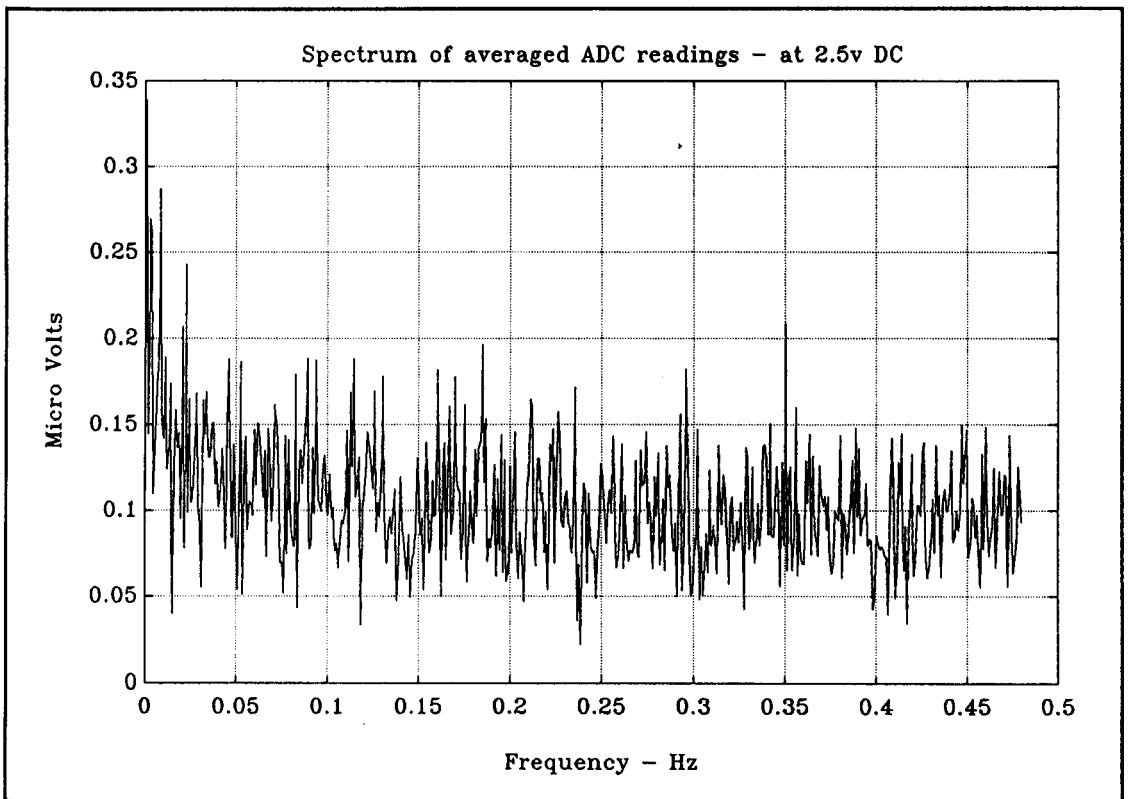


Figure 6.9 - Low frequency noise of filtered ADC readings

### 6.2.2 Power-on/off transients

The voltage-to-current converter circuit contains resistors R34 and R35 which protect the output amplifier from a short-circuit coil or accidental connection of the coil output to analogue ground. (see circuit diagram 5 in Annex [1]). Consequently the voltage at the connector on the rear panel corresponding to pin 2 of JP7 on the circuit is larger than the control voltage by a factor of  $(10+70)/70$ . Using a data acquisition system [6.5], samples of the output voltage with respect to analogue ground were taken every 1 ms for about 2.5 seconds for both coils. During this time mains power was applied and then removed from both drives. Figure 6.10 shows the output expressed as a percentage of full scale, accounting for the voltage drop across R35.

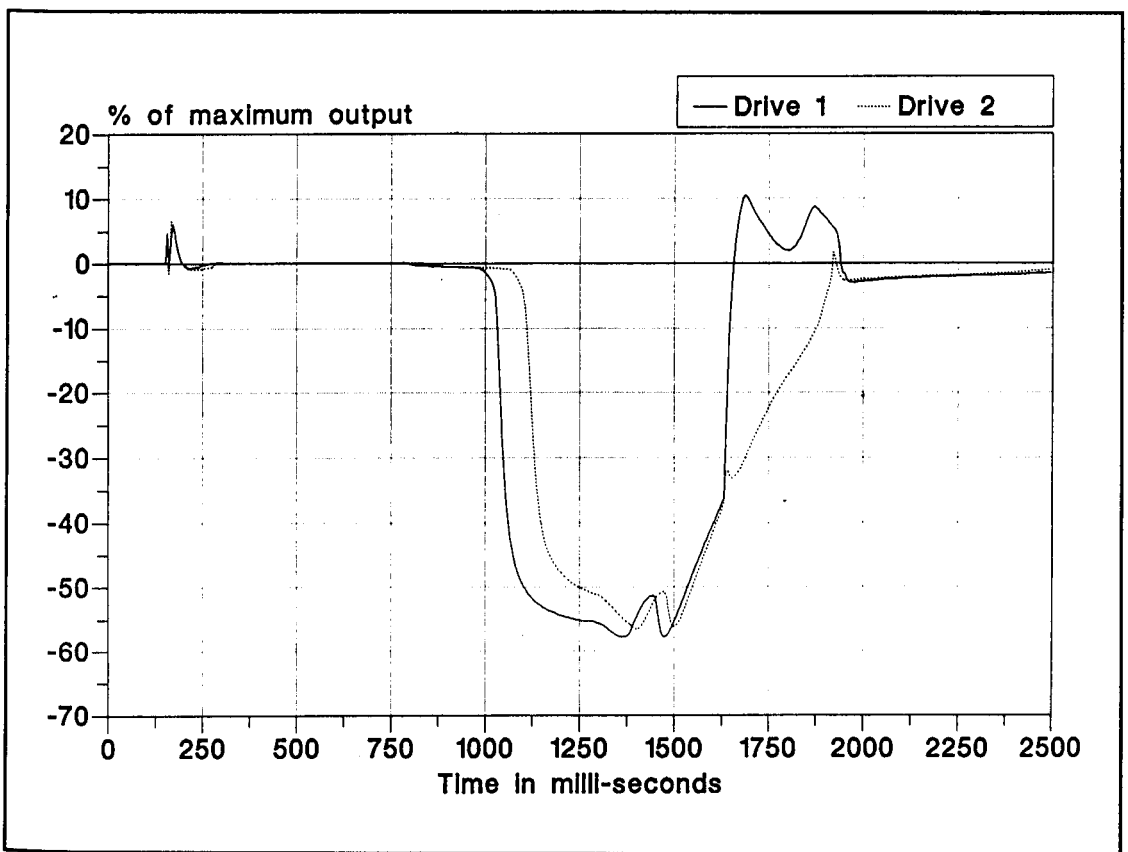


Figure 6.10 - Power on and off transients

Both drives have similar outputs, showing a small transient when power is applied at time=130ms, but much larger transients when power is removed at about time=750ms. Care was taken when selecting the DACs that they power-on at 0volts so the relatively small power-on transient was expected, but no consideration was given to power-off conditions. The transients are no larger than could be applied under program control and from this point of view they are acceptable, however if the transients had been in opposite directions a torque would be applied to the monolith which is far larger than any desired under program control. In hindsight

additional circuitry should have been included to prevent the power-off transient.

### 6.2.3 Step response

Using the keyboard entry option of the controlling software running on the slave PC the set-point for both drives was changed from 0v to +4v, representing a step of 80% of +full scale output. Monitoring the output voltage as described in 6.2.2, allowed the plot shown in Figure 6.11 to be produced. It shows the output of both drives settling to  $4 \times 80/70 = 4.57\text{v}$  in about 100 ms, and that there is excellent agreement between the simulated and actual responses; indeed two curves lay almost on top of each other. The output of drive 1 lags drive 2 because of the time taken to communicate messages serially from/to the slave PC where the interrupt structure gives priority to drive 2. Specifically drive 2 is on channel COM2 with interrupt request level 3, while drive 1 is on channel COM1 with interrupt request level 4, and level 3 has a higher priority than 4 [6.6, 6.7]. The delay results in an undesirable short-lived twist of the monolith which could reduce contrast of X-Ray fringes, but this has never been noticed.

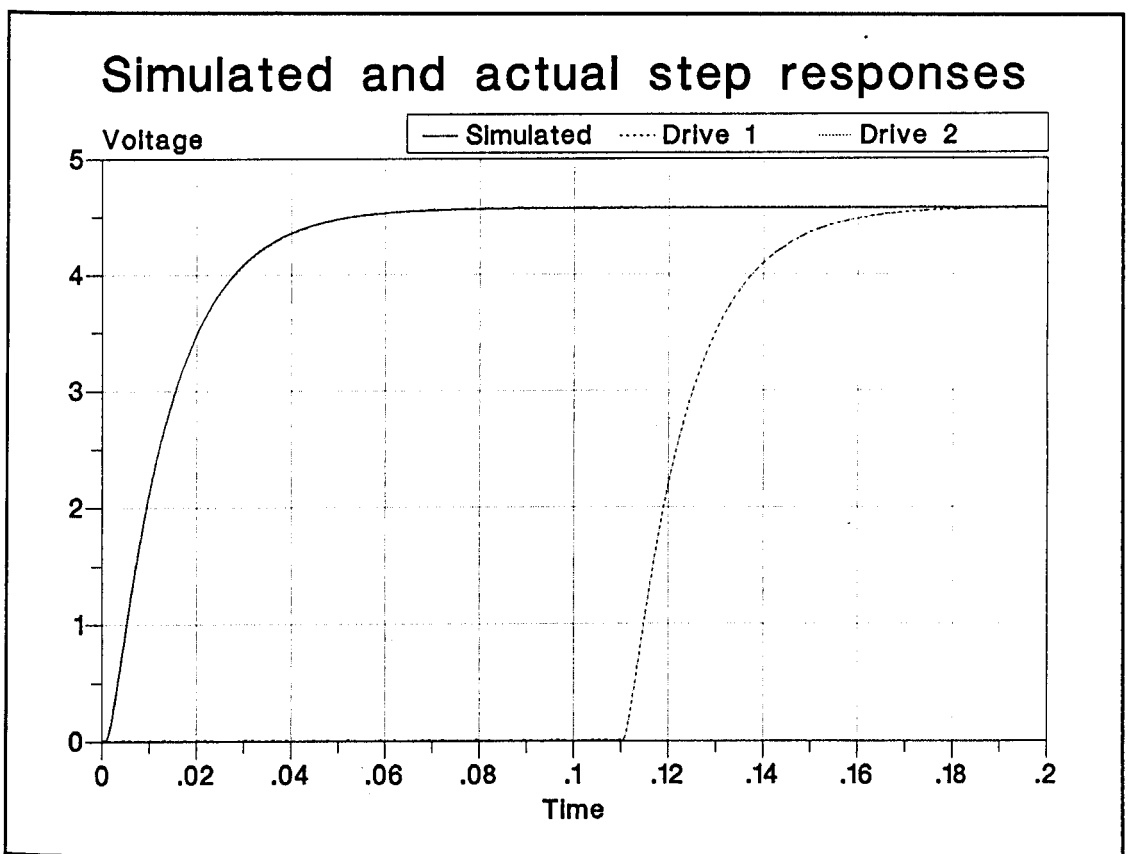


Figure 6.11 - Step response

#### 6.2.4 Noise in the coil

It is to be expected that any silicon monolith will have mechanical resonances in the range of a few hertz to a few kilohertz [6.8]. Consequently extensive effort was made to determine the current noise in the coil in this region. For frequencies up to about 1kHz the voltage on one side of the coil with respect to ground is closely related to the current flowing through it, as shown in Figure 6.4 and associated text. However for higher frequencies this is not true and another means of measuring the current through the coil is needed. It was decided to place a  $10\ \Omega$  resistor in series with the coil and monitor the voltage across it, and hence infer the current. Although a higher value of resistance would give a larger voltage drop, which in turn would be easier to measure, the value of  $10\ \Omega$  was used so that it did not alter the normal operating conditions too much. An ac-coupled differential amplifier with high input impedance, low-noise and high-gain was needed to amplify the voltage across the resistor so that signals could be read via the sampled data acquisition system. Unfortunately no suitable amplifier was available in the laboratory and it was necessary to build one. In section 6.1.1 the predicted peak-peak noise across the current sensing resistor was about  $15\ \mu\text{V}$ . This corresponds to a current noise of  $15/70\ \mu\text{A}$ , and a voltage of  $15/70 \times 10\ \mu\text{V}$  across the  $10\ \Omega$  resistor. Using a gain of about 500,000 produced signals which could be measured by the data acquisition system, and yet still allowed signals up to 5 times larger to be captured before causing an over-range condition.

The circuit diagram appears Figure 6.12. and shows 3 amplifiers in cascade. The first is an instrumentation amplifier with high impedance differential inputs, a single-ended output and a gain set at 100 by the particular choice of connections. The next two are low-noise operational amplifiers connected with voltage gains of 101 and 46.5 respectively as determined by fixed resistors. The combined gain is  $100 \times 101 \times 46.5 = 469000$ . It was built on a square pad prototyping circuit board and operated by two 9 V batteries inside a aluminium box.



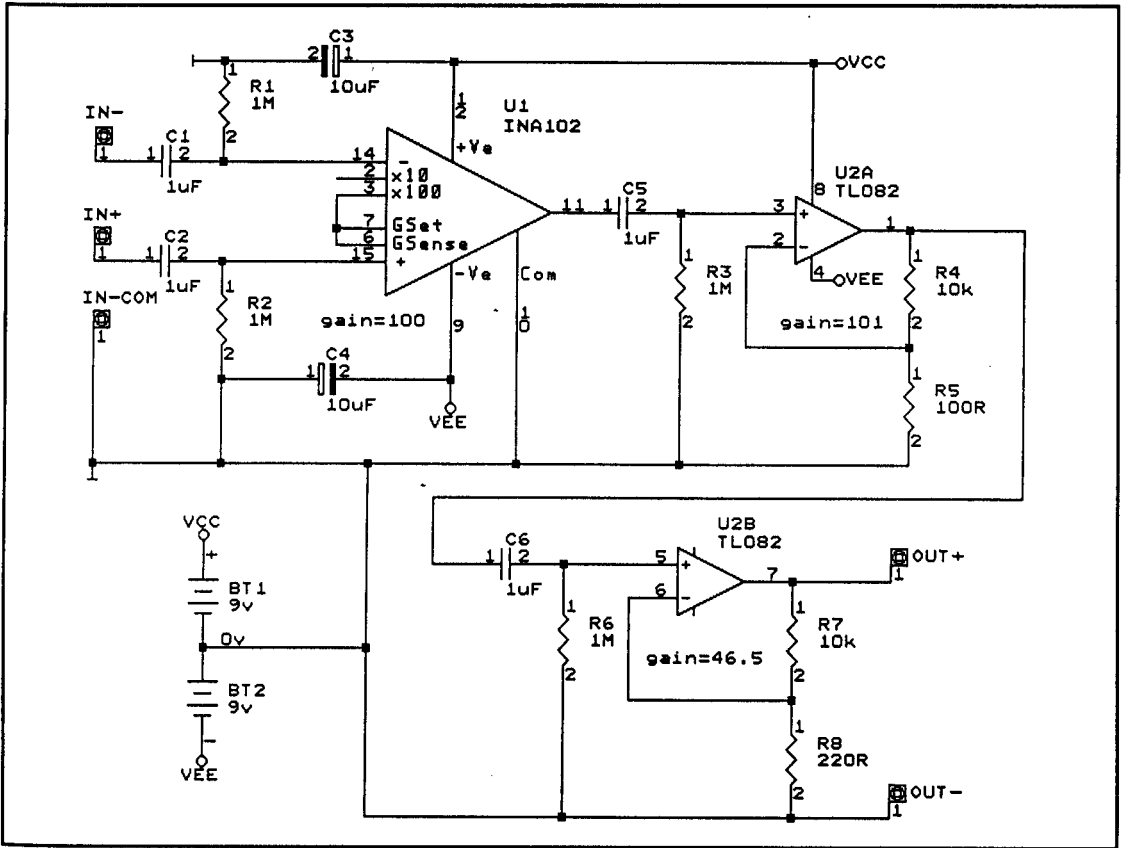


Figure 6.12 - High gain test amplifier

The output was sampled every  $100\mu\text{s}$  for  $7 \times 1024$  readings and then analyzed using MATLAB [6.4]. The sampling interval of  $100\mu\text{s}$  was chosen because it enabled frequencies up to 5 kHz to be studied, and 7 blocks of 1024 samples allowed averaging of the output of successive Fast Fourier Transforms, while keeping within the matrix limits imposed by the PC version of MATLAB. In order to present the spectra in terms of parts per million FSO a correction factor is needed, and this was calculated as follows.

$R$  is a  $10\Omega$  resistor in series with the coil.

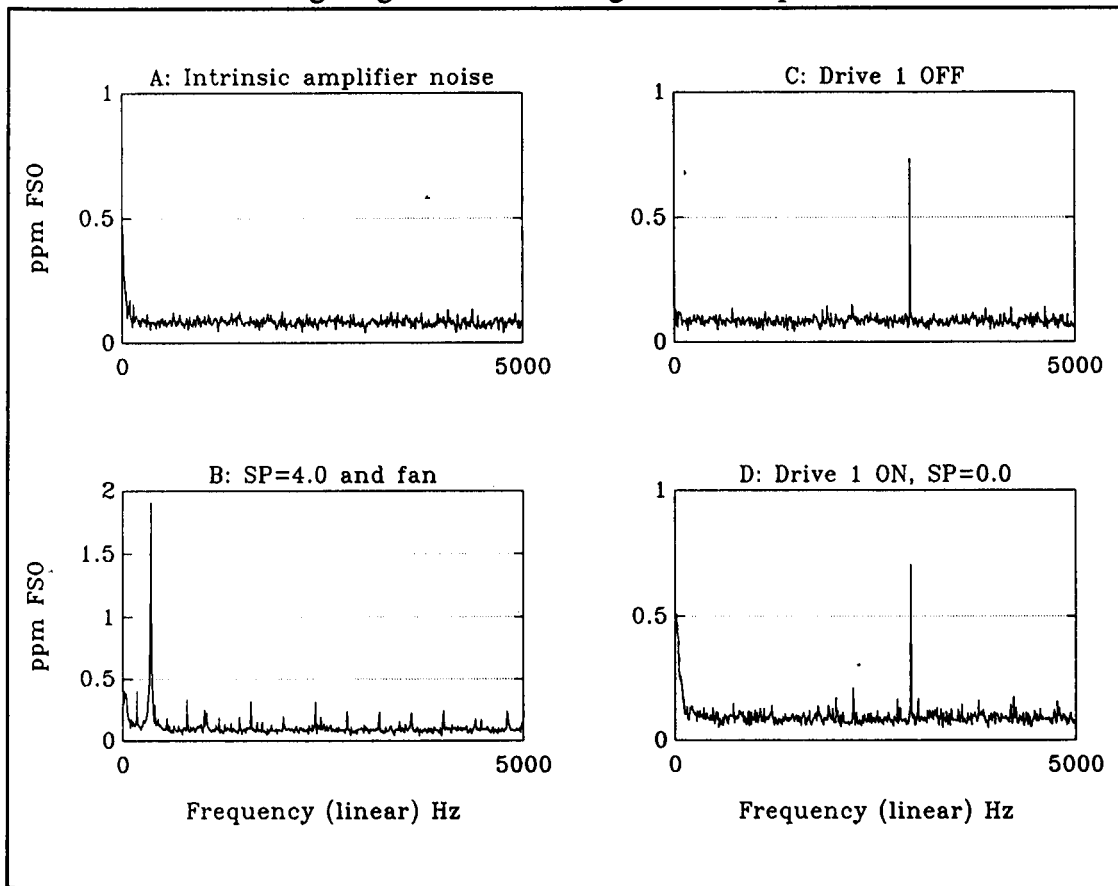
Let  $V_R$ =voltage across  $R$ ,  $V_a$ =amplified voltage,  
 $g$ =gain=469000,  $I_c$ =coil current

$$V_R = I_c R \therefore I_c = \frac{V_R}{10} = \frac{V_a}{10g} \quad \text{also} \quad +I_{\max} = \frac{5}{70} \Rightarrow I_{\text{range}} = 2 \times \frac{5}{70}$$

$$\therefore \text{fraction} = \frac{I_c}{I_{\text{range}}} = \frac{\frac{V_a}{10g}}{2 \times \frac{5}{70}} = \frac{V_a}{10g} \times \frac{70}{5 \times 2} = 0.7 \frac{V_a}{g}$$

$$\therefore \text{ppm} = 0.7 \times \frac{10^6}{469000} \times V_a$$

Averaging proved necessary because of the intrinsic noise in the amplifier which is shown in Figure 6.13a) and the low level of the signals of interest. The first few tests resulted in a spectrum with an unexpected peak of about 2 ppm at 351 Hz, see Figure 6.13b), but further investigation showed this was due to a temporary connecting cable with a poor shield being too close to the brushless cooling fan, which creates a rotating magnetic field. Using the cable specified for connection to



**Figure 6.13 - Noise spectra of coil-current**

the coil with a woven braid screen lapped with foil, and routed away from the fan this peak was no longer observed in the spectrum of either drive. It was possible to determine without doubt that the fan was the source of the interference by covering the air outlet and seeing a shift in the frequency of the peak as the fan partially stalls due to the impeded airflow. Spectra of the current in the coil for drive 1 appear Figure 6.13c) and Figure 6.13d). The peak at 2939 Hz is present even if the mains power to the drive is off, but is not present when the differential inputs of the amplifier are shorted together and to ground. The graphs for drive 1 and drive 2 are almost identical. This leads to the conclusion that the peak is due to the cabling between the amplifier and the coils, which was common during measurements of each drive. The peak is undesirable but of little practical significance because its amplitude is less than 1 ppm at a frequency above natural resonances.

Figure 6.14 shows the MATLAB script files that were used to create the plots in Figure 6.13.

```

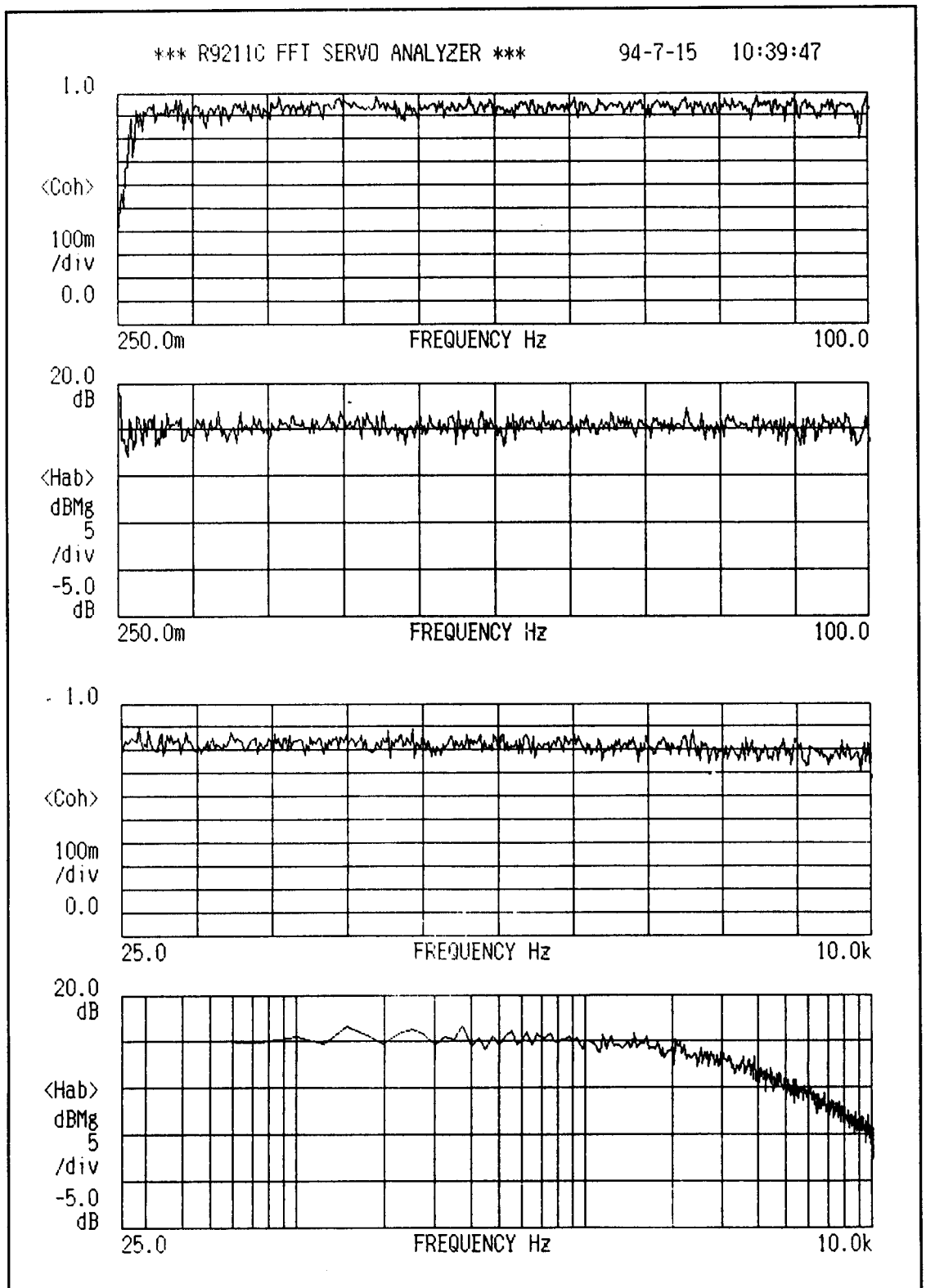
file spec3.m
function z = spec3(x)
n=1024; % block size
s=zeros(n,1);
m=fix(max(size(x))/n); % number of blocks
for i=1:m
    y=fft(x((i-1)*n+1:i*n));
    s=s+abs(y); % accumulate in s (sum)
end;
f=10000*(0:n-1)/n; % actual frequencies with 100µs samples
z=[f',s./m/(n/2)];

file pnoise4.m
% Load files and compute spectra
load pcdn1; a=spec3(pcdn1); clear pcdn1; % amplifier noise
load pcd1n16; b=spec3(pcd1n16); clear pcd1n16; % mains off
load pcd1n17; c=spec3(pcd1n17); clear pcd1n17; % SP=0
load pcd1n1; d=spec3(pcd1n1); clear pcd1n1; % SP=4 and lead near %
fan
% remove dc component and scale to ppm of Full Scale Output (FSO)
g=0.7*1000000/469000; % scaling factor see section 6.2.5
f=a([2:512],1); % frequencies
a=a([2:512],2)*g; % intrinsic noise
b=b([2:512],2)*g; % drive with mains power off
c=c([2:512],2)*g; % drive with mains power on SP=0.0
d=d([2:512],2)*g; % drive with mains power on SP=4.0
% and lead near fan
% Plot
clg;
subplot(221); axis([0,5000,0,1]); grid;
ylabel('ppm FSO'); title('1: Intrinsic amplifier noise'); plot(f,a,'w-');
subplot(222); grid;
title('3: Drive 1 OFF'); plot(f,b,'w-');
subplot(224); grid;
xlabel('Frequency(linear) Hz'); title('4: Drive 1 ON, SP=0.0'); plot(f,c,'w-');
subplot(223); axis([0,5000,0,2]); grid;
xlabel('Frequency(linear) Hz'); ylabel('ppm FSO'); title('2: SP=4.0 and fan');
plot(f,d,'w-');

```

Figure 6.14 - MATLAB script files for spectral analysis

The frequency response of the high-gain test-amplifier was obtained with an Advance Spectrum Analyzer model R9211C, with an external resistive attenuator of 10/820k. Various plots are shown in Figure 6.15. The net gain was  $469000 \times 10/820000 = 5.72$  or about 15 dB. Intrinsic noise means a smooth trace may not be obtained, even though the coherence function is nearly 1. The plots show the amplifier to have an almost flat response from 0.25 Hz to 2 kHz. At 5 kHz the gain is reduced by a factor of about 2, which means that although the trends in Figure 6.13 appear to be flat to 5 kHz, the original signal must rise and be complementary to the reduction of intrinsic gain. Even taking this effect into account the amplitude of noise in the coil is still only about 0.2 ppm at 5 kHz.



**Figure 6.15 - Frequency response of test amplifier**

### 6.2.5 Closed-loop response

When a particular set-point is defined, either by direct keyboard entry or by a message from the host computer, the control algorithm determines the most

appropriate value for the primary DAC by using a look-up table, and computes the necessary value for the secondary DAC. Unfortunately due to variations induced by fluctuations in temperature in the laboratory since the time of calibration, a large change in the set-point requires a small automatic trim of the secondary DAC. (For a full description of these operations see section 5.5). Also when the set-point crosses a boundary such that the primary DAC must be changed as well as the secondary DAC, it may be necessary to trim the secondary DAC again.

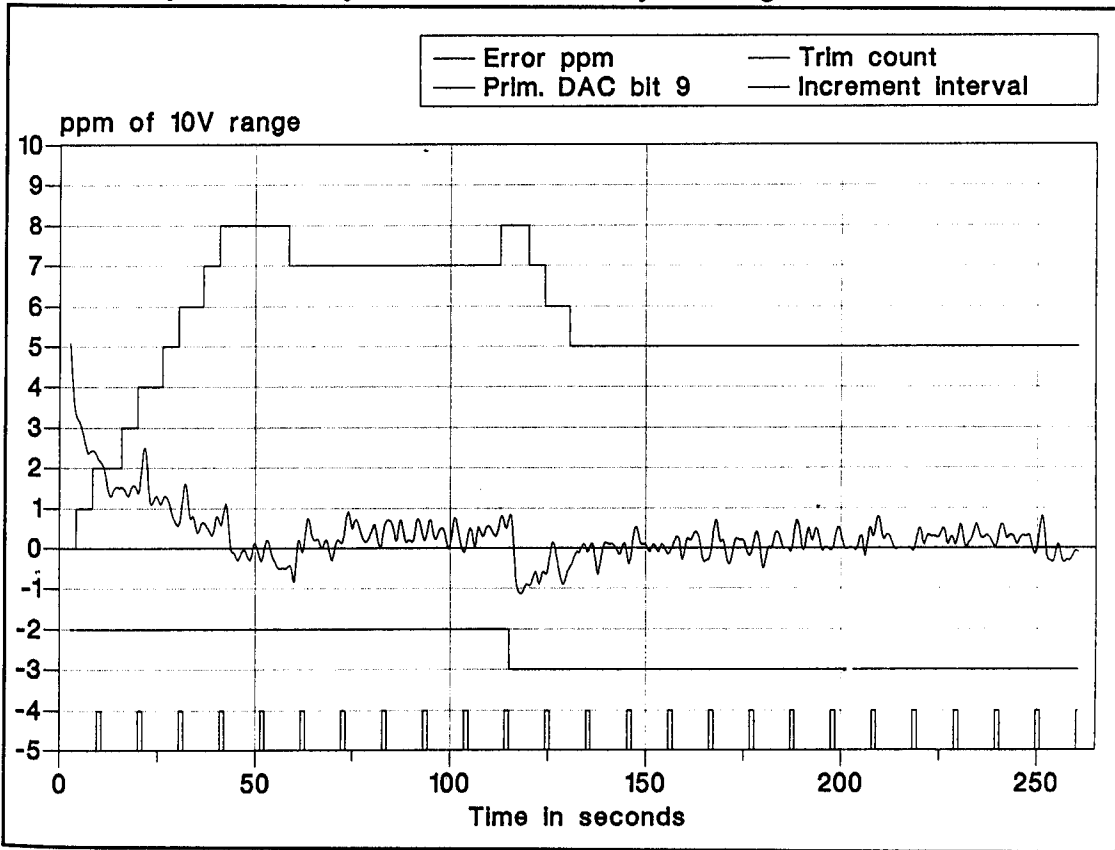


Figure 6.16 - Error in ramped output

The control software was modified to include an additional feature not accessible to the normal user which caused the set-point to be incremented from a given starting value in defined steps every 10 seconds. Figure 6.16 shows the error in the voltage read by the precision ADC and the trim value in counts. The initial set-point was chosen as 3.398665 volts so that the trim had time to settle before the primary DAC was changed; and the step size was 0.000005 V or 0.5 ppm of full scale output. Whenever the mean of the readings obtained from the precision ADC in the preceding 4 seconds is outside  $\pm 0.5$  ppm the trim value is altered by 1 in the direction appropriate to reduce the error. During the first 40 seconds the trim value is increased at a regular rate until the error is less than  $\pm 0.5$  ppm and then there are no further changes until time=115 s when the primary DAC changes from 22016 to 22528, and the secondary DAC from 16395 to -16377. The value predicted for the secondary DAC is not quite correct and a change in the trim value is required. This change is -

3 counts in 22 bits, which moves the error by about 0.5 ppm. The graph shows clearly that for these level changes, the drive output can track changes in the set-point as small as 0.5 ppm even when the secondary DAC experiences a major transition, but there is no reason to suppose that it will not function in a similar way for all levels. The behaviour of both drives is similar but the levels at which major changes of the secondary DACs occur are different, because of differences in components, and particularly offset voltages.

### 6.3 X-Ray interferometer fringes

All of the previous performance measures showed the drives to perform as desired, and within design requirements, but the greatest test was to use both drives together to control the position of a silicon monolith on an X-Ray interferometer. The slave PC and the drives are regarded as a subsystem by the host computer, which sends messages via a serial link to define the required operating voltages and hence currents. This host computer runs a commercial program that treats the two coils as 'linked-drives' and the operator can specify offset and gain factors for each of the drives to compensate for differences such as the strength of the permanent magnets, coil geometries and absolute or relative positioning. Once this has been done the coils may be considered as 'identical' and the user can work with 'equal' steps. A scan then consists of a ramp of equal step increments in sequence, and during each step the following occurs: 1) Alter drives, 2) pause for mechanical settling - typically 1 s, 3) photon count X-rays to get fringe intensity - 1 to 5 s. Overall rates are usually 1-10 seconds per step.

Tests on a large monolith, where the overall sensitivity of the drives was about 100nm/mA, show that contrast can be maintained across at least a  $\pm 4.5 \mu\text{m}$  scan range without adjusting the twist compensation setting. This is excellent evidence of the drive stability and linearity as the two independent drives must be tracking to a very high degree.

The graphs in Figure 6.17 to Figure 6.20 show the fringe pattern under a number of different operating conditions. In each case one fringe corresponds to the  $\langle 111 \rangle$  Si lattice parameter, 0.316..nm. The inference from these graphs (and others not presented) is that the drives provide stable control for scan speeds as low as 0.3nm/hour for a stiff monolith, and 1.4nm/hour for a large monolith. Mechanical resonances of the monolith can degrade or even destroy the contrast if the amplitude

approaches that of half the fringe-width. Resonances tend to be in the region of a few hundred hertz, and perhaps as low as 50 Hz for the lowest mode in the biggest monoliths. Figure 6.18 shows a noise spike on the basic fringe shape while traversing in one direction, which is attributed to a temporary loss of contrast induced by excessive external noise, including traffic and construction work. Noise is always present on the fringe pattern as the counting of x-rays follows a Poisson distribution. With 4000 counts per second (cps), a deviation of approximately  $\pm 65$  cps on a 1 s count can be expected. In no respect did the behaviour of the drives limit the performance of the X-Ray interferometer.

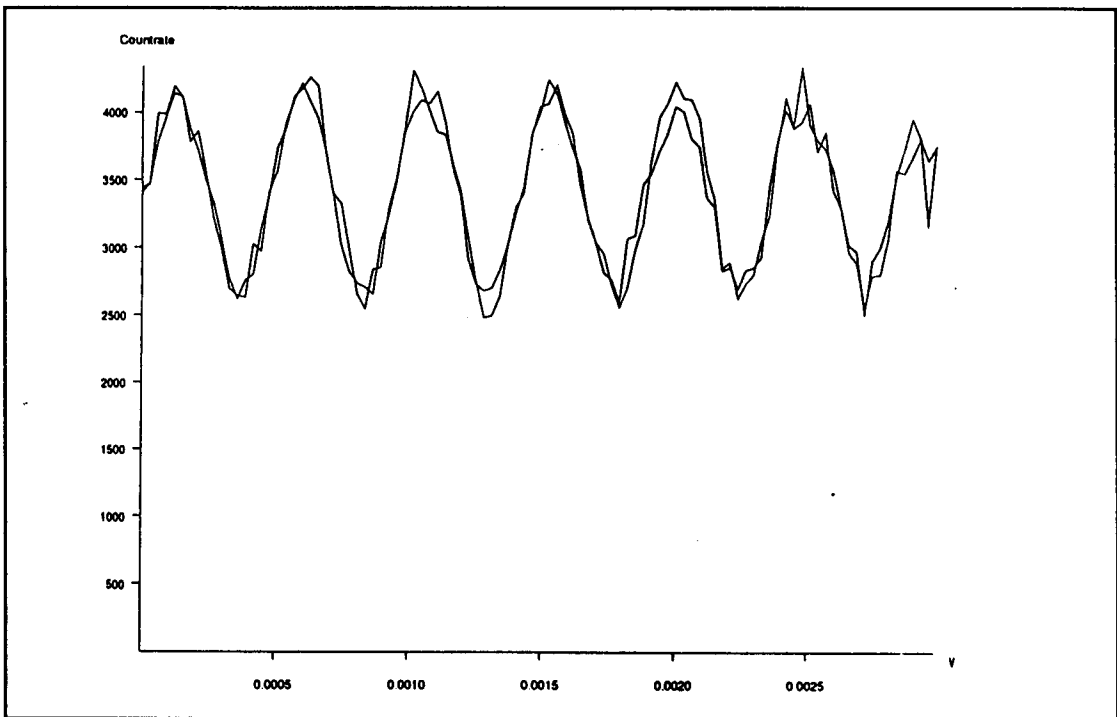
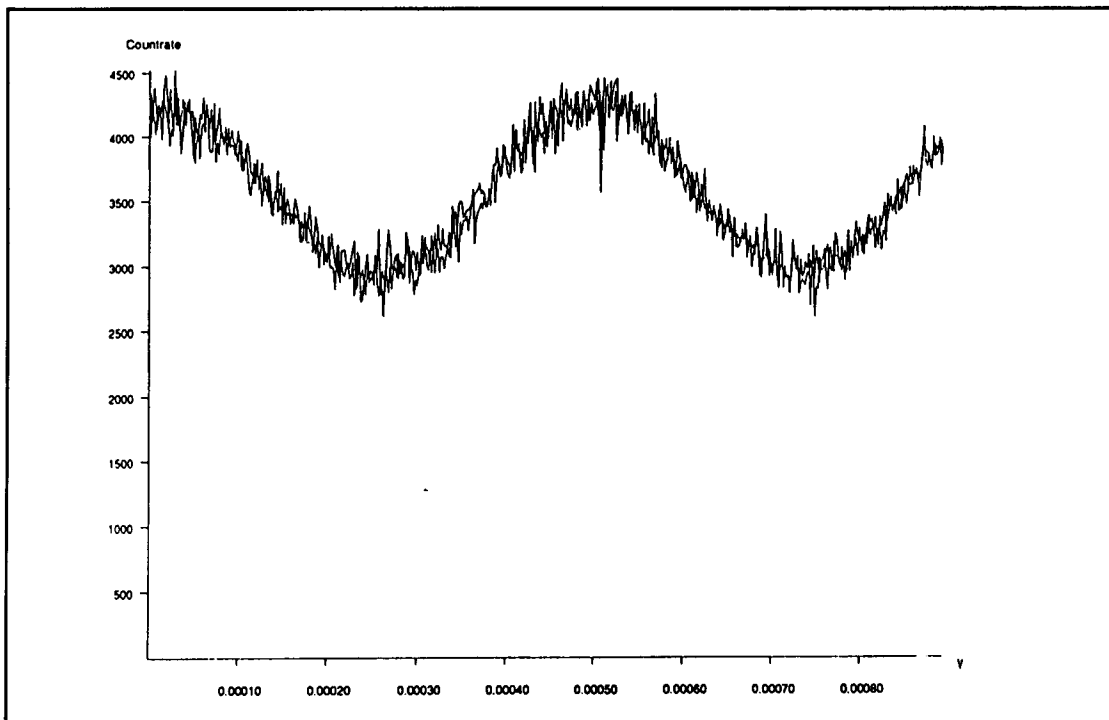


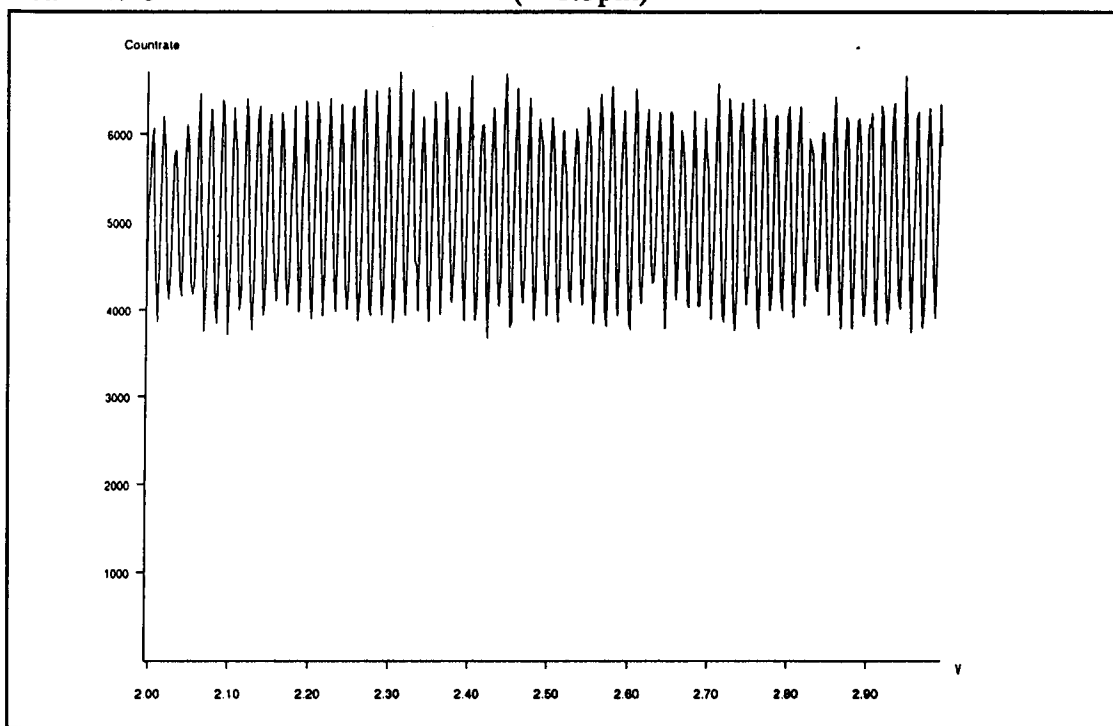
Figure 6.17 - NPL Monolith - 2.1 fringes/mV or 0.67nm/mV - G3

Offset/V	Settling/s	Gate/s	Step size	Comment
Front 4.50	1.0	1.0	30 $\mu$ V	Ramp and return of 100 steps
Rear 4.45			(~20pm)	



**Figure 6.18 - NPL Monolith - 2.1 fringes/mV or 0.67nm/mV - G4**

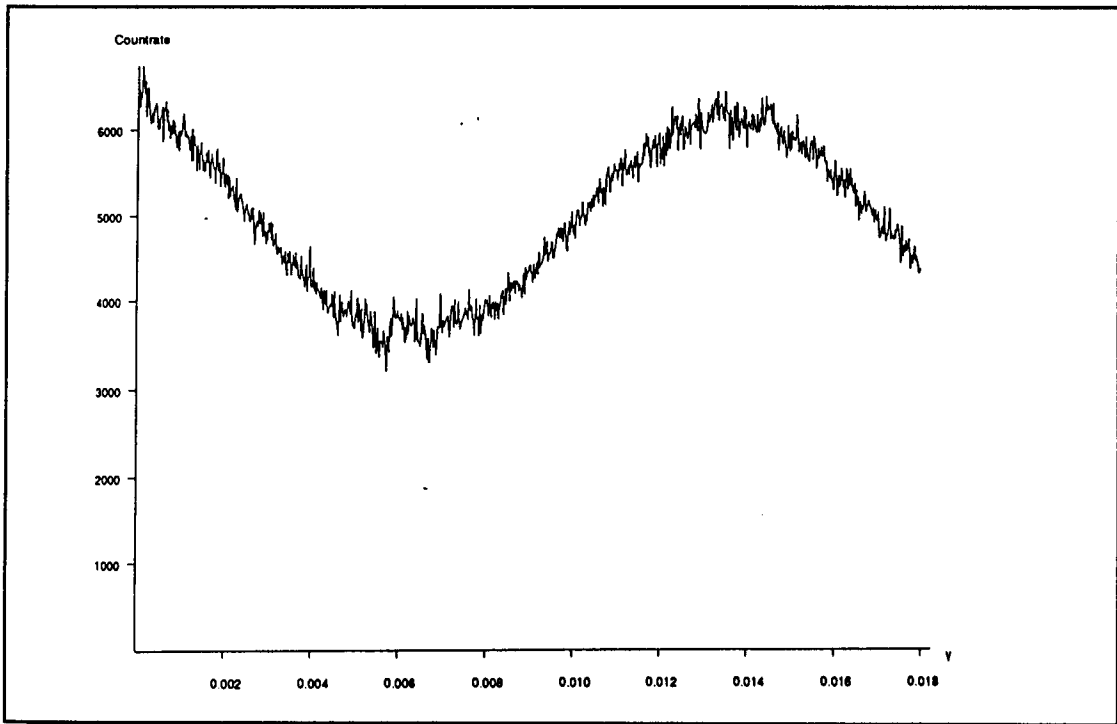
Offset/V	Settling/s	Gate/s	Step size	Comment
Front 4.50	1.0	1.0	2 $\mu$ V	Ramp and return in 30 minutes
Rear 4.45			(~1.5pm)	



**Figure 6.19 - Warwick (stiff) Monolith - 0.067 fringes/mV or 20pm/mV - G5**

Offset/V	Settling/s	Gate/s	Step size	Comment
Front -2.00	5.0	0.5	2mV	Long range of 500 steps
Rear -2.65			(~40pm)	





**Figure 6.20 - Warwick (stiff) Monolith - 0.067 fringes/mV or 20pm/mV - G6**

Offset/V	Settling/s	Gate/s	Step size	Comment
Front 2.02	5.0	0.5	2 $\mu$ V	Very slow scan of 900 steps (~0.4pm) in 85 minutes
Rear 0.78				

## **Chapter 7 Alternative approaches and new proposals**

It is an inevitable consequence of the very rapid rate of development in integrated circuit design and technology, that by the time a state-of-the-art system design has been implemented and tested rigorously there will have been changes in the commercially available range of components used to make it. Since the changes usually represent improvements, 'better' components are always available at the end of a project. It would also be of some surprise were not the testing to lead to ideas for alternate ways of using new(er) components. This chapter addresses such developments, and although these occurred at irregular intervals over the time of the project, they are presented below in groups for the purpose of discussion. The intention is to highlight ways in which the existing design may be modified and/or extended, to produce a more effective implementation (in terms of eg. cost, precision and speed), and thereby increase the number of areas of application. Comments should be judged with regard to the components available when the design was committed (frozen) in January 1993.

The discussion is also motivated by the fact that the precision ADC module and the high-stability DAC, both made by Analogue Devices, were classified in 1993 as obsolete parts and no longer available. This is surprising because they were so good, but must be a reflection on the fact that there was, or is, insufficient commercial interest in such components for them to be profitable. No other DACs have been found which are as stable, nor ADC modules with integral non-linearity at 1 ppm.

### **7.1 Availability of improved components**

It has been the case for many years that the complexity of digital integrated circuits doubles every few years [7.1]. For analogue integrated circuits the complexity does not necessarily increase in this way but the performance characteristics continue to improve steadily. Some developments are not relevant to the present work, such as high power and high frequency devices, but several developments are worthy of further discussion.

#### **7.1.1 Voltage references at 1 ppm/°C**

Precision voltage references which have drifts below 1 ppm/°C have been available

since about 1982 [7.2] but have usually been in the form of temperature controlled/compensated modules, often with significant power dissipation. During the present work a general design strategy was to select components with minimal power dissipation and use forced cooling to maintain the temperature of devices near to ambient conditions. For this reason the most appropriate voltage reference was the AD586LQ [3.5] which dissipated only 30 mW but with a potentially excessive drift of 5 ppm/°C . This was not actually critical because the use of an ADC with a stability of 1 ppm/°C, and a closed-loop servo-control algorithm, compensated for its (AD586) drift. However, if all the components involved with the generation of a reference voltage have negligible drift it would be possible to eliminate the need for an embedded ADC, since an external precision voltmeter could then be used during infrequent (re)calibration cycles. As of March 1995 Maxim Electronics offers a voltage reference in integrated circuit form which incorporates a proprietary method of temperature compensation to achieve a stability of < 1 ppm/°C [7.3]. Although not pin-compatible with the AD586, the circuit may easily be modified to accommodate the changes. The overall design would become less sensitive to local temperature changes and the forced air cooling may not be needed.

### 7.1.2 Delta-Sigma ADCs

The precision ADC module type AD1175K cost about £800 (1992) and has a resolution of 1 part in about 4700000, or 22-bits, with integral non-linearity of less than 1 ppm. Unfortunately it is no longer available, but cheap low-power integrated ADCs using delta-sigma modulation techniques are becoming much more accurate and may soon achieve a performance similar to the AD1175K but at a fraction of the cost. The CS5504-BP by Crystal Semiconductor Corporation [7.4] offers two differential inputs, self-calibration and 20-bit resolution with no missing codes, in a 20 pin dual-in-line package for £15 (1995). This provides monotonic performance but unfortunately integral non-linearity is (only) 0.0007% FSO. The noise and drift performance do not match the 20-bit resolution, but the device may be used to achieve 17-bit linearity which is still excellent for some applications. It seems likely that as processing improvements are made this kind of ADC will have reduced linearity errors. If this is so, the close-loop design considered here could become very cost-effective.

### 7.1.3 Linear operational amplifiers with low drift

Chopper-stabilised amplifiers offer very low drift with temperature and time but suffer from excessive noise when compared with other amplifiers. In particular there is usually significant noise at the internal chopping frequency. For most amplifiers this occurs between 250 and 450 Hz, and is undesirable because noise in this region may well cause resonances in associated mechanical components. The amplifier by Texas Instruments type TLC2654A currently used is unique in that its chopping frequency is at 10 kHz; but it requires external capacitors, supplies of  $\pm 8$  volts, and the external clock used to synchronise several devices must switch between the negative supply  $V_{DD-}$ , and  $V_{DD-} + 5$  V.

It is much easier to design with non chopper-stabilised amplifiers but the drift of offset voltage with temperature, and limited gain, are usually severe limitations. However, Burr-Brown have introduced the OPA177E [7.5], which has some performance figures usually associated with chopper-stabilised amplifiers. Unfortunately its input bias current is still large when compared with FET input amplifiers and may limit its application. However FET amplifiers often have larger drifts with temperature, the OPA627 [7.6] being a notable exception. Both amplifiers may be appropriate for future designs, see Figure 7.1.

Parameter	Value(s)
<b>OPA177E</b>	
Voltage offset	4 $\mu$ V (typ) 10 $\mu$ V (max) at 25°C
Voltage offset drift	0.03 $\mu$ V/°C (typ), 0.1 $\mu$ V/°C (max)
Open loop gain	134 dB (min)
Input noise voltage	85 nV rms (typ), 1 Hz to 100 Hz
Long term drift	0.2 $\mu$ V/month
Input bias current	0.5 nA (typ)
bias current drift	25 pA/°C (max)
Supply current	1.3 mA at $\pm 15$ V
<b>OPA627BM</b>	
Voltage offset	40 $\mu$ V (typ) 100 $\mu$ V (max) at 25°C
Voltage offset drift	0.4 $\mu$ V/°C (typ), 0.8 $\mu$ V/°C (max)
Open loop gain	112 dB (min)
Input noise voltage	0.6 $\mu$ Vp-p (typ), 0.1 Hz to 10 Hz
Long term drift	not specified
Input bias current	1 pA (typ) 5 pA (max) at 25°C
bias current drift	doubles every 10°C
Supply current	$\pm 7$ mA at $\pm 15$ V

Figure 7.1 - OPA177E and OPA627BM specifications

#### 7.1.4 Buffer amplifiers

The use of the TLC2654A, with supplies limited to  $\pm 8$  V, in the voltage-to-current converter meant that the output power amplifier had to provide voltage, as well as current, gain. See circuit diagram 5 in Annex [1]. This precluded the use of many buffer amplifiers which have a voltage gain of 1. If a design were based on the OPA177E discussed above with its increased output voltage swing, buffer amplifiers such as the BUF634 [7.7] could be used. This particular device, also by Burr-Brown, is available in a TO220 package, which is significantly smaller than the TO3 package used by the OPA654M [3.6]. The saving in PCB area is considerable and leads to reduced costs. The reduction in package size may result in increased local heating, and therefore voltage offsets, but this is of little consequence as it still lies within an analogue servo-loop whose performance is dominated by that of the OPA177E.

#### 7.2 Use of an external voltmeter

If the programmable current source has to be a self-contained embedded system then the present design demands a local precision ADC. However with the introduction of a 'slave' computer the possibility exists for communication with an external precision d.c. voltmeter via a suitable digital interface. Obviously the introduction of a computer violates the idea of self-contained sources, but this may not be of much import in some applications. For example the Schlumberger voltmeter type 7081 [7.8] has a resolution better than 1 part in  $10^7$ , linearity of  $<0.2$  ppm of full scale, and a temperature coefficient of less than  $0.3$  ppm/ $^{\circ}\text{C}$ , as well as IEEE488 and RS232 interfaces. This makes it ideally suitable for measuring the voltage across the precision reference resistor, although at £5000 (1993) it is more expensive than the cost of all other components. However using newer and smaller components, it seems possible to build 2 or 4 programmable current sources on one PCB in a single chassis, and multiplex the sensing terminals of the precision resistors to the external voltmeter. The cost of the voltmeter is therefore shared across a number of programmable sources and may be cost-effective. The proposed arrangement is shown in Figure 7.2a). It is essential for the analogue multiplexer to have negligible leakage currents on unselected channels and for the cross-talk between channels for be lower than  $-120$  dB, if overall performance is to reach 1 ppm, and a number of multiplexers exist which are suitable for this purpose. Another requirement is to include unity gain buffer amplifiers on the PCB to isolate the precision resistors from the effects of capacitive loading in the cable connected to the voltmeter.

In order to achieve closed-loop control of several multiplexed drives it will be necessary to change the select code at a regular rate. It is a characteristic of all analogue multiplexers that small charges are injected at the selected input, as the select code changes. These charges may be of the order of pico-coulombs every 0.1 seconds, and may disrupt the current in the coil in a significant way. To alleviate this problem additional capacitive decoupling may be included as shown in Figure 7.2b). The additional components will introduce undesirable parasitic thermo-electric effects but the differential characteristics remain unchanged. Unfortunately even a charge injection as low as 5 pC, and a capacitor of 0.1  $\mu\text{F}$ , will give a voltage change of 50  $\mu\text{V}$ , which on a range of 5 volts represents 10 ppm. Consequently it may be necessary to buffer each connection to the reference resistors before multiplexing, as shown in Figure 7.2c). The low impedance output of each buffer amplifier will be able to supply current to compensate for the effects of transitory charge injection, but the input impedance must be high enough not to load the reference resistors unduly. Since the analogue multiplexer is unlikely to be ideal and has an internal resistance between a selected input and the output, it is still necessary to include a buffer amplifier at its output so that negligible current flows across it, and there are no parasitic voltage drops. If the internal resistance is independent of temperature and absolute voltage level it may be possible to compensate for parasitic losses but this is improbable.

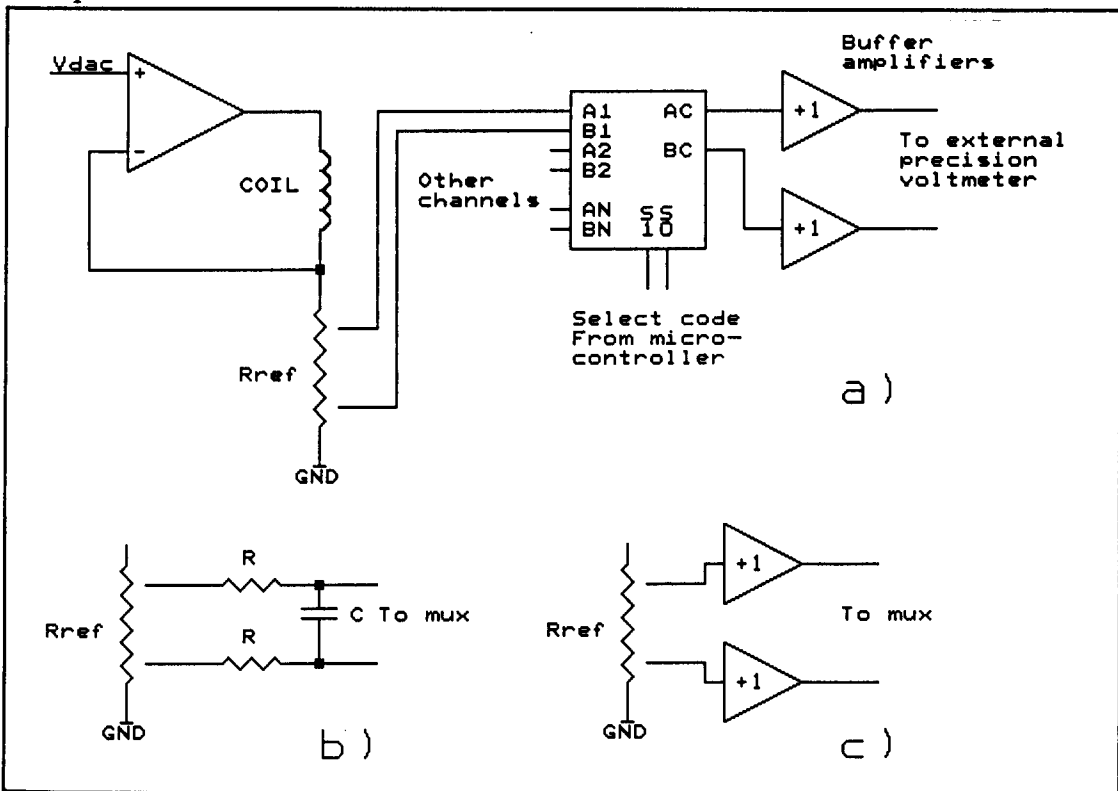


Figure 7.2 - Use of external voltmeter

Another aspect to the use of an external voltmeter is to consider a system where the performance of a multiple-output current source is so stable and predictable that a voltmeter is needed only for infrequent calibration cycles. For example if recalibration is needed only once every few days and takes two hours, the meter may be used for other measurements most of the time. It is therefore worth considering designs which may not exhibit excellent linearity but are very stable.

### 7.3 Application of switch capacitor building blocks

A novel integrated circuit type LTC1043, is available from Linear Technology, and is described as a "Dual precision instrumentation switched-capacitor building block" [7.9]. It consists of a number of analogue switches which act together to connect a capacitor alternately between different pairs of pins under the control of an internal or external clock. Proprietary circuits to compensate for charge injection are incorporated, and suggested circuits indicate that some signal processing may be performed to within  $\pm 1$  ppm. A number of useful applications for this device have been identified and are presented below.

#### 7.3.1 For voltage halving and inversion

Digital-to-analogue converters invariably create a unipolar output which must be biased by half-range to produce a bipolar output. This is usually done with matched on-chip resistors connected to a summing amplifier and the reference voltage. However it may be preferable to bias the amplifiers directly, and this may be done by a combination of voltage halving and voltage inversion. The circuits in Figure 7.3 showing how these functions may be achieved, and were taken from [7.9]

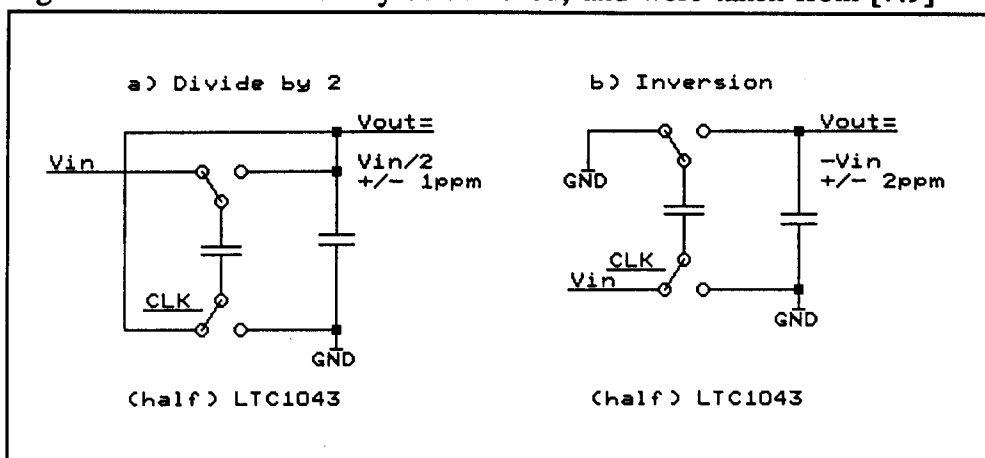


Figure 7.3 - Voltage halving and inversion

The quoted tolerances on the outputs assume they are unloaded and that no currents flow once equilibrium levels have been established. Care should be taken to buffer the outputs if they are to drive other circuits.

### 7.3.2 In voltage-to-current conversion

The end effects of all 2-terminal resistors mean that for precision voltage-sensing applications 4-terminal devices must be used where current forcing pins are separated from voltage-sensing pins. This necessarily elevates the voltage of both pins from ground and creates a differential output. The general arrangement of using part of an LTC1043 to convert a differential voltage to a single-ended signal with respect to ground has been copied from the manufacturers data sheet and is shown in Figure 7.4a). Applying this technique to create a precision voltage-to-current converter is shown in Figure 7.4b), where the differential voltage across the sensing terminals of a precision resistor is reference to ground and used to provide negative feedback around a very high gain power amplifier. Assuming the input current of the amplifier is negligible, the voltage across R will be zero, and equilibrium will be achieved when, for all practical purposes,  $V_h = V_{dac}$ . Since  $V_h =$  voltage across sensing pins of  $R_{ref}$ , and the coil and  $R_{ref}$  are in series, the current in the coil is proportional to  $V_{dac}$ . C reduces the high frequency response and provides closed-loop stability.

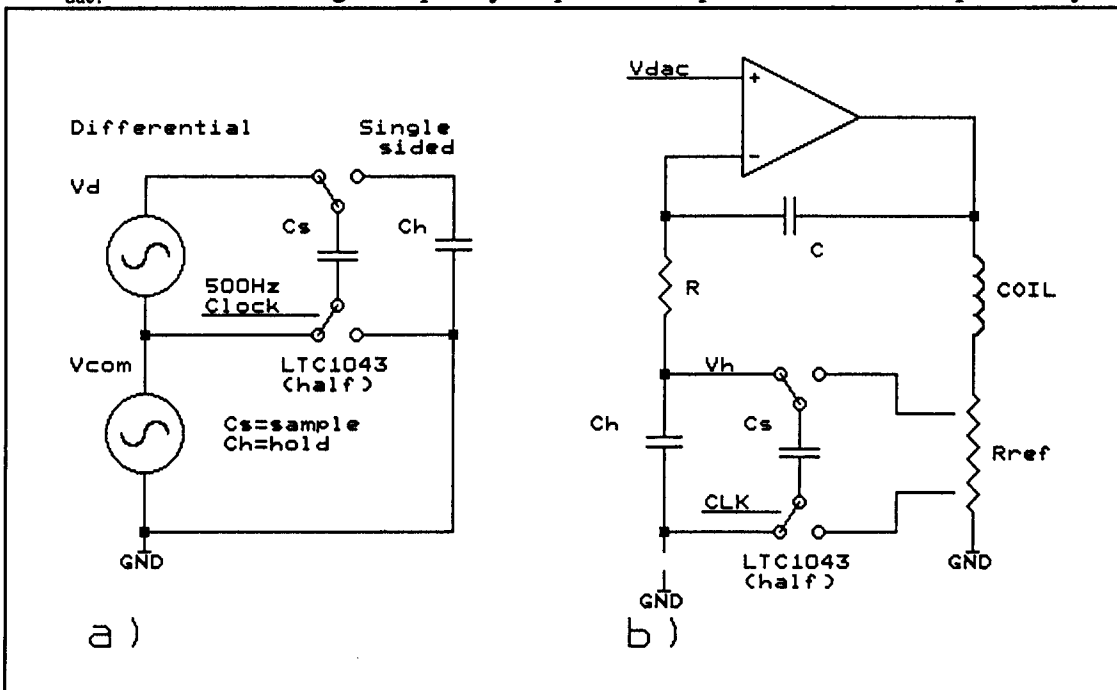


Figure 7.4 - Differential to single-ended conversion

If the gain of the power amplifier is large enough, as should be the case using a combination of the OPA177E and BUF634, it may be possible to show that the



voltage-to-current converter subsystem tracks  $V_{dac}$  voltage so well that measurement, or calibration, of this alone is enough to characterise the changes of current in the coil with respect to DAC levels. This is of benefit in two respects, firstly, the measurement is made outside the voltage-to-current servo-loop and therefore cannot interfere with its operation, and secondly the DAC voltage is single-ended, and easier to multiplex than the differential voltage across the sensing pins of  $R_{ref}$ .

Although the LTC1043 incorporates elements to compensate for charge injection, it may still present a dynamic load to  $R_{ref}$  at the beginning of each sampling interval, consequently a decoupling capacitor may be advantageous. It is also beneficial to bias the 'hold' capacitor,  $C_h$ , to create a bipolar output current for a unipolar input voltage. These additions are shown in Figure 7.5, where the LTC1043 has been replaced with 4 single pole switches and the general format has been modified to aid the preparation of a circuit definition ready for simulation by PSPICE [6.2].

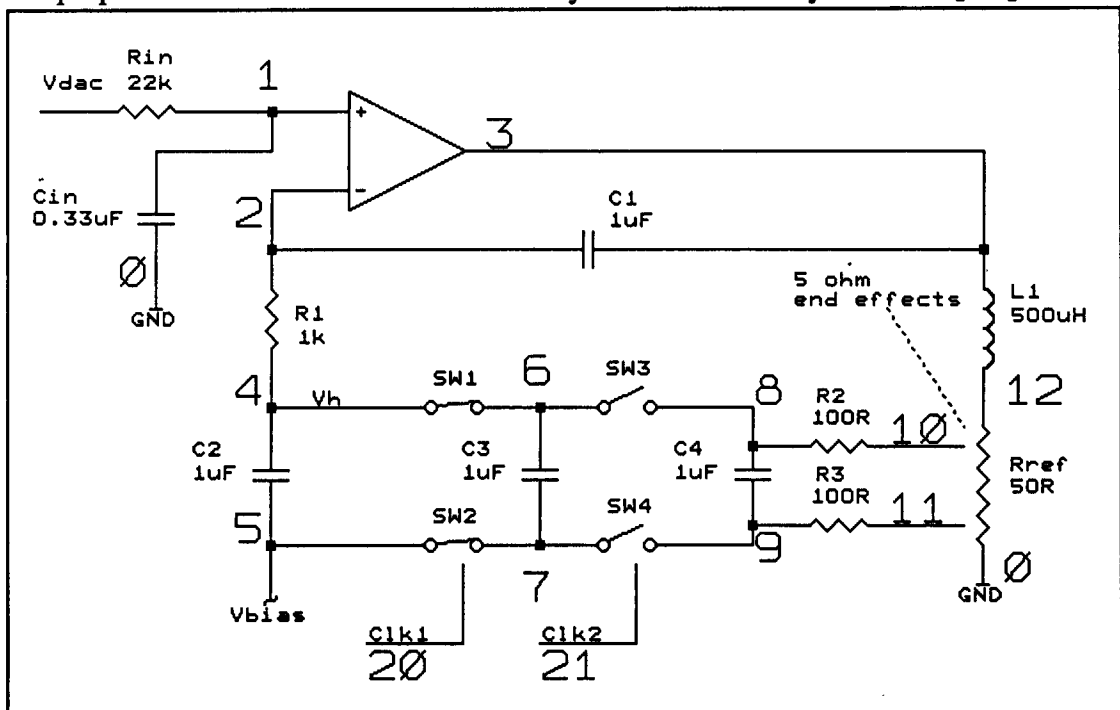
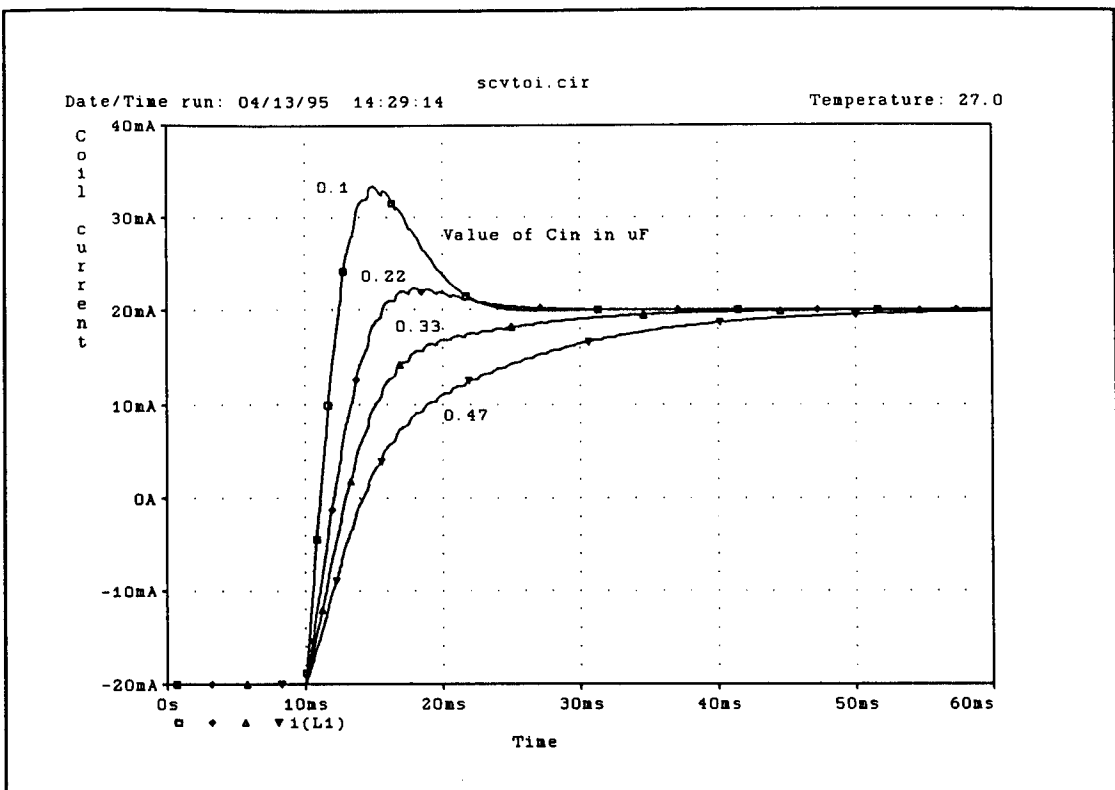


Figure 7.5 - Switched capacitor V-to-I with bias

In order to minimise the effects of charge injection the sample and hold capacitors should be of the order of  $1 \mu\text{F}$ .  $R_2, R_3$  and  $C_4$  should be chosen to provide added decoupling (filtering) but their time-constant must not be so large that a significant phase shift arises around the whole circuit, as this will result in unwanted oscillation.

Using the component values given in Figure 7.5 several simulations were performed, for different values of the input filter capacitor  $C_{in}$ . It is important to limit the rate of rise at the non-inverting input of the amplifier, in order to avoid overshoot in the current through the coil, as this may have adverse effects in a system with mechanical

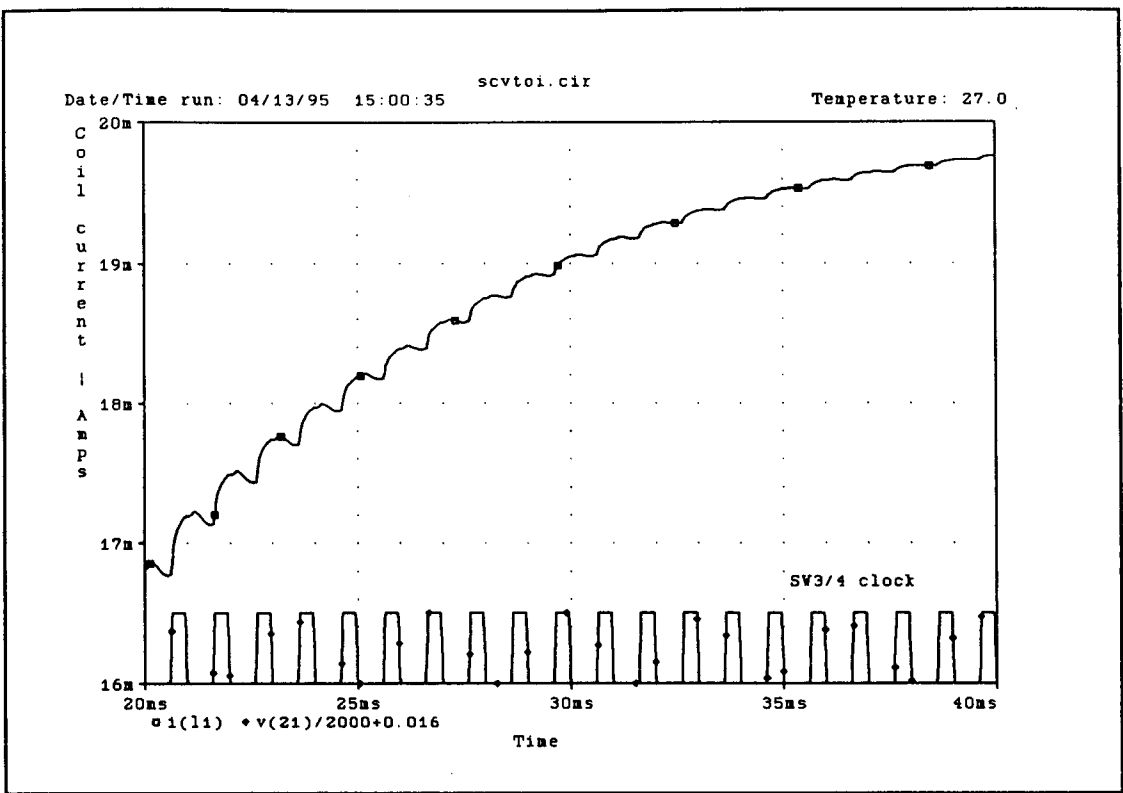


**Figure 7.6 - Response of switched capacitor V-to-I**

hysteresis. The curves in Figure 7.6 show the coil current with respect to time for various values of  $C_{in}$ , when the input voltage changes from 1.5 V to 3.5 V at time =  $t_c = 10$  ms. Before  $t_c$  the current is stable at  $(1.5-2.5)/R_{ref} = -1/50 = -20$  mA and thereafter it rises to +20 mA. Study of the simulation source-file called *SCVTOI* at the end of Annex [5] shows how non-overlapping clocks at 1 kHz were created for the switches, and how bias conditions were defined to give bipolar current output.

That part of the response from 20 ms to 40 ms when  $C_{in} = 0.33 \mu\text{F}$  is shown in Figure 7.7, together with a scaled clock to make clear the synchronous nature of the sampling. As time passes the current difference of successive levels is reduced, and, although not shown, equilibrium is achieved when the voltage across the sensing pins of  $R_{ref}$  equals  $(V_{in} - V_{bias}) = 1$  volt, and the current becomes constant at +20 mA.

The simulated performance of a voltage-to-current converter based on a switched capacitor looks promising but further experimental work is needed to establish the exact behaviour of the LTC1043 and the overall dependence on temperature. It is also appropriate to discover if the clocks for multiple LTC1043's in the same system are best synchronised (or left to free-run), bearing in mind that, for a particular mechanical system, there may be a resonant frequency which is the same as that used to clock the switches. In a real design perhaps there should be a way of setting the clock frequency.



**Figure 7.7 - Response of switched capacitor V-to-I**

### 7.3.3 Deglitching and demultiplexing a DAC

A sample and hold circuit is often used to de-glitch the output of a digital-to-analogue converter. The idea is to remove the transient voltage signal, which occurs at the DAC output when the digital control code is changed, by isolating a 'holding' capacitor until the transient subsides. An analogue switch is usually employed but these are prone to charge injection which offsets the level being stored. However the LTC1043 has internal charge compensation circuits, and charge injection is significantly reduced. This suggests it may be used as a deglitching element by synchronising its switching action with changes in the DAC output as shown in Figure 7.8a), where the DAC code is changed only when  $C_s$  is connected to  $C_h$ . Most of the time the DAC level will not change between samples, but there would be no interference with  $C_s$  if the DAC *did* change while  $C_s$  is connected to  $C_h$ . This immediately introduces the idea of time demultiplexing the DAC between two channels, as shown in Figure 7.8b). So long as the time for the glitch is short compared with the sampling time, each  $C_s$  will acquire the correct level by the end of the sampling interval just before it is connected to the corresponding  $C_h$ .

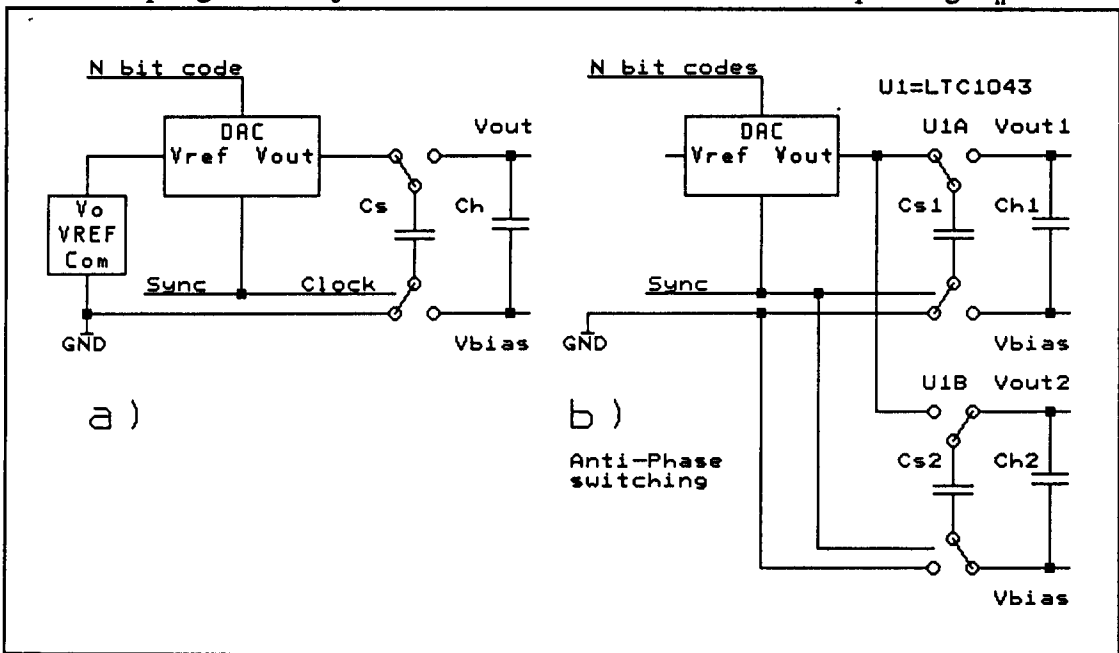
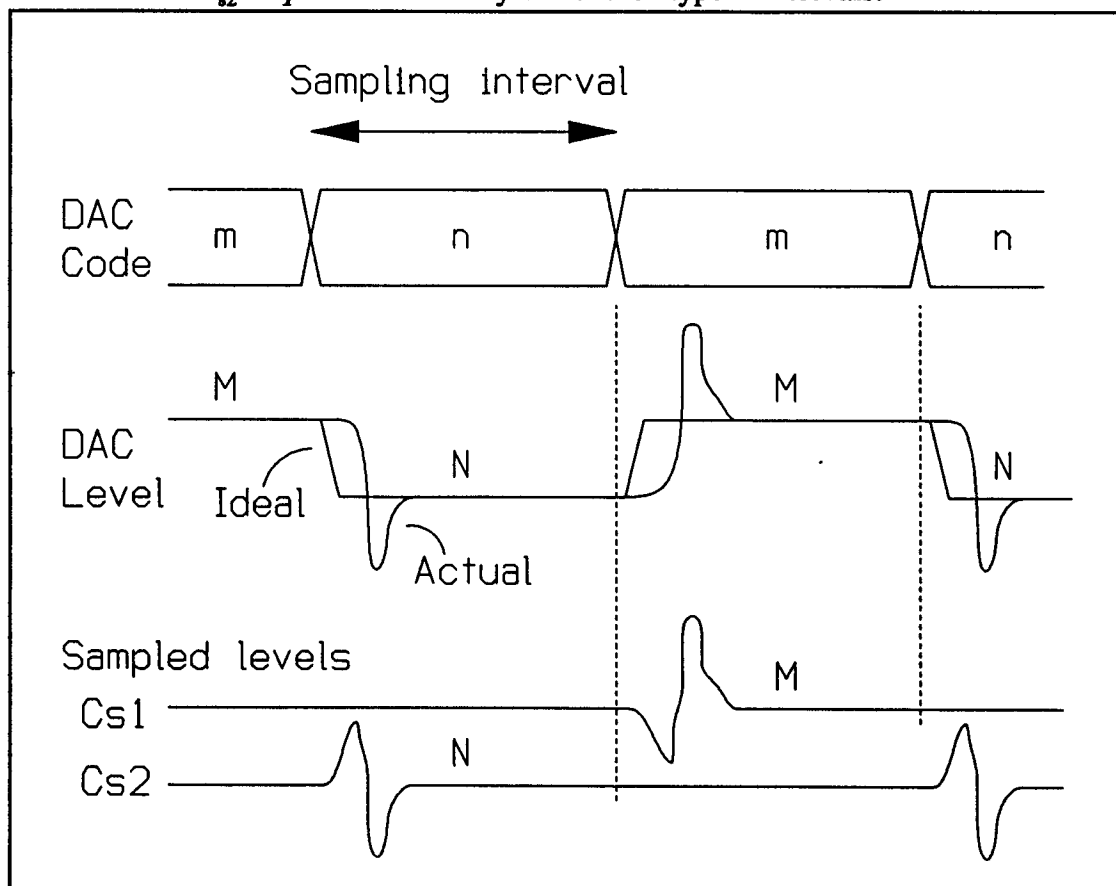


Figure 7.8 - Deglitched and demultiplexing a DAC

The behaviour of Figure 7.8b) is best explained with the aid of the waveforms presented in Figure 7.9. At the beginning of each sampling interval an ideal DAC would respond by a simple linear change from one level to the next after a fixed delay, however a real DAC will output a code-dependent 'glitch' after an additional delay. Suppose DAC code  $m$  produces level  $M$  and is associated with  $C_{s1}$ , and code  $n$  produces level  $N$  and is associated with  $C_{s2}$ . In the case of an interval of type- $m$ ,

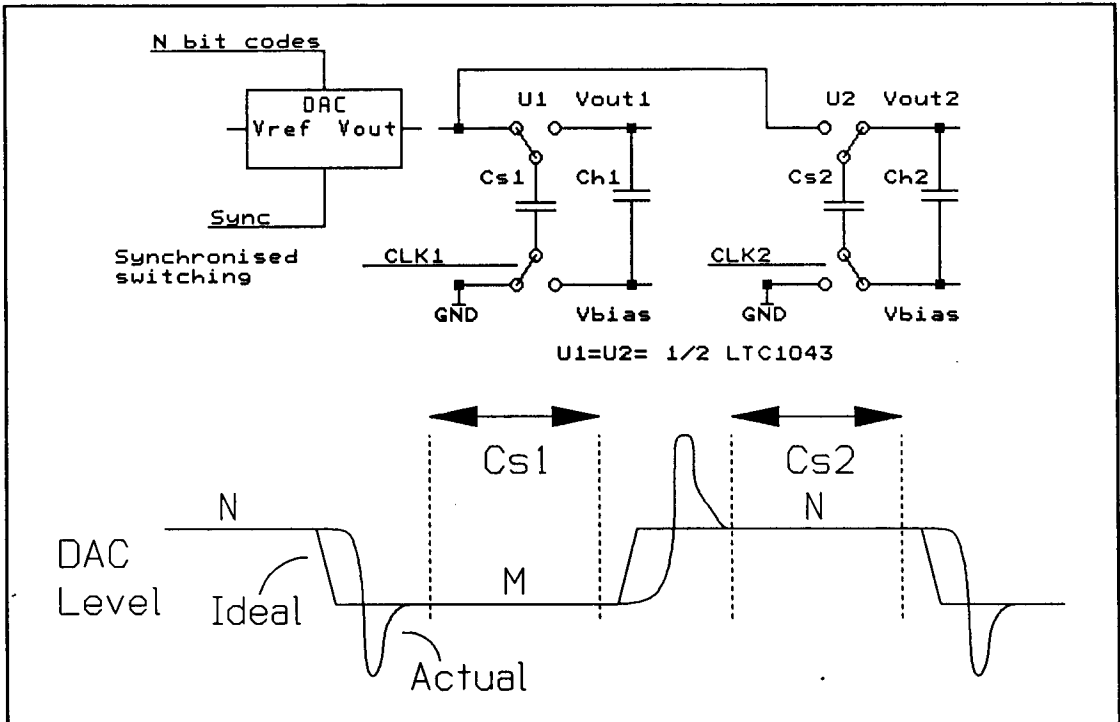
$C_{s1}$  is briefly subject to the previous level  $N$ , then a glitch, before settling to the desired level  $M$ . The value of  $C_{s1}$  has to be chosen after consideration of the internal resistance of the analogue switches in the LTC1043, and the drive capability of the DAC output, such that it will always be able to *acquire* the expected voltage at the end of each interval. Strictly this condition must be satisfied only when the channel is in equilibrium, for when a large change occurs as  $M$  becomes  $M'$ ,  $C_{h1}$  will not follow immediately, and many samples will be necessary before charge redistribution is completed. While the charge on  $C_{h1}$  is in flux the voltage on  $C_{s1}$  need not settle to the expected level by the end of its sampling interval. The behaviour of  $C_{s2}$  and  $C_{h2}$  is similar but  $C_{s2}$  *acquires* level  $N$  by the end of type- $n$  intervals.



**Figure 7.9 - Demultiplexed DAC waveforms**

The LTC1043 contains two sampling circuits that operate in anti-phase and this leads directly to the implementation in Figure 7.8b), but its operation is not optimal because each sampling capacitor still 'sees' the DAC glitch. A better arrangement is shown in Figure 7.10, where two LTC1043's (with only half of each being used) are controlled by independent clocks both synchronised to changes in the DAC output. In this way each  $C_s$  is connected to the DAC output after the glitch has died away. The duty cycle is necessarily no longer 1:1, but need not be as bad as the waveforms suggest, as the duration of each glitch appears exaggerated. Many DAC have a glitch

which lasts for only a few microseconds, and with a nominal sampling time of 0.5ms, the duty cycle need not be far from 1:1. If the DAC includes an amplifier with limited slew rate, it may be this, and not the glitch-time, which limits the time for the DAC to change from level M to level N. In which case the clocks may have a duty cycle of 1:2 or more, and the effect of this remains to be investigated.



**Figure 7.10 - Better demultiplexing**

It is anathema to electronic design engineers for circuits to be incorporated into a design and not be fully utilised, yet this would be the case by using only half of two LTC1043's. Fortunately the other half may be used in the voltage-to-current converter, as simulations show its performance is acceptable even when the duty-cycle of the switched-capacitor is not 1:1.

### 7.3.4 Interpolation in a time demultiplexed DAC

As a further modification to the previous design, the level presented to the sampling capacitor during each of its sampling intervals need not be the same. By including additional filters the pulse level modulated signal thus generated may be averaged to provide interpolation between DAC levels. Further experimental work is needed to establish the scope for this technique and the optimal design of the filters. The extended circuit is shown in Figure 7.11.

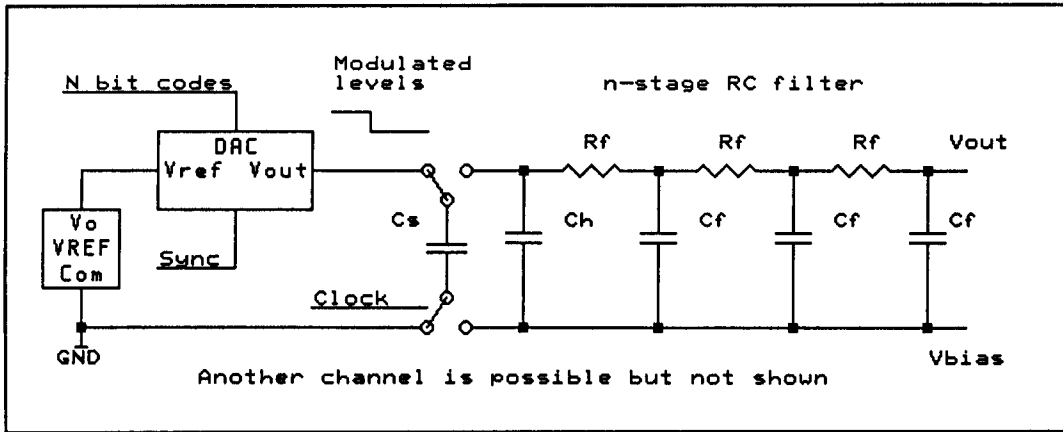


Figure 7.11 - Interpolation in a time demultiplexed DAC

As was discussed in section 2.3.2 the integral non-linearity (INL) of this approach will be limited to the INL of the DAC. But so long as it is monotonic it should be possible to provide an ideal linear scale by calibration using a precision ADC or voltmeter.

#### 7:4 PWM DACs and Field Programmable Gate Arrays (FPGA)

The difficulties of creating a precision pulse-width-modulated DAC using a 20-bit counter were discussed in section 2.3.1. The settling time was considered excessive and the technique dismissed. However it may be practical to produce a 10-bit PWM DAC, with a clock rate of about 1 MHz and corresponding cycle time of  $2^{10} \times 10^{-6} = 1.024$  ms, which requires a low pass filter to remove frequency components of about 1 kHz and above. A settling time of 100 ms is acceptable for many applications and it may be possible to achieve this with a combination of low drift active filters and/or passive RC filters. Although there are only 1024 levels, and such a DAC will still use an analogue switch with associated charge injection, its overall integral non-linearity may be small and approach 1 ppm for each level. This needs to be shown by experimentation but if it can be achieved it may be used as a coarse DAC in a system with coarse and fine DACs. The great advantage is that its performance may be accurately predicted and characterised by measurement of relatively few levels. Combining its output with an 'ordinary' monotonic 16 bit fine DAC in the ratio 1:64 ( $1:2^6$ ) will provide a composite DAC with a resolution of  $16+6 = 22$  bits, as depicted in Figure 7.12. The characteristics of the fine DAC are less critical than those of the PWM DAC, and numerous devices with acceptable specifications are commercially available.

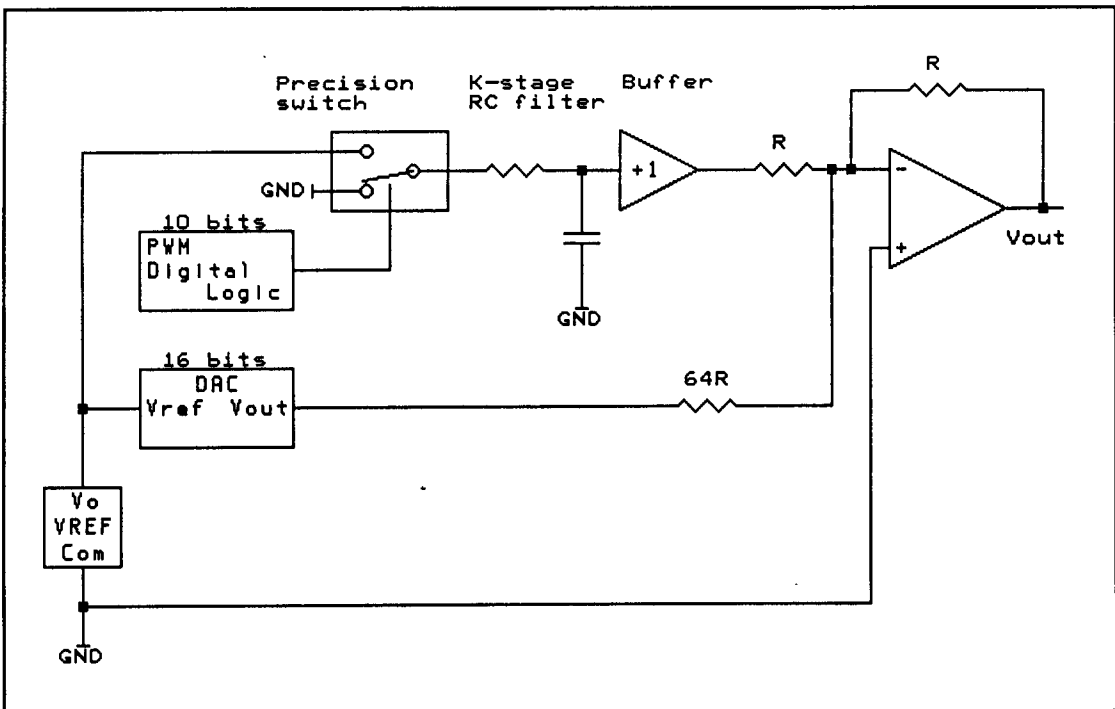


Figure 7.12 - Using a 10-bit PWM DAC as the coarse DAC

In a design with multiple composite converters of this form the number of digital integrated logic circuits 'on the analogue side' conflicts with the principle outlined in 2.1.4. However, Field Programmable Gate Arrays (FPGAs) [7.10,7.11] are readily available which have more than sufficient resources to implement several 10-bit PWM converters. Since all digital logic is confined to one integrated circuit, it may be possible to keep the effects of interference to an acceptably low level. It is also possible to use additional capacity in the FPGA to time-demultiplex the fine DAC.

## 7.5 Suppression of power on/off transients

The current in the coil during power-on, and power-off, conditions was measured and presented in Figure 6.10. Although the power-on transient is acceptably small, the power-off transient is large and unpredictable, and in making proposals for future designs this issue must be addressed. When the mains power is interrupted the behaviour of the power amplifier which drives the coil becomes undefined. The most reliable way to ensure there is no force in the actuator is to use a relay that shorts out the coil, thereby removing all current flow. 'Normally closed' contacts are used, and the relay is not energised unless correct power supply regulation is established. Some care must be taken in the selection of the relay, as it must have a response time of only a few milliseconds, and not subject to 'welding' of its contacts in the event of high transient currents. A miniature mercury-wetted reed-relay is most suitable. The design for a control circuit is shown in Figure 7.13, which is powered from an



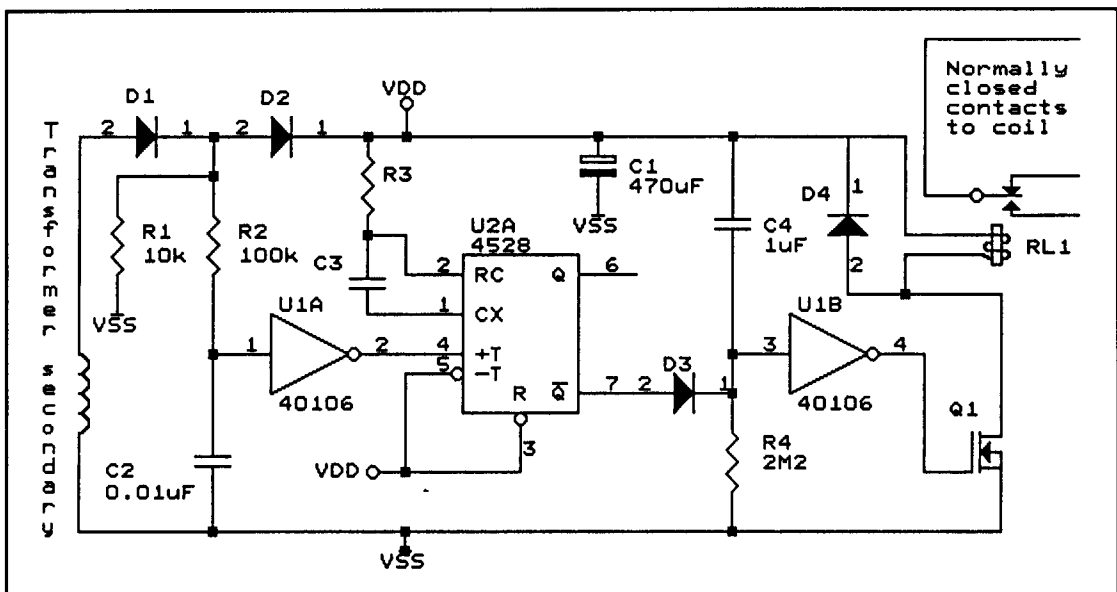


Figure 7.13 - Power on/off protection

independent mains transformer. Its operation is relatively simple but effective; at power-on there is a delay, determined by C4 and R4, before the relay is energised; while during normal operation the retriggerable monostable (U2A), with a time-out of about 0.1 s, detects an excessive number of missing mains half-cycles and causes the relay to de-energise before the power rails fail. There may be multiple sets of relays or contacts for designs with more than one coil.

## 7.6 Proposal for dual drive

Most of the ideas presented in this chapter have been incorporated into a design for a dual programmable source and appear in Figure 7.14. The circuit is more than a block diagram, but less than a complete design, since individual sections within this chapter have already dealt with specific sub-functions in detail. A number of signals and functions are highlighted by a \* character, to indicate they are generated within one FPGA. What is not shown is an embedded microcontroller which accepts serial messages from a controlling computer and defines the operation of the FPGA accordingly. To understand the basic operation it is sufficient to describe the behaviour of one channel, as the other is identical.  $V_{ref}$  is a stable voltage reference for the DAC and the precision switch, both of which are controlled by the FPGA. PS1 is driven by a pulse width modulated signal using a 10-bit counter, while the DAC receives 16-bit code levels which are synchronised to the clock for U1. The PWM logic (running at 1 MHz) and the timing of the DAC (with sampling at 1 kHz) will be synchronised in some way by virtue of the fact that the FPGA has a single master clock frequency of several MHz, and it may be advantageous to ensure the

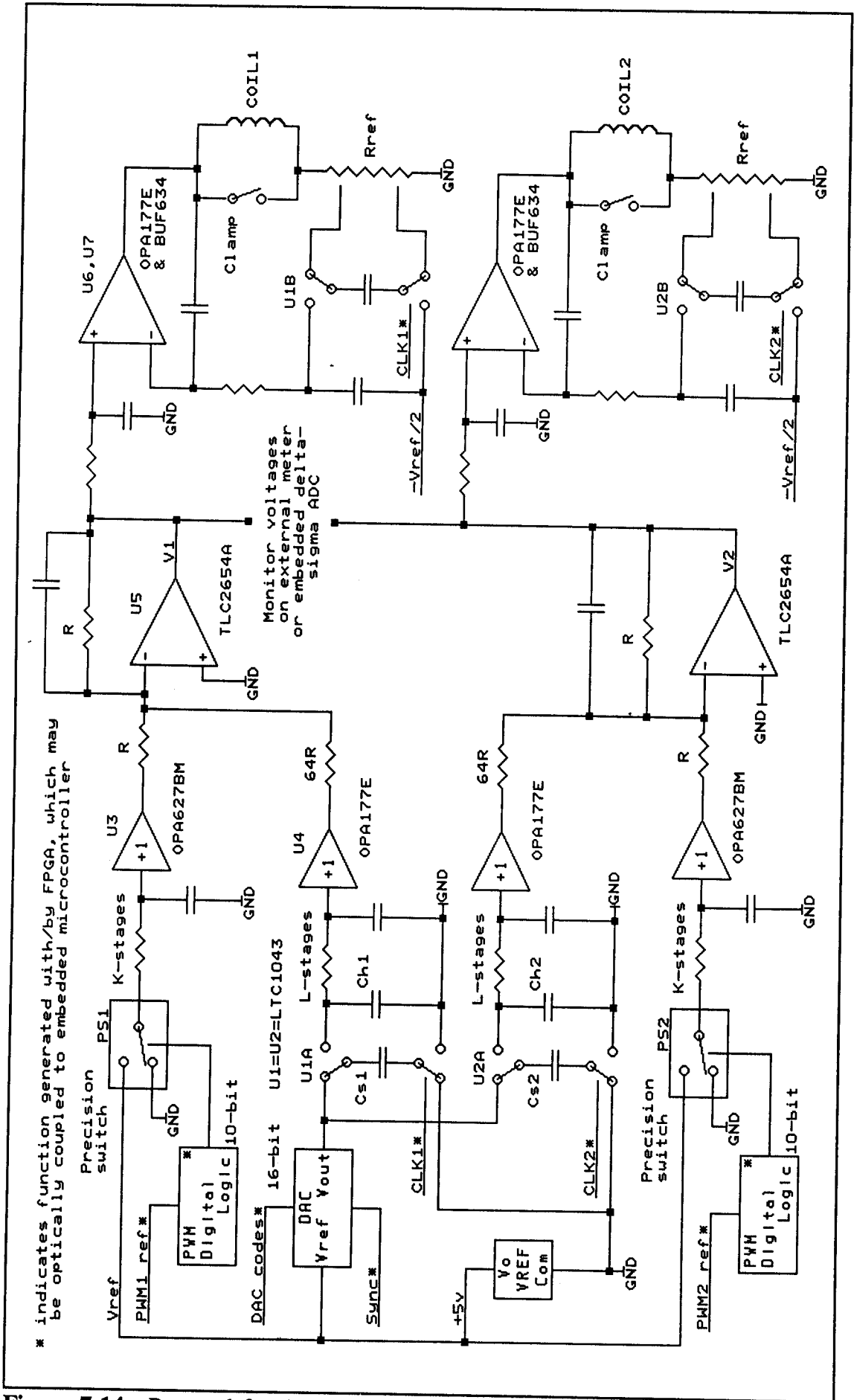


Figure 7.14 - Proposal for dual drive

cycle time for all signals are in a simple ratio. If this is not the case, undesirable 'beat' frequencies may be generated.

The analogue PWM signal from PS1, and the sampled signal from the DAC, are both filtered by multiple RC stages, however these are of different length and do not offer the same attenuation. For the PWM signal the K-stage filter must provide an attenuation of more than 120 dB at the fundamental frequency, so the output is stable to 1 ppm. Assuming a frequency of 1 kHz, 8 stages of 10 k $\Omega$  and 0.1 $\mu$ F will provide sufficient attenuation. The L-stage filter for the DAC output may not even be needed, but a value of L=1,2 is practical. Care must be taken to consider the effects of input bias current for U3 and U4. If U3 were type OPA177E (bipolar) the bias current of 0.5 nA results in an offset of 40  $\mu$ V (for a source impedance of 80 k $\Omega$ ). This, in itself, may not be too serious, as calibration will compensate for the offset, however its bias current changes at a rate of 25 pA/ $^{\circ}$ C (max.) causing a voltage drift of 2 $\mu$ V/ $^{\circ}$ C. U3 is specified as type OPA627BM (FET) because its bias current is only 5 pA, which results in a voltage loss of 0.4  $\mu$ V across the filter resistors, and its voltage drift is only 0.8  $\mu$ V/ $^{\circ}$ C.

The summing amplifier, U5, needs to have low input bias current (<50 pA), low drift (<1  $\mu$ V/ $^{\circ}$ C) and high gain (>120 dB). These requirements are considered best satisfied with a chopper-stabilised amplifier type TLC2654A. In the original design, amplifiers of this type were used throughout, and there was concern that, by having unsynchronised clocks, the output of one amplifier may cause aliasing at the input of the next. Consequently additional circuitry was employed to provide synchronised clocks. In the design now being considered there is only one chopper stabilised amplifier (per channel) and synchronisation is not necessary. The TLC2654A must operate from supplies of no more than  $\pm$ 8 V, whereas driving amplifiers U3 and U4 may operate from  $\pm$ 15 V. However, using  $\pm$ 15 V introduces the possibility of latch-up at the input of U5, and it is therefore considered preferable to operate U3, U4 and U5 all at  $\pm$ 8 V.

The output of the summing amplifier provides the reference for the voltage-to-current converter, but compared with previous discussions and simulations it is negative. Consequently the bias is  $-V_{ref}/2$  and the interpretation of the digital codes for the PWM logic and DAC must be inverted, to restore the expected sense of changes in the coil current. (Although not shown  $-V_{ref}/2$  may be derived from  $V_{ref}$  by halving the inverted value, using circuit elements from Figure 7.3). The combination of an OPA177E with a BUF634 gives an amplifier which is capable of delivering up to

$\pm 50$  mA at 12.5 V, or  $\pm 100$  mA at  $\pm 12$  volts, with other characteristics determined by the OPA177E. The value of  $R_{ref}$  should be chosen such that the maximum required coil current produces a voltage drop of  $V_{ref}/2$  across it. For example, if  $V_{ref}=5$  V and  $I_{max}=50$  mA, the value of  $R_{ref}= 5/2/0.05 = 50\Omega$ . Assuming the end effects of  $R_{ref}$  are small compared with its value the maximum coil resistance is  $(12.5-2.5)/0.05 = 200 \Omega$ . This is larger in value than those that have been tried, but increasing the maximum allowed resistance is beneficial as it allows more turns of finer wire, which will produce a stronger magnetic field.

In chapter 1 some mention was made of the application of multiple actuators to complicated mechanical systems. For a long range X-ray interferometer 2 or possibly 3 drives are beneficial, but it is not impossible to consider systems that could use from 4 to 8 drives. It is therefore of interest to consider the design of a circuit with more than 2 outputs. Of course it is possible merely to replicate the design presented in Figure 7.14, and create a number of dual drives in a single chassis, but this would be wasteful of a FPGA used to create only 2 x 10-bit PWM DACs. However it seems altogether feasible to extend the idea of time demultiplexing the DAC (see Figure 7.10) from 2 to 4 drives, and make better use a FPGA to generate 4 PWM signals. The switched capacitor elements will necessarily have a duty cycle of at least 1:3, but may still operate as required. An adverse consequence of this approach is to lower the sampling rate to about 250 Hz, which may lead to unwanted mechanical resonances if the electrical signals are not filtered properly.

While some of the methods proposed need experimental evaluation to establish their potential for super-precision applications, there is no reason to believe any method is intrinsically unworkable. The methodologies employed for the present drives were appropriate given the constraints of the project for the DTI/NPL, however if progress is to be made towards more general research in precision programmable current sources, quantitative analysis of real circuits based on new proposals is needed. Additional simulations using idealised components will not prove the practicality of the techniques, and it will not be until circuit boards have been fabricated and instrumented that a full understanding of the performance will emerge. All this is left for future work.

## Chapter 8 Final comments and conclusion

Throughout this thesis considerable effort has been made to present ideas in a logical order and in sensible groups. However, certain thoughts would have disrupted the flow, and/or had insufficient background, if they were to be included within certain sub-sections. Consequently these have been left to the end and are now discussed. They should be considered in the further development of programmable drives or systems that use them. Thereafter is a final section which concludes the work.

### 8.1 Settling time of DACs

In the present design the coarse and fine DACs are of the same type and each has a settling time of  $6 \mu\text{s}$  to  $\pm 0.5 \text{ LSB}$ , which is very short compared with the time constant of the filter at the input of the voltage-to-current converter. Since the embedded software always changes both DACs simultaneously their weighted output also settles in a similar time. This is especially significant when a small overall change is required but the fine DAC is already at full scale. In this situation the coarse and fine DACs must both change, and it is desirable for the transition to the new level to occur smoothly. If the coarse DAC takes a long time to settle compared with that for the fine DAC the net output will not be a smooth transition.

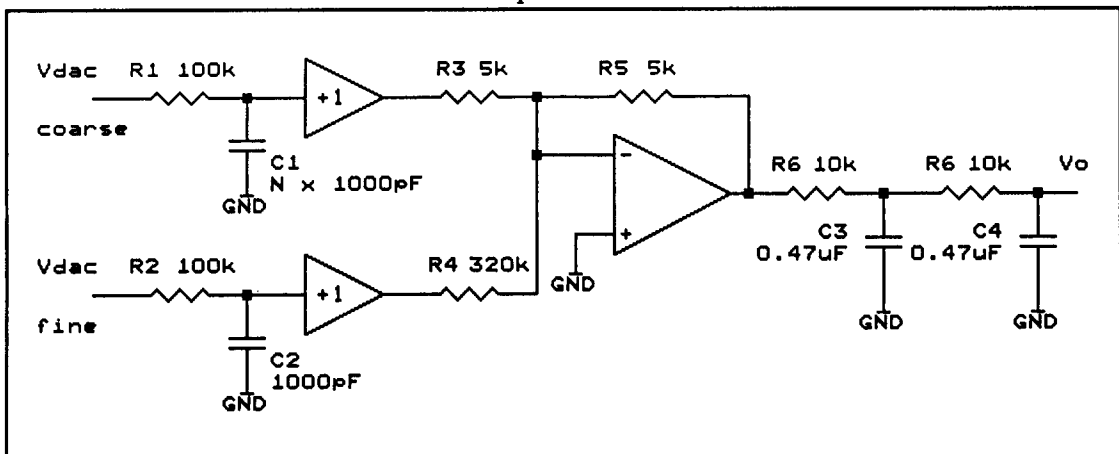


Figure 8.1 - Circuit depicting DACs with different time constants

Consider the circuit in Figure 8.1 which represents an idealised model of the present circuit as taken from diagram 4 in Annex [1]. It shows two voltage inputs from ideal coarse and fine DACs driving single stage RC networks. A simple RC network (with a nominal time constant of  $10 \mu\text{s}$ ) may be inappropriate for a real DAC but is acceptable for the purpose of discussion. The filtered outputs are buffered and summed in the ratio 1:1/64 and then filtered again. The output  $V_o$  is used to drive the voltage-to-current converter.

The simulated response is shown in Figure 8.2 when the time constant for the coarse DAC is 0.5, 1, 2 and 5 times that of the fine DAC. At time=5 ms the coarse and fine DACs change from -0.95 to -1.05, and -3.2 to +3.1968 volts respectively, which causes a net increase of 50  $\mu$ V to the initial level of 1 volt. For  $N > 1$  there is change in the wrong direction, and, when  $N=5$ , a pulse whose amplitude is many times the desired step change. This is clearly undesirable but altogether likely for the composite DAC proposed in Figure 7.12, where the coarse DAC level is derived from a filtered PWM signal. Consequently future design(er)s should include components which balance the response time of DACs. Alternatively the fine DAC may be made to pass through a number of sub-levels which compensate for any delayed response of the coarse DAC, in such a way that the output pulse is reduced or removed.

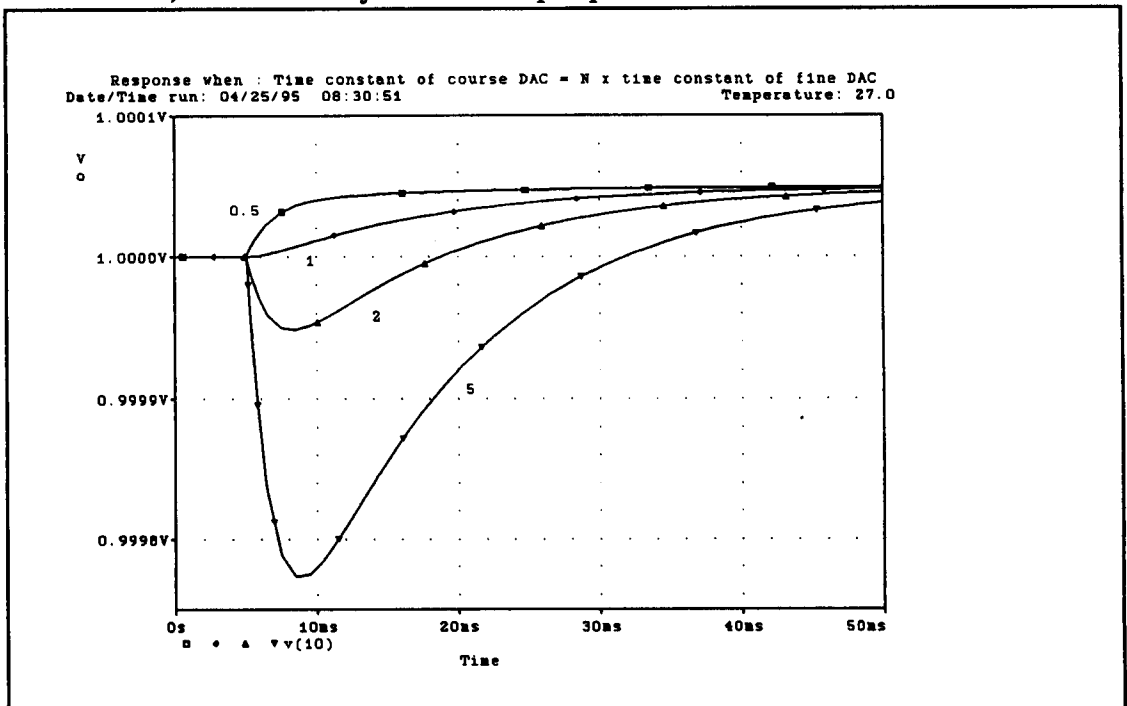


Figure 8.2 - Responses when DACs have different time constants

## 8.2 Additional auxiliary circuits

Several components are included in the current circuit which are not strictly needed during normal operation, but provide additional confidence that all is working well. For example, the auxiliary ADC channel which monitors the voltage level of the main power amplifier, and the sensor which monitors the temperature of the exhaust air. These are of trivial cost when compared with other components and their inclusion was certainly worthwhile. However, if the project were repeated, additional circuits should be included to provide even more knowledge about the performance. Three such examples are:-

- a) It is very difficult to measure the noise current in the coil because it is so small, and external amplifiers are subject to unwanted interference. Consequently an a.c. coupled differential amplifier with a gain of about 1000 should be placed across the connections to the coil. A typical circuit appears in Figure 8.3. The output provides a signal of the order of milli-volts that can be taken to an oscilloscope or spectrum analyzer. The simple high-pass RC network has a -3dB point at 0.3 Hz, which is well below the resonant frequency of typical mechanical mechanisms. The response is almost flat above 1 Hz and hence all frequencies of interest will be passed through with negligible attenuation.

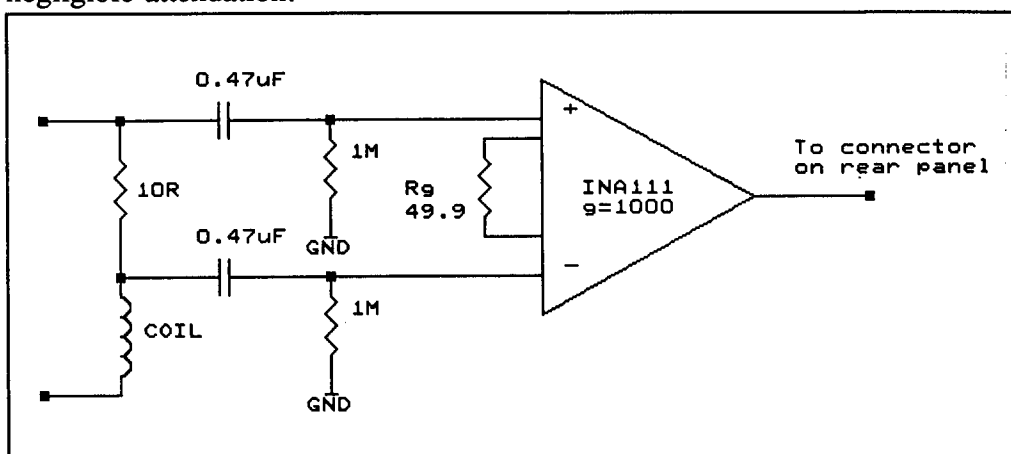


Figure 8.3 - Embedded diagnostic amplifier

- b) Circuit diagram 6 in Annex [1] shows that two of the inputs to the analogue multiplexer connected to the auxiliary ADC are not used and are tied to ground. This represents an inefficient use of resources and the inputs should be brought to a connector on the rear panel so the user can have the benefit of reading two external voltage levels. Care should be taken not to compromise the isolated analogue ground signal.
- c) In the same vein as b) some of the digital inputs associated with U22 are unused and may be of more general use if brought to a connector on the rear panel. Care should be taken not to introduce unwanted earth loops and/or noise.

Of course there comes a point where additional circuits may represent a significant cost and this should be considered, but the suggestions above are inexpensive and easy to implement.

### 8.3 Commercial considerations

Much has been said already about the alternative methods and/or improvements that can be made to the present design, but from some points of view these comments represent a rather narrow perspective of the possibilities, for they do not take into account potential modifications to the systems as a whole. If the x-ray interferometer, as developed for the DTI, is looked at from a commercial position a number of other thoughts for the future emerge.

The DTI project was essentially a 'one off' exercise, and involved little consideration for the sale of duplicate systems. The dominant cost was for the development of technology that exceeded existing capabilities; all of which was carried out on one unit. Hence its cost was high when compared with a possible production unit, but the methods of construction can be justified as they allowed the instrument to meet the specifications on time and within budget. The market for such precision instruments is small and there is little practical need to plan for vast sales. However, refinements may be made to the electronic control sub-system and these are worthy of discussion, since the precision current sources may be used on other systems which have the potential for commercial use in greater numbers in metrology laboratories.

The x-ray interferometer contains a number of expensive components, such as the x-ray source, detector, camera etc., all of which are interfaced to a controlling computer running commercially written software [8.1]. This software expected a remote programmable subsystem to respond to simple message packets, sent out via a serial port, and cause movement of the monolith. When a computer was included within the subsystem it was natural to describe the controlling computer as the *host* and the subsystem computer as the *slave*. However, no provision was made for anything other than the communication of set-point values from the host to the slave computers, using a proprietary software handshake mechanism. In particular no facility was provided for the host computer to 'learn' about the status of the subsystem circuits, and it was necessary to include a display for the slave computer. This display gave a great deal of diagnostic information which was useful during the development of the drives and was certainly cost effective for the DTI project but can be rendered unnecessary by modifications to the software in the host and slave. Using extended data exchange mechanisms will allow all data currently presented on the slave's screen to be presented at the host's screen upon request, as it is needed only infrequently. In order to remove the slave PC entirely it is necessary to embed the servo control algorithm within each drive, and there is sufficient capability for this



to be done using the floating point interpreter which has been written. Unfortunately the removal of the slave PC means that two serial ports are needed on the host for communication to each drive, as inferred from Figure 8.4a) which shows the present arrangement. This may be inconvenient for systems that require one port for other facilities, as a total of two ports is the usual maximum on many desk-top computers. Fortunately there are two ways around this problem. The first is to connect the drives in a 'daisy' chain and for extended messages to contain an address identifier so they may be relayed to the correct drive as depicted in Figure 8.4b). The second requires that the host computer and drives have hardware for multi-drop communications such as either RS485, or IEEE488, as shown in Figure 8.4c). The first arrangement is preferable because it is easy to preserve the isolation between different drives. Although RS485 tri-state drivers may be optically isolated the communications strategy is more complicated. The IEEE488 communications protocol, with some 16 signal lines, does not lend itself to isolation, and earth loops may be formed between the drives. The most effective arrangement is shown in Figure 8.4d) where a single RS232 communications channel connects the host to a multiple drive, which contains a common power supply, and microcontroller to support a number (say 2 or 4) programmable current sources.

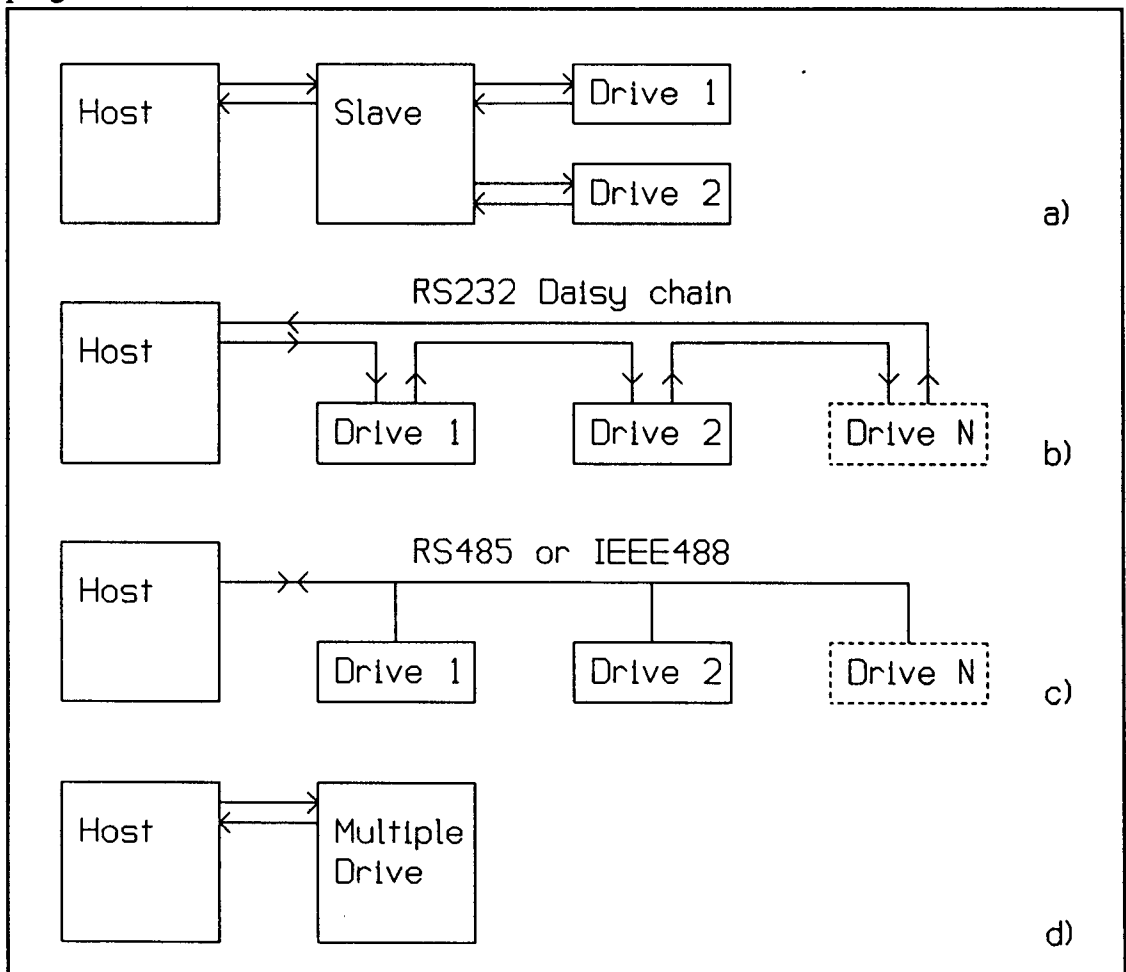


Figure 8.4 - Alternative communication schemes

## 8.4 Conclusion

The need to design a super-precision programmable current source to meet the needs of a long range x-ray interferometer was established in chapter 1, as was the fact that such a device has other applications in metrological environments. The chapters that followed presented a methodical development of ideas from initial concepts and constraints, to implementation and testing. Extensive use was made of computer aided design and simulation software and there are numerous suggestions for further work. Taken together they show that a programmable current source may be build with all performance parameters measured in parts per million. As a project it was deemed entirely successful for the immediate application. The exceptional stability and linearity of the current source(s) is over 100 times better than commercial systems and provides opportunities for new levels of control for current-driven devices.

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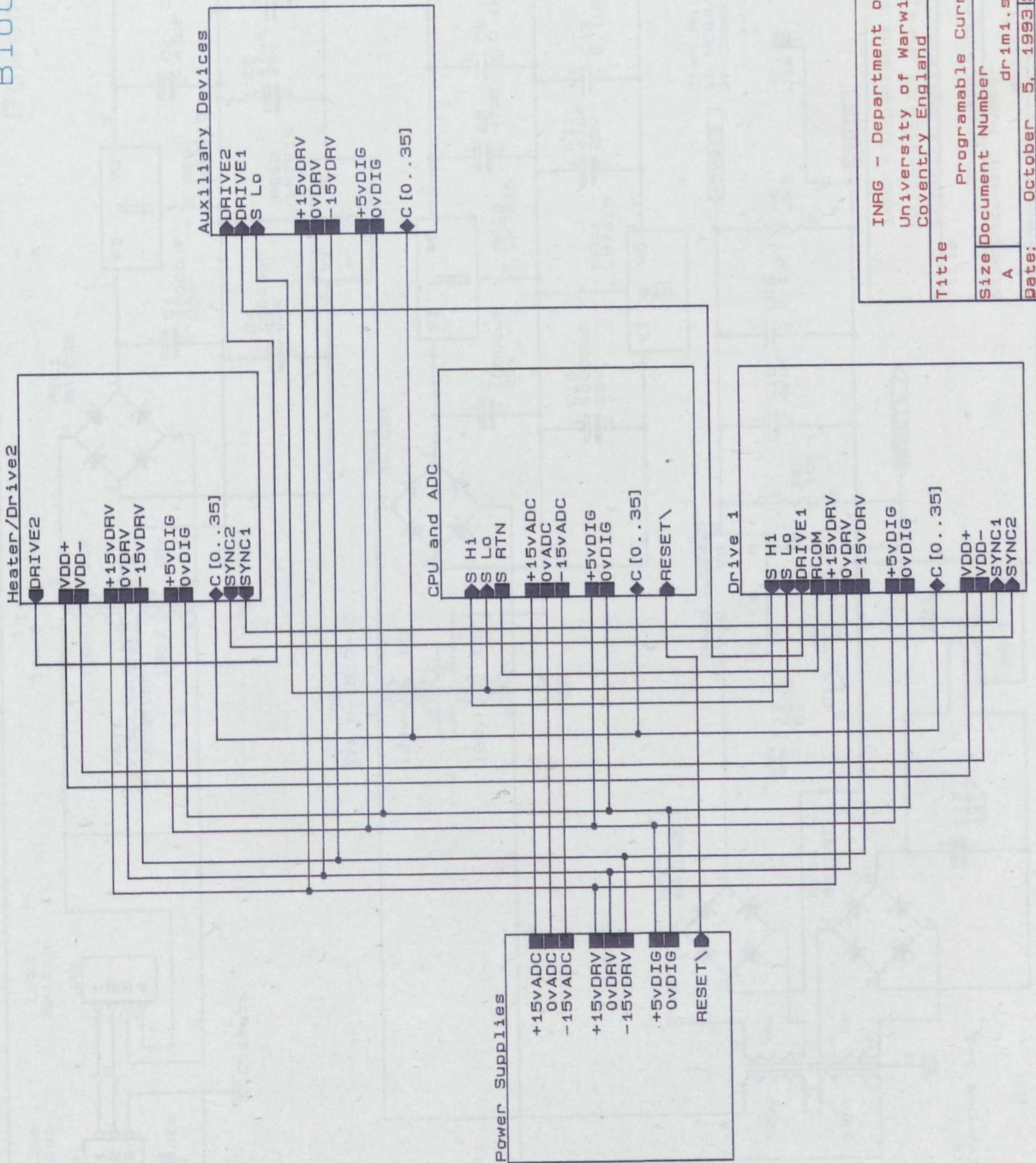
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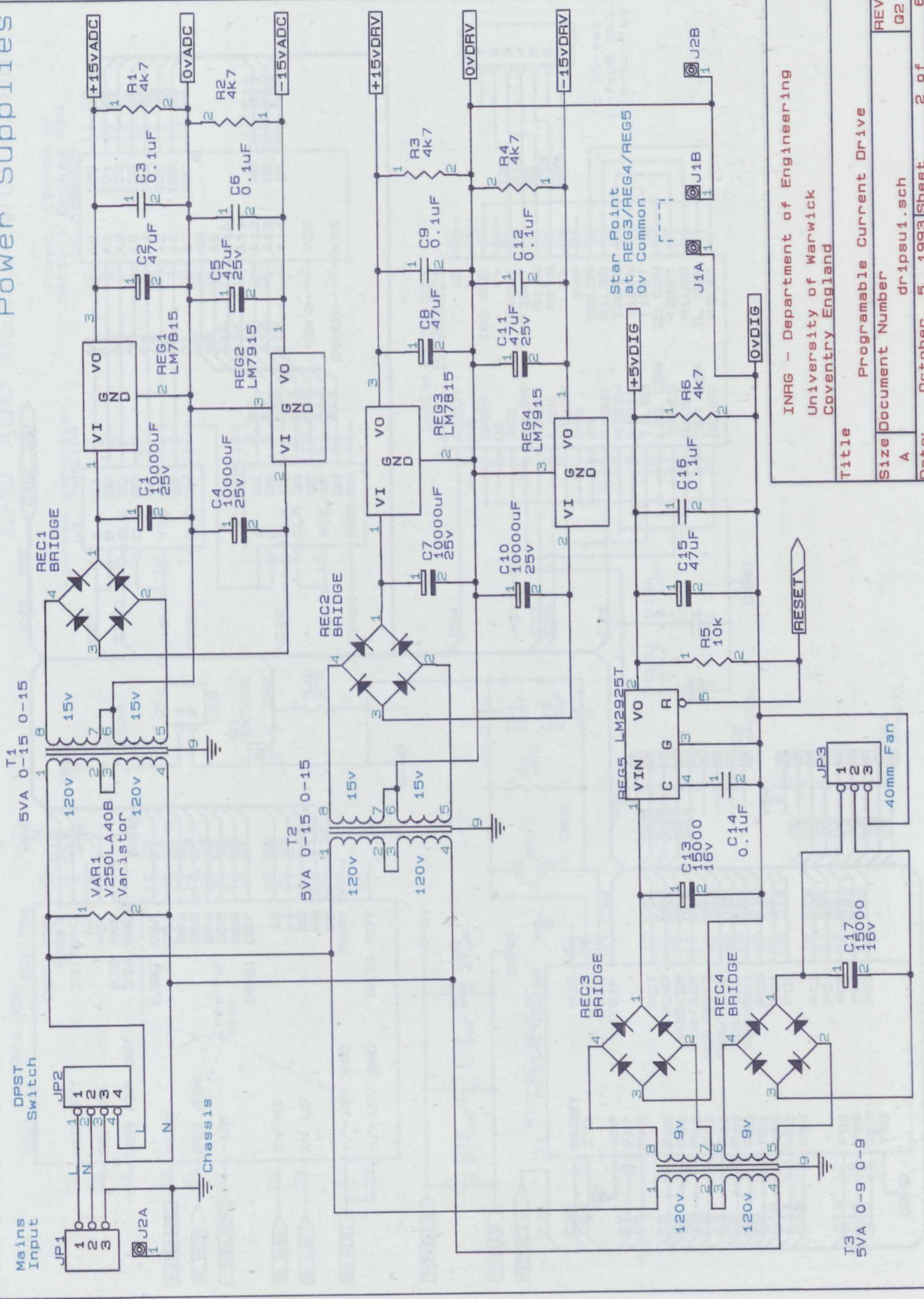
# Block Diagram



INRG - Department of Engineering  
 University of Warwick  
 Coventry England

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Date:	October 5, 1993	Sheet 1 of 6

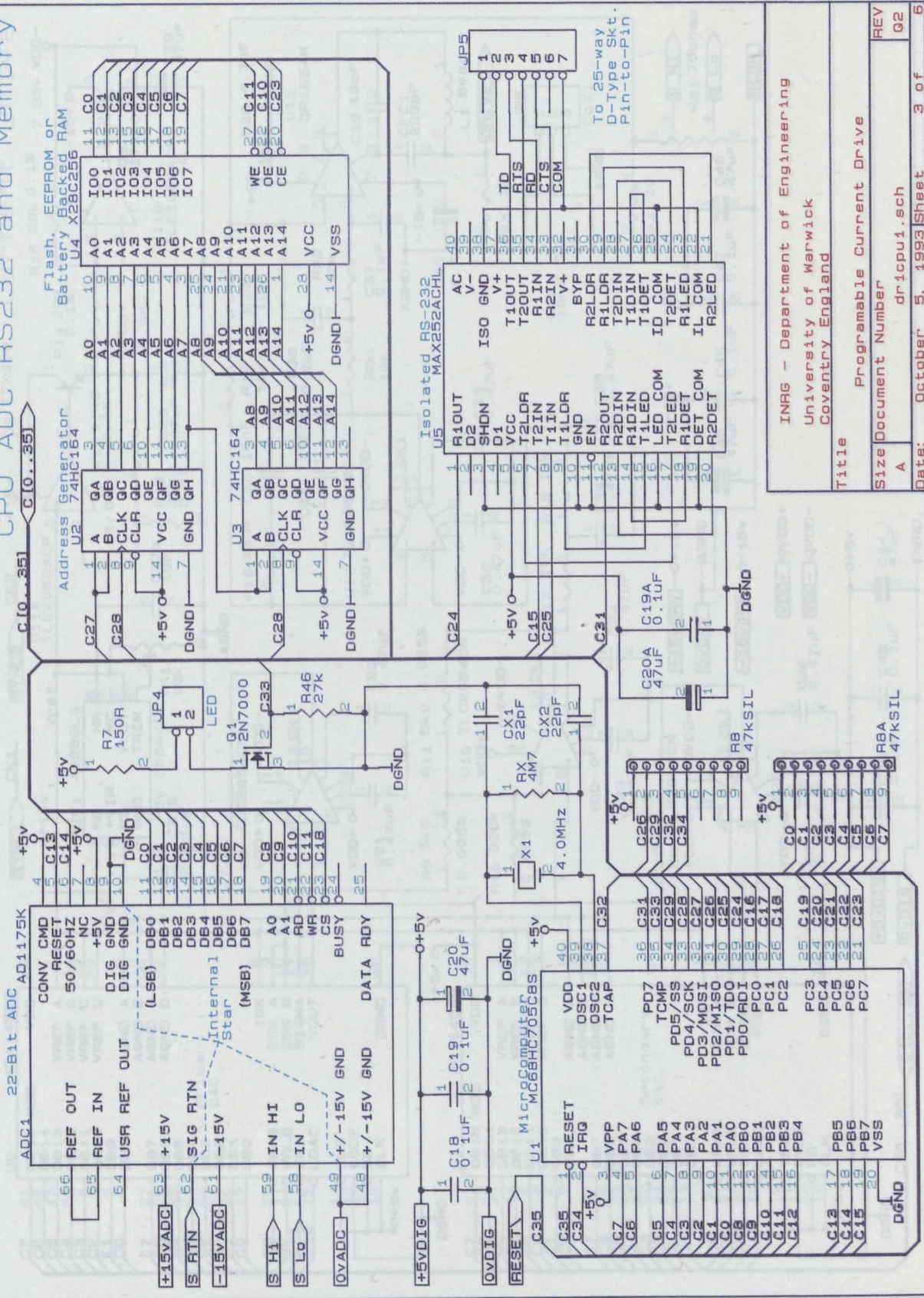
# Power Supplies



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 University of Warwick  
 Coventry, England

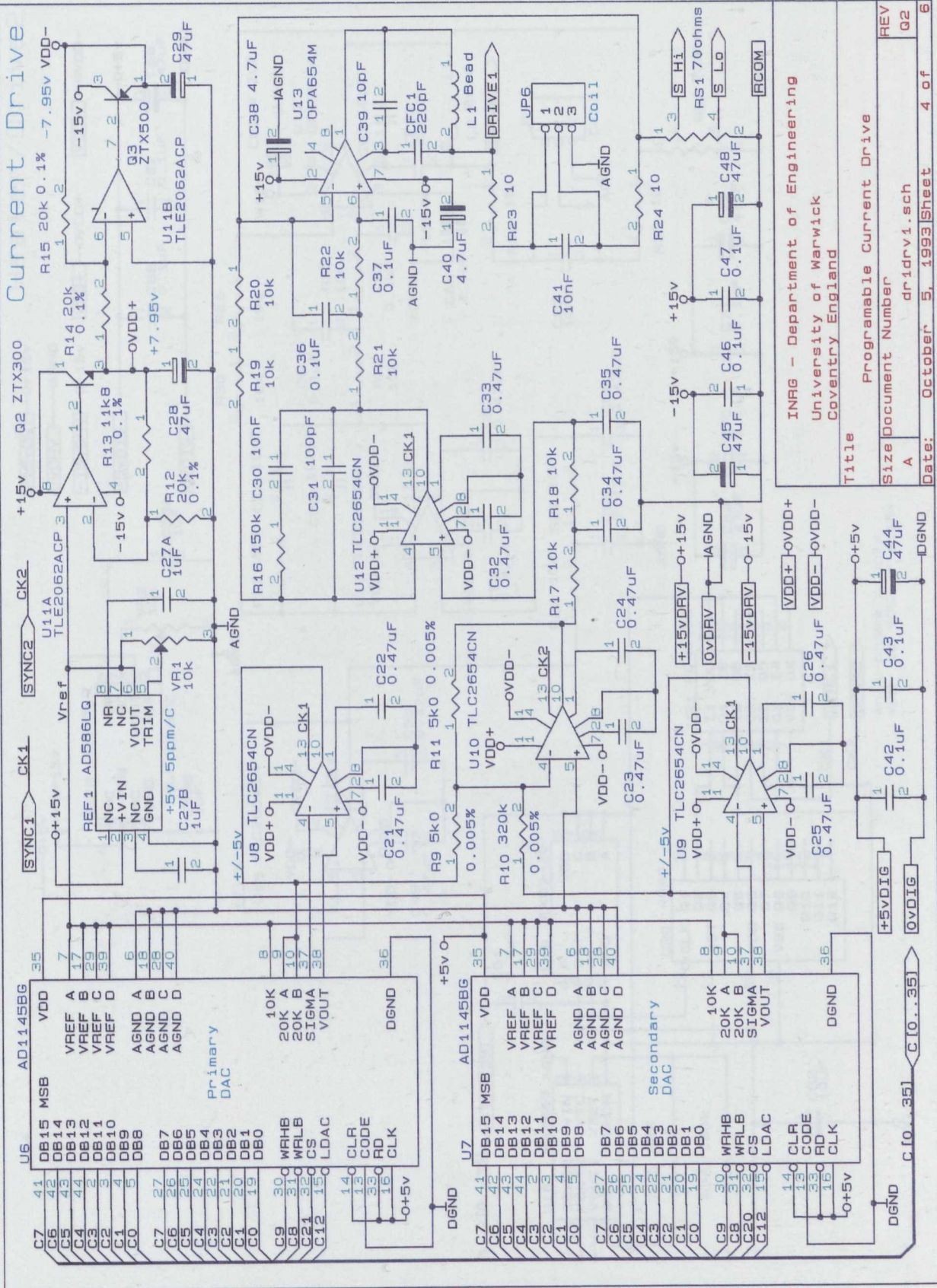
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# CPU ADC RS232 and Memory



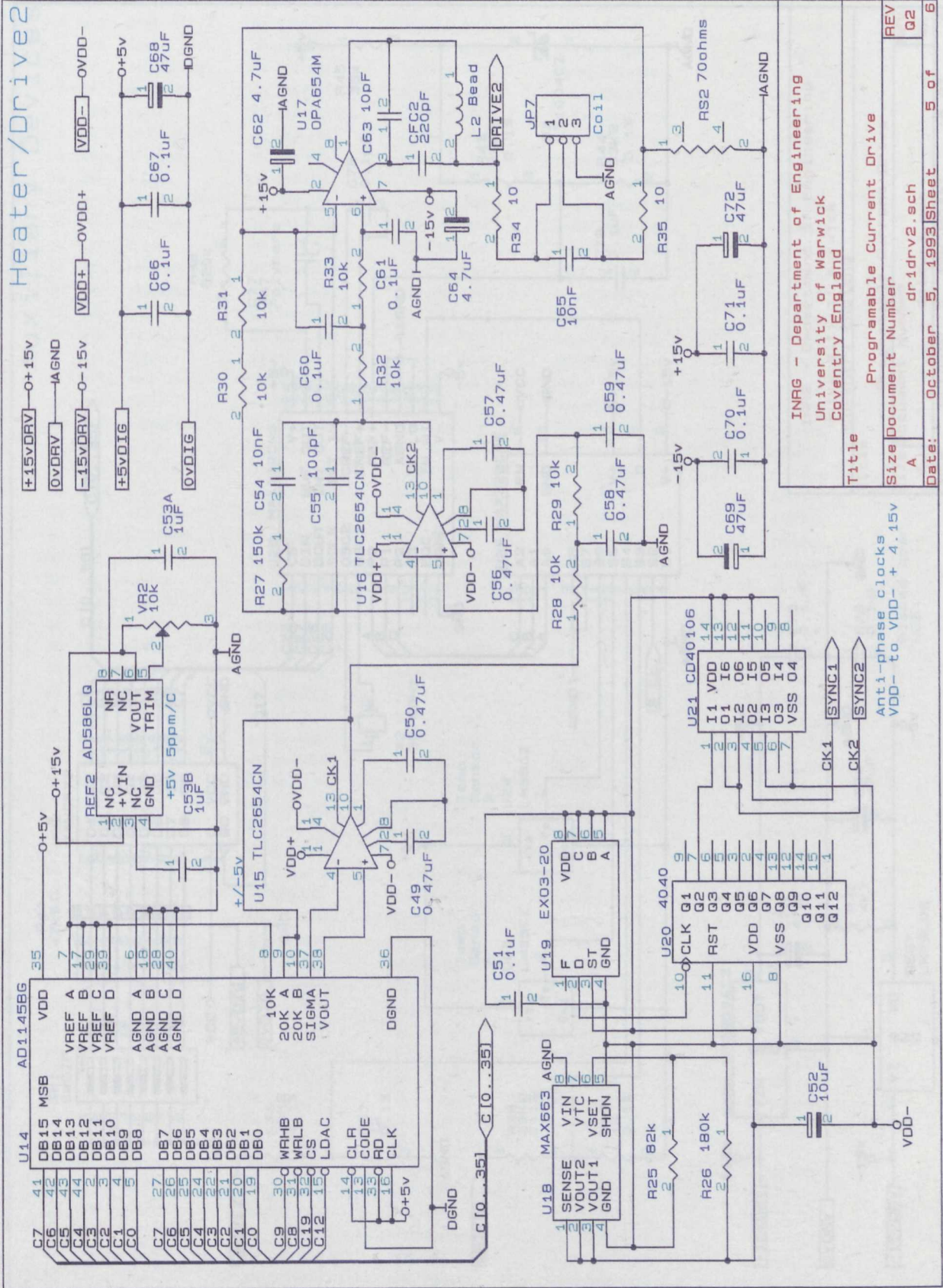
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# Current Drive



Title	
INRG - Department of Engineering University of Warwick Coventry England	
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# Heater/Drive2



INRG - Department of Engineering	
University of Warwick	
Coventry England	
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A	dr1drv2.sch
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Programable Current Drive			Revised: 30 November 1993	From DR1MIQ1A.CAL		
#	Ref	Part	Supplier	Function	Sheetname	No. File.sch
1	ADC1	AD1175K	Analog Devices	Feedback ADC	CPU and ADC	3 DR1CPU1
2	CX1	22pF	RS 126-124	CPU oscillator	CPU and ADC	3 DR1CPU1
3	CX2	22pF	RS 126-124	CPU oscillator	CPU and ADC	3 DR1CPU1
4	C1	10000uF/40v	RS 104-382	+15vADC PSU	Power Supplies	2 DR1PSU1
5	C2	47uF/16v	FN 100-884	+15vADC PSU	Power Supplies	2 DR1PSU1
6	C3	0.1uF	RS 125-733	+15vADC PSU	Power Supplies	2 DR1PSU1
7	C4	10000uF/40v	RS 104-382	-15vADC PSU	Power Supplies	2 DR1PSU1
8	C5	47uF/16v	FN 100-884	-15vADC PSU	Power Supplies	2 DR1PSU1
9	C6	0.1uF	RS 125-733	-15vADC PSU	Power Supplies	2 DR1PSU1
10	C7	10000uF/40v	RS 104-382	+15vDRV PSU	Power Supplies	2 DR1PSU1
11	C8	47uF/16v	FN 100-884	+15vDRV PSU	Power Supplies	2 DR1PSU1
12	C9	0.1uF	RS 125-733	+15vDRV PSU	Power Supplies	2 DR1PSU1
13	C10	10000uF/40v	RS 104-382	-15vDRV PSU	Power Supplies	2 DR1PSU1
14	C11	47uF/16v	FN 100-884	-15vDRV PSU	Power Supplies	2 DR1PSU1
15	C12	0.1uF	RS 125-733	-15vDRV PSU	Power Supplies	2 DR1PSU1
16	C13	15000/16v	RS 104-348	+5vDIG PSU	Power Supplies	2 DR1PSU1
17	C14	0.1uF	RS 125-733	/RESET logic	Power Supplies	2 DR1PSU1
18	C15	47uF/16v	FN 100-884	+5vDIG PSU	Power Supplies	2 DR1PSU1
19	C16	0.1uF	RS 125-733	+5vDIG PSU	Power Supplies	2 DR1PSU1
20	C17	15000/16v	RS 104-348	FAN PSU	Power Supplies	2 DR1PSU1
21	C18	0.1uF	RS 125-733	+5v bypass	CPU and ADC	3 DR1CPU1
22	C19	0.1uF	RS 125-733	+5v bypass	CPU and ADC	3 DR1CPU1
23	C19A	0.1uF	RS 125-733	+5v bypass	RS232 Chip	3 DR1CPU1
24	C20	47uF/16v	FN 100-884	+5v bypass	CPU and ADC	3 DR1CPU1
25	C20A	47uF/16v	FN 100-884	+5v bypass	RS232 Chip	3 DR1CPU1
26	C21	0.47uF	RS 114-862	U8 chopper	Drive 1	4 DR1DRV1
27	C22	0.47uF	RS 114-862	U8 chopper	Drive 1	4 DR1DRV1
28	C23	0.47uF	RS 114-862	U10 chopper	Drive 1	4 DR1DRV1
29	C24	0.47uF	RS 114-862	U10 chopper	Drive 1	4 DR1DRV1
30	C25	0.47uF	RS 114-862	U9 chopper	Drive 1	4 DR1DRV1
31	C26	0.47uF	RS 114-862	U9 chopper	Drive 1	4 DR1DRV1
32	C27A	1uF	RS 126-067	REF1 filter	Drive 1	4 DR1DRV1
33	C27B	1uF	RS 126-067	REF1 filter	Drive 1	4 DR1DRV1
34	C28	47uF/16v	FN 100-884	VDD+ bypass	Drive 1	4 DR1DRV1
35	C29	47uF/16v	FN 100-884	VDD- bypass	Drive 1	4 DR1DRV1
36	C30	10nF	RS 114-812	U12 Phase comp.	Drive 1	4 DR1DRV1
37	C31	100pF	RS 126-922	HF filter	Drive 1	4 DR1DRV1
38	C32	0.47uF	RS 114-862	U12 chopper	Drive 1	4 DR1DRV1
39	C33	0.47uF	RS 114-862	U12 chopper	Drive 1	4 DR1DRV1
40	C34	0.47uF	RS 114-862	Low pass filter	Drive 1	4 DR1DRV1
41	C35	0.47uF	RS 114-862	Low pass filter	Drive 1	4 DR1DRV1
42	C36	0.1uF	RS 114-840	Filter	Drive 1	4 DR1DRV1
43	C37	0.1uF	RS 114-840	Filter	Drive 1	4 DR1DRV1
44	C38	4.7uF/16v	FN 100-878	U13 +bypass	Drive 1	4 DR1DRV1
45	C39	10pF	RS 126-809	U13 comp.	Drive 1	4 DR1DRV1
46	C40	4.7uF	FN 100-878	U13 -bypass	Drive 1	4 DR1DRV1
47	C41	10nF	RS 114-812	HF filter	Drive 1	4 DR1DRV1
48	C42	0.1uF	RS 125-733	+5v bypass	Drive 1	4 DR1DRV1
49	C43	0.1uF	RS 125-733	+5v bypass	Drive 1	4 DR1DRV1
50	C44	47uF/16v	FN 100-884	+5v bypass	Drive 1	4 DR1DRV1
51	C45	47uF/16v	FN 100-884	-15vDRV bypass	Drive 1	4 DR1DRV1
52	C46	0.1uF	RS 125-733	-15vDRV bypass	Drive 1	4 DR1DRV1
53	C47	0.1uF	RS 125-733	+15vDRV bypass	Drive 1	4 DR1DRV1
54	C48	47uF/16v	FN 100-884	+15vDRV bypass	Drive 1	4 DR1DRV1
55	C49	0.47uF	RS 114-862	U15 chopper	Heater/Drive2	5 DR1DRV2
56	C50	0.47uF	RS 114-862	U15 chopper	Heater/Drive2	5 DR1DRV2
57	C51	0.1uF	RS 125-733	U18 bypass	Heater/Drive2	5 DR1DRV2
58	C52	10uF	RS 101-816	U18 bypass	Heater/Drive2	5 DR1DRV2
59	C53A	1uF	RS 126-067	REF2 filter	Heater/Drive2	5 DR1DRV2
60	C53B	1uF	RS 126-067	REF2 filter	Heater/Drive2	5 DR1DRV2
61	C54	10nF	RS 114-812	Phase comp.	Heater/Drive2	5 DR1DRV2

Programable Current Drive Revised: 30 November 1993				From DR1M1Q1A.CAL			
#	Ref	Part	Supplier	Function	Sheetname	No.	File.sch
62	C55	100pF	RS 126-922	HF filter	Heater/Drive2	5	DR1DRV2
63	C56	0.47uF	RS 114-862	U12 chopper	Heater/Drive2	5	DR1DRV2
64	C57	0.47uF	RS 114-862	U12 chopper	Heater/Drive2	5	DR1DRV2
65	C58	0.47uF	RS 114-862	Low pass filter	Heater/Drive2	5	DR1DRV2
66	C59	0.47uF	RS 114-862	Low pass filter	Heater/Drive2	5	DR1DRV2
67	C60	0.1uF	RS 114-840	Filter	Heater/Drive2	5	DR1DRV2
68	C61	0.1uF	RS 114-840	Filter	Heater/Drive2	5	DR1DRV2
69	C62	4.7uF/16v	FN 100-878	U13 +bypass	Heater/Drive2	5	DR1DRV2
70	C63	10pF	RS 126-809	U13 comp.	Heater/Drive2	5	DR1DRV2
71	C64	4.7uF/16v	FN 100-878	U13 -bypass	Heater/Drive2	5	DR1DRV2
72	C65	10nF	RS 114-812	HF filter	Heater/Drive2	5	DR1DRV2
73	C66	0.1uF	RS 125-733	+5v bypass	Heater/Drive2	5	DR1DRV2
74	C67	0.1uF	RS 125-733	+5v bypass	Heater/Drive2	5	DR1DRV2
75	C68	47uF/16v	FN 100-884	+5v bypass	Heater/Drive2	5	DR1DRV2
76	C69	47uF/16v	FN 100-884	-15vDRV bypass	Heater/Drive2	5	DR1DRV2
77	C70	0.1uF	RS 125-733	-15vDRV bypass	Heater/Drive2	5	DR1DRV2
78	C71	0.1uF	RS 125-733	+15vDRV bypass	Heater/Drive2	5	DR1DRV2
79	C72	47uF/16v	FN 100-884	+15vDRV bypass	Heater/Drive2	5	DR1DRV2
80	C73	47uF/16v	FN 100-884	U22 +bypass	Auxiliary Devices	6	DR1AUX1
81	C74	47uF/16v	FN 100-884	U22 -bypass	Auxiliary Devices	6	DR1AUX1
82	C75	0.1uF	RS 125-733	U22 +bypass	Auxiliary Devices	6	DR1AUX1
83	C76	0.1uF	RS 125-733	U22 -bypass	Auxiliary Devices	6	DR1AUX1
84	C77	4n7	RS 115-736	U22 Int. C.	Auxiliary Devices	6	DR1AUX1
85	C78	0.1uF	RS 114-840	U22 Ref. C	Auxiliary Devices	6	DR1AUX1
86	C79	0.1uF	RS 114-840	Vref filter	Auxiliary Devices	6	DR1AUX1
87	CFC1	220pF	RS 113-285	U13 freq. comp.	Drive 1	4	DR1DRV1
88	CFC2	220pF	RS 113-285	U17 freq. comp.	Drive 1	4	DR1DRV1
89	D3	LT1004CZ	Linear Technology	Bandgap Ref.	Auxiliary Devices	6	DR1AUX1
90	JP1	HEADER 3	3 pads for mains	Mains input	Power Supplies	2	DR1PSU1
91	JP2	HEADER 4	4 pads for mains switch	Mains switch	Power Supplies	2	DR1PSU1
92	JP3	HEADER 2	2 pin 0.1" pitch	Fan connector	Power Supplies	2	DR1PSU1
93	JP4	HEADER 2	2 pin 0.1" pitch	LED connector	CPU and ADC	3	DR1CPU1
94	JP5	HEADER 7	7 pin 0.1" pitch	Serial link	CPU and ADC	3	DR1CPU1
95	JP6	HEADER 3	3 pin 0.1" pitch	Drive 1	Drive 1	4	DR1DRV1
96	JP7	HEADER 3	3 pin 0.1" pitch	Drive 2	Heater/Drive2	5	DR1DRV2
97	J1A	TP	no component	Star point	Power Supplies	2	DR1PSU1
98	J1B	TP	no component	Star pooint	Power Supplies	2	DR1PSU1
99	L1	Bead	FN 108-269	U13 HF suppression	Drive 1	4	DR1DRV1
100	L2	Bead	FN 108-269	U17 HF suppression	Heater/Drive2	5	DR1DRV2
101	Q1	2N7000	RS 296-043	LED driver	CPU and ADC	3	DR1CPU1
102	Q2	ZTX300	RS 294-457	VDD+ booster	Drive 1	4	DR1DRV1
103	Q3	ZTX500	RS 294-463	VDD- booster	Drive 1	4	DR1DRV1
104	REC1	BRIDGE	FN 1KAB20E	ADC rectifiers	Power Supplies	2	DR1PSU1
105	REC2	BRIDGE	FN 1KAB20E	DRV rectifiers	Power Supplies	2	DR1PSU1
106	REC3	BRIDGE	FN 1KAB20E	DIG rectifiers	Power Supplies	2	DR1PSU1
107	REC4	BRIDGE	FN 1KAB20E	FAN rectifiers	Power Supplies	2	DR1PSU1
108	REF1	AD586LQ	Analog Devices	Drive1 Vref	Drive 1	4	DR1DRV1
109	REF2	AD586LQ	Analog Devices	Drive2 Vref	Heater/Drive2	5	DR1DRV2
110	REG1	LM7815CT	RS 648-444	+15vADC regulator	Power Supplies	2	DR1PSU1
111	REG2	LM7915CT	RS 648-472	-15vADC regulator	Power Supplies	2	DR1PSU1
112	REG3	LM7815CT	RS 648-444	+15vDRV regulator	Power Supplies	2	DR1PSU1
113	REG4	LM7915CT	RS 648-472	-15vDRV regulator	Power Supplies	2	DR1PSU1
114	REG5	LM2925T	RS 648-545	+5vDIG regulator	Power Supplies	2	DR1PSU1
115	REG6	LP2950ACZ	FN 2950ACZ5	U22 +5v regulator	Auxiliary Devices	6	DR1AUX1
116	REG7	LM79L05	FN 79L05ACZ	U22 -5v regulator	Auxiliary Devices	6	DR1AUX1
117	RS1	70ohms	N/A	External Coil	Drive 1	4	DR1DRV1
118	RS2	70ohms	N/A	External Coif	Heater/Drive2	5	DR1DRV2
119	RX	4M7	RS 135-645	CPU oscillator	CPU and ADC	3	DR1CPU1
120	R1	4k7	RS 148-663	+15vADC load	Power Supplies	2	DR1PSU1
121	R2	4k7	RS 148-663	-15vADC load	Power Supplies	2	DR1PSU1

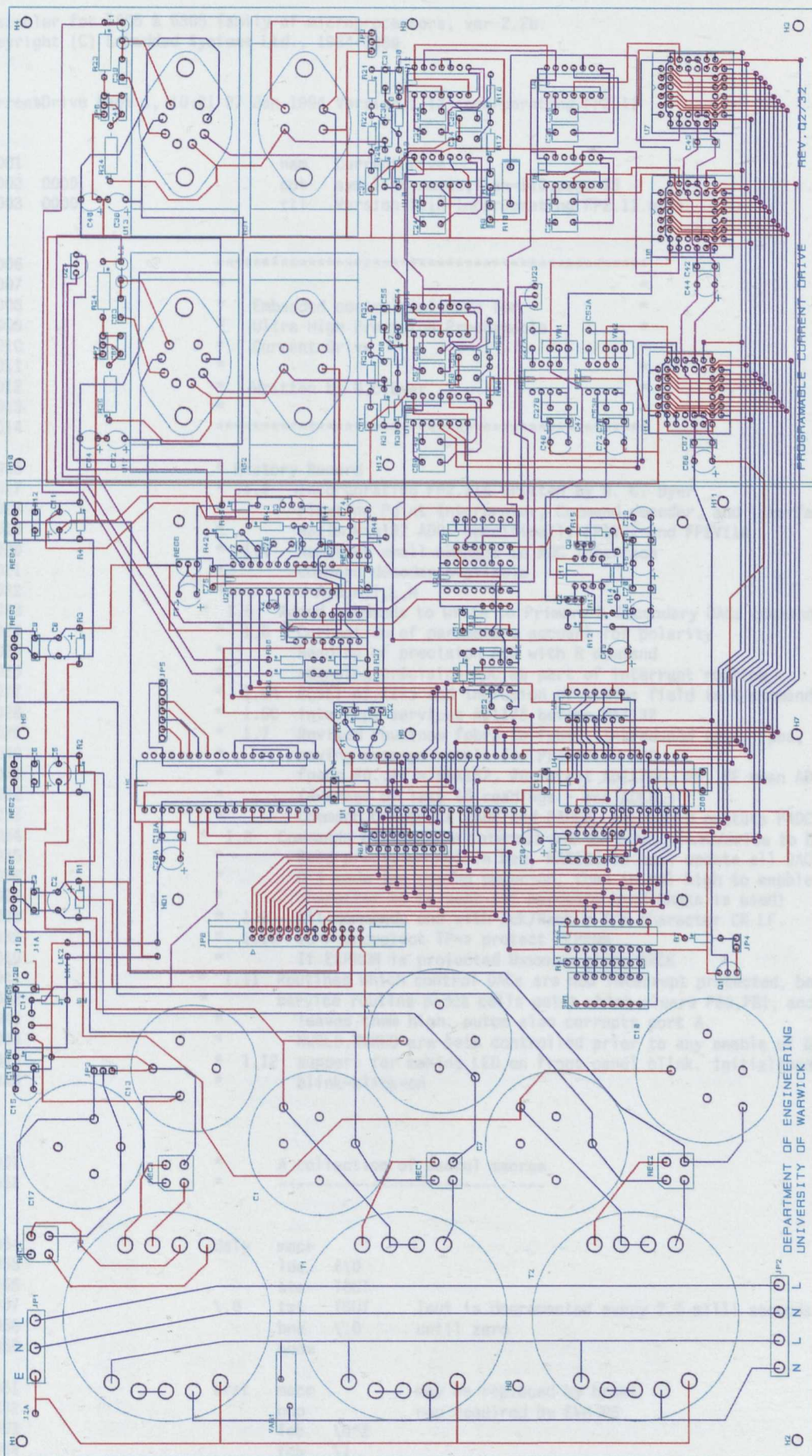


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122	R3	4k7	RS 148-663	+15vDRV load	Power Supplies	2 DR1PSU1
123	R4	4k7	RS 148-663	-15vDRV load	Power Supplies	2 DR1PSU1
124	R5	10k	RS 148-736	/RESET pullup	Power Supplies	2 DR1PSU1
125	R6	4k7	RS 148-663	+5vDIG load	Power Supplies	2 DR1PSU1
126	R7	150R	RS 148-304	LED I-limit	CPU and ADC	3 DR1CPU1
127	R8	47kSIL	RS 140-990	CPU pullups	CPU and ADC	3 DR1CPU1
128	R8A	47kSIL	RS 140-990	CPU pullups	CPU and ADC	3 DR1CPU1
129	R9	5k0	Vishay S102K	Primary DAC	Drive 1	4 DR1DRV1
			5k0 0.005%	weight		
130	R10	320k	Vishay S102K	Secondary DAC	Drive 1	4 DR1DRV1
			320k0 0.005%	weight		
131	R11	5k0	Vishay S102K	U10 feedback	Drive 1	4 DR1DRV1
			5k0 0.005%			
132	R12	20k	RS 167-018	VDD+ gain	Drive 1	4 DR1DRV1
133	R13	11k8	RS 166-790	VDD+ gain	Drive 1	4 DR1DRV1
134	R14	20k	RS 167-018	VDD- gain	Drive 1	4 DR1DRV1
135	R15	20k	RS 167-018	VDD- gain	Drive 1	4 DR1DRV1
136	R16	150k	RS 149-026	U12 Phase comp.	Drive 1	4 DR1DRV1
137	R17	10k	RS 148-736	Low pass filter	Drive 1	4 DR1DRV1
138	R18	10k	RS 148-736	Low pass filter	Drive 1	4 DR1DRV1
139	R19	10k	RS 148-736	DC feedback	Drive 1	4 DR1DRV1
140	R20	10k	RS 148-736	DC feedback	Drive 1	4 DR1DRV1
141	R21	10k	RS 148-736	Filter	Drive 1	4 DR1DRV1
142	R22	10k	RS 148-736	Filter	Drive 1	4 DR1DRV1
143	R23	10	RS 148-017	Current limit	Drive 1	4 DR1DRV1
144	R24	10	RS 148-017	Current limit	Drive 1	4 DR1DRV1
145	R25	82k	RS 148-950	Voltage set	Heater/Drive2	5 DR1DRV2
146	R26	180k	RS 149-048	Voltage set	Heater/Drive2	5 DR1DRV2
147	R27	150k	RS 149-026	U16 Phase comp.	Heater/Drive2	5 DR1DRV2
148	R28	10k	RS 148-736	Low pass filter	Heater/Drive2	5 DR1DRV2
149	R29	10k	RS 148-736	Low pass filter	Heater/Drive2	5 DR1DRV2
150	R30	10k	RS 148-736	DC feedback	Heater/Drive2	5 DR1DRV2
151	R31	10k	RS 148-736	DC feedback	Heater/Drive2	5 DR1DRV2
152	R32	10k	RS 148-736	Filter	Heater/Drive2	5 DR1DRV2
153	R33	10k	RS 148-736	Filter	Heater/Drive2	5 DR1DRV2
154	R34	10	RS 148-017	Current limit	Heater/Drive2	5 DR1DRV2
155	R35	10	RS 148-017	Current limit	Heater/Drive2	5 DR1DRV2
156	R36	23K2	RS 167-074	Voltage divider	Auxiliary Devices	6 DR1AUX1
157	R37	1K	RS 165-769	Voltage divider	Auxiliary Devices	6 DR1AUX1
158	R38	23K2	RS 167-074	Voltage divider	Auxiliary Devices	6 DR1AUX1
159	R39	1K	RS 165-769	Voltage divider	Auxiliary Devices	6 DR1AUX1
160	R40	4k7	RS 148-663	U22 +5v load	Auxiliary Devices	6 DR1AUX1
161	R41	47kSIL	RS 140-990	U19 pullup	Auxiliary Devices	6 DR1AUX1
162	R42	620k	RS 149-177	U22 Int. R	Auxiliary Devices	6 DR1AUX1
163	R43	33k2 0.1%	RS 167-226	Vref divider	Auxiliary Devices	6 DR1AUX1
164	R44	33k2 0.1%	RS 167-226	Vref divider	Auxiliary Devices	6 DR1AUX1
165	R45	33k	RS 148-859	D3 bias	Auxiliary Devices	6 DR1AUX1
166	R46	27k	RS 148-837	Q1 gate pull-down	CPU and ADC	3 DR1CPU1
167	SW1	SWDIP	RS 337-560	Setup switches	Auxiliary Devices	6 DR1AUX1
168	T1	5VA 0-15 0-15	RS 207-807	ADC PSU	Power Supplies	2 DR1PSU1
169	T2	5VA 0-15 0-15	RS 207-807	Drive PSU	Power Supplies	2 DR1PSU1
170	T3	5VA 0-9 0-9	RS 207-970	Digital/Fan PSU	Power Supplies	2 DR1PSU1
171	U1	MC68HC705C8S	Motorola	Microprocessor	CPU and ADC	3 DR1CPU1
172	U2	74HC164	RS 301-347	Address Generator	CPU and ADC	3 DR1CPU1
173	U3	74HC164	RS 301-347	Address Generator	CPU and ADC	3 DR1CPU1
174	U4	X28C256	RS 656-041	Memory	CPU and ADC	3 DR1CPU1
175	U5	MAX252ACHL	Maxim	Isolated RS232	CPU and ADC	3 DR1CPU1
176	U6	AD1145BG	Analog Devices	Primary DAC	Drive 1	4 DR1DRV1
177	U7	AD1145BG	Analog Devices	Secondary DAC	Drive 1	4 DR1DRV1
178	U8	TLC2654CN	FN TLC2654CN	U6 output	Drive 1	4 DR1DRV1
179	U9	TLC2654CN	FN TLC2654CN	U7 output	Drive 1	4 DR1DRV1

Programable Current Drive			Revised: 30 November 1993	From DR1M1Q1A.CAL		
#	Ref	Part	Supplier	Function	Sheetname	No. File.sch
180	U10	TLC2654CN	FN TLC2654CN	Summing amplifier	Drive 1	4 DR1DRV1
181	U11A	TLE2062ACP	RS 264-765	VDD+ generator	Drive 1	4 DR1DRV1
182	U11B	TLE2062ACP	(A/B is dual pk.)	VDD- generator	Drive 1	4 DR1DRV1
183	U12	TLC2654CN	FN TLC2654CN	Output stage	Drive 1	4 DR1DRV1
184	U13	OPA654M	Burr Brown	Power Output	Drive 1	4 DR1DRV1
185	U14	AD1145BG	Analog Devices	Heater/Drive 2	Heater/Drive2	5 DR1DRV2
186	U15	TLC2654CN	FN TLC2654CN	U14 output	Heater/Drive2	5 DR1DRV2
187	U16	TLC2654CN	FN TLC2654CN	Output stage	Heater/Drive2	5 DR1DRV2
188	U17	OPA654M	Burr Brown	Power Output	Heater/Drive2	5 DR1DRV2
189	U18	MAX663CPA	Maxim	Voltage regulator	Heater/Drive2	5 DR1DRV2
190	U19	EX03-20	FN 221-764	Oscillator module	Heater/Drive2	5
191	U20	CD4040BCN	FN CD4040CN	Divider	Heater/Drive2	5
192	U21	CD40106BCN	FN CD40106BCN	Inverter	Heater/Drive2	5
193	U22	MC74HC573	RS 643-512	Buffer	Auxiliary Devices	6 DR1AUX1
194	U23	LM35CZ	FN LM35CZ	Temperature sensor	Auxiliary Devices	6 DR1AUX1
195	U24	LM35CZ	FN LM35CZ	Temperature sensor	Auxiliary Devices	6 DR1AUX1
196	U25	MAX132CNG	Maxim	Auxiliary ADC	Auxiliary Devices	6 DR1AUX1
197	U26	MAX328CPE	Maxim	Analog Multiplexer	Auxiliary Devices	6 DR1AUX1
198	VAR1	V250LA40B	FN V250LA40B	Varistor	Power Supplies	2 DR1PSU1
199	VR1	10k	Vishay 1260W	Trim resistor	Drive 1	4 DR1DRV1
			10k 5%			
200	VR2	10k	Vishay 1260W	Trim resistor	Heater/Drive2	5 DR1DRV2
			10k 5%			
201	X1	4.0MHz	RS 658-895	CPU crystal	CPU and ADC	3 DR1CPU1
202	X2	32768Hz	RS 304-447	Aux ADC crystal	Auxiliary Devices	6 DR1AUX1

\* Present if REFx is AD586LQ

\*\* Present if REFx is LT1027BCN8



```
00001          nam CurrentDrive
00002 0000      opt sym,list,nomex,llen=110,page=73
00003 0000      ttl Version 1.12 incorporating FP2.11 sful
```

```
00006          *****
00007          *
00008          * Embedded control software for
00009          * Ultra High Precision Programable
00010          * Current Drive
00011          *
00012          * Written by D.C.Dyer
00013          *
00014          *****
```

```
00016          * History Record
00017          * 1.1 Incorporating FP2.11A written by D. C. Dyer
00018          * Floating Point Interpreter, Command decoder, and interface to
00019          * Maxim Max132 ADC. Specifically FP1V22 and FP2V11A
00020          * 1.4 Numerous small changes to ADC interface
00021          * Command decoder available
00022          * A,B,H,I,L,M
00023          * 1.5 Added commands to write to Primary & Secondary DACs commands P,S
00024          * 1.6 Correction of parameters account for polarity
00025          * Reading of precision ADC with R command
00026          * scanning precision ADC as part of interrupt routine
00027          * 1.6A RESET of 1175 and inclusion of status field in R command
00028          * 1.6C interrupt services AD1175 before MAX132
00029          * 1.7 Revised routines fbra to fpbmi; Introduced fpbc, fpbs, fpdly
00030          * moving average sample for Precision ADC
00031          * fpadc #0..#7 = MAX132, #8 latest AD1175K, #9..#F mean AD1175K
00032          * (average of last 16 readings - see ADCBL)
00033          * Command C outputs PADC and PADCA, command D ouputs PADCA
00034          * 1.8 Commands to read the internal DIL switches, read/write to EEPROM
00035          * Read precision ADC in hex, MAX132 in hex, update all DACS
00036          * CTS made low during power-on, then in rd1 high to enable
00037          * character so be sent (if hardware hand-shake is used)
00038          * 1.9 All commands end with Ack/Nack = Y/N character CR LF
00039          * 1.10 TU=> unprotect TP=> protect EEPROM
00040          * If EEPROM is protected Wxxxxyy gives NACK
00041          * 1.11 Routines which control DACs are now interrupt protected, because
00042          * service routine padcs calls getst which clears PBO,PB1, and getr
00043          * leaves them high. putcm also corrupts port A.
00044          * NWRLB,NWRHB are both controlled prior to any enable of DAC
00045          * 1.12 support for making LED on front panel blink. Initialised to
00046          * blink-blink-on
```

```
00051          * A collection of useful macros
00052          * -----
```

```
00054          dely macr
00055          lda #\0
00056          sta TOUT
00057          \.0 tst TOUT Tout is decremented every 2.5 milli seconds
00058          bne \.0 until zero
00059          endm
```

```
00061          brst macr may be replaced by brset
00062          nop nop required by EVM-05
00063          fcb \0*2
00064          fcb \1
00065          \.0 fcb \2-\.0-1
```

```

00066                endm

00068                brc1  macr          may be replaced by brc1r
00069                    nop          nop required by EVM-05
00070                    fcb  \0*2+1
00071                    fcb  \1
00072                \.0  fcb  \2-\.0-1
00073                    endm

00075                mul   macr          define multiply instruction
00076                    fcb  $42
00077                    endm

00079                * partial product
00080                pmul  macr          (arg2)= (arg2) + arg0 * arg1
00081                    lda  \0
00082                    ldx  \1
00083                    mul
00084                    add  \2
00085                    sta  \2
00086                    txa
00087                    adc  \2-1      high part at lower address
00088                    sta  \2-1
00089                    bcc  \.1      allow for carry to higher byte
00090                    inc  \2-2
00091                \.1  equ  *
00092                    endm

00094                fc   macr  c        defines one or more codes
00095                    fcb  \0*16+\1
00096                    ifgt NARG-2
00097                    fcb  \2
00098                    endc
00099                    ifgt NARG-3
00100                    fcb  \3
00101                    endc
00102                    endm

00104                * used when defining 'fop's for interpreter jump table
00105                fopdef macr
00106                f\0  equ  (*-foptab)/2
00107                fdb  fp\0
00108                endm

00110                * used when defining function group for interpreter jump table
00111                fundef macr
00112                f\0  equ  (*-funtab)/2
00113                fdb  fp\0
00114                endm

00116                * used when defining branch group interpreter jump table
00117                fbrdef macr
00118                f\0  equ  (*-fbrtab)/2
00119                fdb  fp\0
00120                endm

00122                * constants
00123                0008  BS  equ  $08      Back Space
00124                000D CR  equ  $0D      Carriage return
00125                000A LF  equ  $0A      Line Feed
00126                0020  SP  equ  $20      Space

00128                * Port Addresses
00129                0000  PA  equ  0        Port A Data Register - I/O
00130                0001  PB  equ  1        Port B Data Register - I/O
00131                0002  PC  equ  2        Port C Data Register - I/O
00132                0003  PD  equ  3        Port D input register
00133                0004  DDRA equ  4        Data Direction Register for port A

```

00134	0005	DDRB	equ	5	Data Direction Register for port B
00135	0006	DDRC	equ	6	Data Direction Register for port C
00136	0007	DDRD	equ	7	Data Direction Register for port C on MC68HC05C9
00137	000A	SPCR	equ	\$A	Serial Peripheral Control Register
00138	000B	SPSR	equ	\$B	Serial Peripheral Status Register
00139	000C	SPDAT	equ	\$C	Serial Peripheral DATA register
00140	000D	SCBRR	equ	\$D	Serial Communications Baud Rate Generator
00141	000E	SCCR1	equ	\$E	Serial Communications Control Register 1
00142	000F	SCCR2	equ	\$F	Serial Communications Control Register 2
00143	0010	SCSR	equ	\$10	Serial Communications Status Register
00144	0011	SCDAT	equ	\$11	Serial Communications DATA register
00145	0012	TCR	equ	\$12	Timer Control Register
00146	0013	TSR	equ	\$13	Timer Status Register
00147	0014	ICHR	equ	\$14	Input Capture High Register
00148	0015	ICLR	equ	\$15	Input Capture Low Register
00149	0016	OCHR	equ	\$16	Output Compare High Register
00150	0017	OCLR	equ	\$17	Output Compare Low Register
00151	0018	CHR	equ	\$18	Counter High Register
00152	0019	CLR	equ	\$19	Counter Low Register
00153	001A	ACHR	equ	\$1A	Alternate Counter High Register
00154	001B	ACLR	equ	\$1B	Alternate Counter Low Register
00155	001C	PR	equ	\$1C	Program Register
00156	001D	COPR	equ	\$1D	COP reset register
00157	001E	COPC	equ	\$1E	COP control register
00158	1FDF	OPT1	equ	\$1FDF	option register
00159	3FDF	OPT2	equ	\$3FDF	option register in 705C9 (Emulator)
00161	00A0	EEPPA	equ	\$A0	include physical device address of EEPROM
00163		*			Bit Assignments
00164		*			Timer Control Register - TCR - See P4-9
00165	0007	ICIE	equ	7	Input Capture Interrupt Enable
00166	0006	OCIE	equ	6	Output Compare Interrupt Enable
00167	0005	TOIE	equ	5	Timer Overflow Interrupt Enable
00168	0001	IEDGE	equ	1	Input EDGE
00169	0000	OLVL	equ	0	Output LeVeL
00171		*			Timer Status Register - TSR - See p4-10
00172	0007	ICF	equ	7	Input Capture Flag
00173	0006	OCF	equ	6	Output Compare Flag
00174	0005	TOF	equ	5	Timer Overflow Flag
00176		*			Serial Communications Control Register 1 - SCCR1 - See p5-5
00177	0007	R8	equ	7	Receive bit #8
00178	0006	T8	equ	6	Transmit bit #8
00179	0004	M	equ	4	Mode bit (0=>8 bits, 1=>9)
00180	0003	WAKE	equ	3	Wake-up enable - See 5-7
00182		*			Serial Communications Control Register 2 - SCCR2 - See p5-7
00183	0007	TIE	equ	7	Transmit Interrupt Enable
00184	0006	TCIE	equ	6	Transmission Complete Interrupt Enable
00185	0005	RIE	equ	5	Receive Interrupt Enable
00186	0004	ILIE	equ	4	Idle Line Interrupt Enable
00187	0003	TE	equ	3	Transmit Enable
00188	0002	RE	equ	2	Receive Enable
00189	0001	RWU	equ	1	Receiver Wake-Up
00190	0000	SBK	equ	0	Send Break
00192		*			Serial Communications Status Register - SCSR - See p5-9
00193	0007	TDR	equ	7	Transmit Data Register Empty
00194	0006	TC	equ	6	Transmission Complete
00195	0005	RDRF	equ	5	Receive Data Register Full
00196	0004	IDLE	equ	4	Idle detect bit
00197	0003	OR	equ	3	Overrun error
00198	0002	NF	equ	2	Noise Flag
00199	0001	FE	equ	1	Framing Error
00201		*			Serial Communications Baud Rate Register - SCBRR - See p5-10

```

00202      0005      SCP1 equ 5      Serial Communications Prescaler
00203      0004      SCP0 equ 4      Divide by 1(00), 3(01),4(10),13(11)
00204      0002      SCR2 equ 2      Divide by 2**(SCR2,1,0)
00205      0001      SCR1 equ 1      i.e. SCR2=1,SCRO=0,SRCO=1 =>
00206      0000      SCRO equ 0      divide by 2**5 = 32

00208      *      Serial Peripheral Control Register - SPCR - See p6-7
00209      0007      SPIE equ 7      Serial Peripheral Interrupt Enable
00210      0006      SPE equ 6      Serial Peripheral output Enable
00211      0004      MSTR equ 4      MaSTeR bit
00212      0003      CPOL equ 3      Clock Polarity
00213      0002      CPHA equ 2      Clock Phase
00214      0001      SPR1 equ 1      Serial Peripheral Rate Select
00215      0000      SPR0 equ 0      Divide by 2(00),4(01),16(10),32(11)

00217      *      Serial Peripheral Status Register - SPSR - See p6-8
00218      0007      SPIF equ 7      Serial PerIpheral Flag
00219      0006      WCOL equ 6      Write COLLision
00220      0004      MODF equ 4      MODe Fault flag

00222      *      Option Register
00223      0001      IRQ equ 1      0=> -edge, 1=>-edge and level
00224      0003      SEC equ 3      Security bit 1=> bootloader disabled
00225      0006      RAM1 equ 6      96 bytes of ram at $100
00226      0007      RAM0 equ 7      32 bytes of ram at $20

00228      *      Program Register
00229      0006      CPEN equ 6      Charge Pump ENable
00230      0003      ERASE equ 3      Clock Polarity
00231      0002      LATA equ 2      LATCh array A
00232      0001      LATB equ 1      LATCh Array B
00233      0000      EEPGM equ 0      Electrically Erase/PRograM

00235      *      Port A
00236      *      Bidirectional Data Bus

00238      *      Port B
00239      *      All bits are outputs
00240      0000      NWRLB equ 0      Not WRite Low Byte / A0
00241      0000      A0 equ NWRLB
00242      0001      NWRHB equ 1      Not WRite High Byte / A1
00243      0001      A1 equ NWRHB
00244      0002      NRD equ 2      Not Read
00245      0003      NWR equ 3      Not Write
00246      0004      NLDAC equ 4      Not LoaD AdC
00247      0005      RESET equ 5      Reset AD1175 - ADC1 22 bit ADC
00248      0006      FREQ equ 6      50/60Hz frequency select of ADC1
00249      0007      RTS equ 7      RS232 output

00251      *      Port C
00252      *      All bits are outputs
00253      0000      PC0 equ 0      Not used
00254      0001      NSIS equ 1      Not Switch Input Select - U22
00255      0002      N1175 equ 2      Not select for AD1175 - ADC1
00256      0003      N1145H equ 3      Not AD1145 Heater select - U14
00257      0004      N1145S equ 4      Not AD1145 Secondary select - U7
00258      0005      N1145P equ 5      Not AD1145 Primary select - U6
00259      0006      N132 equ 6      Not MAX132 select - U25
00260      0007      NEEP equ 7      Not EEPROM select - U4

00262      *      Port D
00263      *      Directions implicit by function on MC68HC705C8
00264      *      Emulator using 'C9 part needs data direction register set up
00265      *      see cfigtb
00266      0000      RX equ 0      RS232 input
00267      0001      TX equ 1      RS232 output
00268      0002      MISO equ 2      Master In Slave Out from MAX132
00269      0003      MOSI equ 3      Master Out Slave In to MAX132

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```

00270      0004      SCLK equ 4      Serial clock to MAX132
00271      0005      NSS equ 5      Not Slave Select, tied to +5v
00272      0006      PD6 equ 6      Does not exist
00273      0007      CTS equ 7      RS232 input
00274      0050      zrams equ $50   Start of RAM
00275      00FF      zrame equ $FF   End of RAM
00276      0030      zram0 equ $30   Start of extra RAM block - OPTION reg bit #7
00277      0100      zram1 equ $100  Start of extra RAM block - Option reg bit #6

00280      0200      zroms equ $0200  Start of (EEP)rom area
00281      10FF      zrome equ $10FF  End of (EEP)rom area
00282      1FF4      zvect equ $1FF4  Start of VECTOR table

00285      *          vector table
00286      *          -----
00287      1FF4      org zvect
00288      1FF4 0203 spi fdb spis Serial Peripheral Interface
00289      1FF6 0205 sci fdb scis Serial Communications Interface
00290      1FF8 0D62 tim fdb tims TIMER Service routine
00291      1FFA 0207 irq fdb irqs external Interrupt ReQuest
00292      1FFC 0209 swi fdb swis Software Interrupt
00293      1FFE 0200 reset fdb start Start-up routine

00295      *          option register
00296      *          -----
00297      1FDF      org OPT1 force no security bit by default in 'C8
00298      1FDF 02 fcb $02
00299      3FDF      org OPT2 force no security bit by default in 'C9
00300      3FDF 02 fcb $02

00302      *          Ram locations
00303      *          -----

00305      * Floating point numbers use a 3 byte mantissa and a 1 byte exponent.
00306      * The mantissa is normalised so that the left most bit is 1 and this
00307      * is then replace by the sign. The exponent is biased by $80, and zero
00308      * is represented by an exponent of $00. If the exponent is $00 the
00309      * mantissa bits are undefined.

00311      0030      org zram0 Floating point variables FP0..FP7 fit here
00312      0030      fpram equ * start of variables
00313      0030      FP0 rmb 4 temporary result

00315      0034      FP1 equ *
00316      0034      FP1EX RMB 1 FP1 Exponent
00317      0035      FP1HB RMB 1 FP1 Highest Significant Byte
00318      0036      FP1MB RMB 1 FP1 Middle Significant Byte
00319      0037      FP1LB RMB 1 FP1 Least Significant Byte

00321      0038      FP2 equ *
00322      0038      FP2EX RMB 1 FP2 Exponent
00323      0039      FP2HB RMB 1 FP2 Highest Significant Byte
00324      003A      FP2MB RMB 1 FP2 Middle Significant Byte
00325      003B      FP2LB RMB 1 FP2 Least Significant Byte

00327      003C      FP3 RMB 4 additional floating point variables
00328      0040      FP4 RMB 4
00329      0044      FP5 RMB 4
00330      0048      FP6 RMB 4
00331      004C      FP7 RMB 4

00333      0050      org zrams define use of RAM locations

00335      0050      FCNT0 RMB 1 counters accessed by user not fp package
00336      0051      FCNT1 RMB 1
00337      0052      FCNT2 RMB 1

```



00338	0053	FCNT3	RMB	1	
00339	0054	FCNT4	RMB	1	
00340	0055	FCNT5	RMB	1	
00341	0056	FCNT6	RMB	1	
00342	0057	FCNT7	RMB	1	
00344	0058	DMAL	RMB	1	Decimal conversion including FPT5-FPT0
00345	0059	FPT5	RMB	1	Temp area for product or quotient
00346	005A	FPT4	RMB	1	needs to be twice as long as mantissa
00347	005B	FPT3	RMB	1	
00348	005C	FPT2	RMB	1	
00349	005D	FPT1	RMB	1	
00350	005E	FPT0	RMB	1	
00352	005F	FP1GB	RMB	1	FP1 Guard Byte
00353	0060	FPEXE	rmb	1	exponent extension
00354	0061	FPEXOF	rmb	1	exponent offset used in square root function
00355	0062	FPCNT1	rmb	1	counter within package
00356	0063	FP1SGN	rmb	1	sign of fp1
00357	0064	FP2SGN	rmb	1	sign of fp2
00358	0065	FPRSGN	rmb	1	sign of result
00360	0066	FPERR	RMB	1	error code
00361	0001	over	equ	1	
00362	0002	divzer	equ	2	
00363	0003	fixerr	equ	3	
00365	0067	FLAGS	rmb	1	flags to control interpreter operation
00366	0000	flexit	equ	0	set to exit interpreter
00367	0001	flnoex	equ	1	set for no execution of low nibble
00370	0068	FCODE	RMB	1	function code for/from interpreter
00371	0069	SMODC	RMB	7	self modifiable code see 'cfigtb'
00372		* lda		\$????	
00373		* rts			
00374		* jmp		\$????	
00377		* All variables are modified by timer interrupt service routine except			
*					
00378	0018	ADCLen	equ	8*3	
00379	0070	ADCR	rmb	ADCLen	space for all ADC readings
00380	0088	ADCC	rmb	ADCLen	space for copy of ADC readings
00381	00A0	ADCS	rmb	4	sum for moving average
00382	00A4	ADCBP	rmb	1	ADC Buffer Pointer
00383	00A5	ADCH	rmb	1	
00384	00A6	ADCM	rmb	1	
00385	00A7	ADCL	rmb	1	
00386	00A8	SPIT	rmb	1	store of last byte sent out via SPI
00387	00A9	TOUT	rmb	1	decremented at time out rate until zero
00388	00AA	TOVF	rmb	1	decremented at overflow rate until zero
00389	00AB	STATE	rmb	1	state counter for ADC control
00390	00AC	CHAN	rmb	1	channel counter for ADC multiplexer
00391	00AD	SAMCNT	rmb	1	SAMple CouNT. 8=> complete list of readings
00392		* Next two declarations must be adjacent			
00393	00AE	PADCR	rmb	3	Precision ADC readings (first byte is ms)
00394	00B1	PADCST	rmb	1	Precision ADC status
00396	00B2	PADCC	rmb	4	Precision ADC copy of readings incl. STATUS
00397	00B6	PADCA	rmb	3	Precision ADC Average (first byte is ms)
00399	00B9	MODE	rmb	1	MODE flags
00400		* allocation of bits in MODE byte			
00401	0000	QUIET	equ	0	1=>ADC sampling starts with fsyn => quiet RS232
00402	0001	NEXT	equ	1	1=> wait for next conversion of Precision ADC
00403	0007	ACK	equ	7	ACKnowledge byte for all commands.
00405	00BA	TEMPX	rmb	1	temp locations

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00406 00BB          TEMPA rmb 1
00407 00BC          BP    rmb 1      Buffer Pointer for command buffer

00409 00BD          PARAM rmb 1      parameter(s) for commands
00410 00BE          PARH  rmb 1      high byte of parameter
00411 00BF          PARL  rmb 1      low byte of parameter

00413 00C0          BLSTAT rmb 1     BLink STATE
00414 00C1          BLCNT rmb 1     BLink interval counter
00415 00C2          BLIVL rmb 1     BLink InterVal n * 0.131s

00417 0100          org    zram1    auxilliary ram
00418          0028          CMDLEN equ 40
00419 0100          CMDBUF rmb  CMDLEN

00421          * buffer for moving average window
00422          0030          ADCBL equ 16*3    number of bytes in buffer
00423          0004          ADCBD equ 4      number of bits to shift
00424 0128          ADCB  rmb  ADCBL    Precision ADC buffer

00427          *      start of main code
00428          *      -----
00429          0200          org    zroms
00430 0200 CC 020B          start jmp  main

00432          *      null routines
00433 0203 20 FE          0203 spis bra  spis    Serial Peripheral Interface
00434 0205 20 FE          0205 scis bra  scis    Serial Communications Interface
00435 0207 20 FE          0207 irq$ bra  irq$    external Interrupt ReQuest
00436 0209 20 FE          0209 swis bra  swis    Software Interrupt

00438 020B 9C          main  rsp          reset stack pointer
00439 020C 9B          sei          disable interrupts
00440 020D CD 0CFE          jsr  cfig    set up ports and all special locations
00441 0210 9A          cli

00443          *      make power on LED flash
00444 0211 9D          nop          changed to sei during development/testing
00445 0212 1A 01          bset  RESET,PB reset AD1175 precision ADC
00446 0214 9D          nop
00447 0215 9D          nop
00448 0216 9D          nop
00449 0217 1B 01          bclr  RESET,PB
00450 0219 CD 0231          main1 jsr  rd1    read a line
00451 021C 1F B9          bclr  ACK,MODE anticipate not acknowledged
00452 021E CD 026A          jsr  cmd    CoMmand Decode and execute
00453 0221 A6 4E          lda  #'N    anticipate not acknowledged
00454 0223          brcl  ACK,MODE,main2 anticipate not acknowledged
00455 0227 A6 59          lda  #'Y
00456 0229 CD 0FA7          main2 jsr  zputw  'Y' or 'N' then CR LF
00457 022C CD 0F8B          jsr  crlf   end of command
00458 022F 20 E8          0219 bra  main1

00460          * read command line into buffer
00461 0231 1F 01          rd1  bclr  RTS,PB  allow characters to arrive
00462 0233 5F          clrx    point to start of buffer
00463 0234 CD 0F9B          rd11 jsr  zgetw  get character
00464 0237 A4 7F          and  #$7F  strip msb
00465 0239 A1 08          cmp  #BS   is it a back space ?
00466 023B 26 13          0250 bne  rd12   no => contine as before
00467 023D 5D          tstx    if there have been no characters then ignore
00468 023E 27 F4          0234 beq  rd11
00469 0240 CD 0FA7          jsr  zputw  echo a backspace
00470 0243 A6 20          lda  #SP   over-write character
00471 0245 CD 0FA7          jsr  zputw
00472 0248 A6 08          lda  #BS
00473 024A CD 0FA7          jsr  zputw

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00474 024D 5A          decx      remove entry
00475 024E 20 E4    0234      bra      rd11  and try again
00476 0250 CD 0FA7    rd12      jsr      zputw  echo
00477 0253 A1 0D          cmp      #CR    test for carriage return
00478 0255 26 06    025D      bne      rd13
00479 0257 A6 0A          lda      #LF
00480 0259 CD 0FA7    jsr      zputw  and send line feed
00481 025C 4F          clra     put null code at end of buffer
00482 025D D7 0100    rd13      sta      CMDBUF,x
00483 0260 27 07    0269      beq      rd1z
00484 0262 A3 27          cpx      #CMDLEN-1
00485 0264 27 CE    0234      beq      rd11
00486 0266 5C          incx
00487 0267 20 CB    0234      bra      rd11
00488 0269 81          rd1z     rts

00490          * command decode
00491 026A 3F BC          cmd      clr      BP    clear buffer pointer
00492 026C CD 02B0      jsr      ibnc  get next character from input buffer
00493 026F A1 41          cmp      #'A
00494 0271 25 14    0287      blo      cmdz  less than 'A'
00495 0273 A1 5A          cmp      #'Z
00496 0275 22 10    0287      bhi      cmdz  greater than 'Z'
00497 0277 A0 41          sub      #'A
00498 0279 48          lsla    form word offset
00499 027A 97          tax
00500 027B D6 0288      lda      cmdtb,x  get jump address
00501 027E B7 6E          sta      SMODC+5 into self modifying code
00502 0280 D6 0289      lda      cmdtb+1,x
00503 0283 B7 6F          sta      SMODC+6
00504 0285 BC 6D          jmp      SMODC+4  execute
00505 0287 81          cmdz     rts

00508          * a list of command from A..Z
00509 0288 033D    cmdtb  fdb  cmdA  A - synchronises ADC then outputs 8 numbers
00510 028A 035F      fdb  cmdB  B - repeated cmdA
00511 028C 0367      fdb  cmdC  C - repeatedly outputs PADC, averaged PADC
00512 028E 0388      fdb  cmdD  D - repeatedly outputs averaged PADC
00513 0290 02BC      fdb  nul   E
00514 0292 02BC      fdb  nul   F
00515 0294 02BC      fdb  nul   G
00516 0296 03DA      fdb  cmdH  H - Prepare Heater DAC
00517 0298 03A7      fdb  cmdI  I - Output a ramp to Heater DAC
00518 029A 02BC      fdb  nul   J
00519 029C 02BC      fdb  nul   K
00520 029E 0404      fdb  cmdL  L - Load all DACs - pulses -LDAC line
00521 02A0 0410      fdb  cmdM  M - set MODE byte
00522 02A2 02BC      fdb  nul   N
00523 02A4 02BC      fdb  nul   O
00524 02A6 041A      fdb  cmdP  P - Prepare Primary DAC
00525 02A8 0461      fdb  cmdQ  Q - Read precision ADC 20 times
00526 02AA 0471      fdb  cmdR  R - Read precision ADC as 6+2 hex characters
00527 02AC 0495      fdb  cmdS  S - Prepare Secondary DAC
00528 02AE 04C2      fdb  cmdT  T - Enable/Disable software protection of EEPROM
00529 02B0 057B      fdb  cmdU  U - Read DIL switches as hex pair
00530 02B2 05C3      fdb  cmdV  V - Read bytes from EEPROM
00531 02B4 05EA      fdb  cmdW  W - Write a byte to EEPROM
00532 02B6 0615      fdb  cmdX  X - Read moving average of recision ADC in Hex
00533 02B8 063B      fdb  cmdY  Y - Read all MAX132 channels in hex
00534 02BA 064C      fdb  cmdZ  Z - Set some/all DACs

00536          * nothing to do
00537 02BC 81          nul     rts

00539          * get next character from input buffer - x points to character just read
00540          * characters are folded to upper case
00541          * z=1 if end of buffer

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00542 02BD BE BC      ibnc ldx BP      get buffer pointer
00543 02BF D6 0100    lda  CMDBUF,x
00544 02C2 98         clc                    anticipate end of buffer
00545 02C3 27 09      02CE beq  ibncz
00546 02C5 3C BC      inc  BP
00547 02C7 A1 60      cmp  #$60             test for lower case
00548 02C9 25 02      02CD blo  ibncl
00549 02CB A0 20      sub  #$20             move to upper case
00550 02CD 99          ibncl sec             flag valid character by cy=1
00551 02CE 81          ibncz rts

00553                * get parameter
00554                * treat characters as hexadecimal and pack into a byte
00555 02CF 3F BD      getpa clr  PARAM
00556 02D1 AD EA      02BD bsr  ibnc             get next character
00557 02D3 24 1B      02F0 bcc  getpaz           exit with cy=0 if end of buffer
00558 02D5 AD 1C      02F3 bsr  chtb            convert ascii hex to binary
00559 02D7 24 17      02F0 bcc  getpaz           not HEX
00560 02D9 B7 BD      sta  PARAM
00561 02DB AD E0      02BD bsr  ibnc             get next character
00562 02DD 24 11      02F0 bcc  getpaz           exit with cy=0 if end of buffer
00563 02DF AD 12      02F3 bsr  chtb            convert ascii hex to binary
00564 02E1 24 0D      02F0 bcc  getpaz           not HEX
00565 02E3 38 BD      lsl  PARAM            move to ms nibble
00566 02E5 38 BD      lsl  PARAM
00567 02E7 38 BD      lsl  PARAM
00568 02E9 38 BD      lsl  PARAM
00569 02EB 8B BD      add  PARAM
00570 02ED B7 BD      sta  PARAM
00571 02EF 99          sec                    flag as valid by cy=1
00572 02F0 B6 BD      getpaz lda  PARAM
00573 02F2 81          rts

00575                * convert ascii hex character into binary
00576                * s=1 if ok otherwise 0
00577 02F3 A1 30      chtb cmp  #'0
00578 02F5 25 15      030C blo  chtby           below '0', and cannot be converted
00579 02F7 A1 39      cmp  #'9
00580 02F9 22 04      02FF bhi  chtb1
00581 02FB A0 30      sub  #'0              now in binary
00582 02FD 20 0A      0309 bra  chtbx
00583 02FF A1 41      chtb1 cmp  #'A
00584 0301 25 09      030C blo  chtby           below 'A', and cannot be converted
00585 0303 A1 46      cmp  #'F
00586 0305 22 05      030C bhi  chtby           above 'F', and cannot be converted
00587 0307 A0 37      sub  #'A-10
00588 0309 99          chtbx sec             indicated conversion ok
00589 030A 20 01      030D bra  chtbz
00590 030C 98          chtby clc             indicates no conversion
00591 030D 81          chtbz rts

00593                * convert high and low nibbles to ASCII and send
00594 030E B7 BB      casb sta  TEMPA
00595 0310 BF BA      stx  TEMPX
00596 0312 AD 0D      0321 bsr  cash
00597 0314 B6 BB      lda  TEMPA
00598 0316 48          asla
00599 0317 48          asla
00600 0318 48          asla
00601 0319 48          asla
00602 031A AD 05      0321 bsr  cash
00603 031C B6 BB      lda  TEMPA
00604 031E BE BA      ldx  TEMPX
00605 0320 81          rts

00607                * convert and send high nibble
00608 0321 44          cash lsra
00609 0322 44          lsra

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00610 0323 44          lsra
00611 0324 44          lsra
00612 0325 97          tax
00613 0326 D6 032D     lda  cashtb,x
00614 0329 CD 0FA7     jsr  zputw
00615 032C 81          rts
00616 032D             cashtb fcc  "0123456789ABCDEF"

00618 033D AE 03       cmdA ldx  #cAtb/256 pointer high
00619 033F A6 47       lda  #cAtb%256 pointer low
00620 0341 CD 06BD     jsr  fintp  interpret
00621 0344 1E B9       bset ACK,MODE acknowledge
00622 0346 81          rts

00624 0347             cAtb  fc   fcnt,1,10
00625 0349             cAtb1 fc   fbr,fsyn
00626 034A             fc     fadc,0
00627 034B             fc     ffun,fout
00628 034C             fc     fadc,1
00629 034D             fc     ffun,fout
00630 034E             fc     fadc,2
00631 034F             fc     ffun,fout
00632 0350             fc     fadc,3
00633 0351             fc     ffun,fout
00634 0352             fc     fadc,4
00635 0353             fc     ffun,fout
00636 0354             fc     fadc,5
00637 0355             fc     ffun,fout
00638 0356             fc     fadc,6
00639 0357             fc     ffun,fout
00640 0358             fc     fadc,7
00641 0359             fc     ffun,fout
00642 035A             fc     ffun,fcrlf
00643 035B             fc     fcnt,8+1,cAtb1-*-1
00644 035D             fc     ffun,fcrlf
00645 035E             fc     fbr,fexit

00647             * repeated cmdA
00648 035F AD DC       033D cmdB bsr  cmdA
00649 0361 CD 0F93     jsr  zget
00650 0364 24 F9       035F bcc  cmdB
00651 0366 81          rts

00654             * outputs current reading from Precision ADC and Averaged reading from
00655             * precision ADC
00656 0367 AD 08       0371 cmdC bsr  cmdC1
00657 0369 CD 0F93     jsr  zget
00658 036C 24 F9       0367 bcc  cmdC
00659 036E 1E B9       bset ACK,MODE acknowledge
00660 0370 81          rts

00662 0371 AE 03       cmdC1 ldx  #cC1tb/256 pointer high
00663 0373 A6 79       lda  #cC1tb%256 pointer low
00664 0375 CD 06BD     jsr  fintp  interpret
00665 0378 81          rts

00667 0379             cC1tb fc   fcnt,1,10
00668 037B             cC1tb1 fc  fcnt,2,4
00669 037D             cC1tb2 fc  fadc,8
00670 037E             fc     ffun,fout
00671 037F             fc     fadc,9
00672 0380             fc     ffun,fout
00673 0381             fc     fcnt,8+2,cC1tb2-*-1
00674 0383             fc     ffun,fcrlf
00675 0384             fc     fcnt,8+1,cC1tb1-*-1
00676 0386             fc     ffun,fcrlf
00677 0387             fc     fbr,fexit

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00680 0388 AD 08    0392 cmdD  bsr  cmdD1
00681 038A CD 0F93          jsr  zget
00682 038D 24 F9    0388          bcc  cmdD
00683 038F 1E B9          bset ACK,MODE acknowledge
00684 0391 81          rts

00686 0392 AE 03          cmdD1 ldx  #cD1tb/256 pointer high
00687 0394 A6 9A          lda  #cD1tb%256 pointer low
00688 0396 CD 06BD          jsr  fintp  interpret
00689 0399 81          rts

00691 039A          cD1tb fc  fcnt,1,10
00692 039C          cD1tb1 fc  fcnt,2,8
00693 039E          cD1tb2 fc  fadc,9
00694 039F          fc  ffun,fout
00695 03A0          fc  fcnt,8+2,cD1tb2--1
00696 03A2          fc  ffun,fcrlf
00697 03A3          fc  fcnt,8+1,cD1tb1--1
00698 03A5          fc  ffun,fcrlf
00699 03A6          fc  fbr,fexit

00702          * test Heater DAC by outputting a RAMP
00703 03A7 3F 5E          cmdI  clr  FPT0
00704 03A9 3F 5D          clr  FPT1
00705 03AB CD 02CF          jsr  getpa  get high byte
00706 03AE 24 29    03D9          bcc  cmdIz  ignore if absent
00707 03B0 B7 5B          sta  FPT3
00708 03B2 CD 02CF          jsr  getpa  get high byte
00709 03B5 24 22    03D9          bcc  cmdIz  ignore if absent
00710 03B7 B7 5C          sta  FPT2
00711 03B9 B6 5D          cmdI1 lda  FPT1  get and output high part
00712 03BB CD 03EA          jsr  cmdHh
00713 03BE B6 5E          lda  FPT0  get and output low part
00714 03C0 CD 03F7          jsr  cmdH1
00715 03C3 CD 0409          jsr  cmdLs  pulse -LDAC line
00716 03C6 B6 5E          lda  FPT0
00717 03C8 BB 5C          add  FPT2
00718 03CA B7 5E          sta  FPT0
00719 03CC B6 5D          lda  FPT1
00720 03CE B9 5B          adc  FPT3
00721 03D0 B7 5D          sta  FPT1
00722 03D2 CD 0F93          cmdI2 jsr  zget  continue until a character has arrived
00723 03D5 24 E2    03B9          bcc  cmdI1
00724 03D7 1E B9          bset ACK,MODE acknowledge
00725 03D9 81          cmdIz rts

00727          * write to Heater DAC buffer
00728 03DA CD 042D          cmdH  jsr  getpw  get word parameter
00729 03DD 24 0A    03E9          bcc  cmdHz  part is missing
00730 03DF B6 BE          lda  PARH  output high part
00731 03E1 AD 07    03EA          bsr  cmdHh
00732 03E3 B6 BF          lda  PARL
00733 03E5 AD 10    03F7          bsr  cmdH1
00734 03E7 1E B9          bset ACK,MODE acknowledge
00735 03E9 81          cmdHz rts

00737 03EA 9B          cmdHh sei  protect sequence
00738 03EB B7 00          sta  PA  output high byte to heater DAC
00739 03ED 13 01          bclr NWRHB,PB select high byte
00740 03EF 10 01          bset NWRLB,PB but not low byte
00741 03F1 17 02          bclr N1145H,PC
00742 03F3 16 02          bset N1145H,PC
00743 03F5 9A          cli  allow interrupts again
00744 03F6 81          rts

00746 03F7 9B          cmdH1 sei  protect sequence
00747 03F8 B7 00          sta  PA  output low byte to heater DAC

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00748 03FA 11 01          bclr  NWRLB,PB select low byte
00749 03FC 12 01          bset  NWRHB,PB but not high byte
00750 03FE 17 02          bclr  N1145H,PC
00751 0400 16 02          bset  N1145H,PC
00752 0402 9A            cli           allow interrupts again
00753 0403 81            rts

00755                    * pulse LDAC line low and acknowledge
00756 0404 AD 03      0409 cmdL  bsr  cmdLs
00757 0406 1E B9          bset  ACK,MODE acknowledge
00758 0408 81            rts

00760                    * pulse LDAC line low
00761 0409 9B          cmdLs  sei           protect sequence
00762 040A 19 01          bclr  NLDAC,PB load all DAC's from internal latches
00763 040C 18 01          bset  NLDAC,PB
00764 040E 9A            cli           allow interrupts again
00765 040F 81            rts

00767                    * set MODE to first parameter
00768 0410 CD 02CF      cmdM   jsr  getpa  get parameter
00769 0413 24 04      0419          bcc  cmdMz  ignore if absent
00770 0415 B7 B9          sta  MODE
00771 0417 1E B9          bset  ACK,MODE acknowledge
00772 0419 81          cmdMz  rts

00774                    * write to Primary DAC buffer 2's complement of input parameters
00775 041A CD 042D      cmdP   jsr  getpw  get word parameter
00776 041D 24 0D      042C          bcc  cmdPz  part is missing
00777 041F CD 043C          jsr  paneg
00778 0422 B6 BE          lda  PARH  output high part
00779 0424 AD 21      0447          bsr  cmdPh
00780 0426 B6 BF          lda  PARL
00781 0428 AD 2A      0454          bsr  cmdP1
00782 042A 1E B9          bset  ACK,MODE acknowledge
00783 042C 81          cmdPz  rts

00785                    * get two bytes as a word parameter into PARH:PARL
00786                    * return with carry clear if characters are absent or invalid
00787 042D CD 02CF      getpw  jsr  getpa  get high byte
00788 0430 24 09      043B          bcc  getpwz  ignore if absent
00789 0432 B7 BE          sta  PARH
00790 0434 CD 02CF          jsr  getpa  get high byte
00791 0437 24 02      043B          bcc  getpwz  ignore if absent
00792 0439 B7 BF          sta  PARL
00793 043B 81          getpwz  rts

00795                    * parameter PARH:PARL negate
00796 043C 4F          paneg  clra
00797 043D B0 BF          sub  PARL
00798 043F B7 BF          sta  PARL
00799 0441 4F          clra
00800 0442 B2 BE          sbc  PARH
00801 0444 B7 BE          sta  PARH
00802 0446 81            rts

00804 0447 9B          cmdPh  sei           protect sequence
00805 0448 B7 00          sta  PA  output high byte to Primary DAC
00806 044A 13 01          bclr  NWRHB,PB select high byte
00807 044C 10 01          bset  NWRLB,PB but not low byte
00808 044E 1B 02          bclr  N1145P,PC
00809 0450 1A 02          bset  N1145P,PC
00810 0452 9A            cli           allow interrupts again
00811 0453 81            rts

00813 0454 9B          cmdP1  sei           protect sequence
00814 0455 B7 00          sta  PA  output low byte to Primary DAC
00815 0457 11 01          bclr  NWRLB,PB select low byte

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00816 0459 12 01          bset  NWRHB,PB but not high byte
00817 045B 1B 02          bclr  N1145P,PC
00818 045D 1A 02          bset  N1145P,PC
00819 045F 9A             cli    allow interrupts again
00820 0460 81             rts

00822                    * Read precision ADC 20 times
00823 0461 3F 5E          cmdQ  clr  FPTO    counter
00824 0463 AD 0C          0471 cmdQ1 bsr  cmdR    do reading
00825 0465 CD 0F8B          jsr  cr1f
00826 0468 3C 5E          inc  FPTO
00827 046A B6 5E          lda  FPTO
00828 046C A1 14          cmp  #20
00829 046E 26 F3          0463  bne  cmdQ1
00830 0470 81             rts

00832                    * Read precision ADC as 6+2 hex characters
00833 0471                    cmdR  brcl  NEXT,MODE,cmdR2
00834 0475                    cmdR1 brst  0,PADCST,cmdR1
00835 0479 9B                    cmdR2 sei    protect transfer
00836 047A 5F                    clrx
00837 047B E6 AE          cmdR3 lda  PADCR,x copy data and status
00838 047D E7 B2                    sta  PADCC,x
00839 047F 5C                    incx
00840 0480 A3 04          cpx  #4
00841 0482 26 F7          047B  bne  cmdR3
00842 0484 10 B1          bset  0,PADCST set lsb to indicate data has been read
00843 0486 9A                    cli
00844 0487 5F                    clrx
00845 0488 E6 B2          cmdR4 lda  PADCC,x output from high byte to low byte
00846 048A CD 030E          jsr  casb
00847 048D 5C                    incx
00848 048E A3 04          cpx  #4
00849 0490 26 F6          0488  bne  cmdR4
00850 0492 1E B9          bset  ACK,MODE acknowledge
00851 0494 81             rts

00853                    * write to Secondary DAC buffer 2's complement of input parameters
00854 0495 CD 042D          cmdS  jsr  getpw  get word parameter
00855 0498 24 0D          04A7  bcc  cmdSz  part is missing
00856 049A CD 043C          jsr  paneg
00857 049D B6 BE          lda  PARH    output high part
00858 049F AD 07          04A8  bsr  cmdSh
00859 04A1 B6 BF          lda  PARL
00860 04A3 AD 10          04B5  bsr  cmdS1
00861 04A5 1E B9          bset  ACK,MODE acknowledge
00862 04A7 81             cmdSz rts

00864 04A8 9B                    cmdSh sei    protect sequence
00865 04A9 B7 00          sta  PA    output high byte to Secondary DAC
00866 04AB 13 01          bclr  NWRHB,PB select high byte
00867 04AD 10 01          bset  NWRLB,PB but not low byte
00868 04AF 19 02          bclr  N1145S,PC
00869 04B1 18 02          bset  N1145S,PC
00870 04B3 9A             cli    allow interrupts again
00871 04B4 81             rts

00873 04B5 9B                    cmdS1 sei    protect sequence
00874 04B6 B7 00          sta  PA    output low byte to Secondary DAC
00875 04B8 11 01          bclr  NWRLB,PB select low byte
00876 04BA 12 01          bset  NWRHB,PB but not high byte
00877 04BC 19 02          bclr  N1145S,PC
00878 04BE 18 02          bset  N1145S,PC
00879 04C0 9A             cli    allow interrupts again
00880 04C1 81             rts

00882                    * if parameter='P' then protect
00883                    * if parameter='U' then unprotect

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00884          * any other parameter is invalid
00885 04C2 CD 02BD      cmdT  jsr  ibnc
00886 04C5 24 29      04F0    bcc  cmdTz  no parameter
00887 04C7 A1 50          cmp  #'P
00888 04C9 27 09      04D4    beq  cmdT1
00889 04CB A1 55          cmp  #'U      unprotect
00890 04CD 26 21      04F0    bne  cmdTz
00891 04CF CD 04F1      jsr  unp
00892 04D2 20 1A      04EE    bra  cmdT2
00893 04D4          cmdT1  dely  1
00894 04DC 9B          sei          should be OK for approx 1ms but protect anyway
00895 04DD A6 7F          lda  #$7F    address to read then write
00896 04DF B7 BE          sta  PARH
00897 04E1 A6 FF          lda  #$FF
00898 04E3 B7 BF          sta  PARL
00899 04E5 CD 058F      jsr  eepr
00900 04E8 B7 BD          sta  PARAM  PARAM=contents of ($7FFF)
00901 04EA 9A          cli
00902 04EB CD 0527      jsr  prot
00903 04EE 1E B9      cmdT2  bset  ACK,MODE
00904 04F0 81      cmdTz  rts

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00906          * issue obscure control sequence to remove protection from EEPROM
00907 04F1          unp  dely  1
00908 04F9 9B          sei          should be OK for approx 1ms but protect anyway
00909 04FA 5F          clr          work through table
00910 04FB D6 0569      unpi  lda  cmdTb2,x
00911 04FE CD 0D57      jsr  spioi
00912 0501 5C          incx
00913 0502 D6 0569      lda  cmdTb2,x
00914 0505 CD 0D57      jsr  spioi
00915 0508 5C          incx
00916 0509 D6 0569      lda  cmdTb2,x  get data
00917 050C B7 00          sta  PA      onto bus
00918 050E 14 01          bset  NRD,PB  set up control lines
00919 0510 17 01          bclr  NWR,PB
00920 0512 1F 02          bclr  NEEP,PC  and enable
00921 0514 1E 02          bset  NEEP,PC
00922 0516 16 01          bset  NWR,PB
00923 0518 5C          incx
00924 0519 A1 20          cmp  #$20
00925 051B 26 DE      04FB    bne  unpi
00926 051D 9A          cli
00927 051E          dely  4
00928 0526 81          rts

```

```

00930          * issue obscure control sequence to create protection for EEPROM
00931 0527          prot dely  1
00932 052F 9B          sei          should be OK for approx 1ms but protect anyway
00933 0530 5F          clr          work through table
00934 0531 D6 0560      prot1 lda  cmdTb1,x
00935 0534 CD 0D57      jsr  spioi
00936 0537 5C          incx
00937 0538 D6 0560      lda  cmdTb1,x  get data
00938 053B CD 0D57      jsr  spioi
00939 053E 5C          incx
00940 053F D6 0560      lda  cmdTb1,x  get data
00941 0542 B7 00          sta  PA      onto bus
00942 0544 14 01          bset  NRD,PB  set up control lines
00943 0546 17 01          bclr  NWR,PB
00944 0548 1F 02          bclr  NEEP,PC  and enable
00945 054A 1E 02          bset  NEEP,PC
00946 054C 16 01          bset  NWR,PB
00947 054E 5C          incx
00948 054F A1 A0          cmp  #$A0
00949 0551 26 DE      0531    bne  prot1
00950 0553 CD 05AA      jsr  eepr  write byte previously read
00951 0556 9A          cli

```

```

00952 0557                dely 4
00953 055F 81            rts

00955 0560 55            cmdTb1 fcb $55,$55,$AA protect sequence
00956 0563 2A            fcb $2A,$AA,$55
00957 0566 55            fcb $55,$55,$A0

00959 0569 55            cmdTb2 fcb $55,$55,$AA unprotect sequence
00960 056C 2A            fcb $2A,$AA,$55
00961 056F 55            fcb $55,$55,$80
00962 0572 55            fcb $55,$55,$AA
00963 0575 2A            fcb $2A,$AA,$55
00964 0578 55            fcb $55,$55,$20

00967                    * read state of DIL switches and output as hex pair
00968 057B 9B            cmdU sei protect transfer
00969 057C 3F 04        clr DDRA change bus to inputs
00970 057E 13 02        bclr NSIS,PC enable buffer U22
00971 0580 9D            nop a few us to settle
00972 0581 86 00        lda PA get data
00973 0583 12 02        bset NSIS,PC release bus
00974 0585 33 04        com DDRA restore to outputs
00975 0587 9A            cli
00976 0588 43            coma change polarity
00977 0589 CD 030E      jsr casb
00978 058C 1E B9        bset ACK,MODE acknowledge
00979 058E 81            rts

00981                    * read EEPROM at address given in PARH:PARL
00982                    * should be called from interrupt-protected environment
00983 058F B6 BE            eepr lda PARH output address
00984 0591 CD 0D57        jsr spioi via SPI
00985 0594 B6 BF            lda PARL
00986 0596 CD 0D57        jsr spioi
00987 0599 3F 04        clr DDRA change to inputs
00988 059B 15 01        bclr NRD,PB set up control lines
00989 059D 16 01        bset NWR,PB
00990 059F 1F 02        bclr NEEP,PC and enable
00991 05A1 B6 00        lda PA get data
00992 05A3 1E 02        bset NEEP,PC
00993 05A5 14 01        bset NRD,PB
00994 05A7 33 04        com DDRA change back to outputs
00995 05A9 81            rts

00998                    * write to EEPROM at address given in PARH:PARL
00999                    * with data in PARAM
01000                    * should be called from interrupt-protected environment
01001 05AA B6 BE            eepr lda PARH output address
01002 05AC CD 0D57        jsr spioi via SPI
01003 05AF B6 BF            lda PARL
01004 05B1 CD 0D57        jsr spioi
01005 05B4 B6 BD            lda PARAM get data
01006 05B6 B7 00        sta PA onto bus
01007 05B8 14 01        bset NRD,PB set up control lines
01008 05BA 17 01        bclr NWR,PB
01009 05BC 1F 02        bclr NEEP,PC and enable
01010 05BE 1E 02        bset NEEP,PC
01011 05C0 16 01        bset NWR,PB
01012 05C2 81            rts

01015                    * read a block of bytes from the EEPROM U4
01016                    * because address is controlled by SPI interface this routine is
01017                    * interlaced with interrupt timing
01018 05C3 CD 042D        cmdV jsr getpw get word into PARH:PARL as start address
01019 05C6 24 21 05E9    bcc cmdVz part is missing

```

```

01020 05C8 CD 02CF          jsr  getpa  get byte into PARAM as counter
01021 05CB 24 1C    05E9    bcc  cmdVz  part is missing
01022 05CD          cmdV1  dely  1
01023 05D5 9B          sei          should be OK for approx 1ms but protect anyway
01024 05D6 CD 058F          jsr  eepr   read EEPROM
01025 05D9 9A          cli          allow interrupts again
01026 05DA CD 030E          jsr  casb  output in hex
01027 05DD 3C BF          inc  PARL  increment address
01028 05DF 26 02    05E3    bne  cmdV2
01029 05E1 3C BE          inc  PARH
01030 05E3 3A BD          cmdV2  dec  PARAM  reduce loop counter
01031 05E5 26 E6    05CD    bne  cmdV1
01032 05E7 1E B9          bset ACK,MODE acknowledge
01033 05E9 81          cmdVz  rts

```

```

01035          * write a byte to the EEPROM U4
01036          * because address is controlled by SPI interface this routine is
01037          * interlaced with interrupt timing
01038 05EA CD 042D          cmdW  jsr  getpw  get word parameter into PARH:PARL
01039 05ED 24 25    0614    bcc  cmdWz  part is missing
01040 05EF CD 02CF          jsr  getpa  get byte parameter into PARAM
01041 05F2 24 20    0614    bcc  cmdWz  part is missing
01042 05F4          dely  1
01043 05FC 9B          sei          should be OK for approx 1ms but protect anyway
01044 05FD CD 05AA          jsr  eepr   write to EEPROM
01045 0600 9A          cli          allow interrupts again
01046 0601          dely  4
01047 0609 9B          sei          should be OK for approx 1ms but protect anyway
01048 060A CD 058F          jsr  eepr   read from EEPROM
01049 060D 9A          cli          allow interrupts again
01050 060E B1 BD          cmp  PARAM  see if byte was written OK
01051 0610 26 02    0614    bne  cmdWz  leave as negative acknowledge
01052 0612 1E B9          bset ACK,MODE acknowledge
01053 0614 81          cmdWz  rts

```

```

01055          * read moving average of precision adc in hex
01056          * this is in PADCA, PADCA+1 and PADCA+2 and may be modified
01057          * during timer interrupt. Care is take to interlace readings.
01058 0615          cmdX  dely  1
01059 061D 9B          sei          should be OK for approx 1ms but protect anyway
01060 061E B6 B8          lda  PADCA+2
01061 0620 B7 BD          sta  PARAM
01062 0622 B6 B7          lda  PADCA+1
01063 0624 B7 BF          sta  PARL
01064 0626 B6 B6          lda  PADCA
01065 0628 B7 BE          sta  PARH  copy to temporary area
01066 062A 9A          cli
01067 062B CD 030E          jsr  casb  now output as 6 hex characters
01068 062E B6 BF          lda  PARL
01069 0630 CD 030E          jsr  casb
01070 0633 B6 BD          lda  PARAM
01071 0635 CD 030E          jsr  casb
01072 0638 1E B9          bset ACK,MODE acknowledge
01073 063A 81          rts

```

```

01076          * copy current MAX132 U25 readings and output in hex
01077 063B CD 0ADF          cmdY  jsr  adccp  copy block with interrupt protect
01078 063E 5F          clrx
01079 063F E6 88          cmdY1 lda  ADCC,x  get byte(s)
01080 0641 CD 030E          jsr  casb  and output in hex pairs
01081 0644 5C          incx
01082 0645 A3 18          cpx  #ADCLEN
01083 0647 26 F6    063F    bne  cmdY1
01084 0649 1E B9          bset ACK,MODE acknowledge
01085 064B 81          rts

```

```

01087          * update some/all DACS if buffer empties DAC value does not change

```

```

01088 064C CD 0495      cmdZ  jsr  cmdS      update Secondary DAC
01089 064F              brc|  ACK,MODE,cmdZz
01090 0653 CD 041A      jsr  cmdP      update Primary DAC
01091 0656 CD 03DA      jsr  cmdH      update Heater DAC
01092 0659 CD 040A      jsr  cmdL      load all DACs simultaneously
01093 065C 81          cmdZz  rts

01095                  * interpreter code structure
01096                  * a single code-byte consists of two 4-bit codes each called 'fop'.
01097                  * 'fop' indicates one of 16 operations and may require an additional
01098                  * 4 bits of 'sub' code, as well as additional bytes for operand(s).
01099                  * Within a byte if 'fop' is in the high nibble then the ssub-code is
01100                  * taken from the right nibble; if 'fop' is in the right nibble and a
01101                  * sub-code is needed then zero is assumed.

01103                  * define 'fop's ; fopdef creates table entries and offsets
01104                  * by concatenating 'f'+arg' and 'fp'+arg. See macro definition
01105                  * basic floating point operations jump table
01106                  foptab equ  *
01107 065D              fopdef  nop
01108 065F              fopdef  sld1
01109 0661              fopdef  sst1
01110 0663              fopdef  sld2
01111 0665              fopdef  ld1
01112 0667              fopdef  st1
01113 0669              fopdef  ld2
01114 066B              fopdef  add
01115 066D              fopdef  sub
01116 066F              fopdef  mul
01117 0671              fopdef  div
01118 0673              fopdef  br
01119 0675              fopdef  fun
01120 0677              fopdef  cnt
01121 0679              fopdef  adc
01122 067B 0726        fdb   fpnop    F

01124                  * branch group jump table
01125                  fbrtab equ  *
01126 067D              fbrdef  bra
01127 067F              fbrdef  beq
01128 0681              fbrdef  bne
01129 0683              fbrdef  bpl
01130 0685              fbrdef  bmi
01131 0687              fbrdef  call
01132 0689              fbrdef  ret
01133 068B              fbrdef  exit
01134 068D              fbrdef  wt
01135 068F              fbrdef  syn
01136 0691              fbrdef  bc
01137 0693              fbrdef  bs
01138 0695              fbrdef  dly
01139 0697 0726        fdb   fpnop    D
01140 0699 0726        fdb   fpnop    E
01141 069B 0726        fdb   fpnop    F

01146                  * function group jump table
01147                  funtab equ  *
01148 069D              fundef  clr
01149 069F              fundef  abs
01150 06A1              fundef  neg
01151 06A3              fundef  sgn
01152 06A5              fundef  sqrt
01153 06A7              fundef  sqr
01154 06A9              fundef  swp
01155 06AB              fundef  fix

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```

01156 06AD                fundef flt
01157 06AF                fundef int
01158 06B1                fundef frac
01159 06B3                fundef out
01160 06B5                fundef crlf
01161 06B7                fundef spac
01162 06B9 0726          fdb  fprop  E
01163 06BB 0726          fdb  fprop  F

01165                    * start of interpreter - may also be entered at fintp1 to continue
01166                    *****

01168 06BD BF 6A          fintp stx  SMODC+1  high part of source address
01169 06BF B7 6B          sta  SMODC+2  low part of source address
01170 06C1 CD 070F        fintp1 jsr  gnb     get next byte to interpret
01171 06C4 B7 68          sta  FCODE     save code for later
01172 06C6 3F 67          clr  FLAGS
01173 06C8 44            lsra
01174 06C9 44            lsra
01175 06CA 44            lsra
01176 06CB 44            lsra
01177 06CC CD 06ED        jsr  fdec     execute using foptab
01178 06CF                brst flnoex,FLAGS,fintp2
01179 06D3 B6 68          lda  FCODE
01180 06D5 A4 0F          and  #$0F     get low nibble
01181 06D7 3F 68          clr  FCODE     default sub-code to zero
01182 06D9 CD 06ED        jsr  fdec     execute
01183 06DC                fintp2 brcl flexit,FLAGS,fintp1
01184 06E0 81            rts         return

01186                    * set up table offset to access branch group
01187 06E1 12 67          fpbr bset flnoex,FLAGS
01188 06E3 AE 20          ldx  #fbtab-foptab form offset
01189 06E5 20 08          bra  fdec1    06EF

01191                    * set up table offset to access function group
01192 06E7 12 67          fpfun bset flnoex,FLAGS
01193 06E9 AE 40          ldx  #funtab-foptab form offset
01194 06EB 20 02          bra  fdec1    06EF

01196                    * main decoder using look-up tables
01197 06ED AE 00          fdec ldx  #foptab-foptab
01198 06EF BF 5E          fdec1 stx  FPT0     store offset
01199 06F1 48            lsra     form word offset
01200 06F2 BB 5E          add  FPT0     point to right table
01201 06F4 97            tax
01202 06F5 D6 065D        lda  foptab,x get jump address
01203 06F8 B7 6E          sta  SMODC+5 into self modifying code
01204 06FA D6 065E        lda  foptab+1,x
01205 06FD B7 6F          sta  SMODC+6
01206 06FF B6 68          lda  FCODE     copy of low nibble code if required
01207 0701 A4 0F          and  #$0F     mask out high bits
01208 0703 BC 6D          jmp  SMODC+4 execute

01210                    * convert number in x into bit position in A
01211 0705 A4 07          convb and  #$07
01212 0707 97            tax
01213 0708 4F            clra
01214 0709 99            sec
01215 070A 49          convb1 rola
01216 070B 5A          decx
01217 070C 2A FC        bpl  convb1    070A
01218 070E 81            rts

01220                    * get next byte from stream being interpreted and increment address
01221 070F BD 69          gnb  jsr  SMODC  a=code byte
01222 0711 3C 6B          sminc inc  SMODC+2 increment address
01223 0713 26 02          bne  smincz    0717

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01224 0715 3C 6A          inc  SMODC+1
01225 0717 81          smincz rts

01227          * add accumulator to address with sign extension
01228 0718 4D          smadd tsta          sign extend first
01229 0719 2A 02      071D    bpl  smadd1
01230 071B 3A 6A          dec  SMODC+1  reduce high byte of address
01231 071D BB 6B          smadd1 add  SMODC+2  add to low byte
01232 071F B7 6B          sta  SMODC+2
01233 0721 24 02      0725    bcc  smaddz
01234 0723 3C 6A          inc  SMODC+1  correct high byte
01235 0725 81          smaddz rts

01239          * no operation
01240          *****

01242 0726 81          fmnop rts          return with no other operation

01245          * load and store operations
01246          *****

01248          * load FP1 using code in low nibble of A
01249 0727 12 67      fpsld1 bset flnoex,FLAGS indicate no execution of low-nibble code
01250 0729 CD 07E7    jsr  cstol  convert short to long code
01251 072C 20 03      0731    bra  fpldia

01253          * load FP1 from source determined by x
01254 072E CD 070F    fpld1 jsr  gnb  get next byte
01255 0731 CD 07E0    fpldia jsr  compx compute value of x
01256 0734 25 2A      0760    bcs  fpllx  load from external device = EEPROM
01257 0736 27 02      073A    beq  fpllra load from ram
01258 0738 26 11      074B    bne  fpllro load from rom

01260          * load FP1 from page zero using x as offset i.e. FP1=(RAM)
01261 073A E6 30      fpllra lda  fpram,x
01262 073C B7 34          sta  FP1EX
01263 073E E6 31          lda  fpram+1,x
01264 0740 B7 35          sta  FP1HB
01265 0742 E6 32          lda  fpram+2,x
01266 0744 B7 36          sta  FP1MB
01267 0746 E6 33          lda  fpram+3,x
01268 0748 B7 37          sta  FP1LB
01269 074A 81          rts

01271          * load FP1 from constants in ROM using x as offset i.e. FP1=(ROM)
01272 074B D6 0CDE    fpllro lda  fprom,x
01273 074E B7 34          sta  FP1EX
01274 0750 D6 0CDF    lda  fprom+1,x
01275 0753 B7 35          sta  FP1HB
01276 0755 D6 0CE0    lda  fprom+2,x
01277 0758 B7 36          sta  FP1MB
01278 075A D6 0CE1    lda  fprom+3,x
01279 075D B7 37          sta  FP1LB
01280 075F 81          rts

01282          * load FP1 from constants in EEPROM using a as offset/2 i.e. FP1=(EEPROM)
01283 0760 AD 1C      077E fpllx bsr  fplx  load external to CMDBUF
01284 0762 AE 34          ldx  #FP1
01285 0764 20 04      076A    bra  fp21x1
01286          * load FP1 from constants in EEPROM using a as offset/2 i.e. FP1=(EEPROM)
01287 0766 AD 16      077E fp21x bsr  fplx  load external to CMDBUF
01288 0768 AE 38          ldx  #FP2
01289 076A C6 0100    fp21x1 lda  CMDBUF  now copy to FPx
01290 076D F7          sta  ,x
01291 076E C6 0101    lda  CMDBUF+1

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01292 0771 E7 01          sta 1,x
01293 0773 C6 0102       lda CMDBUF+2
01294 0776 E7 02          sta 2,x
01295 0778 C6 0103       lda CMDBUF+3
01296 077B E7 03          sta 3,x
01297 077D 81            rts

01299                    * not yet implemented
01300                    * action is to copy 4 bytes of EEPROM to CMDBUF
01301 077E 48            fplx asla          move msb of offset to carry
01302 077F 5F            clr x
01303 0780 59            rol x          and then into x
01304                    * now copy from assigned location plus offset
01305 0781 81            rts

01307                    * store FP1 using code in low nibble of A
01308 0782 12 67         fpsst1 bset flnoex,FLAGS indicate no execution of low-nibble code
01309 0784 CD 07E7       jsr cstol      convert short to long code
01310 0787 20 03 078C    bra fpstla

01312                    * store FP1 to destination determined by x
01313 0789 CD 070F       fpst1 jsr gnb   get next byte
01314 078C CD 07E0       fpstla jsr compx compute value of x
01315 078F 25 04 0795   bcs fpstlz     external not yet defined
01316 0791 27 03 0796   beq fplsra     store to ram
01317 0793 26 00 0795   bne fpstlz     store to rom not defined
01318 0795 81          fpstlz rts          load FP1

01320                    * store FP1 to page zero using x as offset i.e. (RAM)=FP1
01321 0796 B6 34         fplsra lda FP1EX
01322 0798 E7 30          sta fpram,x
01323 079A B6 35          lda FP1HB
01324 079C E7 31          sta fpram+1,x
01325 079E B6 36          lda FP1MB
01326 07A0 E7 32          sta fpram+2,x
01327 07A2 B6 37          lda FP1LB
01328 07A4 E7 33          sta fpram+3,x
01329 07A6 81            rts

01331                    * load FP2 using code in low nibble of A
01332 07A7 12 67         fpsld2 bset flnoex,FLAGS indicate no execution of low-nibble code
01333 07A9 CD 07E7       jsr cstol      convert short to long code
01334 07AC 20 03 07B1   bra fpld2a

01336                    * load FP2 from source determined by x
01337 07AE CD 070F       fpld2 jsr gnb   get next byte
01338 07B1 CD 07E0       fpld2a jsr compx compute value of x
01339 07B4 25 80 0766   bcs fp21x     load from external device = EEPROM
01340 07B6 27 02 07BA   beq fp21ra    load from ram
01341 07B8 26 11 07CB   bne fp21ro    load from rom

01343                    * load FP2 from page zero using x as offset i.e. FP1=(RAM)
01344 07BA E6 30         fp21ra lda fpram,x
01345 07BC B7 38          sta FP2EX
01346 07BE E6 31          lda fpram+1,x
01347 07C0 B7 39          sta FP2HB
01348 07C2 E6 32          lda fpram+2,x
01349 07C4 B7 3A          sta FP2MB
01350 07C6 E6 33          lda fpram+3,x
01351 07C8 B7 3B          sta FP2LB
01352 07CA 81            rts

01354                    * load FP2 from constants in ROM using x as offset i.e. FP2=(ROM)
01355 07CB D6 0CDE       fp21ro lda fprom,x
01356 07CE B7 38          sta FP2EX
01357 07D0 D6 0CDF       lda fprom+1,x
01358 07D3 B7 39          sta FP2HB
01359 07D5 D6 0CE0       lda fprom+2,x

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01360 07D8 B7 3A          sta  FP2MB
01361 07DA D6 0CE1       lda  fprom+3,x
01362 07DD B7 3B          sta  FP2LB
01363 07DF 81            rts

01365                    * support routines used by above load/store operations
01366                    * input 00xxxxxx = RAM          output x=xxxxxx00
01367                    *      01xxxxxx = ROM          a=yyyyyyy0
01368                    *      1yyyyyyy = External

01369 07E0 97          compx tax          copy of byte code number
01370 07E1 58          aslx
01371 07E2 58          aslx          x=?????00
01372 07E3 48          asla
01373 07E4 A5 80       bit   #$80      CY=1 if external, CY=0 if internal
01374 07E6 81          rts          if CY=0 then Z=1 if RAM, Z=0 if rom

01376                    * converts 0000?xxx to 0?000xxx; ?=0=>RAM, ?=1=>ROM, xxx=FPx or FKx
01377                    * 0 to 7 => RAM FP0 to FP7
01378                    * 8 to 15 => ROM FK0 to FK7
01379 07E7 AB 08       cstol add   #$08      find out if bit #3 is set
01380 07E9 29 04       07EF bhcs cstol1
01381 07EB A4 07          and   #$07      remove bit #3
01382 07ED 20 02       07F1 bra    cstolz
01383 07EF AB 30       cstol1 add  #$30      move to bit #6
01384 07F1 81          cstolz rts

01386                    * basic floating point operation fsub, fpadd, fpmul and fpdiv
01387                    *****

01389                    * floating point subtract
01390 07F2 CD 0964       fsub jsr  fp2tst  nothing to do if FP2=0
01391 07F5 27 08       07FF beq  fsubz
01392 07F7 86 39          lda  FP2HB      toggle sign bit
01393 07F9 A8 80          eor  #$80
01394 07FB B7 39          sta  FP2HB
01395 07FD 20 06       0805 bra  fpadd0
01396 07FF 81          fsubz rts

01398                    * floating point add
01399 0800 CD 0964       fpadd jsr  fp2tst  nothing to do if FP2=0
01400 0803 27 6C       0871 beq  fpaddz
01401 0805 CD 0960       fpadd0 jsr  fp1tst  test FP1
01402 0808 27 13       081D beq  fpadd2  result is FP2
01403 080A B6 34          lda  FP1EX      find difference between exponents
01404 080C B0 38          sub  FP2EX
01405 080E 97          tax          keep count
01406 080F 26 05       0816 bne  fpadd1
01407 0811 CD 08EC          jsr  fppre     prepare mantissas
01408 0814 20 30       0846 bra  fpadd7     continue immediately - no shifts necessary
01409 0816 24 1E       0836 fpadd1 bcc  fpadd5     branch if FP1EX > FP2EX
01410 0818 40          nega          find positive difference
01411 0819 A1 18          cmp  #24      test for worthwhile shift
01412 081B 25 07       0824 bcs  fpadd3     do shift
01413 081D AE 08          fpadd2 ldx  #FP2-fpram
01414 081F CD 073A          jsr  fp1lra   FP1=FP2
01415 0822 20 4D       0871 bra  fpaddz
01416 0824 B6 38          fpadd3 lda  FP2EX      set up exponent of result
01417 0826 B7 34          sta  FP1EX
01418 0828 CD 08EC          jsr  fppre     prepare
01419 082B 34 35       fpadd4 lsr  FP1HB
01420 082D 36 36          ror  FP1MB
01421 082F 36 37          ror  FP1LB
01422 0831 5C          incx
01423 0832 26 F7       082B bne  fpadd4
01424 0834 20 10       0846 bra  fpadd7
01425 0836 A1 18          fpadd5 cmp  #24      test for worthwhile shift
01426 0838 24 37       0871 bcc  fpaddz     FP2 is too small therefore result is FP1
01427 083A CD 08EC          jsr  fppre     prepare

```



```

01428 083D 34 39          fpadd6 lsr  FP2HB  do shift
01429 083F 36 3A          ror   FP2MB
01430 0841 36 3B          ror   FP2LB
01431 0843 5A             decx
01432 0844 26 F7 083D    bne   fpadd6
01433 0846             fpadd7 brst  7,FPRSGN,fpadd8
01434 084A CD 09A5        jsr   uadd  addition may cause carry
01435 084D CD 0925        jsr   norm
01436 0850 B6 64          lda   FP2SGN
01437 0852 B7 65          sta   FPRSGN  make sign of result = sign of original FP2
01438 0854 20 18 086E    bra   fpaddb now restore expected sign
01439 0856 CD 0987        fpadd8 jsr   usub
01440             * FP1 FP2  abs(FP1)-abs(FP2)  required sign  use
01441             * +4 -2   4-2 => + => CY=0      +          sign (FP1)
01442             * +4 -5   4-5 => - => CY=1      -          sign (FP2)
01443             * -4 +2   4-2 => + => CY=0      -          sign (FP1)
01444             * -4 +5   4-5 => - => CY=1      +          sign (FP2)
01445             * if CY=0 restore sign(FP1) else restore sign(FP2)
01446 0859 24 09 0864    bcc   fpadd9  CY=0 if abs(FP1)>abs(FP2)
01447 085B CD 0872        jsr   ineg
01448 085E B6 64          lda   FP2SGN
01449 0860 B7 65          sta   FPRSGN  make sign of result = sign of original FP2
01450 0862 20 04 0868    bra   fpadda
01451 0864 B6 63          fpadd9 lda   FP1SGN
01452 0866 B7 65          sta   FPRSGN  make sign of result = sign of original FP1
01453 0868 3F 5F          fpadda clr  FP1GB  guard byte = 0
01454 086A 98             clc
01455 086B CD 0925        jsr   norm
01456 086E CD 0905        fpaddb jsr   fpend  restore correct sign
01457 0871 81             fpaddz rts

01459             * integer negate of FP1 mantissa
01460 0872 4F             ineg  clra  negate result
01461 0873 B0 37          sub   FP1LB
01462 0875 B7 37          sta   FP1LB
01463 0877 4F             clra
01464 0878 B2 36          sbc   FP1MB
01465 087A B7 36          sta   FP1MB
01466 087C 4F             clra
01467 087D B2 35          sbc   FP1HB
01468 087F B7 35          sta   FP1HB
01469 0881 81             rts

01471             * floating point multiply
01472 0882 CD 0960        fpmul jsr   fpltst  if FP1=0 then
01473 0885 27 26 08AD    beq   fpmulz  exit
01474 0887 CD 0964        jsr   fp2tst  if FP2=0
01475 088A 26 05 0891    bne   fpmul0  then
01476 088C CD 0B2F        jsr   fpiclr  FP1=0
01477 088F 20 1C 08AD    bra   fpmulz  exit
01478 0891 CD 08EC        fpmul0 jsr   fppre  prepare
01479 0894 CD 09B9        jsr   umul   multiply mantissas and return with cy=0
01480 0897 CD 0925        jsr   norm   normalise
01481 089A B6 34          lda   FP1EX  add exponents with byte extension
01482 089C BB 38          add   FP2EX
01483 089E 24 02 08A2    bcc   fpmul1
01484 08A0 3C 60          inc   FPEXE  correct extension byte
01485 08A2 A0 80          fpmul1 sub  #$80  remove one bias
01486 08A4 B7 34          sta   FP1EX
01487 08A6 24 02 08AA    bcc   fpmul2
01488 08A8 3A 60          dec   FPEXE  correct extension byte
01489 08AA CD 0905        fpmul2 jsr   fpend  see if exponent is too big/small
01490 08AD 81             fpmulz rts

01492             * floating point divide
01493 08AE CD 0960        fpdiv jsr   fpltst  if FP1=0 then
01494 08B1 27 FA 08AD    beq   fpmulz  exit
01495 08B3 CD 0964        jsr   fp2tst  if FP2=0

```

```

01496 0886 26 0B 08C3 bne fpdiv0 then
01497 0888 B6 35 lda FP1HB set up Result Sign = sign of FP1
01498 088A A4 80 and #$80
01499 088C B7 65 sta FPRSGN
01500 08BE CD 0976 jsr fplmax FP1=max
01501 08C1 20 EA 08AD bra fpmulz exit
01502 08C3 CD 08EC fpdiv0 jsr fppre prepare
01503 08C6 3F 5E clr FPT0
01504 08C8 3F 5D clr FPT1
01505 08CA 3F 5C clr FPT2
01506 08CC CD 0A6B jsr udiv divide mantissas msb in CY
01507 08CF 39 5F rol FP1GB save in Guard Byte
01508 08D1 B6 34 lda FP1EX subtract exponents with byte extension
01509 08D3 B0 38 sub FP2EX
01510 08D5 24 02 08D9 bcc fpdiv1
01511 08D7 3A 60 dec FPEXE correct extension byte
01512 08D9 AB 80 fpdiv1 add #$80 restore bias
01513 08DB B7 34 sta FP1EX
01514 08DD 24 02 08E1 bcc fpdiv2
01515 08DF 3C 60 inc FPEXE correct extension byte
01516 08E1 36 5F fpdiv2 ror FP1GB get msb
01517 08E3 3F 5F clr FP1GB
01518 08E5 CD 0925 jsr norm
01519 08E8 CD 0905 jsr fpend see if exponent is too big/small
01520 08EB 81 fpdivz rts

```

```

01523 * support routines used by fpsub, fpadd, fpmul and fpdiv
01524 * prepare to do fp operation - compute sign of result and set msb's
01525 08EC 3F 60 fppre clr FPEXE clear exponent extension
01526 08EE 3F 66 clr FPERR remove error
01527 08F0 B6 35 lda FP1HB
01528 08F2 A4 80 and #$80
01529 08F4 B7 63 sta FP1SGN sign of FP1
01530 08F6 B6 39 lda FP2HB
01531 08F8 A4 80 and #$80
01532 08FA B7 64 sta FP2SGN sign of FP2
01533 08FC B8 63 eor FP1SGN
01534 08FE B7 65 sta FPRSGN sign FP1 exor sign FP2
01535 0900 1E 35 bset 7,FP1HB set msb's
01536 0902 1E 39 bset 7,FP2HB
01537 0904 81 rts

```

```

01539 * end fp operation - test for errors, restore sign etc.
01540 0905 3D 60 fpend tst FPEXE FPEXE Condition
01541 0907 27 0E 0917 beq fpend2 =0 no error
01542 0909 2B 07 0912 bmi fpend1 <0 underflow
01543 090B 12 66 bset over,FPERR >0 overflow
01544 090D CD 0976 jsr fplmax set to max value using FPRSGN
01545 0910 20 12 0924 bra fpendz
01546 0912 CD 082F fpdiv1 jsr fplclr
01547 0915 20 0D 0924 bra fpendz
01548 0917 CD 0960 fpdiv2 jsr fpltst alter sign if non-zero
01549 091A 27 08 0924 beq fpendz
01550 091C B6 35 lda FP1HB
01551 091E A4 7F and #$7F remove normalised bit
01552 0920 BA 65 ora FPRSGN combine with required sign for result
01553 0922 B7 35 sta FP1HB
01554 0924 81 fpdivz rts

```

```

01556 * normalise mantissa so that msb=1
01557 0925 24 0B 0932 norm bcc norm0
01558 0927 36 35 ror FP1HB
01559 0929 36 36 ror FP1MB
01560 092B 36 37 ror FP1LB
01561 092D CD 0952 jsr incex increment exponent
01562 0930 20 1F 0951 bra normz exit
01563 0932 B6 35 norm0 lda FP1HB nothing to do if msb=1

```

```

01564 0934 2B 1B 0951      bmi   normz   so exit
01565 0936 BA 36           ora   FP1MB   test for zero
01566 0938 BA 37           ora   FP1LB
01567 093A 26 08 0944      bne   norm2
01568 093C B7 34           sta   FP1EX   force FP1=0
01569 093E 20 11 0951      bra   normz   and exit
01570 0940           norm1 brst 7,FP1HB,normz and exit
01571 0944 38 5F           norm2 asl   FP1GB
01572 0946 39 37           rol   FP1LB
01573 0948 39 36           rol   FP1MB
01574 094A 39 35           rol   FP1HB
01575 094C CD 0959         jsr   decex
01576 094F 20 EF 0940      bra   norm1
01577 0951 81           normz rts

01579 0952 3C 34           incx  inc   FP1EX   increment exponent with byte extension
01580 0954 26 02 0958      bne   incxz
01581 0956 3C 60           inc   FPEXE   correct extension byte
01582 0958 81           incxz rts

01584 0959 3A 34           decx  dec   FP1EX   increment exponent with byte extension
01585 095B 26 02 095F      bne   decexz
01586 095D 3A 60           dec   FPEXE   correct extension byte
01587 095F 81           decxz rts

01589           * test fp1 for zero
01590 0960 AE 34           fpl1st ldx  #FP1
01591 0962 20 02 0966      bra   fptst

01593           * test fp2 for zero
01594 0964 AE 38           fp2tst ldx  #FP2

01596           * test floating pint number pointed to by X for zero
01597 0966 F6           fptst  lda   ,x
01598 0967 EA 01           ora   1,x
01599 0969 EA 02           ora   2,x
01600 096B EA 03           ora   3,x
01601 096D 27 06 0975      beq   fptstz
01602 096F E6 01           lda   1,x   get sign bit
01603 0971 A4 80           and   #$80
01604 0973 AA 01           ora   #$01   force to be non-zero
01605 0975 81           fptstz rts

01607           * maximise floating point accumulator 1, ie all but sign bit to ones
01608           * sign bit from FPRSGN
01609 0976 A6 FF           fplmax lda  #$FF
01610 0978 B7 34           sta   FP1EX
01611 097A B7 35           sta   FP1HB
01612 097C B7 36           sta   FP1MB
01613 097E B7 37           sta   FP1LB
01614 0980           brst 7,FPRSGN,fplmaz
01615 0984 1F 35           bclr 7,FP1HB
01616 0986 81           fplmaz rts

01618           * unsigned operations
01619           * Unsigned subtraction : Mantissa parts of FP1=FP1-FP2
01620 0987 98           usub  clc
01621 0988 3F 5F           usub0 clr   FP1GB
01622 098A 39 5F           rol   FP1GB   get 1sb of Guard Byte=Carry
01623 098C B6 37           lda   FP1LB   byte by byte
01624 098E B0 3B           sub   FP2LB
01625 0990 B7 37           sta   FP1LB
01626 0992 B6 36           lda   FP1MB
01627 0994 B2 3A           sbc   FP2MB
01628 0996 B7 36           sta   FP1MB
01629 0998 B6 35           lda   FP1HB
01630 099A B2 39           sbc   FP2HB
01631 099C B7 35           sta   FP1HB

```

```

01632 099E B6 5F          lda  FP1GB
01633 09A0 A2 00          sbc  #0      if underflow then CY=1, and FP1GB=$FF
01634 09A2 B7 5F          sta  FP1GB  otherwise CY=0 and FP1GB=$00
01635 09A4 81              rts

01637                    * Unsigned addition      : Mantissa parts of FP1=FP1+FP2
01638 09A5 98          uadd  clc
01639 09A6 B6 37      uadd0  lda  FP1LB  byte by byte
01640 09A8 B9 3B          adc  FP2LB
01641 09AA B7 37          sta  FP1LB
01642 09AC B6 36          lda  FP1MB
01643 09AE B9 3A          adc  FP2MB
01644 09B0 B7 36          sta  FP1MB
01645 09B2 B6 35          lda  FP1HB
01646 09B4 B9 39          adc  FP2HB
01647 09B6 B7 35          sta  FP1HB  if overflow then CY=1 otherwise CY=0
01648 09B8 81              rts

01650                    * Unsigned multiply
01651                    * do first partial product
01652 09B9 B6 37      umul  lda  FP1LB
01653 09BB BE 3B          ldx  FP2LB
01654 09BD              mul
01655 09BE B7 5E          sta  FPT0  store lowest part
01656 09C0 BF 5D          stx  FPT1
01657 09C2 3F 5C          clr  FPT2  clear higher parts
01658 09C4 3F 5B          clr  FPT3
01659 09C6 3F 5A          clr  FPT4
01660 09C8 3F 59          clr  FPT5
01661                    * now do other partial products
01662 09CA          pmul  FP1LB,FP2MB,FPT1
01663 09DC          pmul  FP1MB,FP2LB,FPT1
01664 09EE          pmul  FP1LB,FP2HB,FPT2
01665 0A00          pmul  FP1MB,FP2MB,FPT2
01666 0A12          pmul  FP1HB,FP2LB,FPT2
01667 0A24          pmul  FP1MB,FP2HB,FPT3
01668 0A36          pmul  FP1HB,FP2MB,FPT3
01669 0A48          pmul  FP1HB,FP2HB,FPT4
01670 0A5A B6 59          lda  FPT5  copy result to FP1
01671 0A5C B7 35          sta  FP1HB
01672 0A5E B6 5A          lda  FPT4
01673 0A60 B7 36          sta  FP1MB
01674 0A62 B6 5B          lda  FPT3
01675 0A64 B7 37          sta  FP1LB
01676 0A66 B6 5C          lda  FPT2  keep bottom bits in Guard Byte
01677 0A68 B7 5F          sta  FP1GB
01678 0A6A 81              rts

01680                    * Unsigned divide
01681 0A6B AE 19          udiv  ldx  #25  set up counter
01682 0A6D 98          clc
01683 0A6E CD 0988      udiv1  jsr  usub0  try subtract FP1=FP1-FP2; cy=1 => won't go
01684 0A71 24 06      0A79  bcc  udiv2
01685 0A73 CD 09A5      jsr  uadd  restore FP1=(FP1-FP2)+FP2=FP1
01686 0A76 98          clc  indicate subtraction failed
01687 0A77 20 01      0A7A  bra  udiv3
01688 0A79 99          udiv2  sec
01689 0A7A 39 5E      udiv3  rol  FPT0  indicate subtraction was ok
01690 0A7C 39 5D          rol  FPT1  rotate result bits
01691 0A7E 39 5C          rol  FPT2  high bit may produce carry
01692 0A80 39 37          rol  FP1LB
01693 0A82 39 36          rol  FP1MB
01694 0A84 39 35          rol  FP1HB
01695 0A86 5A          decx
01696 0A87 26 E5      0A6E  bne  udiv1
01697 0A89 36 37          ror  FP1LB  recover msb to CY
01698 0A8B B6 5E          lda  FPT0
01699 0A8D B7 37          sta  FP1LB

```

```

01700 0A8F B6 5D          lda  FPT1
01701 0A91 B7 36          sta  FP1MB
01702 0A93 B6 5C          lda  FPT2
01703 0A95 B7 35          sta  FP1HB
01704 0A97 81          udivz rts          result in CY:FP1HB:FP1MB:FP1LB

01707          * branch group decoded by low nibble of FCODE
01708          *****

01710          * branch always
01711 0A98 CD 070F        fpbra jsr  gnb      get byte
01712 0A9B CD 0718          jsr  smadd     and add it in
01713 0A9E 81          rts

01715 0A9F CD 070F        fpbran jsr  gnb      no branch => throw away offset byte
01716 0AA2 81          rts

01718          * branch if FP1=0
01719 0AA3 CD 0960        fpbeq jsr  fpltst
01720 0AA6 27 F0 0A98      beq  fpbra
01721 0AA8 20 F5 0A9F      bra  fpbran

01723          * branch if FP1<>0
01724 0AAA CD 0960        fpbne jsr  fpltst
01725 0AAD 26 E9 0A98      bne  fpbra
01726 0AAF 20 EE 0A9F      bra  fpbran

01728          * branch if FP1 sign bit = 0
01729 0AB1 CD 0960        fpbpl jsr  fpltst
01730 0AB4 2A E2 0A98      bpl  fpbra
01731 0AB6 20 E7 0A9F      bra  fpbran

01733          * branch if FP1 sign bit = 1
01734 0AB8 CD 0960        fpbmi jsr  fpltst
01735 0ABB 2B DB 0A98      bmi  fpbra
01736 0ABD 20 E0 0A9F      bra  fpbran

01738 0ABF 81          fpcall rts          call subroutine

01740 0AC0 81          fpret rts          return from subroutine

01742          * exit interpreter
01743 0AC1 10 67          fpexit bset flexit,FLAGS
01744 0AC3 81          rts

01746          * if a character has been received then wait for another character
01747 0AC4 CD 0F93          fpwt  jsr  zget     try to get a character
01748 0AC7 24 03 0ACC      bcc  fpwtz
01749 0AC9 CD 0F9B          jsr  zgetw     now wait for a character
01750 0ACC 81          fpwtz rts

01752          * synchronise with CHANNEL counter; wait for channel 3 to become 0
01753 0ACD          fpsyn brcl QUIET,MODE,fpsyn1
01754 0AD1 A6 FF          lda  #$FF
01755 0AD3 B7 AD          sta  SAMCNT
01756 0AD5 B6 AD          fpsyn1 lda  SAMCNT     wait for 8 entries
01757 0AD7 A1 08          cmp  #8
01758 0AD9 26 FA 0AD5      bne  fpsyn1
01759 0ADB CD 0ADF          jsr  adccp     copy ADC block
01760 0ADE 81          rts

01762 0ADF          adccp dely 1
01763 0AE7 9B          sei          protect environment for copy
01764 0AE8 5F          clr
01765 0AE9 E6 70          adccpl lda  ADCR,x     copy block from ADCReadings to
01766 0AEB E7 88          sta  ADCC,x     ADCCopy of readings
01767 0AED 5C          incx

```

```

01768 0AEE A3 18          cpx  #ADCLEN
01769 0AF0 26 F7    0AE9  bne  adccpl
01770 0AF2 3F AD          clr  SAMCNT  flag that all readings have been copied
01771 0AF4 9A          cli
01772 0AF5 81          rts

```

```

01774          * usage 'fc fbr,fpbc,mask,port,offset'
01775          * branch if bits selected by mask are all zero
01776 0AF6 CD 070F    fpbc  jsr  gnb  get mask
01777 0AF9 B7 BB          sta  TEMPA
01778 0AFB CD 070F    jsr  gnb
01779 0AFE 97          tax
01780 0AFF F6          lda  ,x      form an index
01781 0B00 B4 BB    fpbc1 and  TEMPA  get data
01782 0B02 26 08    0B0C  bne  fpbc2  apply mask
01783 0B04 CD 070F    jsr  gnb
01784 0B07 CD 0718    jsr  smadd  add offset
01785 0B0A 20 03    0B0F  bra  fpbcz  to address
01786 0B0C CD 070F    fpbc2 jsr  gnb  throw offset away
01787 0B0F 81    fpbcz rts

```

```

01790          * usage 'fc fbr,fpbs,mask,port,offset'
01791          * branch if bits selected by mask are all one
01792 0B10 CD 070F    fpbs  jsr  gnb  get mask
01793 0B13 B7 BB          sta  TEMPA
01794 0B15 CD 070F    jsr  gnb
01795 0B18 97          tax
01796 0B19 F6          lda  ,x      form an index
01797 0B1A 43          coma
01798 0B1B 20 E3    0B00  bra  fpbc1  get data

```

```

01800          * delay for multiple of 0.1 seconds, 25 seconds max
01801 0B1D CD 070F    fpdly jsr  gnb  delay for n * 0.1 sec
01802 0B20 B7 BB          sta  TEMPA
01803 0B22          fpdly1 dely 40
01804 0B2A 3A BB          dec  TEMPA
01805 0B2C 26 F4    0B22  bne  fpdly1
01806 0B2E 81          rts

```

```

01809          * function group decoded by low nibble of FCODE
01810          *****

```

```

01812          * clear floating point accumulator 1, ie set to zero
01813          0B2F    fpclr equ  *
01814 0B2F 3F 34    fpclr clr  FP1EX  FP1=0
01815 0B31 3F 35          clr  FP1HB
01816 0B33 3F 36          clr  FP1MB
01817 0B35 3F 37          clr  FP1LB
01818 0B37 81          rts

```

```

01820          * absolute value
01821 0B38 1F 35    fpabs bclr 7,FP1HB
01822 0B3A 81          rts

```

```

01824          * negate value
01825 0B3B CD 0960    fpneg jsr  fpltst  if FP1<>0 then toggle sign bit
01826 0B3E 27 06    0B46  beq  fpnegz
01827 0B40 B6 35          lda  FP1HB
01828 0B42 A8 80          eor  #$80
01829 0B44 B7 35          sta  FP1HB
01830 0B46 81          fpnegz rts

```

```

01832          * FP1=-1,0,+1 matching sign of FP1
01833 0B47 CD 0960    fpsgn jsr  fpltst
01834 0B4A 27 10    0B5C  beq  fpsgnz  nothing to do if zero
01835 0B4C 97          tax      save sign

```

```

01836 0B4D A6 81          lda  #$81      set up +1
01837 0B4F B7 34          sta  FP1EX
01838 0B51 3F 35          clr  FP1HB
01839 0B53 3F 36          clr  FP1MB
01840 0B55 3F 37          clr  FP1LB
01841 0B57 5D              tstx
01842 0B58 2A 02    0B5C    bpl  fpsgnz   leave as plus 1
01843 0B5A 1E 35          bset 7,FP1HB make negative
01844 0B5C 81              fpsgnz rts

01846                    * makes use of FP0,FP1,FP2 and FP3
01847 0B5D CD 0960        fpsqt jsr  fpl1st
01848 0B60 27 6D    0BCF    beq  fpsqtz   nothing to do if zero
01849 0B62 2A 05    0B69    bpl  fpsqt0   ok if positive
01850 0B64 CD 0B2F        jsr  fplclr   clear if negative
01851 0B67 20 66    0BCF    bra  fpsqtz   exit
01852 0B69 B6 34        fpsqt0 lda  FP1EX   reduce range
01853 0B6B A0 80          sub  #$80     remove bias
01854 0B6D 47            asra        divide by 2 saving sign
01855 0B6E B7 61          sta  FPEXOF   exponent offset - 2's complement
01856 0B70 A6 40          lda  #$40
01857 0B72 49            rola        $80 or $81
01858 0B73 B7 34          sta  FP1EX   new exponent
01859 0B75 AE 0C          ldx  #FP3-fpram store FP1 to FP3 - call it y
01860 0B77 CD 0796        jsr  fpl1sra
01861 0B7A              brst 0,FP1EX,fpsqt1
01862 0B7E AE 14          ldx  #fksqtb-fprom load fp2 with 0.5901621 - constant b
01863 0B80 CD 07CB        jsr  fp2lro
01864 0B83 CD 0882        jsr  fpmul    multiply FP1=FP1*FP2
01865 0B86 AE 10          ldx  #fksqta-fprom load fp2 with 0.4173076 - constant a
01866 0B88 CD 07CB        jsr  fp2lro
01867 0B8B CD 0800        jsr  fpadd    add FP1=FP1+FP2
01868 0B8E 20 10    0BA0    bra  fpsqt2
01869 0B90 AE 10        fpsqt1 ldx  #fksqta-fprom load fp2 with 0.4173076 - constant a
01870 0B92 CD 07CB        jsr  fp2lro
01871 0B95 CD 0882        jsr  fpmul    multiply FP1=FP1*FP2
01872 0B98 AE 14          ldx  #fksqtb-fprom load fp2 with 0.5901621 - constant b
01873 0B9A CD 07CB        jsr  fp2lro
01874 0B9D CD 0800        jsr  fpadd    add FP1=FP1+FP2
01875 0BA0 AE 00        fpsqt2 ldx  #FP0-fpram
01876 0BA2 CD 0796        jsr  fpl1sra store FP1 to FP0 - store estimate xi
01877 0BA5 A6 02          lda  #2
01878 0BA7 B7 62          sta  FPCNT1  set up counter
01879 0BA9 AE 0C        fpsqt3 ldx  #FP3-fpram load FP1 from FP3 - recover y
01880 0BAB CD 073A        jsr  fpl1ra
01881 0BAE AE 00          ldx  #FP0-fpram load FP2 from FP0 - recover xi
01882 0BB0 CD 07BA        jsr  fp2lra
01883 0BB3 CD 08AE        jsr  fpdiv    divide FP1=FP1/FP2
01884 0BB6 AE 00          ldx  #FP0-fpram load FP2 from FP0 - recover xi
01885 0BB8 CD 07BA        jsr  fp2lra
01886 0BBB CD 0800        jsr  fpadd    add FP1=FP1+FP2
01887 0BBE 3A 34          dec  FP1EX   divide result by 2
01888 0BC0 AE 00          ldx  #FP0-fpram store FP1 to FP0 - new estimate
01889 0BC2 CD 0796        jsr  fpl1sra
01890 0BC5 3A 62          dec  FPCNT1  loop counter
01891 0BC7 26 E0    0BA9    bne  fpsqt3
01892 0BC9 B6 34          lda  FP1EX   correct exponent
01893 0BCB BB 61          add  FPEXOF
01894 0BCD B7 34          sta  FP1EX
01895 0BCF 81              fpsqtz rts

01897                    * square FP1
01898 0BD0 AE 04        fpsqr ldx  #FP1-fpram
01899 0BD2 CD 07BA        jsr  fp2lra  FP2=FP1
01900 0BD5 CC 0882        jmp  fpmul

01902                    * swap FP1 with FP2
01903 0BD8 AE 03        fpswp ldx  #3      set up counter

```

```

01904 OBDA E6 34      fpswpl lda  FP1EX,x  move
01905 OBDC B7 5E      sta  FPT0   temporary place
01906 OBDE E6 38      lda  FP2EX,x
01907 OBE0 E7 34      sta  FP1EX,x  FP1=FP2
01908 OBE2 B6 5E      lda  FPT0   recover
01909 OBE4 E7 34      sta  FP1EX,x  FP2=original FP1
01910 OBE6 5A          decx
01911 OBE7 2A F1      OBDA  bpl  fpswpl
01912 OBE9 81          rts

01914                * convert floating point number in FP1 into fixed format
01915                * Exponent=0; sign+7+8+8 data bits in FP1HB:FP1MB:FP1LB
01916 OBEA CD 0960     fpfix jsr  fplst
01917 OBED 27 24      OC13  beq  fpfixz  nothing to do
01918 OBEF 3F 39      clr  FP2HB  clear sign of FP2 so that FPRSGN=FP1SGN
01919 OBF1 CD 08EC     jsr  fppre
01920 OBF4 B6 34      lda  FP1EX  calculate number of shifts
01921 OBF6 A0 80      sub  #$80
01922 OBF8 22 03      OBF8  bhi  fpfix1
01923 OBFA CC 0B2F     jmp  fpclr  clear FP1 and return
01924 OBF8 A0 18      fpfix1 sub  #24
01925 OBF8 25 06      OC07  blo  fpfix2
01926 OC01 CD 0C14     jsr  imax   set to integer max value
01927 OC04 CC 0905     jmp  fpend  restore sign and return
01928 OC07 34 35      fpfix2 lsr  FP1HB  move right
01929 OC09 36 36      ror  FP1MB
01930 OC0B 36 37      ror  FP1LB
01931 OC0D 4C          inca
01932 OC0E 26 F7      OC07  bne  fpfix2
01933 OC10 CC 0905     jmp  fpend  restore sign and return
01934 OC13 81          fpfixz rts

01936                * set FP1 to maximum signed integer - 007FFFFF
01937 OC14 A6 7F      imax  lda  #$7F
01938 OC16 B7 35      sta  FP1HB
01939 OC18 A6 FF      lda  #$FF
01940 OC1A B7 36      sta  FP1MB
01941 OC1C B7 37      sta  FP1LB
01942 OC1E 3F 34      clr  FP1EX
01943 OC20 81          rts

01945                * float integer in FP1 in 3 byte signed format
01946 OC21 3F 39      fpflt clr  FP2HB  clear sign of FP2 so that FPRSGN=FP1SGN
01947 OC23 CD 08EC     jsr  fppre
01948 OC26 1F 35      bclr 7,FP1HB restore integer format
01949 OC28 A6 98      lda  #$80+24 set up exponent
01950 OC2A CC 0868     jmp  fpadda  normalise, correct sign and return

01952                * find integer part of FP1. (FP2 corrupted)
01953 OC2D CD 08EC     fpint jsr  fppre  prepare FP1, FP2 about to contain mask
01954 OC30 CD 0C4B     jsr  fgmsk  generate mask
01955 OC33 CD 0C65     fpint1 jsr  famsk  apply mask
01956 OC36 B6 63      lda  FP1SGN use original sign
01957 OC38 B7 65      sta  FPRSGN
01958 OC3A CC 0868     jmp  fpadda  normalise and return

01960                * find fractional part of FP1. (FP2 corrupted)
01961 OC3D CD 08EC     fpfrac jsr  fppre  prepare FP1, FP2 about to contain mask
01962 OC40 CD 0C4B     jsr  fgmsk  generate mask
01963 OC43 33 3B      com  FP2LB  complement mask
01964 OC45 33 3A      com  FP2MB
01965 OC47 33 39      com  FP2HB
01966 OC49 20 E8      OC33  bra  fpint1  apply mask, normalise and return

01968                * generate mask in FP2 mantissa corresponding to the position
01969                * of the binary point; 1's before and 0's after
01970 OC4B 4F          fgmsk clr
01971 OC4C B7 39      sta  FP2HB  clear mask bits

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01972 0C4E B7 3A          sta  FP2MB
01973 0C50 B7 3B          sta  FP2LB
01974 0C52 B6 34          lda  FP1EX
01975 0C54 A0 80          sub  #$80      test for too small
01976 0C56 23 0C          0C64 bls  fgmskz
01977 0C58 99             fgmsk1 sec      introduce 1's
01978 0C59 36 39          ror  FP2HB
01979 0C5B 36 3A          ror  FP2MB
01980 0C5D 36 3B          ror  FP2LB
01981 0C5F 25 03          0C64 bcs  fgmskz      full up
01982 0C61 4A             deca
01983 0C62 26 F4          0C58 bne  fgmsk1
01984 0C64 81             fgmskz rts

01986                      * apply mask in FP2 to FP1
01987 0C65 B6 37          famsk lda  FP1LB      apply mask byte by byte
01988 0C67 B4 3B          and  FP2LB
01989 0C69 B7 37          sta  FP1LB
01990 0C6B B6 36          lda  FP1MB
01991 0C6D B4 3A          and  FP2MB
01992 0C6F B7 36          sta  FP1MB
01993 0C71 B6 35          lda  FP1HB
01994 0C73 B4 39          and  FP2HB
01995 0C75 B7 35          sta  FP1HB
01996 0C77 81             rts

01998                      * counter group with low nibble = xnnn; x=0=>load, x=1=>decrement and
01999                      * branch if non-zero, nnn=counter number
02000                      *****

02002                      * load/decrement 8-bit counter indexed by low nibble
02003 0C78 12 67          fpcnt bset flnoex,FLAGS indicate no execution of low-nibble code
02004 0C7A A1 08          cmp  #$08      test for >7
02005 0C7C A4 07          and  #$07      allow only counters 0 to 7
02006 0C7E 97             tax           save index
02007 0C7F 25 0C          0C8D bcs  fpcnt1      just load counter
02008 0C81 CD 070F        jsr  gnb       get displacement if needed
02009 0C84 6A 50          dec  FCNT0,x   decrement and branch if non zero
02010 0C86 27 0A          0C92 beq  fpcntz     nothing to do if zero
02011 0C88 CD 0718        jsr  smadd     add a to self modifying code with sign extension
02012 0C8B 20 05          0C92 bra  fpcntz
02013 0C8D CD 070F        fpcnt1 jsr  gnb
02014 0C90 E7 50          sta  FCNT0,x  load counter
02015 0C92 81             fpcntz rts

02017                      * convert ADC channel given in low nibble - pass to FP1 as 0 to 2.0(ish)
02018                      * Number format from CS5505 is 0000 to FFFF for -2.5v to +2.5v
02019                      * Subtract $80 from high byte to change to 2's complement
02020                      *****

02021 0C93 12 67          fpadc bset flnoex,FLAGS indicate no execution of low-nibble code
02022 0C95 A1 08          cmp  #8        test for MAX132 range 0 to 7
02023 0C97 25 19          0CB2 blo  fpadc1
02024 0C99 A4 07          and  #7
02025 0C9B 97             tax           pick up start address of 3-byte number
02026 0C9C DE 0CD6        ldx  fpadct,x  #8 -> PADCR, >= #9 ->PADCA
02027 0C9F 9B             sei           protect transfer
02028 0CA0 E6 02          lda  2,x
02029 0CA2 B7 37          sta  FP1LB
02030 0CA4 E6 01          lda  1,x
02031 0CA6 B7 36          sta  FP1MB
02032 0CA8 F6             lda  ,x
02033 0CA9 9A             cli
02034 0CAA A0 40          sub  #$40      convert to 2's complement
02035 0CAC B7 35          sta  FP1HB
02036 0CAE A6 83          lda  #$83     prepare exponent
02037 0CB0 20 12          0CC4 bra  fpadc2
02038 0CB2 AE 03          fpadc1 ldx  #3      form offset
02039 0CB4             mul

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02040 0CB5 97          tax          into ADCC table
02041 0CB6 E6 8A      lda  ADCC+2,x get low part
02042 0CB8 B7 37      sta  FP1LB
02043 0CBA E6 89      lda  ADCC+1,x get middle part
02044 0CBC B7 36      sta  FP1MB
02045 0CBE E6 88      lda  ADCC,x   get high part
02046 0CC0 B7 35      sta  FP1HB
02047 0CC2 A6 85      lda  #$85
02048 0CC4 B7 34      fpadc2 sta FP1EX  anticipate bias
02049 0CC6 3F 60      clr  FPEXE  clear extension
02050 0CC8 3F 65      clr  FPRSGN anticipate positive
02051 0CCA          brcl 7,FP1HB,fpadc3 anticipate positive
02052 0CCE 1E 65      bset 7,FPRSGN indicate negative
02053 0CD0 CD 0872     jsr  ineg   integer negate
02054 0CD3 CC 0868     fpadc3 jmp  fpadda normalise and return

02056          * table to convert channel numbers above 7 to start address
02057 0CD6 AE      fpadct fcb PADCR,PADCA,PADCA,PADCA,PADCA,PADCA,PADCA,PADCA

02059          * start of a block of useful constants - indexed by 0..63.
02060          * at most 64 constants. First 8 accessible by short load operations.
02061          OCDE      fprom equ  *
02062 0CDE 00      fk0  fcb  0,0,0,0 zero
02063 0CE2 81      fk1e0 fcb  $81,$00,$00,$00 + 1
02064 0CE6 84      fk1e1 fcb  $84,$20,$00,$00 + 10
02065 0CEA 94      fk1e6 fcb  $94,$74,$24,$00 + 1,000,000
02066 0CEE 7F      fksqta fcb  $7F,$55,$A9,$57 + 0.4173076
02067 0CF2 80      fksqtb fcb  $80,$17,$14,$DD + 0.5901621
02068 0CF6 00      fcb  0,0,0,0
02069 0CFA 00      fcb  0,0,0,0

02071          * General configuration and support routines
02072          * Note references to SMODC must be present for interpreter to work
02073          *****

02075          * Configure registers and ports and memory locations
02076 0CFE 9B      cfig  sei          must be protected
02077 0CFF 5F      clr  x          offset into table
02078 0D00 BF A8      cfig1 stx SPIT   keep x
02079 0D02 D6 0D25     lda  cfigtb+1,x get data
02080 0D05 DE 0D24     ldx  cfigtb,x get address
02081 0D08 A3 FF      cpx  #$FF
02082 0D0A 27 07      0D13 beq  cfig2   end of table
02083 0D0C F7          sta  ,x      write to port
02084 0D0D BE A8      ldx  SPIT   recover x
02085 0D0F 5C          incx          move to next entry
02086 0D10 5C          incx
02087 0D11 20 ED      0D00 bra  cfig1   and continue
02088 0D13 A6 C2      cfig2 lda  #%11000010 extra ram at $20 and $100
02089 0D15 C7 1FDF     sta  OPT1   68HC705C8
02090 0D18 C7 3FDF     sta  OPT2   68HC705C9 (used in EVM05 emulator)
02091 0D1B A6 42      lda  #%01000010 no start,50Hz, awake,vin,BA=01 => status
02092 0D1D CD 0EF5     jsr  adccom configure MAX132 ADC
02093 0D20 CD 0E62     jsr  adcdbc clear buffer for precision ADC readings
02094 0D23 81          rts

02096          * configuration table
02097 0D24 00      cfigtb fcb  PA,$00 data bus as outputs
02098 0D26 01      fcb  PB,%00011111 controls inactive
02099 0D28 02      fcb  PC,%11111111 all selects on stand-by
02100 0D2A 04      fcb  DDRA,$FF default state of 'bus' is output
02101 0D2C 05      fcb  DDRB,$FF
02102 0D2E 06      fcb  DDRC,$FF CONV,CAL,CS's, SCLas outputs
02103 0D30 07      fcb  DDRD,%00011000 needed for SPI with EVM05 using MC68HC705C9
02104 0D32 0A      fcb  SPCR,%01010001
02105 0D34 0D      fcb  SCBRR,%00110000 9600 baud
02106 0D36 0E      fcb  SCCR1,%00001000
02107 0D38 0F      fcb  SCCR2,%00001100

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02108 0D3A 12          fcb  TCR,%01100000 OCIE,TOIE on, OLVL=1 => LED off
02109 0D3C 1C          fcb  PR,%00000000 Program EEPROM
02110 0D3E A9          fcb  TOUT,0   counters to zero
02111 0D40 AA          fcb  TOVF,0
02112 0D42 AB          fcb  STATE,40 force time-out
02113 0D44 AC          fcb  CHAN,0
02114 0D46 AD          fcb  SAMCNT,$F8 allow ($100-$F8+8) test/warm-up cycles
02115 0D48 B9          fcb  MODE,0   allow sampling during RS232 reception
02116                * following are needed for floating point routines
02117 0D4A 69          fcb  SMODC,$C6 lda extended
02118 0D4C 6C          fcb  SMODC+3,$81 rts
02119 0D4E 6D          fcb  SMODC+4,$CC jmp extended
02120 0D50 C0          fcb  BLSTAT,5 BLink STATE => 5 changes
02121 0D52 C1          fcb  BLCNT,0 BLink interval counter is cleared
02122 0D54 C2          fcb  BLIVL,4 BLink InterVal 4 * 0.131s = 0.5
02123 0D56 FF          fcb  $FF   Stopper code

02126                *      spi (interface) output and input a byte

02128 0D57 B7 A8      spioi  sta  SPIT   keet last byte sent out
02129 0D59 B7 0C      sta  SPDAT  output a byte to get a byte
02130 0D5B            spioil brcl  SPIF,SPSR,spioil
02131 0D5F B6 0C      lda  SPDAT  get data
02132 0D61 81          rts

02134                * Timer interrupt service routine
02135          04E2      TINVAL equ 2500*4/8 (interval in us)* (clock in MHz.) / 8
02136 0D62            tims  brcl  TOF,TSR,tims1 (interval in us)* (clock in MHz.) / 8
02137 0D66 B6 19      lda  CLR   remove overflow flag
02138 0D68 3D C0      tst  BLSTAT if BLSTAT<>0 then
02139 0D6A 27 20      0D8C  beq  tims1
02140 0D6C 3D C1      tst  BLCNT if BLCNT<> then
02141 0D6E 27 04      0D74  beq  tims0
02142 0D70 3A C1      dec  BLCNT dec(BLCNT)
02143 0D72 20 12      0D86  bra  tims0a
02144 0D74 B6 C2      tims0  lda  BLIVL else begin
02145 0D76 B7 C1      sta  BLCNT BLCNT:=BLIVL
02146 0D78 B6 12      lda  TCR   TCR:=TCR xor $01 for OLVL
02147 0D7A A8 01      eor  #(1<OLVL)
02148 0D7C B7 12      sta  TCR
02149 0D7E B6 C0      lda  BLSTAT
02150 0D80 A1 FF      cmp  #$FF if BLSTAT<>$FF then dec(BLSTAT)
02151 0D82 27 02      0D86  beq  tims0a
02152 0D84 3A C0      dec  BLSTAT end
02153 0D86 3D AA      tims0a  tst  TOVF
02154 0D88 27 02      0D8C  beq  tims1
02155 0D8A 3A AA      dec  TOVF
02156 0D8C            tims1  brcl  OCF,TSR,tims2 end
02157 0D90 B6 17      lda  OCLR add offset for timing interval
02158 0D92 AB E2      add  #TINVAL%256 low byte
02159 0D94 97          tax   OCLR must be written last !
02160 0D95 B6 16      lda  OCHR
02161 0D97 A9 04      adc  #TINVAL/256 high byte
02162 0D99 B7 16      sta  OCHR
02163 0D9B BF 17      stx  OCLR re-enable by write to low byte
02164 0D9D CD ODAA     jsr  padcs service precision adc
02165 0DA0 CD 0E77     jsr  adcs service adc
02166 0DA3 3D A9      tst  TOUT
02167 0DA5 27 02      0DA9  beq  tims2
02168 0DA7 3A A9      dec  TOUT
02169 0DA9 80          tims2  rti   may be extended to allow for ICF

02171                * service precision adc
02172 0DAA CD 0DBF     padcs  jsr  getst get status byte
02173 0DAD A5 81      bit  #$81 leave if warming up or busy
02174 0DAF 26 0D      0DBE  bne  padcsz
02175 0DB1 B7 B1      sta  PADCST save in status byte

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02176 0DB3 CD ODD2          jsr  getr  get readings
02177 0DB6 A6 00          lda  #$00  DEFCOM command
02178 0DB8 CD ODEA          jsr  putcm put command
02179 0DBB CD ODFA          jsr  sampb sample to buffer and moving sum
02180 0DBE 81          padcsz rts

02182          * get status of AD1175K by reading register 0
02183 0DBF 11 01          getst bclr AO,PB set to register 00
02184 0DC1 13 01          bclr A1,PB
02185 0DC3 3F 04          clr  DDRA  change port A to inputs
02186 0DC5 15 02          bclr N1175,PC select AD1175K
02187 0DC7 15 01          bclr NRD,PB enable reading
02188 0DC9 B6 00          lda  PA  get data
02189 0DCB 14 01          bset NRD,PB disable reading
02190 0DCD 14 02          bset N1175,PC disable AD1175K
02191 0DCF 33 04          com  DDRA  restore to outputs
02192 0DD1 81          rts

02194          * get readings from precision adc
02195 0DD2 3F 04          getr  clr  DDRA  change port A to inputs
02196 0DD4 AE 02          ldx  #2  form index to PADCR table
02197 0DD6 3C 01          getr1 inc  PB  move from status byte to next byte(s)
02198 0DD8 15 02          bclr N1175,PC select AD1175K
02199 0DDA 15 01          bclr NRD,PB enable reading
02200 0DDC B6 00          lda  PA  get data
02201 0DDE E7 AE          sta  PADCR,x store in table
02202 0DE0 14 01          bset NRD,PB disable reading
02203 0DE2 14 02          bset N1175,PC disable AD1175K
02204 0DE4 5A          decx  move to higher byte
02205 0DE5 2A EF          ODD6 bpl  getr1
02206 0DE7 33 04          com  DDRA  restore to outputs
02207 0DE9 81          rts

02209          * put command to precision ADC
02210 0DEA B7 00          putcm sta  PA
02211 0DEC 11 01          bclr AO,PB set to register 00
02212 0DEE 13 01          bclr A1,PB
02213 0DF0 15 02          bclr N1175,PC select AD1175K
02214 0DF2 17 01          bclr NWR,PB enable writing
02215 0DF4 90          nop
02216 0DF5 16 01          bset NWR,PB disable writing
02217 0DF7 14 02          bset N1175,PC disable AD1175K
02218 0DF9 81          rts

02220          * sum:=sum-buf(i); buf(i):=new entry:=ADCH,M,L;sum:=sum+buf(i);
02221          * wrapup/round i;
02222          * Routine timed at 120us
02223 0DFA BE A4          sampb ldx  ADCBP
02224 0DFC B6 A3          lda  ADCS+3 sum:=sum-buf(index)
02225 0DFE D0 012A          sub  ADCB+2,x
02226 0E01 B7 A3          sta  ADCS+3
02227 0E03 B6 A2          lda  ADCS+2
02228 0E05 D2 0129          sbc  ADCB+1,x
02229 0E08 B7 A2          sta  ADCS+2
02230 0E0A B6 A1          lda  ADCS+1
02231 0E0C D2 0128          sbc  ADCB,x
02232 0E0F B7 A1          sta  ADCS+1
02233 0E11 24 02          OE15 bcc  sampb1
02234 0E13 3A A0          dec  ADCS  account for borrow from highest byte
02235 0E15 B6 AE          sampb1 lda  PADCR  buf(index):=PADCR High to Low
02236 0E17 D7 0128          sta  ADCB,x
02237 0E1A B6 AF          lda  PADCR+1
02238 0E1C D7 0129          sta  ADCB+1,x
02239 0E1F B6 B0          lda  PADCR+2
02240 0E21 D7 012A          sta  ADCB+2,x
02241 0E24 B6 A3          lda  ADCS+3 sum:=sum+buf(index)
02242 0E26 DB 012A          add  ADCB+2,x
02243 0E29 B7 A3          sta  ADCS+3

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02244 0E2B B6 A2          lda  ADCS+2
02245 0E2D D9 0129       adc  ADCB+1,x
02246 0E30 B7 A2          sta  ADCS+2
02247 0E32 B6 A1          lda  ADCS+1
02248 0E34 D9 0128       adc  ADCB,x
02249 0E37 B7 A1          sta  ADCS+1
02250 0E39 24 02         0E3D  bcc  sampb2
02251 0E3B 3C A0          inc  ADCS          account for carry to highest byte
02252 0E3D 9F             sampb2  txa          get start point
02253 0E3E AB 03          add  #3
02254 0E40 A1 30          cmp  #ADCBL
02255 0E42 26 01         0E45  bne  sampb3
02256 0E44 4F             clra          wrap round index
02257 0E45 B7 A4          sampb3  sta  ADCBP
02258 0E47 B6 A3          lda  ADCS+3       copy to PADCA
02259 0E49 B7 B8          sta  PADCA+2
02260 0E4B B6 A2          lda  ADCS+2
02261 0E4D B7 B7          sta  PADCA+1
02262 0E4F B6 A1          lda  ADCS+1
02263 0E51 B7 B6          sta  PADCA
02264 0E53 B6 A0          lda  ADCS
02265 0E55 AE 04          ldx  #ADCBD       now divide by 4,8,16 etc
02266 0E57 44             sampb4  lsra
02267 0E58 36 B6          ror  PADCA
02268 0E5A 36 B7          ror  PADCA+1
02269 0E5C 36 B8          ror  PADCA+2
02270 0E5E 5A             decx
02271 0E5F 26 F6         0E57  bne  sampb4
02272 0E61 81             rts          PADCA now is sum/2^n (n=ADCBD)

02274          * ADC Clear Buffer and pointers
02275 0E62 5F             adcbc  clrxc       clear ADC buffer, pointer and sum
02276 0E63 4F             clra
02277 0E64 B7 A4          sta  ADCBP
02278 0E66 B7 A0          sta  ADCS
02279 0E68 B7 A1          sta  ADCS+1
02280 0E6A B7 A2          sta  ADCS+2
02281 0E6C B7 A3          sta  ADCS+3
02282 0E6E D7 0128       adcbc1 sta  ADCB,x
02283 0E71 5C             incx
02284 0E72 A3 30          cpx  #ADCBL
02285 0E74 26 F8         0E6E  bne  adcbc1
02286 0E76 81             rts

02288          * service routine for ADC called from within timer service routine
02289          * MAX132 manual is confusing in its numbering of registers.
02290          * The letters B and A have been substituted for RS0 and RS1 respectively
02291          * Hence BA = 00 => Data bits B10..B3
02292          *       BA = 01 => Status bits and B2..B0
02293          *       BA = 10 => Data Bits B18..B11
02294          *       BA = 11 => Invalid
02295          * See MAX132 manual for detailed(ish !) explanation of registers and bits

02297 0E77 3C AB          adcs   inc  STATE
02298 0E79 B6 AB          lda  STATE
02299 0E7B A1 0A          cmp  #10
02300 0E7D 25 75         0EF4  blo  adcsz       nothing to do
02301 0E7F 26 11         0E92  bne  adcs1       greater than 10
02302 0E81 B6 AC          lda  CHAN         move to next channel
02303 0E83 4C             inca
02304 0E84 A4 07          and  #7           wrap to 3 bits
02305 0E86 B7 AC          sta  CHAN
02306 0E88 48             asla          move up 4 bits as expected by register 1
02307 0E89 48             asla          of MAX132
02308 0E8A 48             asla
02309 0E8B 48             asla
02310 0E8C 4C             inca          select register 1
02311 0E8D CD 0EF5       jsr  adccom       send new channel address

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02312 0E90 20 62   0EF4   bra   adcsz   now end
02313 0E92 A1 28           adcs1  cmp   #40
02314 0E94 24 57   0EED           bhs   adcs3   greater than 100ms
02315 0E96 A6 42           lda   #01000010 no start,50Hz,awake,vin,BA=01 = status
02316 0E98 CD 0EF5           jsr   adccom
02317 0E9B A5 40           bit   #01000000 wait for EOC to become high
02318 0E9D 27 55   0EF4   beq   adcsz   nothing to do
02319 0E9F B7 A7           sta   ADCL   store status and lsb's
02320 0EA1 A6 44           lda   #01000100 no start,50Hz,awake,vin,BA=10 => B18..B11
02321 0EA3 CD 0EF5           jsr   adccom
02322 0EA6 A6 40           lda   #01000000 no start,50Hz,awake,vin,BA=00 => B10..B3
02323 0EA8 CD 0EF5           jsr   adccom
02324 0EAB B7 A5           sta   ADCH
02325 0EAD A6 C2           lda   #11000010 start,50Hz,awake,vin,BA=01 => status
02326 0EAF CD 0EF5           jsr   adccom
02327 0EB2 B7 A6           sta   ADCM
02328 0EB4 B6 A7           lda   ADCL   extract polarity and data bits
02329 0EB6 48           asla
02330 0EB7 48           asla
02331 0EB8 48           asla
02332 0EB9 48           asla
02333 0EBA 48           asla
02334 0EBB 36 A5           ror   ADCH   move polarity to msb
02335 0EBD 36 A6           ror   ADCM
02336 0EBF 46           rora
02337 0EC0 AE 04           ldx   #4
02338 0EC2 37 A5           adcs2  asr   ADCH   now move to right justify
02339 0EC4 36 A6           ror   ADCM
02340 0EC6 46           rora
02341 0EC7 5A           decx
02342 0EC8 26 F8   0EC2   bne   adcs2
02343 0ECA B7 A7           sta   ADCL
02344 0ECC B6 AC           lda   CHAN
02345 0ECE 4A           deca   restore previous channel
02346 0ECF A4 07           and   #7
02347 0ED1 AE 03           ldx   #3
02348 0ED3           mul
02349 0ED4 97           tax   form an index
02350 0ED5 B6 A5           lda   ADCH
02351 0ED7 E7 70           sta   ADCR,x  copy to destination
02352 0ED9 B6 A6           lda   ADCM
02353 0EDB E7 71           sta   ADCR+1,x
02354 0EDD B6 A7           lda   ADCL
02355 0EDF E7 72           sta   ADCR+2,x
02356 0EE1 3F AB           clr   STATE
02357 0EE3 B6 AD           lda   SAMCNT  increase sample count
02358 0EE5 A1 08           cmp   #8
02359 0EE7 27 08   0EF4   beq   adcsz   limit at 8
02360 0EE9 3C AD           inc   SAMCNT
02361 0EEB 20 07   0EF4   bra   adcsz
02362 0EED A6 C2           adcs3  lda   #11000010 start,50Hz,awake,vin,BA=01 => status
02363 0EEF CD 0EF5           jsr   adccom
02364 0EF2 3F AB           clr   STATE
02365 0EF4 81           adcsz  rts

```

```

02367           * MAXIM MAX132 ADC communication via SPI
02368 0EF5 1D 02           adccom bclr N132,PC
02369 0EF7 CD 0D57           jsr   spioi
02370 0EFA 1C 02           bset  N132,PC
02371 0EFC 81           rts

```

```

02373           * output integer part of FP1
02374 0EFD AE 0C           fpout  ldx   #fkie6-fprom get constant of 1e6
02375 0EFF CD 07CB           jsr   fp2lro  load FP2 from rom
02376 0F02 CD 0882           jsr   fpmul   find product
02377 0F05 CD 0BEA           jsr   fprefix
02378 0F08 A6 20           lda   #SP   output a space
02379 0FOA CD 0FA7           jsr   zputw

```

```

02380 0F0D A6 2B          lda  #' +   anticipate plus sign
02381 0F0F                brc1 7,FP1HB,fpout1
02382 0F13 1F 35          bclr 7,FP1HB clear sign bit
02383 0F15 A6 2D          lda  #' -   minus sign
02384 0F17 CD 0FA7        fpout1 jsr  zputw  output sign
02385 0F1A CD 0F5F        jsr  btod   binary to decimal conversion
02386                    *      jsr  drnd   round up
02387 0F1D CD 0F48        jsr  dprnt  in fixed point format x.xxxxx
02388 0F20 81              rts

02390                    * output a carriage return and line feed
02391 0F21 CC 0F8B        fpctrlf jmp ctrlf

02393                    * output a space
02394 0F24 A6 20          fspac lda  #$20   code for a space
02395 0F26 CC 0FA7        jmp  zputw  output and return

02397                    * decimal round up if least significant digit is >=5
02398 0F29 AE 05          drnd  ldx  #5     get least significant digit
02399 0F2B E6 59          lda  DMAL+1,x digit #6, ie 7th. digit
02400 0F2D A1 05          cmp  #$05    test for range
02401 0F2F 25 16          0F47 blo  drndz   nothing to do as digit is 0..4
02402 0F31 99            sec
02403 0F32 E6 58          drnd1 lda  DMAL,x  BCD add
02404 0F34 A9 00          adc  #0
02405 0F36 A1 0A          cmp  #10    decimal adjust
02406 0F38 25 07          0F41 bcs  drnd2
02407 0F3A AB 06          add  #6
02408 0F3C A4 0F          and  #$F
02409 0F3E 99            sec
02410 0F3F 20 01          0F42 bra  drnd3
02411 0F41 98            drnd2 clc
02412 0F42 E7 58          drnd3 sta  DMAL,x
02413 0F44 5A            decx
02414 0F45 2A EB          0F32 bpl  drnd1
02415 0F47 81            drndz rts

02417                    * print decimal string without leading zero suppression
02418                    * decimal point after first digit
02419 0F48 5F            dprnt clr x
02420 0F49 E6 58          dprnt1 lda  DMAL,x  get number
02421 0F4B AB 30          add  #$30    convert to ascii
02422 0F4D CD 0FA7        jsr  zputw
02423 0F50 5C            incx
02424 0F51 A3 01          cpx  #1     decimal point after first digit
02425 0F53 26 05          0F5A bne  dprnt2
02426 0F55 A6 2E          lda  #' .   output a decimal point
02427 0F57 CD 0FA7        jsr  zputw
02428 0F5A A3 07          dprnt2 cpx  #7   loop ?
02429 0F5C 26 EB          0F49 bne  dprnt1
02430 0F5E 81            rts

02432                    * binary to decimal conversion
02433 0F5F AE 06          btod  ldx  #6     clear result registers
02434 0F61 6F 58          btod1 clr  DMAL,x
02435 0F63 5A            decx
02436 0F64 2A FB          0F61 bpl  btod1
02437 0F66 A6 18          lda  #24    24 loops
02438 0F68 B7 62          sta  FPCNT1
02439 0F6A 39 37          btod2 rol  FP1LB  shift binary pattern
02440 0F6C 39 36          rol  FP1MB
02441 0F6E 39 35          rol  FP1HB
02442 0F70 AE 06          ldx  #6     set up loop counter
02443 0F72 E6 58          btod3 lda  DMAL,x  decimal double
02444 0F74 49            rola
02445 0F75 A1 0A          cmp  #10    decimal adjust
02446 0F77 25 07          0F80 bcs  btod4
02447 0F79 AB 06          add  #6

```

```

02448 0F7B A4 0F          and  #$F
02449 0F7D 99             sec
02450 0F7E 20 01      0F81  bra  btod5
02451 0F80 98             btod4  clc
02452 0F81 E7 58       btod5  sta  DMAL,x
02453 0F83 5A             decx
02454 0F84 2A EC      0F72  bpl  btod3
02455 0F86 3A 62             dec  FPCNT1
02456 0F88 26 E0      0F6A  bne  btod2
02457 0F8A 81             btod6  rts

02459                    * output CR and LF
02460 0F8B A6 0D      crlf  lda  #CR
02461 0F8D AD 18      0FA7  bsr  zputw
02462 0F8F A6 0A             lda  #LF
02463 0F91 20 14      0FA7  bra  zputw

02465                    * see if there is a character in the receive register and get it
02466 0F93             zget  brcl RDRF,SCSR,zgetz
02467 0F97 B6 11             lda  SCDAT  get character
02468 0F99 99             sec          flag a character
02469 0F9A 81             zgetz rts

02471                    * wait until there is a received character
02472 0F9B AD F6      0F93  zgetw bsr  zget  try to get a character
02473 0F9D 24 FC      0F9B  bcc  zgetw  wait until successful
02474 0F9F 81             rts

02476                    * try to output a character
02477 0FA0             zput  brcl TDRE,SCSR,zputz
02478 0FA4 B7 11             sta  SCDAT  send data with carry set
02479 0FA6 81             zputz rts          carry set => data sent

02481                    * wait until character has been output to buffer
02482 0FA7 AD F7      0FA0  zputw bsr  zput  try to send
02483 0FA9 24 FC      0FA7  bcc  zputw  wait until successful
02484 0FAB 81             rts
02485 0FAC             end

```





fpwtz	0ACC	fret	0006	fsgn	0003	fsld1	0001	fsld2	0003	fspac	000D	fsqr	0005	fsqt	0004
fsst1	0002	fst1	0005	fsub	0008	fswp	0006	fsyn	0009	fundef	macr	funtab	069D	fwt	0008
getpa	02CF	getpaz	02F0	getpw	042D	getpwz	043B	getr	0DD2	getr1	00D6	getst	0DBF	gnb	070F
ibnc	02BD	ibnc1	02CD	ibncz	02CE	imax	0C14	incex	0952	incexz	0958	ineg	0872	irq	1FFA
irqs	0207	main	020B	main1	0219	main2	0229	mul	macr	norm	0925	norm0	0932	norm1	0940
norm2	0944	normz	0951	nul	02BC	over	0001	padcs	0DAA	padcsz	0DBE	paneg	043C	pmul	macr
prot	0527	prot1	0531	putcm	0DEA	rd1	0231	rd11	0234	rd12	0250	rd13	025D	rd1z	0269
reset	1FFE	sampb	0DFA	sampb1	0E15	sampb2	0E3D	sampb3	0E45	sampb4	0E57	sci	1FF6	scis	0205
smadd	0718	smadd1	071D	smaddz	0725	sminc	0711	smincz	0717	spi	1FF4	spioi	0D57	spioi1	0D58
spis	0203	start	0200	swi	1FFC	swis	0209	tim	1FF8	tims	0D62	tims0	0D74	tims0a	0D86
tims1	0D8C	tims2	0DA9	uadd	09A5	uadd0	09A6	udiv	0A6B	udiv1	0A6E	udiv2	0A79	udiv3	0A7A
udivz	0A97	umul	09B9	unp	04F1	unpl	04FB	usub	0987	usub0	0988	zget	0F93	zgetw	0F9B
zgetz	0F9A	zput	0FA0	zputw	0FA7	zputz	0FA6	zram0	0030	zram1	0100	zrame	00FF	zrams	0050
zrome	10FF	zroms	0200	zvect	1FF4										

```

1  program cclv15fp;
2  { Program to control current drives with messages sent from host or keyboard }
3  { same as cclv15f.pas but with additional comments and revised layout      }

4  uses
5      dos,crt,ccsup,unit_a0,unit_a1,unit_a2,unit_dd;

6  const
7      file_text   = 'cclv15f.dt'; {file for ASCII copy of calibration parameters}
8      file_binary = 'cclv15f.db'; {file for binary copy of calibration parameters}

9  { Development History
10     lv1  Data types and variables for one drive on COM1
11     lv2  Data Types for 1..3 drives but using just 1
12     lv2a minor but essential corrections to lv2
13     lv3  includes routines to convert longint to hex
14     lv4  major changes to allow 2 drives with scanning
15     lv4a loop_state now initialised
16     lv4b wt initialised
17     lv5  auxiliary ADC channels read once every 2 seconds
18         timeout during get_reply from drive
19     lv6  Windows and screen_layout established
20     lv6a some variables displayed
21     lv7  Refined presentation
22     lv7a Amplifier 1 shown to 4dp for testing
23     lv8  Warning Box with Blink
24         Time per loop controlled by ticks_loop_max
25     lv8a Difference between set point and precision adc is also averaged
26     lv9  Host communications established
27     lv10 Keyboard Entry primitives
28     lv10b Main program revised into smaller procedures
29     lv10d Keyboard entry almost complete
30     lv10e Mean loop time and loop monitor displayed, Ctrl Left Arrow available
31     lv11 AIM Automatic determination of gains and offset for precision drive.
32     lv11a Moving average filters rationalised
33     lv11b AIM calibrate via internal source
34     lv11c revised position of initial set_source(host);
35     lv11d lv11c has strange compile-time error
36     lv11e may calibrate p_dac
37     lv11f corrected incorrect scope of if in cal_p
38     lv11g uses fp_p_dac in calibration
39     lv11h tests levels with p_dac=%10000010...0 to %01111110..0
40     lv12 AIM to create a file of calibration points.
41         regression fits now volts per lsb
42     lv12a longint declaration in fun(bits..) to give expected results
43     lv12b regression data stored in stats.x[] and y[]
44         test and binary files created to store stats
45     lv12c Revised Keywords. Reads calibration file.
46         Does open loop control of dacs using calibration information
47         corrections to calculation of p_code in main control loop
48     lv13 AIM trimming both manual and automatic. revised filenames
49         length of filter for p_adc is altered depending on activity
50         for calibration and after keyboard entry
51         length=precision_adc_filter_length otherwise it is shorter
52     lv13a heater is controlled and power estimated. files name.lpt
53         contains resistance of coil then heater in ohms.
54         find_nearest_index applies to stats_type generally
55     lv13c keeps a copy of the fp_last_setpoint to decide if look_up
56         is needed;
57     lv14 AIM revision of structure for parameters and data files
58     lv14a Reports on time of last calibration
59     lv14b reports current time
60     lv14c white_text now included in set_source
61     lv15 AIM new procedure for displaying options
62         stats_type now includes temperature_in
63         temperature during calibration stored in parameter block
64         estimate of finish time for calibration
65     lv15b drive 1 showed out of range value for fp_s_dac after calibration
66     lv15c cal_finished placed in set_dacs, revised keyboard routines
67     lv15d AIM major revision of keyboard entry
68     lv15e beginnings of parameter form
69     lv15f fully operational
70     lv15fp revised format of source code }

```

```

71  const
72      max_filter_length      = 50;
73      loop_time_filter_length = 25;
74      stats_data_max         = 200;
75      max_drive               = 2;
76      number_of_parameters   = 2;
77      space_for_parameters    = 10;
78      r_ref = 70.0; { Reference resistance assumed same for coil and heater }
79      v_max = 5;      { Maximum voltage from dac is 5 volts }
80      differential_range = 2 ; {During keyboard entry limit difference in drives}
81      max_error          = 0.000005;
82      ticks_Y_max        = 18 * 5 ; { 18.2 ticks per second * number of seconds }
83      ticks_timeout_max  = 18 * 3 ; { 18.2 ticks per second * number of seconds }
84      ticks_loop_max     = 18;
85      ticks_clock_max    = 18;      { up_date visible clock once per second }
86      wait = 0;
87      data_block_null : data_block_type = (v:0.0; vs:'0.0          '; vv:false);

88  type {Main}
89      float          = real;
90      com_state_type = (idle, command_sent, ack_received, nack_received,
91                      valid_reply,time_out,command_received,reply_sent,
92                      valid_command);
93      com_type       = record
94                      number,address,IRQ          : word;
95                      last_command, last_reply    : string;
96                      state                       : com_state_type;
97                      error                       : integer;
98                      ticks_timeout               : longint;
99                      response                    : boolean;
100                     end;

101     file_type       = record
102                     inp,out : text;
103                     end;

104     loop_state_type = (loop_idle,
105                      sent_X, received_X, sent_Y, received_Y, sent_Z, received_Z);

106     filter_type     = record
107                     history : array[1..max filter_length] of float;
108                     count,index,length,guard : integer;
109                     mean    : float;
110                     valid   : boolean;
111                     end;

112     loop_time_type  = record
113                     current_tick,last_tick : longint;
114                     filter : filter_type;
115                     end;

116     cal_state_type  = (cal_idle,cal_start,cal_p,cal_s,cal_finished);

117     stats_type      = record
118                     n : integer;
119                     x,y,error : array[1..stats_data_max] of float;
120                     xb,yb,a,b,r,sx,sx2,sy,sy2,sxy,var_x,var_y,cov : float;
121                     temperature_in : float
122                     end;

123     calibrate_type  = record
124                     state          : cal_state_type;
125                     p_stats,s_stats : stats_type;
126                     end;

127     param_array_type = array[1..space_for_parameters] of data_block_type;

128     param_type      = record
129                     valid : boolean;
130                     p_stats,s_stats : stats_type;
131                     case integer of
132                     0 : (r_coil, r_heater : data_block_type);
133                     1 : (data : param_array_type);

```

```

134                                     end;
135 drive_type = record
136     number           : integer;
137     com              : com_type;
138     f                : file_type;
139     longint_precision_adc : longint;
140     p_dac, s_dac, h_dac : string[4];
141     p_code,s_code,h_code : longint;
142     s_trim           : integer;
143     vref,
144     fp_setpoint, fp_precision_adc,
145     fp_p_dac, fp_s_dac, fp_h_dac,
146     fp_agnd, fp_d1, fp_d2,
147     fp_temperature_in, fp_temperature_out,
148     fp_last_setpoint : float;
149     nearest_index    : integer;
150     precision_adc,agnd,d1,d2,sensor_in,sensor_out : string;
151     loop_state       : loop_state_type;
152     ticks_Y          : longint;
153     ticks_loop       : longint;
154     padc_filter      : filter_type;
155     fp_mean_error    : float;
156     loop_time        : loop_time_type;
157     monitor_count    : integer;
158     cal              : calibrate_type;
159     p                : param_type;
160     fp_power         : float;
161     end;
162
163 host_type = record
164     com      : com_type;
165     f        : file_type;
166     fp_setpoint : float;
167     drive_number : integer;
168     drive_id    : char;
169     fault       : boolean;
170     end;
171
172 source_type = (host_pc,keyboard,calibrate);
173 warning_type = (exit,abort,calib);
174
175 keyboard_type = record
176     data      : data_block_type;
177     x,y,f1,f2 : integer;
178     index     : integer;
179     first     : boolean;
180     drive_data : array[1..max_drive] of data_block_type;
181     kb_drive_number : integer;
182     end;
183
184 const {Main}
185     com_ref : array[1..4] of com_type =
186         ((number:1; address:$3F8; IRQ : 4),
187          (number:2; address:$2F8; IRQ : 3),
188          (number:3; address:$3E8; IRQ : 5),
189          (number:4; address:$2E8; IRQ : 7));
190     screen_offset_hex : array[1..max_drive] of integer = (39,67);
191     screen_offset_fp  : array[1..max_drive] of integer = (25,53);
192     monitor_char      : array[1..4] of char = ('d','-',',','-');
193
194 var {Main}
195     drive      : array[1..max_drive] of drive_type;
196     host       : host_type;
197     kb        : keyboard_type;
198     done,flag : boolean;
199     source     : source_type;
200     ticks_clock,tries,loop_count, reply_count : longint;
201     ExitSave   : pointer;
202     j,precision_adc,filter_length : integer;
203     ft         : text;
204     fp         : file of param_type;
205
206 function sign(x : float) : integer;

```

```

201     begin
202         if x>0 then
203             sign := 1
204         else
205             if x<0 then
206                 sign := -1
207             else
208                 sign := 0;
209     end;

210     function right(s : string; n:integer) : string;
211     var
212         start : integer;
213     begin
214         start := length(s)-n+1;
215         if start<1 then
216             start := 1;
217         right := copy(s,start,n);
218     end;

219     function file_exists(name: string) : boolean;
220     var
221         f : file;
222     begin
223         {$I-}
224         assign(f,name);
225         reset(f);
226         close(f);
227         {$I+}
228         file_exists := (IOResult=0) and (name<>'');
229     end;

230     procedure white_text;
231     begin
232         TextAttr := white;
233     end;

234     procedure white_text_with_underline;
235     begin
236         TextAttr := 9;
237     end;

238     procedure grey_text;
239     begin
240         TextAttr := lightgray;
241     end;

242     procedure blinking_white_text;
243     begin
244         TextAttr := $80+white;
245     end;

246     function ticks : longint;
247     begin
248         ticks := longint(Ptr($40,$6C)^); {Specific location holds real-time tick}
249     end;

250     procedure message(s : string; delay_in_milli_seconds : integer);
251     var
252         xmin,xmax,width,depth : byte;
253     begin {message}
254         width := length(s);
255         if delay_in_milli_seconds<>0 then
256             depth := 4
257         else
258             depth := 5;
259         xmin := 40-width div 2 - 2;
260         xmax := 40+width div 2 + 2;
261         openwindow(xmin,10,xmax,10+depth,' message ',white,$7A);
262         put_string(2,2,s);
263         if delay_in_milli_seconds=0 then
264             begin
265                 put_string(2,3,'Press any key to continue');
266                 inkey

```

```

267     end
268     else
269         delay(delay_in_milli_seconds*1000);
270         closewindow;
271     end; {message}

272     function longint_to_hex(number : longint; count : integer) : string;
273     var
274         r : string;
275         i : integer;
276     const
277         hex_table : array[0..15] of char = ('0','1','2','3','4','5','6','7',
278                                             '8','9','A','B','C','D','E','F');
279     begin {longint_to_hex}
280         r := '';
281         for i := count downto 1 do
282             begin
283                 r := hex_table[number and 15] + r;
284                 number := number shr 4;
285             end;
286         longint_to_hex := r;
287     end; {longint_to_hex}

288     function fp_to_hex(number,scale : float; count : integer) : string;
289     begin
290         fp_to_hex := longint_to_hex(round(number*scale), count);
291     end;

292     function hex_char_to_value(ch : char) : byte;
293     begin
294         case ch of
295             '0'..'9' : hex_char_to_value := ord(ch)-ord('0');
296             'A'..'F' : hex_char_to_value := ord(ch)-ord('A')+10;
297         else
298             hex_char_to_value := 0;
299         end;
300     end;

301     function hex_to_longint(hex_string : string) : longint;
302     var
303         t : longint;
304         i : integer;
305     begin
306         if length(hex_string)=0 then
307             hex_to_longint := 0
308         else
309             begin
310                 t := 0;
311                 for i := 1 to length(hex_string) do
312                     t := (t shl 4) + hex_char_to_value(hex_string[i]);
313                 hex_to_longint := t
314             end;
315         end;

316     function p_adc_hex_to_fp(hex_string:string) : float;
317     begin
318         p_adc_hex_to_fp := 5.0*(hex_to_longint(hex_string)-$400000)/$200000;
319     end;

320     function max132_hex_to_fp(hex_string:string; v : float) : float;
321     var
322         t:string;
323     begin
324         if hex_string[1]='0' then
325             t := '00'
326         else
327             t := 'FF';
328         max132_hex_to_fp :=
329             v*(hex_to_longint(t+hex_string))/(655*512);
330     end;

331     procedure put_highlighted_string(x,y:integer; s:string; i:integer);
332     begin
333         grey_text;

```

```

334     put_string(x,y,s);
335     change_attribute(x+i-1,y,$9);
336     white_text;
337 end;

338 procedure edit_keyboard_entry;
339     procedure delete_char( var d : data_block_type; i : integer);
340     begin
341         with d do vs := copy(vs,1,i-1)+right(vs,length(vs)-i)+' ';
342     end;

343     procedure insert_char( var d : data_block_type; var i:integer; code:integer);
344     begin
345         with d do
346             begin
347                 vs := copy(vs,1,i-1)+chr(code)+copy(vs,i,length(vs)-i);
348                 if i<length(vs) then inc(i);
349             end;
350     end;

351     procedure validate_data( var d:data_block_type; f1,f2 : integer);
352     var
353         error_code : integer;
354     begin
355         with d do
356             begin
357                 val(strip_spaces(vs),v,error_code);
358                 if error_code=0 then
359                     update(d,d.v,f1,f2);
360             end;
361     end;

362 begin {edit_keyboard_entry}
363     with kb do
364         begin
365             case last_key_code of
366                 CHome           : begin
367                     data.vs := spaces(9);
368                     index  := 1;
369                 end;
370                 HOME            : index := 1;
371                 Endkey          : index := length(data.vs);
372                 Delkey         : delete_char(data,index);
373                 RightArrow     : wrap_up(index,length(data.vs));
374                 LeftArrow      : wrap_down(index,length(data.vs));
375                 BS              : begin
376                     if index>1 then
377                         dec(index);
378                         delete_char(data,index);
379                     end;
380                 ord('-'),ord('.') ,ord(' ') ,ord('0')..ord('9')
381                 : begin
382                     if first then
383                         begin
384                             data.vs := spaces(length(data.vs));
385                             case last_key_code of
386                                 ord('-') : index := 1;
387                                 ord('.') :
388                                     begin
389                                         data.vs := spaces(f1-f2-2)+'0'+spaces(f2+1);
390                                         index := f1-f2;
391                                     end;
392                                 else
393                                     index := 2;
394                                 end;
395                             end;
396                             insert_char(data,index,last_key_code);
397                         end;
398                     CR,TAB,STAB,DownArrow,UpArrow : validate_data(data,f1,f2);
399                 end;
400                 first := false;
401                 if data.vv then
402                     begin
403                         grey_text;

```



```

404         put_string(x,y,data.vs);
405         white_text;
406     end
407 else
408     put_highlighted_string(x,y,data.vs,index);
409 end;
410 end; {edit_keyboard_entry}

411 procedure start_keyboard_entry(value:float; xd,yd,f1d,f2d : integer);
412 begin
413     with kb do
414     begin
415         f1 := f1d; f2 := f2d; x := xd; y := yd;
416         update(data,value,f1,f2);
417         index := length(data.vs);
418         first := true;
419         put_highlighted_string(x,y,data.vs,index);
420         data.vv := false;
421     end;
422 end;

423 procedure start_drive_entry(n : integer);
424 begin
425     with kb do
426     begin
427         kb_drive_number := n;
428         start_keyboard_entry(drive[n].fp_setpoint,screen_offset_fp[n],8,9,6);
429     end;
430 end;

431 procedure set_filter (var f : filter_type;
432                       new_value:float;
433                       new_length,new_guard : integer);
434 var
435     i : integer;
436 begin {set_filter}
437     with f do
438     begin
439         length := new_length;
440         guard := new_guard;
441         for i := 1 to length do history[i] := new_value;
442         index := 1;
443         count := 0;
444         mean := new_value;
445         valid := false;
446     end;
447 end; {set_filter}

448 procedure apply_filter (var f : filter_type; new_value : float);
449 var
450     i : integer;
451     sum : float;
452 begin {apply_filter}
453     with f do
454     begin
455         history[index] := new_value;
456         inc(count);
457         valid := valid or (count>=length+guard);
458         wrap_up(index,length);
459         sum := 0;
460         for i := 1 to length do sum := sum+history[i];
461         mean := sum/length;
462     end;
463 end; {apply_filter}

464 procedure set_stats( var s : stats_type);
465 var
466     i : integer;
467 begin
468     with s do
469     begin
470         n := 0; sx := 0; sx2 := 0; sy := 0; sy2 := 0; sxy := 0;
471         for i := 1 to stats_data_max do
472             begin

```

```

473         x[i] := 0; y[i] := 0; error[i] := 0;
474     end;
475 end;
476 end;

477 procedure enter_stats( var s: stats_type; xd,yd:float);
478 begin
479     with s do
480     begin
481         inc(n);
482         sx := sx+xd;
483         sx2 := sx2+sqr(xd);
484         sy := sy+yd;
485         sy2 := sy2+sqr(yd);
486         sxy := sxy+xd*yd;
487         x[n] := xd;
488         y[n] := yd;
489     end;
490 end;

491 procedure apply_stats(var s: stats_type);
492 var
493     i : integer;
494 begin
495     with s do
496     if n>1 then
497     begin
498         xb := sx/n; yb := sy/n;
499         var_x := (sx2-sqr(sx)/n)/n;
500         var_y := (sy2-sqr(sy)/n)/n;
501         b := (sxy-(sx*sy)/n)/(sx2-sqr(sx)/n);
502         a := 1/n*(sy-b*sx);
503         cov := 0;
504         for i := 1 to n do
505             begin
506                 error[i] := y[i]-(a+b*x[i]);
507                 cov := cov+(x[i]-xb)*(y[i]-yb);
508             end;
509         cov := cov/n;
510         r := cov/sqrt(var_x*var_y);
511     end
512     else
513     begin
514         a := 0; b := y[1]; error[1] := 0; r := 1;
515     end;
516 end;

517 procedure report_time_of_last_calibration;
518 var
519     time : longint;
520     DT : DateTime; { from dos unit }
521 begin
522     GetFTime(fp,time);
523     UnpackTime(time,DT);
524     grey_text;
525     with DT do put_string(42,21,' Last calibration '+
526         copy(time_string(Hour,Min,Sec),1,5)+
527         ' on '+date_string(Year,Month,Day));
528     put_string(42,23,spaces(37));
529     white_text;
530 end;

531 procedure report_current_time;
532 var
533     Year,Month,Day,DayofWeek,Hour,Min,Sec,Sec100 : word;
534 begin
535     if abs(ticks-ticks_clock)>ticks_clock_max then
536     begin
537         ticks_clock := ticks;
538         GetDate(Year,Month,Day,DayofWeek);
539         GetTime(Hour,Min,Sec,Sec100);
540         grey_text;
541         put_string(50,22,'Currently '+ copy(time_string(Hour,Min,Sec),1,5)+
542         ' on '+date_string(Year,Month,Day));

```

```

543         white_text;
544     end;
545 end;

546 procedure write_all_parameters;
547     procedure write_stats(var s : stats_type);
548     var
549         i : integer;
550     begin
551         with s do
552             begin
553                 writeln(ft,'Temperature (in) = ',temperature_in:7:4);
554                 writeln(ft,'Number= ',n);
555                 for i := 1 to n do
556                     writeln(ft,i:4,' ',x[i]:11:1,' ',y[i]:12:8,' ',error[i]:12:8);
557                 writeln(ft,'mean x= ',xb:11:1,' mean_y := ',yb:12:8);
558                 writeln(ft,'a= ',a,' b= ',b,' r= ',r);
559             end;
560         end;
561     var
562         i : integer;
563     begin {write_all_parameters}
564         message('Saving parameters and calibration data',3);
565         assign(ft,file_text);
566         rewrite(ft);
567         assign(fp,file_binary);
568         rewrite(fp);
569         for i := 1 to max_drive do
570             with drive[i] do
571                 begin
572                     writeln(ft,'Drive= ',i);
573                     p.p_stats := cal.p_stats;
574                     p.s_stats := cal.s_stats;
575                     writeln(ft,'Coil Resistance = ',p.r_coil.vs);
576                     writeln(ft,'Heater Resistance= ',p.r_heater.vs);
577                     writeln(ft,'Primary DAC statistics');
578                     write_stats(p.p_stats);
579                     write_stats(p.s_stats);
580                     write(fp,p);
581                     report_time_of_last_calibration;
582                 end;
583             end;
584         close(ft);
585         close(fp);
586     end; {write_all_parameters}

587 procedure restore_all_parameters;
588     var
589         i : integer;
590     begin {restore_all_parameters}
591         for i := 1 to max_drive do
592             begin
593                 drive[i].p.valid := false;
594                 for j := 1 to space_for_parameters do
595                     drive[i].p.data[j] := data_block_null;
596                 white_text;
597             end;
598             if file_exists(file_binary) then
599                 begin
600                     assign(fp,file_binary);
601                     reset(fp);
602                     message('Restoring parameters and calibration data',3);
603                     for i := 1 to max_drive do
604                         with drive[i] do
605                             begin
606                                 read(fp,p);
607                                 cal.p_stats := p.p_stats;
608                                 cal.s_stats := p.s_stats;
609                             end;
610                             report_time_of_last_calibration;
611                             close(fp);
612                         end
613                     else
614                         begin

```

```

615         for i := 1 to max_drive do drive[i].p.valid := false;
616         put_string(42,21,'No Previous Calibration');
617         end;
618     end; {restore_all_parameters}

619     procedure prepare_com_files(var ft : file_type; com : com_type);
620     type
621         direction_type = (input,output);

622         procedure prepare_com_file( var f : text; com : com_type;
623             direction : direction_type);
624         var
625             error : word;
626             options : _OptionRecord;
627         begin {prepare_com_file}
628             with StdOpen do
629                 begin
630                     _In_Queue_Size := 1024;
631                     _Out_Queue_Size := 1024;
632                     _Port_Address := com.address;
633                     _Int_Level := com.IRQ;
634                 end;
635                 __assignDD(f,com.number);
636                 if direction = input then
637                     reset(f)
638                 else
639                     rewrite(f);
640                 error := __RetOpDD(f,options);
641                 if (error<>0) then
642                     writeln('Unable to read port settings - error=',error);
643                 with options do
644                     begin
645                         _BaudRate := 9600;
646                         _Parity := 0;
647                         _DataBits := 8;
648                         _StopBits := 1;
649                         _RequireCTS := false;
650                     end;
651                 error := __SetOpDD(f,options);
652                 if (error<>0) then
653                     writeln('Unable to set port settings - error=',error);
654                 end; {prepare_com_file}
655             begin {prepare_com_files}
656                 prepare_com_file(ft.inp,com,input);
657                 prepare_com_file(ft.out,com,output);
658             end; {prepare_com_files}

659     procedure initialise_com( var com : com_type; channel : integer);
660     begin
661         with com do
662             begin
663                 number := com_ref[channel].number;
664                 address := com_ref[channel].address;
665                 IRQ := com_ref[channel].IRQ;
666                 last_command := '';
667                 last_reply := '';
668                 state := idle;
669                 response := true;
670             end;
671         end;

672     procedure initialise_loop_time(var d : drive_type);
673     begin
674         with d.loop_time do
675             begin
676                 current_tick := ticks;
677                 set_filter(filter,0,loop_time_filter_length,2);
678             end;
679         end;

680     procedure initialise_drive(var dr : drive_type; channel : integer);
681     var
682         i : integer;
683     begin

```

```

684     with dr do
685         begin
686             number := channel;
687             initialise_com(com,channel);
688             prepare_com_files(f,com);
689             case channel of
690                 1 : drive[1].vref := 0.61772; {voltage across R44 of DRIVE 1}
691                 2 : drive[2].vref := 0.61700; {voltage across R44 of DRIVE 2}
692             end;
693             loop_state := loop_idle;
694             longint_precision_adc := 0;
695             s_trim := 0;
696             fp_setpoint := 0;
697             fp_last_setpoint := 1.0e10 ; {impossibly large to force lookup}
698             fp_precision_adc := 0;
699             fp_p_dac := 0.0;
700             fp_s_dac := 0.0;
701             fp_h_dac := 0.0;
702             fp_agnd := 0.0;
703             fp_d1 := 0.0;
704             fp_d2 := 0.0;
705             fp_temperature_in := 0.0;
706             fp_temperature_out := 0.0;
707             precision_adc := '';
708             agnd := '';
709             d1 := '';
710             d2 := '';
711             sensor_in := '';
712             sensor_out := '';
713             loop_state := loop_idle;
714             ticks_Y := ticks-ticks_Y_max;
715             ticks_loop := ticks-ticks_loop_max;
716             set_filter(padc_filter,fp_setpoint,precision_adc_filter_length,2);
717             initialise_loop_time(dr);
718             cal.state := cal_idle;
719             monitor_count := 1;
720         end;
721     end; {initialise_drive}

722     procedure initialise_host(var hs : host_type; channel : integer);
723     begin
724         with hs do
725             begin
726                 initialise_com(com,channel);
727                 prepare_com_files(f,com);
728                 fp_setpoint := 0;
729                 fault := false;
730             end;
731         end;

732     procedure send_drive_command(var dr : drive_type; message : string);
733     begin
734         with dr do
735             begin
736                 {$I-}
737                 write(f.out,message+chr(13));
738                 {$I+}
739                 with com do
740                     begin
741                         last_command := message;
742                         last_reply := '';
743                         error := IOResult;
744                         state := command_sent;
745                         ticks_timeout := ticks;
746                     end;
747                 end;
748             end; {send_drive_command}

749     procedure send_host_reply(var hs : host_type; message : string);
750     begin
751         with hs do
752             begin
753                 {$I-}
754                 write(f.out,'K'+message+chr(04));

```

```

755     {$I+}
756     with com do
757         begin
758             last_command := '';
759             last_reply := message;
760             error := IOResult;
761             state := reply_sent;
762         end;
763     end;
764 end; {send_host_reply}

765 procedure get_drive_reply(var dr : drive_type);
766 const
767     ack_string = 'Y'+chr(13)+chr(10);
768     nack_string = 'N'+chr(13)+chr(10);
769 var
770     ch : char;
771     len : integer;
772     ts : string;
773 begin {get_drive_reply}
774     with dr.com do
775         begin
776             repeat
777                 read(dr.f.inp,ch);
778                 if ord(ch)<>26 then
779                     begin
780                         last_reply := last_reply+ch;
781                         if right(last_reply,length(ack_string))=ack_string then
782                             state := ack_received;
783                         if right(last_reply,length(nack_string))=nack_string then
784                             state := nack_received;
785                     end;
786             until ord(ch)=26;
787             if state=ack_received then
788                 begin
789                     if pos(last_command,last_reply)=1 then
790                         begin
791                             last_reply := copy(last_reply,length(last_command)+3,
792                                             length(last_reply)-length(last_command)-5);
793                             state := valid_reply;
794                             inc(reply_count);
795                             if not response then
796                                 begin
797                                     response := true;
798                                     put_string(screen_offset_hex[dr.number],2,spaces(12));
799                                 end;
800                             end;
801                         end;
802                     if abs(ticks-ticks_timeout)>ticks_timeout_max then
803                         begin
804                             send_drive_command(dr,dr.com.last_command);
805                             response := false;
806                             gotoxy(screen_offset_hex[dr.number],2);
807                             blinking_white_text;
808                             Write('No Response');
809                             white_text;
810                         end;
811                     end;
812                 end; {get_drive_reply}

813 procedure get_host_command(var hs : host_type);
814 const
815     end_string = chr(4);
816 var
817     ch : char;
818     len : integer;
819     ts : string;
820 begin {get_host_command}
821     with hs.com do
822         begin
823             repeat
824                 read(hs.f.inp,ch);
825                 if ord(ch)<>26 then
826                     begin

```

```

827         last_command := last_command+ch;
828         if right(last_command,length(end_string))=end_string then
829             state := command_received;
830         end;
831     until ord(ch)=26;
832     if (state=command_received) and
833         (length(last_command)=13) and
834         (copy(last_command,1,2)='K0') and
835         (copy(last_command,4,1)='V') then
836         with hs do
837             begin
838                 drive_id := hs.com.last_command[3];
839                 if ord(drive_id)>128 then
840                     drive_number := ord(drive_id)-$80
841                 else
842                     drive_number := ord(drive_id)-ord('0');
843                 fp_setpoint := 5.0/8388608*hex_to_longint(copy(hs.com.last_command,5,8));
844                 if (drive_number in[1..2]) and
845                     (fp_setpoint<5.0) and
846                     (fp_setpoint>-5.0) then
847                     state := valid_command;
848                 end;
849             end;
850         end; {get_host_command}

851     procedure put_shaded_number(x,y:integer; number:float;
852                                f1,f2:integer; flag:boolean);
853     begin
854         if flag then
855             white_text
856         else
857             grey_text;
858         put_number(x,y,number,f1,f2);
859         white_text;
860     end; {put_shaded_number}

861     function find_nearest_index(s:stats_type; yd:float) : integer;
862     var
863         i,j : integer;
864         min_difference,difference : float;
865     begin {find_nearest_index}
866         min_difference := 1e5;
867         with s do
868             begin
869                 for i := 1 to n do
870                     begin
871                         difference := abs(s.y[i]-yd);
872                         if difference<min_difference then
873                             begin
874                                 j := i;
875                                 min_difference := difference;
876                             end;
877                         end;
878                     end;
879                 find_nearest_index := j;
880             end; {find_nearest_index}

881     procedure control_loop;
882     var
883         drive_number : integer;
884         procedure calc_and_disp_aux_adc;
885     begin
886         with drive[drive_number] do
887             begin {calc_and_disp_aux_adc}
888                 grey_text;
889                 put_string(screen_offset_hex[drive_number],15,d1);
890                 put_string(screen_offset_hex[drive_number],16,d2);
891                 put_string(screen_offset_hex[drive_number],17,sensor_in);
892                 put_string(screen_offset_hex[drive_number],18,sensor_out);
893                 white_text;
894                 fp_agnd := max132_hex_to_fp(agnd,vref);
895                 fp_d1 := (max132_hex_to_fp(d1,vref)-fp_agnd)*24.2;
896                 fp_d2 := (max132_hex_to_fp(d2,vref)-fp_agnd)*24.2;

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```

897         fp_temperature_in := (max132_hex_to_fp(sensor_in,vref)-fp_agnd)*100.0;
898         fp_temperature_out := (max132_hex_to_fp(sensor_out,vref)-fp_agnd)*100.0;
899         put_number(screen_offset_fp[drive_number]-1,15,fp_d1,8,4);
900         put_number(screen_offset_fp[drive_number]-1,16,fp_d2,8,4);
901         put_number(screen_offset_fp[drive_number],17,fp_temperature_in,5,2);
902         put_number(screen_offset_fp[drive_number],18,fp_temperature_out,5,2);
903     end;
904 end; {calc_and_disp_aux_adc}

905 procedure calc_and_disp_precision_adc;
906 var
907     i : integer;
908     sum : float;
909 begin {calc_and_disp_precision_adc}
910     with drive[drive_number] do
911         begin
912             grey_text;
913             put_string(screen_offset_hex[drive_number],6,precision_adc);
914             white_text;
915             put_number(screen_offset_fp[drive_number],5,fp_setpoint,9,6);
916             put_number(screen_offset_fp[drive_number],6,fp_precision_adc,9,6);
917             apply_filter(padc_filter,fp_precision_adc);
918             fp_mean_error := padc_filter.mean-fp_setpoint;
919             put_shaded_number(screen_offset_fp[drive_number],7,
920                 fp_mean_error,9,6,padc_filter.valid);
921             wrap_up(monitor_count,4);
922             put_string(screen_offset_fp[drive_number]+10,6,
923                 monitor_char[monitor_count]);
924         end;
925     end; {calc_and_disp_precision_adc}

926 procedure display_settings;
927 var
928     sum : longint;
929     i : integer;
930 begin {display_settings}
931     with drive[drive_number] do
932         begin
933             grey_text;
934             put_string(screen_offset_hex[drive_number],10,p_dac);
935             put_string(screen_offset_hex[drive_number],11,s_dac);
936             put_string(screen_offset_hex[drive_number]+5,11,
937                 longint to hex(s_trim,2));
938             put_string(screen_offset_hex[drive_number],12,h_dac);
939             white_text;
940             put_number(screen_offset_fp[drive_number],10,fp_p_dac,8,5);
941             put_number(screen_offset_fp[drive_number],11,fp_s_dac,8,5);
942             put_number(screen_offset_fp[drive_number],12,fp_h_dac,8,5);
943             put_number(screen_offset_fp[drive_number],13,fp_power,5,2);
944             with loop_time do
945                 begin
946                     last_tick := current_tick;
947                     current_tick := ticks;
948                     apply_filter(filter,abs(current_tick-last_tick));
949                     put_shaded_number(screen_offset_fp[drive_number],19,
950                         filter.mean/18.2,5,2,filter.valid);
951                 end;
952             end;
953     end; {display_settings}

954 procedure auto_trim( var d : drive_type);
955 var
956     difference : float;
957 begin
958     with d do
959         begin
960             if padc_filter.valid then
961                 begin
962                     difference := (fp_setpoint-padc_filter.mean);
963                     if abs(difference)>max_error then
964                         begin
965                             s_trim := s_trim+sign(difference);
966                             set_filter(padc_filter,fp_setpoint,4,0);
967                         end;

```



```

968         end;
969     end;
970 end; {auto_trim}

971 procedure maintain_constant_power( var d : drive_type);
972 var
973     max_power : float;
974 begin {maintain_constant_power}
975     with d do
976     begin
977         max_power := sqr(5/r_ref)*p.r_coil.v;
978         fp_h_dac  := r_ref*sqr((max_power-sqr(fp_setpoint/r_ref)*p.r_coil.v)/
979             p.r_heater.v);
980         fp_power  := sqr(fp_h_dac/r_ref)*p.r_heater.v+
981             sqr(fp_setpoint/r_ref)*p.r_coil.v;
982     end;
983 end; {maintain_constant_power}

984 procedure set_dacs(var d : drive_type);
985 begin
986     with d do
987     begin
988         case cal.state of
989             cal_idle,cal_finished :
990             begin
991                 if fp_setpoint<>fp_last_setpoint then
992                     nearest_index := find_nearest_index(cal.p_stats,fp_setpoint);
993                     fp_last_setpoint := fp_setpoint;
994                     p_code := round(cal.p_stats.x[nearest_index]);
995                     s_code := round((fp_setpoint-cal.p_stats.y[nearest_index])/
996                         cal.s_stats.b)+s_trim;
997                     fp_p_dac := p_code*5.0/32768;
998                     fp_s_dac := s_code*5.0/32768;
999                     maintain_constant_power(d);
1000                     h_code := round(fp_h_dac/5.0*32768);
1001                     auto_trim(d);
1002             end;
1003             cal_p :
1004             begin
1005                 fp_p_dac := fp_setpoint;
1006                 fp_s_dac := 0;
1007                 maintain_constant_power(d);
1008                 p_code := round(fp_p_dac/5.0*32768);
1009                 s_code := 0;
1010                 h_code := round(fp_h_dac/5.0*32768);
1011             end;
1012             cal_s :
1013             begin
1014                 fp_p_dac := 0;
1015                 fp_s_dac := fp_setpoint*64;
1016                 maintain_constant_power(d);
1017                 p_code := 0;
1018                 s_code := round(fp_s_dac/5.0*32768);
1019                 h_code := round(fp_h_dac/5.0*32768);
1020             end;
1021         end;
1022         p_dac := longint_to_hex(p_code,4);
1023         s_dac := longint_to_hex(s_code,4);
1024         h_dac := longint_to_hex(h_code,4);
1025     end;
1026 end; {set_dacs}

1027 begin {control_loop}
1028     for drive_number := 1 to 2 do
1029     with drive[drive_number] do
1030     begin
1031         case drive[drive_number].loop_state of
1032             loop_idle :
1033             begin
1034                 if abs(ticks-ticks_loop) > ticks_loop_max then
1035                 begin
1036                     send_drive_command(drive[drive_number],'x');
1037                     loop_state := sent_X;
1038                     ticks_loop := ticks;

```

```

1039         end;
1040     sent_X :
1041     begin
1042         get_drive_reply(drive[drive_number]);
1043         if com.state=valid_reply then
1044             begin
1045                 precision_adc := com.last_reply;
1046                 fp_precision_adc := p_adc_hex_to_fp(precision_adc);
1047                 calc_and_disp_precision_adc;
1048                 loop_state := received_X;
1049             end;
1050         end;
1051     received_X :
1052     begin
1053         if abs(ticks-ticks_Y) > ticks_Y_max then
1054             begin
1055                 send_drive_command(drive[drive_number],'y');
1056                 loop_state := sent_Y;
1057                 ticks_Y := ticks;
1058             end
1059         else
1060             loop_state := received_Y;
1061         end;
1062     sent_Y :
1063     begin
1064         get_drive_reply(drive[drive_number]);
1065         if com.state=valid_reply then
1066             with drive[drive_number] do
1067                 begin
1068                     agnd := copy(com.last_reply,1,6);
1069                     d1 := copy(com.last_reply,13,6);
1070                     d2 := copy(com.last_reply,19,6);
1071                     sensor_in := copy(com.last_reply,25,6);
1072                     sensor_out := copy(com.last_reply,31,6);
1073                     calc_and_disp_aux_adc;
1074                     loop_state := received_Y;
1075                 end;
1076             end;
1077         end;
1078     received_Y :
1079     begin
1080         set_dacs(drive[drive_number]);
1081         send_drive_command(drive[drive_number],'z'+s_dac+p_dac+h_dac);
1082         loop_state := sent_Z;
1083     end;
1084     sent_Z :
1085     begin
1086         get_drive_reply(drive[drive_number]);
1087         if com.state=valid_reply then
1088             begin
1089                 loop_state := received_Z;
1090                 display_settings;
1091             end;
1092         end;
1093     received_Z :
1094     begin
1095         loop_state := loop_idle;
1096         inc(loop_count);
1097     end;
1098 end;
1099 end; {control_loop}
1100
1101 procedure display_options(x,y : integer; s:string);
1102 var
1103     i : integer;
1104 begin {display_options}
1105     grey_text;
1106     put_string(x,y,'Options');
1107     gotoxy(x,y+2);
1108     for i := 1 to length(s) do
1109         begin
1110             if s[i] in ['A'..'Z'] then
1111                 white_text_with_underline

```

```

1112         else
1113             grey_text;
1114             write(s[i]);
1115         end;
1116     end; {display_options}

1117     procedure draw_main_form;
1118     begin
1119         clrscr;
1120         horizontal_line(1,78,20,1,TextAttr);
1121         vertical_line(40,21,23,1,TextAttr);
1122         put_string2(31,2,'DRIVE 1',59,2,'DRIVE 2');
1123         put_string2(26,3,'Floating',54,3,'Floating');
1124         put_string2(3,5,'Set Point',20,5,'V');
1125         put_string2(3,6,'Precision ADC',20,6,'V');
1126         put_string2(3,7,'Mean Difference',20,7,'V');
1127         put_string2(3,8,'Keyboard Entry',20,8,'V');
1128         put_string2(3,10,'Primary DAC',20,10,'V');
1129         put_string2(3,11,'Secondary DAC',20,11,'V');
1130         put_string2(3,12,'Heater_DAC',20,12,'V');
1131         put_string2(3,13,'Power',20,13,'W');
1132         put_string2(3,15,'Amplifier 1',20,15,'V');
1133         put_string2(3,16,'Amplifier 2',20,16,'V');
1134         put_string2(3,17,'Temperature in',19,17,chr(248)+'C');
1135         put_string2(3,18,'Temperature out',19,18,chr(248)+'C');
1136         put_string2(3,19,'Mean Loop Time',20,19,'s');
1137         display_options(3,21,'Abort Calibrate Exit Host Keyboard');
1138         grey_text;
1139         put_string(3,2,'Source=');
1140         put_string2(39,3,'HEX',67,3,'HEX');
1141         white_text;
1142     end; {draw_main_form}

1143     procedure cursor_control(a,b : byte);
1144     var
1145         Regs : Registers;
1146     begin
1147         Regs.AH := 1;
1148         Regs.CH := a;
1149         Regs.CL := b;
1150         Intr(16,Regs);
1151     end;

1152     procedure cursor_on;
1153     begin
1154         cursor_control(11,12);
1155     end;

1156     procedure cursor_off;
1157     begin
1158         cursor_control($20,12);
1159     end;

1160     {$F+}
1161     procedure MyExit;
1162     begin
1163         ExitProc := ExitSave;
1164         close(drive[1].f.inp);
1165         close(drive[1].f.out);
1166         close(drive[2].f.inp);
1167         close(drive[2].f.out);
1168         cursor_on;
1169         closewindow;
1170         clrscr;
1171     end; {MyExit}
1172     {$F-}

1173     function warning(typ : warning_type) : boolean;
1174     const
1175         message : array[0..2] of string[25] =
1176             ('OK to Exit?      Y/N',
1177              'OK to Abort?      Y/N',
1178              'OK to Calibrate Y/N');
1179     var

```

```

1180     xmin,xmax,width,depth : byte;
1181     reply,done : boolean;
1182     begin {warning}
1183         width := length(message[ord(typ)]);
1184         depth := 4;
1185         xmin := 40-width div 2 - 2;
1186         xmax := 40+width div 2 + 2;
1187         openwindow(xmin,10,xmax,10+depth,' warning ',white,$FA);
1188         put_string(2,2,message[ord(typ)]);
1189         repeat
1190             inkey;
1191             case last_key_code of
1192                 ord('y'),ord('Y') : begin
1193                     reply := true;
1194                     done := true;
1195                 end;
1196                 ord('n'),ord('N') : begin
1197                     reply := false;
1198                     done := true;
1199                 end;
1200             end;
1201         until done;
1202         warning := reply;
1203         closewindow;
1204     end; {warning}

1205     procedure flush_host(var hs : host_type);
1206     var
1207         ch : char;
1208     begin {flush_host}
1209         repeat
1210             read(hs.f.inp,ch);
1211             until ord(ch)=26;
1212     end; {flush_host}

1213     function test_all_parameters : boolean;
1214     var
1215         i,j : integer;
1216         flag : boolean;
1217     begin {test_all_parameters}
1218         flag := true;
1219         for i := 1 to max_drive do
1220             with drive[i].p do
1221                 begin
1222                     valid := true;
1223                     for j := 1 to number_of_parameters do
1224                         valid := valid and data[j].vv;
1225                     flag := flag and valid;
1226                 end;
1227             test_all_parameters := flag;
1228     end; {test_all_parameters}

1229     procedure edit_parameters;
1230     const
1231         screen_offset_param : array[1..max_drive] of integer = (29,45);
1232     var
1233         i,j : integer;
1234         local_done : boolean;
1235         procedure draw_form;
1236         var
1237             i,j : integer;
1238         begin {draw_form}
1239             clrscr;
1240             horizontal_line(1,57,7,1,TextAttr);
1241             put_string2(30,2,'DRIVE 1',46,2,'DRIVE 2');
1242             put_string2(3,4,'Coil Resistance',23,4,chr(234));
1243             put_string2(3,5,'Heater Resistance',23,5,chr(234));
1244             display_options(3,8,'Continue');
1245             for i := 1 to max_drive do
1246                 for j := 1 to number_of_parameters do
1247                     with drive[i].p.data[j] do
1248                         if vv then
1249                             put_string(screen_offset_param[i],3+j,vv);
1250             end; {draw_form}

```

```

1251 procedure next_entry;
1252 begin
1253     with drive[i].p do
1254         begin
1255             if not data[j].vv then
1256                 update(data[j],0,7,3);
1257             start_keyboard_entry(data[j].v,screen_offset_param[i],j+3,7,3);
1258         end;
1259     end; {next_entry}
1260 procedure cycle_pointers;
1261 begin
1262     case last_key_code of
1263         CR : begin
1264             wrap_up(j,number_of_parameters);
1265             if j=1 then wrap_up(i,max_drive);
1266         end;
1267         TAB,STAB : wrap_up(i,max_drive);
1268         UpArrow : if j>1 then dec(j);
1269         DownArrow : if j<number_of_parameters then inc(j);
1270     end;
1271     next_entry;
1272 end; {cycle_pointers}

1273 begin {edit_parameters}
1274     openwindow(11,5,69,16,' Parameters ',white,white);
1275     draw form;
1276     local_done := false;
1277     i := 1;
1278     j := 1;
1279     next_entry;
1280     repeat
1281         get_key;
1282         case last_key_code of
1283             ord('c'),ord('C') : begin
1284                 local_done := test_all_parameters;
1285                 if not local_done then
1286                     message('All parameters must be defined',2);
1287             end;
1288             0 : ;
1289             else
1290                 edit_keyboard_entry;
1291             end;
1292         case last_key_code of
1293             CR,TAB,STAB,DownArrow,UpArrow : if kb.data.vv then
1294                 begin
1295                     drive[i].p.data[j] := kb.data;
1296                     cycle_pointers
1297                 end
1298             else
1299                 message('Invalid Entry',1);
1300         end;
1301     until local_done;
1302     closewindow;
1303 end; {edit_parameters}

1304 procedure execute_host_command(var hs : host_type);
1305 begin
1306     case hs.com.state of
1307         valid_command :
1308             begin
1309                 drive[hs.drive_number].fp_setpoint := hs.fp_setpoint;
1310                 { possibly change length of filter depending on the difference
1311                   between hs.fp_setpoint and drive[?].fp_setpoint }
1312                 set_filter(drive[hs.drive_number].padc_filter,
1313                     drive[hs.drive_number].fp_setpoint,
1314                     precision_adc_filter_length,2);
1315                 send_host_reply(hs,hs.drive_id);
1316             end;
1317         command_received :
1318             begin
1319                 send_host_reply(hs,'E');
1320             end;
1321     end;
1322 end; {execute_host_command}

```

```

1323 procedure set_source(src : source_type);
1324 var
1325     i : integer;
1326 begin {set_source}
1327     source := src;
1328     for i := 1 to max_drive do put_string(screen_offset_fp[i],8,spaces(12));
1329     white_text;
1330     case source of
1331         host_pc : begin
1332             put_string(10,2,'HOST PC  ');
1333             flush_host(host);
1334             for i := 1 to max_drive do
1335                 with drive[i] do
1336                     begin
1337                         cal.state := cal_idle;
1338                         fp_setpoint := 0;
1339                         set_filter(padc_filter,fp_setpoint,
1340                             precision_adc_filter_length,3);
1341                         initialise_loop_time(drive[i]);
1342                     end;
1343                 end;
1344             keyboard : put_string(10,2,'KEYBOARD  ');
1345             calibrate : begin
1346                 put_string(10,2,'CALIBRATION');
1347                 edit_parameters;
1348                 for i := 1 to max_drive do
1349                     drive[i].cal.state := cal_start;
1350                 end;
1351             end;
1352 end; {set_source}

```

```

1353 procedure keyboard_activity;
1354 var
1355     i : integer;
1356     s : string;
1357 begin {keyboard_activity}
1358     get_key;
1359     case source of
1360         keyboard :
1361             case last_key_code of
1362                 ESC : set_source(host_pc);
1363                 ord('c'),ord('C') : if warning(calib) then
1364                     set_source(calibrate);
1365                 ord('e'),ord('E') : done := warning(exit);
1366                 ord('h'),ord('H') : set_source(host_pc);
1367                 0 : { no key => no action };
1368             else
1369                 with kb do
1370                     begin
1371                         edit_keyboard_entry;
1372                         if data.vv then
1373                             begin
1374                                 case kb_drive_number of
1375                                     1 : begin
1376                                         drive_data[1] := data;
1377                                         start_drive_entry(2);
1378                                     end;
1379                                     2 : begin
1380                                         if last_key_code=TAB then
1381                                             start_drive_entry(1)
1382                                         else
1383                                             if abs(drive_data[1].v-data.v)<=
1384                                                 differential_range then
1385                                                 begin
1386                                                     drive_data[2] := data;
1387                                                     drive[1].fp_setpoint := drive_data[1].v;
1388                                                     set_filter(drive[1].padc_filter,
1389                                                         drive[1].fp_setpoint,
1390                                                         precision_adc_filter_length,3);
1391                                                     drive[2].fp_setpoint := drive_data[2].v;
1392                                                     set_filter(drive[2].padc_filter,
1393                                                         drive[2].fp_setpoint,
1394                                                         precision_adc_filter_length,3);

```

```

1395         start_drive_entry(1);
1396     end
1397     else
1398     begin
1399         str(differential_range:3,s);
1400         message('Differential is greater than '+s,0);
1401         start_drive_entry(1);
1402     end
1403     end;
1404 end;
1405 end;
1406 end
1407 end;
1408 host_pc :
1409 case last_key_code of
1410     ord('c'),ord('C') : if warning(calib) then
1411         set_source(calibrate);
1412     ord('e'),ord('E') : done := warning(exit);
1413     ord('k'),ord('K') :
1414         begin
1415             set_source(keyboard);
1416             start_drive_entry(1);
1417         end;
1418     end;
1419 calibrate :
1420 case last_key_code of
1421     ord('a'),ord('A') : if warning(abort) then
1422         begin
1423             if file_exists(file_binary) then
1424                 begin
1425                     restore_all_parameters;
1426                     set_source(host_pc);
1427                 end
1428             else
1429                 message('Cannot abort first calibration',wait);
1430             end;
1431     ord('e'),ord('E') : done := warning(exit); .
1432     end;
1433 end;
1434 end; {keyboard_activity}

1435 procedure calibrate_cycle;
1436 const
1437     p_bits = 7; {7}
1438     s_bits = 6; {6}
1439     p_limit = 2*( 1 shl (p_bits-1) - 1);
1440     s_limit = 2*( 1 shl (s_bits-1) - 1);
1441     guard = 3;

1442 procedure define_setpoint(var d : drive_type; k : integer);
1443 function fun(bits,limit,count : integer) : float;
1444 const
1445     one : longint = 1; { force long integer calculations }
1446 begin {fun}
1447     fun := (one shl (16-bits))*5/32768*(count-(limit div 2));
1448 end; {fun}
1449 begin {define_setpoint}
1450     with d do
1451         begin
1452             case cal.state of
1453                 cal_p : fp_setpoint := fun(p_bits,p_limit,cal.p_stats.n);
1454                 cal_s : fp_setpoint := fun(s_bits,s_limit,cal.s_stats.n)/64;
1455             end;
1456             set_filter(padc_filter,fp_setpoint,precision_adc_filter_length*k,guard);
1457         end;
1458     end; {define_setpoint}

1459 procedure display_finish_time;
1460 var
1461     number_of_samples,ts,tm,th,fth,ftm : longint;
1462     Hour,Min,Sec,Sec100 : word;
1463 begin {display_finish_time}
1464     number_of_samples := 4*precision_adc_filter_length + 2*guard +
1465         (precision_adc_filter_length+guard)*(p_limit+s_limit);

```

```

1466     if drive[1].loop_time.filter.valid then
1467         ts := round(drive[1].loop_time.filter.mean/18.2*number_of_samples)
1468     else
1469         ts := round(number_of_samples*ticks_loop_max/18);
1470     tm := ts div 60;
1471     if (ts mod 60)>30 then
1472         inc(tm);
1473     th := tm div 60;
1474     GetTime(Hour,Min,Sec,Sec100);
1475     ftm := (Min+tm) mod 60;
1476     fth := (Hour+th+(Min+tm) div 60) mod 24;
1477     grey_text;
1478     put_string(42,23,'Calibration until '+copy(time_string(fth,ftm,0),1,5)+
1479         ' approx. ');
1480     white_text;
1481     end; {display_finish_time}

1482 var
1483     i : integer;
1484     begin {calibrate_cycle}
1485         for i := 1 to max_drive do
1486             with drive[i].cal do
1487                 case state of
1488                     cal_idle : ;
1489                     cal_start :
1490                         begin
1491                             set_stats(p_stats);
1492                             state := cal_p;
1493                             define_setpoint(drive[i],2);
1494                             drive[i].s_trim := 0;
1495                             if i=1 then
1496                                 display_finish_time;
1497                             end;
1498                         cal_p :
1499                             begin
1500                                 if drive[i].padc_filter.valid then
1501                                     begin
1502                                         enter_stats(p_stats,drive[i].p_code,
1503                                             drive[i].padc_filter.mean);
1504                                         if p_stats.n=p_limit/2 then { record in middle of run }
1505                                             p_stats.temperature_in := drive[i].fp_temperature_in;
1506                                         if p_stats.n<=p_limit then
1507                                             define_setpoint(drive[i],1)
1508                                         else
1509                                             begin
1510                                                 apply_stats(p_stats);
1511                                                 set_stats(s_stats);
1512                                                 state := cal_s;
1513                                                 define_setpoint(drive[i],2);
1514                                             end;
1515                                         end;
1516                                     end;
1517                                 cal_s :
1518                                     begin
1519                                         if drive[i].padc_filter.valid then
1520                                             begin
1521                                                 enter_stats(s_stats,drive[i].s_code,
1522                                                     drive[i].padc_filter.mean);
1523                                                 if s_stats.n=s_limit/2 then { record in middle of run }
1524                                                     s_stats.temperature_in := drive[i].fp_temperature_in;
1525                                                 if s_stats.n<=s_limit then
1526                                                     define_setpoint(drive[i],1)
1527                                                 else
1528                                                     begin
1529                                                         apply_stats(s_stats);
1530                                                         state := cal_finished;
1531                                                         with drive[i] do
1532                                                             begin
1533                                                                 drive[i].fp_setpoint := 0;
1534                                                                 set_filter(padc_filter,fp_setpoint,
1535                                                                     precision_adc_filter_length,3);
1536                                                             end;
1537                                                         end;
1538                                                     end;
1539                                     end;
1540                                 end;
1541                             end;
1542                         end;
1543                 end;
1544             end;
1545         end;
1546     end;

```



```

1539         end;
1540         cal_finished : ;
1541         end;
1542     end; {calibrate_cycle}

1543 procedure general_initialise;
1544 begin
1545     ExitSave := ExitProc;
1546     ExitProc := @MyExit;
1547     cursor_off;
1548     openwindow(1,1,80,25,' COIL CONTROLLER ',white,white);
1549     draw_main form;
1550     loop_count := 0;
1551     reply_count := 0;
1552     tries := 0;
1553     done := false;
1554     precision_adc_filter_length := 10;
1555     ticks_clock := ticks;
1556 end; {general_initialise}

1557 begin {main}
1558     general_initialise;
1559     initialise_drive(drive[1],1);
1560     initialise_drive(drive[2],2);
1561     initialise_host(host,3);
1562     restore_all_parameters;
1563     if drive[1].p.valid and drive[2].p.valid then
1564         set_source(host_pc)
1565     else
1566         set_source(calibrate);
1567     repeat
1568         keyboard_activity;
1569         case source of
1570             host_pc : begin
1571                 get_host_command(host);
1572                 execute_host_command(host);
1573             end;
1574             calibrate : begin
1575                 if (drive[1].cal.state=cal_finished) and
1576                    (drive[2].cal.state=cal_finished) then
1577                     begin
1578                         drive[1].p.valid := true;
1579                         drive[2].p.valid := true;
1580                         write_all_parameters;
1581                         set_source(host_pc);
1582                     end
1583                 else
1584                     calibrate_cycle
1585                 end;
1586             end;
1587             control_loop;
1588             inc(tries);
1589             { gotoxy(10,21); write(loop_count:6,reply_count:6,tries:8); }
1590             report_current_time;
1591         until done;
1592         clrscr;
1593         halt; {close files/coms via MyExit}
1594     end. {main}

```

```

1595 Unit ccsup;
1596 { Unit for supporting keyboard, window and screen operation
1597   copied from suplv19.pas under development by D.C. Dyer
1598 }
1599 interface
1600 uses dos,crt,win;

1601 type
1602   float = real;
1603   char_set = set of char;
1604   data_block_type = record
1605     v : float;
1606     vs : string[12];
1607     vv : boolean
1608   end;
1609   line_string = string[80];
1610   TitleStrPtr = ^TitleStr;
1611   WinRecPtr = ^WinRec;
1612   WinRec = record
1613     Next: WinRecPtr;
1614     State: WinState;
1615     Title: TitleStrPtr;
1616     TitleAttr, FrameAttr: Byte;
1617     Buffer: Pointer;
1618   end;

1619 const
1620   BELL = 7;
1621   BS = 8;
1622   LF = 10;
1623   CR = 13;
1624   TAB = 9;
1625   ESC = 27;
1626   STAB = 256+15;
1627   F1 = 256+59; F2 = 256+60; F3 = 256+61; F4 = 256+62; F5 = 256+63;
1628   F6 = 256+64; F7 = 256+65; F8 = 256+66; F9 = 256+67; F10 = 256+68;
1629   F11 = 256+133; F12 = 256+134;
1630   SF1 = 256+84; SF2 = 256+85; SF3 = 256+86; SF4 = 256+87; SF5 = 256+88;
1631   SF6 = 256+89; SF7 = 256+90; SF8 = 256+91; SF9 = 256+92; SF10 = 256+93;
1632   SF11 = 256+135; SF12 = 256+136;
1633   CF1 = 256+94; CF2 = 256+95; CF3 = 256+96; CF4 = 256+97; CF5 = 256+98;
1634   CF6 = 256+99; CF7 = 256+100; CF8 = 256+101; CF9 = 256+102; CF10 = 256+103;
1635   CF11 = 256+137; CF12 = 256+138;
1636   AF1 = 256+104; AF2 = 256+105; AF3 = 256+106; AF4 = 256+107; AF5 = 256+107;
1637   AF6 = 256+109; AF7 = 256+110; AF8 = 256+111; AF9 = 256+112; AF10 = 256+113;
1638   AF11 = 256+137; AF12 = 256+138;
1639   ALT1 = 256+120; ALT2 = 256+121; ALT3 = 256+122; ALT4 = 256+123; ALT5 = 256+124;
1640   ALT6 = 256+125; ALT7 = 256+126; ALT8 = 256+127; ALT9 = 256+128; ALTO = 256+129;
1641   ALTA = 256+30; ALTB = 256+48; ALTC = 256+46; ALTD = 256+32; ALTE = 256+18;
1642   ALTF = 256+33; ALTG = 256+34; ALTH = 256+35; ALTI = 256+23; ALTJ = 256+36;
1643   ALTK = 256+37; ALTL = 256+38; ALTM = 256+50; ALTN = 256+49; ALTO = 256+24;
1644   ALTP = 256+25; ALTQ = 256+16; ALTR = 256+19; ALTS = 256+31; ALTT = 256+20;
1645   ALTU = 256+22; ALTV = 256+47; ALTW = 256+17; ALTX = 256+45; ALTY = 256+21;
1646   ALTZ = 256+44;

1647   Home = 256+71; UpArrow = 256+72; PgUp = 256+73;
1648   LeftArrow = 256+75; RightArrow = 256+77; Endkey = 256+79;
1649   DownArrow = 256+80; PgDn = 256+81; Insertkey = 256+82;
1650   Delkey = 256+83; CPrtSc = 256+114; CLeftArrow = 256+115;
1651   CRightArrow = 256+116; CEndkey = 256+117; CPgDn = 256+118;
1652   CHome = 256+119; CPgUp = 256+132;

1653   number_set : char_set = ['0'..'9', '.', '-', '_'];
1654   filename_set : char_set = ['A'..'Z', 'a'..'z', '0'..'9', '!', '@', '#', '$', '%', '&', '(', ')', '*', '+', ',', '-', '.', ':', ';', '<', '>', '=', '?', '[', ']', '^', '_'];
1655   all_set : char_set = [chr(32)..chr(126)];

1657 var
1658   page_number : byte;
1659   relative_mode : boolean;
1660   last_key_code : integer;
1661   TopWindow : WinRecPtr;
1662   WindowCount : Integer;
1663   Regs : Registers;

```

```

1664 procedure beep;
1665 function extended_read_key : integer;
1666 procedure get_key;
1667 procedure inkey;
1668 function test_key(key_code : integer) : boolean;
1669 function spaces(number : byte) : string;
1670 function strip_spaces(s : line string) : string;
1671 function date_string(year,month,day : word) : string;
1672 function time_string(hour,minute,second : word) : string;
1673 function htod(t : char) : byte;
1674 function decimal(hx : string) : longint;
1675 procedure expand_window;
1676 procedure contract_window;
1677 procedure wrap_up( var n : integer; limit : integer);
1678 procedure wrap_down( var n : integer; limit : integer);
1679 procedure set_video_mode(mode : byte);
1680 procedure blink_enable(flag : boolean);
1681 procedure set_page(n : byte);
1682 procedure set_cursor(x,y : byte);
1683 procedure get_char(x,y : byte; var character,attribute : byte);
1684 procedure put_char(character, attribute : byte);
1685 procedure put_string(x,y : byte; s : string);
1686 procedure put_string2(x1,y1:byte;s1:string; x2,y2:byte;s2:string);
1687 procedure put_number(x,y : byte; n : float; f1,f2 : byte);
1688 procedure put_string_and_number(x1,y1:byte;s1:string;
1689                                x2,y2:byte; n:float; f1,f2 :byte);
1690 procedure change_attribute(x,y,new_attribute : byte);
1691 procedure highlight_line(xmin,xmax,y,new_attribute : byte );
1692 procedure write_boarder_char(x,y,character_index,attribute : byte);
1693 procedure horizontal_line(xa,xb,y : integer ; width,attribute : byte);
1694 procedure vertical_line(x,ya,yb : integer ; width,attribute : byte);
1695 procedure left_line(x,ya,yb,width,attribute : byte);
1696 procedure right_line(x,ya,yb,width,attribute : byte);
1697 procedure top_line(xa,xb,y,width,attribute : byte);
1698 procedure bottom_line(xa,xb,y,width,attribute : byte);
1699 procedure draw_box(xmin,ymin,xmax,ymax,width,attribute : byte);
1700 procedure update(var n : data_block type; v : float; f1,f2 : byte);
1701 procedure edit_line(xa,xb,y,next_attribute : byte; var s : line_string;
1702                    allowed_set : char_set);
1703 procedure get_full_string(xa,xb,y,next_attribute : byte; var s : line_string;
1704                           allowed_set : char_set);
1705 procedure edit_number(xa,xb,y,edit_colour, f1,f2 : byte; var d : data_block_type);
1706 procedure get_number(xa,xb,y,edit_colour : byte; f1,f2 : byte;
1707                      var d : data_block_type);
1708 procedure full_window;
1709 procedure clear_screen_area(xa,ya,xb,yb : byte);
1710 procedure ActiveWindow(Active: Boolean);
1711 procedure OpenWindow(X1, Y1, X2, Y2: Byte; T: TitleStr; TAttr, FAttr: Byte);
1712 procedure CloseWindow;

1713 implementation

1714 var
1715     character, attribute : byte;
1716     procedure beep;
1717 begin
1718     Sound(500); Delay(25); NoSound;
1719 end;

1720 function extended_read_key : integer;
1721 { Returns 0    if no key is pressed
1722              n    if an ASCII key is pressed
1723              256+n for extended keys like F1 or Alt-1 etc.
1724              See Pages 135 and 478 of The IBM PC and PS/2 by Peter Norton }
1725 var
1726     Ch : char;
1727     Code : integer;
1728 begin
1729     Code := 0;
1730     Ch := #0;
1731     if KeyPressed then
1732     begin
1733         Ch := ReadKey;

```

```

1734         if Ch = #0 then
1735             begin
1736                 Code := 256;
1737                 Ch := ReadKey;
1738             end;
1739         end;
1740         extended_read_key := Code + ord(Ch);
1741     end;

1742 procedure get_key;
1743 { assigns value to last_key_code }
1744 begin
1745     last_key_code := extended_read_key;
1746 end;

1747 procedure inkey;
1748 { waits for key and returns extended code }
1749 begin
1750     repeat
1751         last_key_code := extended_read_key;
1752     until last_key_code<>0;
1753 end;

1754 function test_key(key_code : integer) : boolean;
1755 { compares last_key_code with parameter }
1756 begin
1757     get_key;
1758     if last_key_code=key_code then
1759         test_key := true
1760     else
1761         test_key := false;
1762 end;

1763 function spaces(number : byte) : string;
1764 { returns a string of spaces }
1765 var
1766     i : integer;
1767     t : line_string;
1768 begin
1769     for i := 1 to number do t[i] := ' ';
1770     t[0] := chr(number);
1771     spaces := t;
1772 end;

1773 function strip_spaces(s : line_string) : string;
1774 { remove leading and trailing spaces }
1775 var
1776     ts : line_string;
1777 begin
1778     ts := s;
1779     while copy(ts,1,1)=' ' do
1780         ts := copy(ts,2,length(ts)-1);
1781     while copy(ts,length(ts),1)=' ' do
1782         ts := copy(ts,1,length(ts)-1);
1783     strip_spaces := ts;
1784 end;

1785 function date_string(year,month,day : word) : string;
1786 const
1787     month_names : array[1..12] of string[3] = (
1788         'Jan','Feb','Mar','Apr','May','Jun',
1789         'Jul','Aug','Sep','Oct','Nov','Dec');
1790 var
1791     ts,t : line_string;
1792 begin
1793     str(Day,2,ts);
1794     ts := ts+' '+month_names[month]+' ';
1795     str(Year,t); ts := ts+copy(t,3,2);
1796     date_string := copy(ts+spaces(8),1,9);
1797 end;

1798 function time_string(hour,minute,second : word) : string;
1799 var
1800     ts,t : line_string;

```

```

1801     begin
1802     ts := '';
1803     str(Hour,t); if length(t)=1 then t := '0'+t; ts := ts+t+'.';
1804     str(Minute,t); if length(t)=1 then t := '0'+t; ts := ts+t+'.';
1805     str(Second,t); if length(t)=1 then t := '0'+t; ts := ts+t;
1806     time_string := ts;
1807     end;

1808     function htod(t : char) : byte;
1809     { convert a hexadecimal character to byte value 0..15 }
1810     begin
1811     case t of
1812     '0'..'9' : htod := ord(t)-ord('0');
1813     'A'..'F' : htod := ord(t)-ord('A')+10;
1814     else
1815     begin
1816     write(chr(7));
1817     htod := 0;
1818     end;
1819     end { case }
1820     end;

1821     function decimal(hx : string) : longint;
1822     { convert hexadecimal string into decimal }
1823     var
1824     i : integer;
1825     temp : longint;
1826     begin
1827     temp := 0;
1828     for i := 1 to length(hx) do
1829     temp := temp*16+htod(hx[i]);
1830     decimal := temp;
1831     end;

1832     procedure expand_window;
1833     begin
1834     dec(windmin,$0101);
1835     inc(windmax,$0101);
1836     end;

1837     procedure contract_window;
1838     begin
1839     inc(windmin,$0101);
1840     dec(windmax,$0101);
1841     end;

1842     procedure wrap_up( var n : integer; limit : integer);
1843     begin
1844     if n<limit then
1845     inc(n)
1846     else
1847     n := 1;
1848     end;

1849     procedure wrap_down( var n : integer; limit : integer);
1850     begin
1851     if n>1 then
1852     dec(n)
1853     else
1854     n := limit;
1855     end;

1856     procedure set_video_mode(mode : byte);
1857     begin
1858     with Regs do
1859     begin
1860     AH := 0; { Set mode }
1861     AL := mode;
1862     Intr(16,Regs);
1863     end;
1864     end;

1865     procedure blink_enable(flag : boolean);
1866     begin

```

```

1867     with Regs do
1868         begin
1869             AH := 16; {Colour palette interface}
1870             AL := 3; {Blink option}
1871             if flag then
1872                 BL := 1 {Blink on}
1873             else
1874                 BL := 0; {Blink off}
1875             Intr(16,Regs);
1876         end;
1877     end;

1878     procedure set_page(n : byte);
1879     { selects a page and makes it active }
1880     begin
1881         with Regs do
1882             begin
1883                 AH := 5; { Set active page number }
1884                 page_number := n;
1885                 AL := n;
1886                 Intr(16,Regs);
1887             end;
1888         end;

1889     procedure set_cursor(x,y : byte);
1890     begin
1891         with Regs do
1892             begin
1893                 AH := 2; { Set cursor position }
1894                 if relative_mode then
1895                     begin
1896                         DH := y+hi(WindMin)-1;
1897                         DL := x+lo(WindMin)-1;
1898                     end
1899                 else
1900                     begin
1901                         DH := y;
1902                         DL := x;
1903                     end;
1904                 BH := page_number;
1905                 Intr(16,Regs);
1906             end;
1907         end;

1908     procedure get_char(x,y : byte; var character,attribute : byte);
1909     begin
1910         set_cursor(x,y);
1911         with Regs do
1912             begin
1913                 AH := 8; { read character and attribute }
1914                 BH := page_number;
1915                 Intr(16,Regs);
1916                 character := AL;
1917                 attribute := AH;
1918             end;
1919         end;

1920     procedure put_char(character, attribute : byte);
1921     begin
1922         with Regs do
1923             begin
1924                 if attribute=0 then
1925                     AH := 10 { write character }
1926                 else
1927                     AH := 9; { write character and attribute }
1928                 AL := character;
1929                 BH := page_number;
1930                 BL := attribute;
1931                 CX := 1;
1932                 Intr(16,Regs);
1933             end;
1934         end;

1935     procedure put_string(x,y : byte; s : string);

```

```

1936     var
1937         i : integer;
1938     begin
1939         if length(s)<>0 then
1940             for i := 1 to length(s) do
1941                 begin
1942                     set_cursor(x+i-1,y);
1943                     put_char(ord(s[i]),textattr);
1944                 end;
1945     end;

1946     procedure put_string2(x1,y1:byte;s1:string; x2,y2:byte;s2:string);
1947     begin
1948         put_string(x1,y1,s1);
1949         put_string(x2,y2,s2);
1950     end;

1951     procedure put_number(x,y : byte; n : float; f1,f2 : byte);
1952     var
1953         s : line_string;
1954     begin
1955         str(n:f1:f2,s);
1956         put_string(x,y,s);
1957     end;

1958     procedure put_string_and_number(x1,y1:byte;s1:string;
1959                                     x2,y2:byte; n:float; f1,f2 :byte);
1960     begin
1961         put_string(x1,y1,s1);
1962         put_number(x2,y2,n,f1,f2);
1963     end;

1964     procedure change_attribute(x,y,new_attribute : byte);
1965     var
1966         old_x,old_y,ch,attr : byte;
1967     begin
1968         old_x := wherex;
1969         old_y := wherey;
1970         get_char(x,y,ch,attr);
1971         put_char(ch,new_attribute);
1972         gotoxy(old_x,old_y);
1973     end;

1974     procedure highlight_line(xmin,xmax,y,new_attribute : byte);
1975     var
1976         x : integer;
1977     begin
1978         for x := xmin to xmax do change_attribute(x,y, new_attribute);
1979     end;

1980     procedure write_boarder_char(x,y,character_index,attribute : byte);
1981     var
1982         next_character, current_character, current_attribute : byte;
1983     const
1984         character_table : array[1..12] of byte =
1985             (218,191,217,192,196,179,201,187,188,200,205,186);
1986         merge_table : array[1..12,1..40] of byte =
1987             ((195,197,181,215,210,184,185,199,187,188,
1988              208,190,194,195,197,194,195,194,197,198,
1989              199,200,201,202,203,204,209,206,216,208,
1990              209,210,211,198,213,214,215,216,197,218),
1991              (180,180,181,182,183,184,185,182,187,188,
1992              189,181,191,197,197,194,197,194,197,198,
1993              215,200,201,202,203,204,209,206,207,208,
1994              209,210,208,198,213,214,215,216,180,194),
1995              (180,180,181,182,183,181,185,182,187,188,
1996              189,190,180,193,193,197,197,193,197,198,
1997              215,200,201,202,203,204,207,206,207,208,
1998              216,210,208,212,198,210,215,216,217,197),
1999              (195,197,181,215,210,181,185,199,187,188,
2000              208,190,197,192,193,197,195,193,197,198,
2001              199,200,201,202,203,204,207,206,207,208,
2002              216,210,211,212,198,214,215,216,193,195),
2003              (197,197,181,215,210,184,185,215,187,188,

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2004      208,190,194,193,193,194,197,196,197,198,
2005      215,200,201,202,203,204,205,206,207,208,
2006      209,210,208,212,213,210,215,216,193,194),
2007      (179,180,181,182,183,181,185,186,187,188,
2008      189,181,180,195,197,197,195,197,197,198,
2009      199,200,201,202,203,204,216,206,216,208,
2010      216,210,211,198,198,214,215,216,180,195),
2011      (201,201,203,204,201,203,206,204,203,206,
2012      204,203,201,201,201,201,201,201,201,201,
2013      204,204,201,206,203,204,203,206,203,204,
2014      203,201,204,201,201,201,204,203,201,201),
2015      (187,187,187,185,187,187,185,185,187,185,
2016      185,187,187,187,187,187,187,187,187,202,
2017      185,206,203,206,203,206,203,206,203,185,
2018      203,187,185,203,203,187,185,203,187,187),
2019      (188,188,188,185,185,188,185,185,185,188,
2020      188,188,188,188,188,188,188,188,188,202,
2021      185,202,206,202,206,206,202,206,202,188,
2022      202,185,188,202,203,185,185,202,188,188),
2023      (200,200,202,204,204,202,206,204,206,202,
2024      200,202,200,200,200,200,200,200,200,200,
2025      204,200,204,202,206,204,202,206,202,202,
2026      202,203,200,200,200,204,204,202,200,200),
2027      (216,216,216,206,203,209,206,206,203,202,
2028      202,207,209,207,207,209,216,205,216,216,
2029      206,202,203,202,203,206,205,206,207,202,
2030      209,203,202,207,209,203,206,216,207,209),
2031      (186,182,185,182,182,185,185,186,185,185,
2032      182,185,182,199,215,215,199,215,215,204,
2033      199,204,204,206,206,204,206,206,206,215,
2034      206,215,199,204,204,199,215,206,182,199)
2035      );
2036      begin
2037      get_char(x,y,current_character,current_attribute);
2038      case current_character of
2039      179..218 :
2040      next_character := merge_table[character_index,current_character-178];
2041      else
2042      next_character := character_table[character_index];
2043      end;
2044      put_char(next_character,attribute);
2045      end;

2046      procedure horizontal_line(xa,xb,y : integer ; width,attribute : byte);
2047      var
2048      i : integer;
2049      begin
2050      if xa<=xb then
2051      for i := xa to xb do write_boarder_char(i,y,5+6*(width-1),attribute);
2052      end;

2053      procedure vertical_line(x,ya,yb : integer ; width,attribute : byte);
2054      var
2055      i : integer;
2056      begin
2057      if ya<=yb then
2058      for i := ya to yb do write_boarder_char(x,i,6+6*(width-1),attribute);
2059      end;

2060      procedure left_line(x,ya,yb,width,attribute : byte);
2061      var
2062      offset : shortint;
2063      begin
2064      offset := 6*(width-1);
2065      write_boarder_char(x,ya,1+offset,attribute);
2066      write_boarder_char(x,yb,4+offset,attribute);
2067      vertical_line(x,ya+1,yb-1,width,attribute);
2068      end;

2069      procedure right_line(x,ya,yb,width,attribute : byte);
2070      var
2071      offset : shortint;
2072      begin
2073      offset := 6*(width-1);

```



```

2074     write_boarder_char(x,ya,2+offset,attribute);
2075     write_boarder_char(x,yb,3+offset,attribute);
2076     vertical_line(x,ya+1,yb-1,width,attribute);
2077 end;

2078 procedure top_line(xa,xb,y,width,attribute : byte);
2079 var
2080     offset : shortint;
2081 begin
2082     offset := 6*(width-1);
2083     write_boarder_char(xa,y,1+offset,attribute);
2084     write_boarder_char(xb,y,2+offset,attribute);
2085     horizontal_line(xa+1,xb-1,y,width,attribute);
2086 end;

2087 procedure bottom_line(xa,xb,y,width,attribute : byte);
2088 var
2089     offset : shortint;
2090 begin
2091     offset := 6*(width-1);
2092     write_boarder_char(xa,y,4+offset,attribute);
2093     write_boarder_char(xb,y,3+offset,attribute);
2094     horizontal_line(xa+1,xb-1,y,width,attribute);
2095 end;

2096 procedure update(var n : data_block_type; v : float; f1,f2 : byte);
2097 begin
2098     n.v := v;
2099     str(v:f1:f2,n.vs);
2100     n.vv := true;
2101 end;

2102 procedure draw_box(xmin,ymin,xmax,ymax,width,attribute : byte);
2103 begin
2104     top_line(xmin,xmax,ymin,width,attribute);
2105     bottom_line(xmin,xmax,ymax,width,attribute);
2106     left_line(xmin,ymin,ymax,width,attribute);
2107     right_line(xmax,ymin,ymax,width,attribute);
2108 end;

2109 procedure edit_line(xa,xb,y,next_attribute : byte; var s : line_string;
2110     allowed_set : char_set);
2111 var
2112     i : integer;
2113     ts,ta : line_string;
2114     x,character,attribute : byte;
2115     done,first : boolean;

2116     procedure write_string;
2117     var
2118         i : integer;
2119     begin
2120         for i := x to xb do
2121             begin
2122                 set_cursor(i,y);
2123                 put_char(ord(ts[i-xa+1]),0);
2124             end;
2125         set_cursor(x,y)
2126     end;

2127     procedure move_right;
2128     begin
2129         if (x<xb) then x := x+1;
2130     end;

2131     procedure move_left;
2132     begin
2133         if x>xa then x := x-1;
2134     end;

2135     procedure move_end;
2136     begin
2137         x := xb;
2138         while (copy(ts,x-xa+1,1)=' ') and (x>=xa) do x := x-1;

```

```

2139     move_right;
2140 end;

2141 procedure delete_char;
2142 begin
2143     ts := copy(ts,1,x-xa)+copy(ts,x-xa+2,length(ts)-(x-xa+1))+ ' ';
2144     write_string;
2145 end;

2146 procedure restore_attributes;
2147 var
2148     i : integer;
2149 begin
2150     for i := xa to xb do
2151         begin
2152             set_cursor(i,y);
2153             put_char(ord(ts[i-xa+1]),ord(ta[i-xa+1]));
2154         end;
2155     set_cursor(xa,y);
2156 end;

2157 begin
2158     ts := '';
2159     ta := '';
2160     for i := xa to xb do
2161         begin
2162             get_char(i,y,character,attribute);
2163             ts := ts+chr(character);
2164             ta := ta+chr(attribute);
2165             put_char(character,next_attribute);
2166         end;
2167     x := xa;
2168     done := false;
2169     first := true;
2170     repeat
2171         set_cursor(x,y);
2172         inkey;
2173         case last_key_code of
2174             Home       : x := xa;      { home }
2175             LeftArrow  : move_left;    { left }
2176             RightArrow : move_right;   { right }
2177             Endkey     : move_end;     { right edge of string }
2178             Delkey    : delete_char;  { delete }
2179             BS        : begin          { delete left }
2180                 move_left;
2181                 delete_char;
2182             end;
2183             127       : begin          { move to far left and clear }
2184                 x := xa;
2185                 ts := spaces(xb-xa+1);
2186                 write_string;
2187             end;
2188             32..255   : if chr(last_key_code) in allowed_set then
2189                 begin { allowed character }
2190                     if first and (ts<>spaces(xb-xa+1)) then
2191                         ts := spaces(xb-xa+1);
2192                         insert(chr(last_key_code),ts,x-xa+1);
2193                         ts := copy(ts,1,length(ts)-1);
2194                         write_string;
2195                         move_right;
2196                     end;
2197             CR,ESC,256..512 : done := true;
2198         end;
2199         first := false;
2200     until done;
2201     s := ts;
2202     s := strip_spaces(ts);
2203     put_string(xa,y,copy(s+spaces(xb-xa+1),1,xb-xa+1));
2204     restore_attributes;
2205     put_string(xa,y,copy(s+spaces(xb-xa+1),1,xb-xa+1));
2206     set_cursor(xa,y);
2207 end;

2208 procedure get_full_string(xa,xb,y,next_attribute : byte; var s : line_string;

```

```

2209                 allowed_set : char_set);
2210 begin
2211     repeat
2212         edit_line(xa,xb,y,next_attribute, s, allowed_set);
2213     until pos(' ',s)=0;
2214 end;

2215 procedure edit_number(xa,xb,y,edit_colour, f1,f2 : byte; var d : data_block_type);
2216 var
2217     i,code : integer;
2218     done : boolean;
2219     ts : line_string;
2220 begin
2221     done := false;
2222     repeat
2223         edit_line(xa,xb,y,edit_colour,ts,number_set);
2224         ts := strip_spaces(ts);
2225         if ts='' then
2226             begin
2227                 done := true;
2228                 with d do
2229                     begin
2230                         vv := false; v := 0; vs := ''
2231                     end;
2232                 end
2233             else
2234                 begin
2235                     val(ts,d.v,code);
2236                     if code=0 then
2237                         begin
2238                             str(d.v:f1:f2,d.vs);
2239                             if length(d.vs)<=(f1) then
2240                                 begin
2241                                     d.vv := true;
2242                                     write(d.vs);
2243                                     done := true;
2244                                 end;
2245                             end;
2246                         end;
2247                     until done;
2248                 end;

2249 procedure get_number(xa,xb,y,edit_colour : byte; f1,f2 : byte;
2250                 var d : data_block_type);
2251 begin
2252     repeat
2253         edit_number(xa,xb,y,edit_colour,f1,f2,d);
2254     until d.vv or (length(d.vs)=0);
2255 end;

2256 procedure full_window;
2257 begin
2258     window(1,1,80,25);
2259 end;

2260 procedure clear_screen_area(xa,ya,xb,yb : byte);
2261 var
2262     wmin, wmax : word;
2263 begin
2264     wmin := windmin;
2265     wmax := windmax;
2266     window(xa,ya,xb,yb);
2267     clrscr;
2268     window(lo(wmin),hi(wmin),lo(wmax),hi(wmax));
2269 end;

2270 procedure ActiveWindow(Active: Boolean);
2271 begin
2272     if TopWindow <> nil then
2273         begin
2274             UnFrameWin;
2275             with TopWindow^ do
2276                 if Active then
2277                     FrameWin(Title^, DoubleFrame, TitleAttr, FrameAttr)

```

```

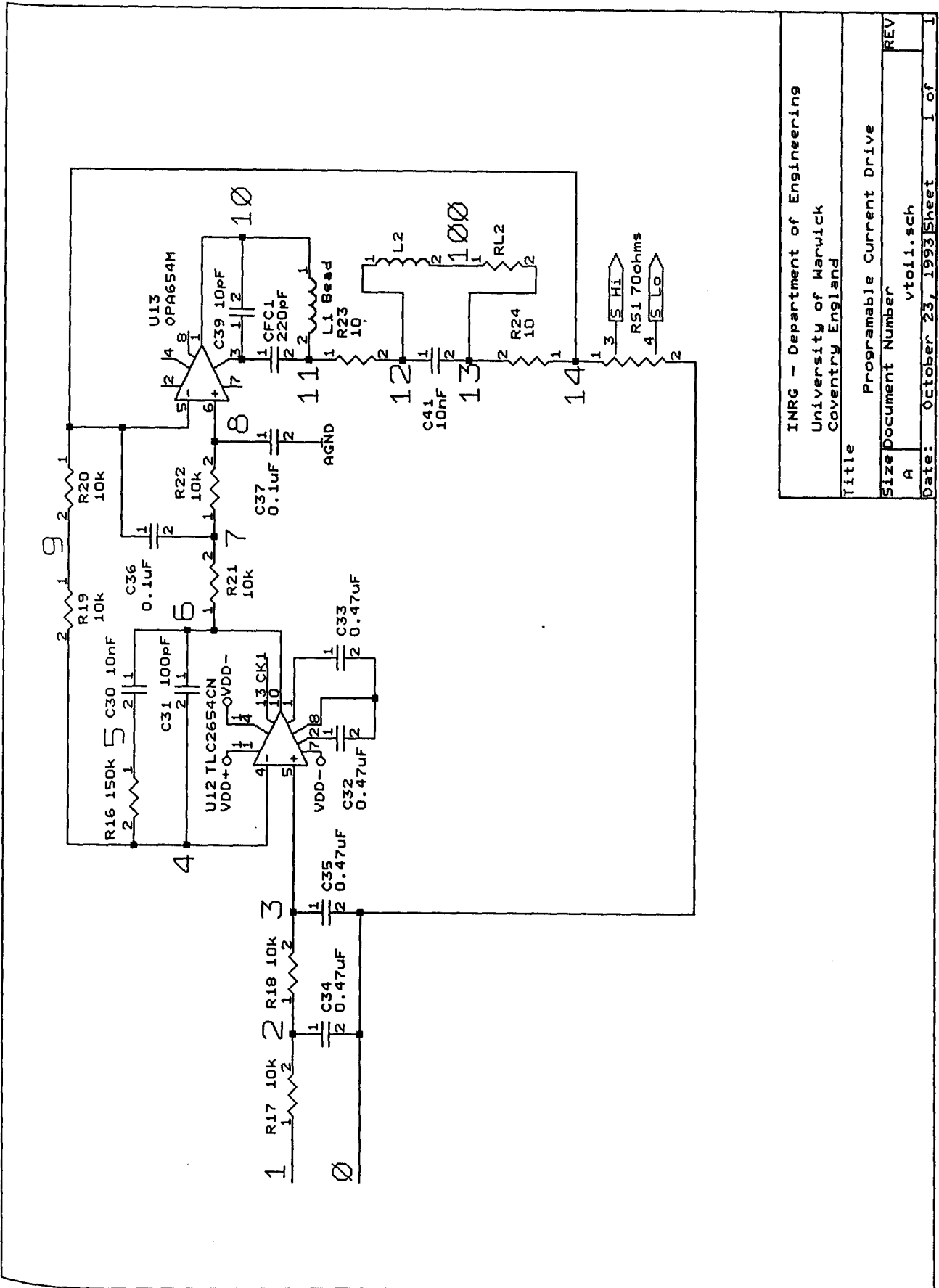
2278         else
2279             FrameWin(Title^, SingleFrame, FrameAttr, FrameAttr);
2280         end;
2281     end;

2282     procedure OpenWindow(X1, Y1, X2, Y2: Byte; T: TitleStr;
2283                         TAttr, FAttr: Byte);
2284     var
2285         W: WinRecPtr;
2286     begin
2287         ActiveWindow(False);
2288         New(W);
2289         with W^ do
2290             begin
2291                 Next := TopWindow;
2292                 SaveWin(State);
2293                 GetMem(Title, Length(T) + 1);
2294                 Title^ := T;
2295                 TitleAttr := TAttr;
2296                 FrameAttr := FAttr;
2297                 Window(X1, Y1, X2, Y2);
2298                 GetMem(Buffer, WinSize);
2299                 ReadWin(Buffer^);
2300                 FrameWin(T, DoubleFrame, TAttr, FAttr);
2301             end;
2302             TopWindow := W;
2303             Inc(WindowCount);
2304             TextAttr := TAttr;
2305             ClrSCr;
2306         end;

2307     procedure CloseWindow;
2308     var
2309         W: WinRecPtr;
2310     begin
2311         if TopWindow <> nil then
2312             begin
2313                 W := TopWindow;
2314                 with W^ do
2315                     begin
2316                         UnFrameWin;
2317                         WriteWin(Buffer^);
2318                         FreeMem(Buffer, WinSize);
2319                         FreeMem(Title, Length(Title^) + 1);
2320                         RestoreWin(State);
2321                         TopWindow := Next;
2322                     end;
2323                 Dispose(W);
2324                 ActiveWindow(True);
2325                 Dec(WindowCount);
2326             end;
2327         end;

2328     { initialisation }
2329     begin
2330         set_page(0);
2331         relative_mode := true;
2332         last_key_code := 0;
2333         TopWindow := nil;
2334         WindowCount := 0;
2335     end.

```



vtoil

\*

\* Output Stage of Precision Current Drive based DR1DRV1.sch rev Q2

.OPT ACCT LIST NODE OPTS NOPAGE RELTOL=.001

\* Small-signal transfer function calculation assuming

\* VIN is the input and V(14), the voltage at node 14, is the output.

.TF V(14) VIN

\* AC analysis. The real and imaginary response of the circuit

\* is calculated as the inputs are swept from 0.1 hertz to 10kHz

\* The only AC input this circuit has is VIN. Linear analysis.

.AC DEC 20 0.1HZ 10000HZ

\* Calculate transient response in 20 microsecond steps for 0.2s

.TRAN 20U 0.2

\* The following statements describe the circuit to PSpice.

\* VIN is the input. It has an amplitude during AC analysis

\* of 1 volt, and changes from 0 to 1 volt for transient analysis

VIN 1 0 AC 1 PULSE(0 1 0.1M 0 0 1 1)

R17 1 2 10K

R18 2 3 10K

C34 2 0 0.47UF

C35 3 0 0.47UF

C31 6 4 100PF

R16 5 4 150K

C30 6 5 0.01UF

R19 9 4 10K

R20 14 9 10K

R21 6 7 10K

R22 7 8 10K

C36 14 7 0.1UF

C37 8 0 0.1UF

L1 10 11 10UH

R23 11 12 10

L2 12 100 800UH

RL2 100 13 40

C41 12 13 0.01UF

R24 13 14 10

RS1 14 0 70

E1 6 0 3 4 5MEG

E2 10 0 8 14 12000

.PROBE

.END



vtoi2

\*

\* Output Stage of Precision Current Drive based on DR1DRV1.sch rev Q2

\* Servo loop has additional 'noise' source

.OPT ACCT LIST NODE OPTS NOPAGE RELTOL=.001

\* Small-signal transfer function calculation assuming

\* VIN is the input and V(14), the voltage at node 14, is the output.

.TF V(14) VIN

\* AC analysis. The real and imaginary response of the circuit

\* is calculated as the inputs are swept from 0.1 hertz to 10kHz

\* Only AC input this circuit has is VIN. This is a linear analysis.

.AC DEC 20 0.1HZ 10000HZ

\* Calculate transient in 20 microsecond steps for 0.1 seconds

.TRAN 20U 0.1

\* The following statements describe the circuit to PSpice.

\* VIN is the input. It has an amplitude during AC analysis

\* of 1 volt, and changes from 0 to 1 volt for transient analysis

\* VIN 1 0 AC 1 PULSE(0 1 0.1M 0 0 1 1)

\* VD 15 0 0

\* voltage disturbance within loop

VD 15 0 AC 1 PULSE(0 1 0.1M 0 0 1 1)

VIN 1 0 0

R17 1 2 10K

R18 2 3 10K

C34 2 0 0.47UF

C35 3 0 0.47UF

C31 6 4 100PF

R16 5 4 150K

C30 6 5 0.01UF

R19 9 4 10K

R20 14 9 10K

R21 6 7 10K

R22 7 8 10K

C36 14 7 0.1UF

C37 8 0 0.1UF

L1 10 11 10UH

R23 11 12 10

L2 12 100 800UH

RL2 100 13 40

C41 12 13 0.01UF

R24 13 14 10

RS1 14 0 70

RD1 15 0 10M

RD2 16 0 10M

E1 6 0 3 4 5MEG

E2 10 0 16 14 12000

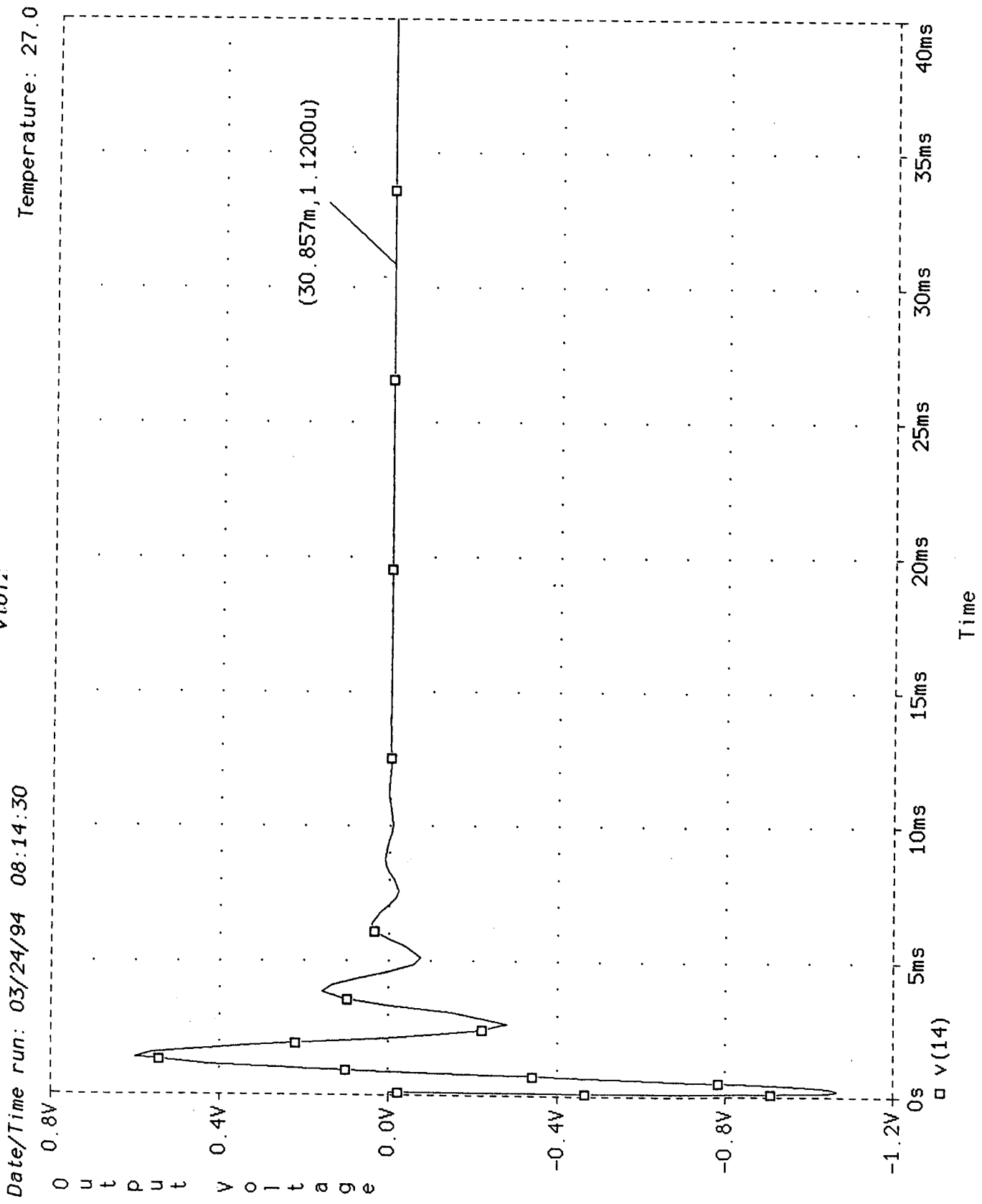
\* E3 allows inclusion of disturbance within servo loop at input to E2

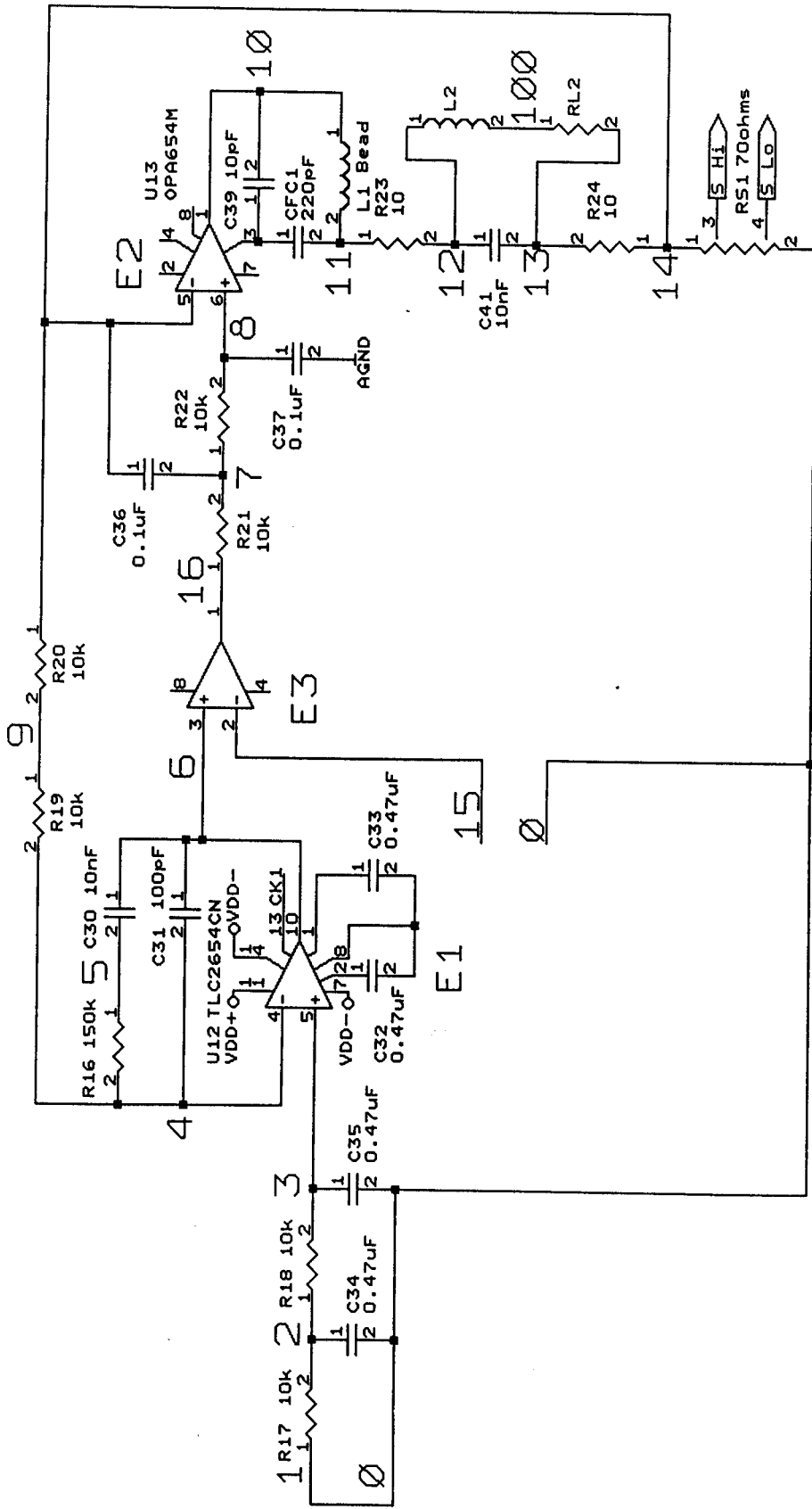
E3 16 0 8 15 1

.PROBE

.END







INRG - Department of Engineering  
 University of Warwick  
 Coventry England

Title		Programmable Current Drive
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REV	A	
Date:	October 29, 1993	Sheet 1 of 1

vtoi3

\*

\* Output Stage of Precision Current Drive based on DR1DRV1.sch rev Q2

\* 'Noise' may be added to output of E1

.OPT ACCT LIST NODE OPTS NOPAGE RELTOL=.001

\* Small-signal transfer function calculation assuming

\* VIN is the input and V(14), the voltage at node 14, is the output.

.TF V(14) VIN

\* AC analysis. The real and imaginary response of the circuit

\* is calculated as the inputs are swept from 0.1 hertz to 10kHz

\* Only AC input is VIN. This is a linear analysis.

.AC DEC 20 0.1HZ 10000HZ

\* Calculate transient in 20 microsecond steps for 0.2 seconds

.TRAN 20U 0.2

\* The following statements describe the circuit to PSpice.

\* VIN is the input. It has an amplitude during AC analysis

\* of 1 volt, and changes from 0 to 1 volt for transient analysis

\* VIN 1 0 AC 1 PULSE(0 1 0.1M 0 0 1 1)

\* VD 15 0 0

\* voltage disturbance within loop at output of E1

VIN 1 0 0

VD 15 0 AC 1 PULSE(0 1 0.1M 0 0 1 1)

R17 1 2 10K

R18 2 3 10K

C34 2 0 0.47UF

C35 3 0 0.47UF

C31 6 4 100PF

R16 5 4 150K

C30 6 5 0.01UF

R19 9 4 10K

R20 14 9 10K

R21 16 7 10K

R22 7 8 10K

C36 14 7 0.1UF

C37 8 0 0.1UF

L1 10 11 10UH

R23 11 12 10

L2 12 100 800UH

RL2 100 13 40

C41 12 13 0.01UF

R24 13 14 10

RS1 14 0 70

RD1 15 0 10M

E1 6 0 3 4 5MEG

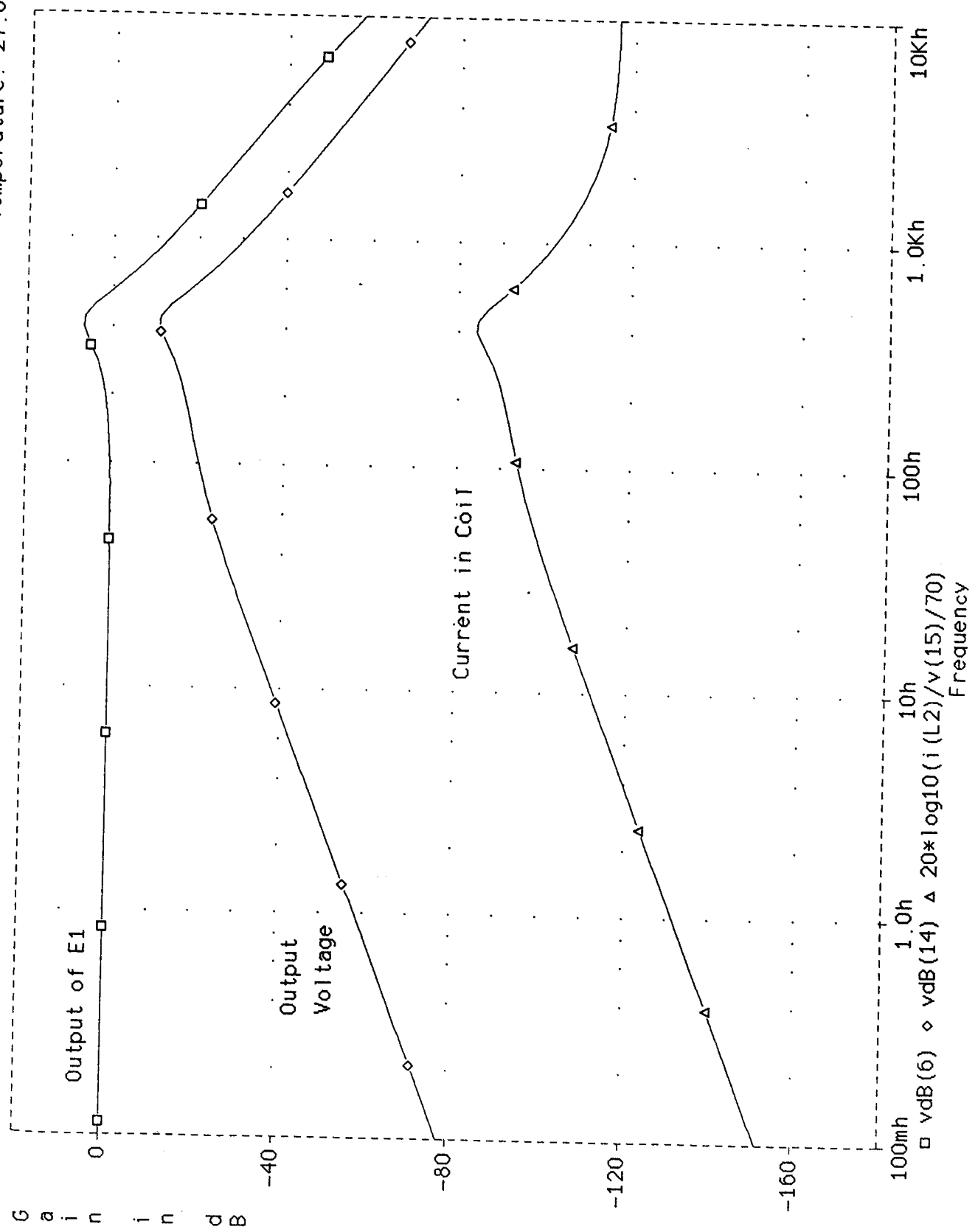
E2 10 0 8 14 12000

\* E3 allows disturbance within servo loop at output of E1

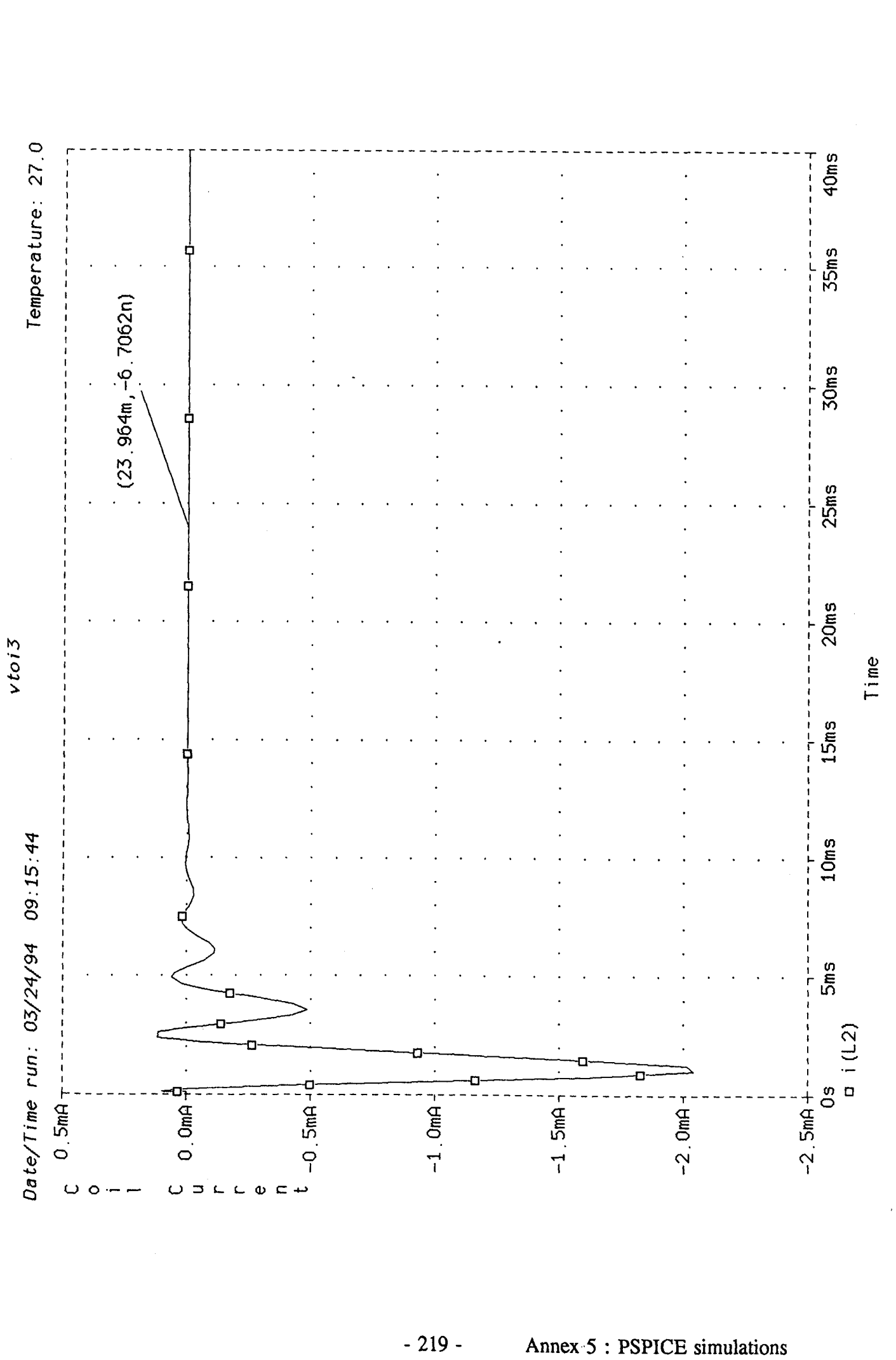
E3 16 0 6 15 1

.PROBE

.END



G a i n i n d B



scvtoi.cir

\* Voltage-to-current converter using a switched capacitor

.OPT ACCT LIST NODE OPTS NOPAGE RELTOL=.001

\* Calculate transient response in 50 microsecond steps for 0.06s

.TRAN 50U 0.06

\* model almost ideal switch

.model sno vswitch(ROFF=1E+10 VON=0.51 VOFF=0.49)

VIN 100 0 PULSE(1.5 3.5 0.01 0 0 1 2) ; bias => -1 to +1

VBIAS 5 0 2.5V ; typically half range

VCL1 20 0 PULSE(0 1 100U 0 0 300U 1M) ; 1kHz square wave

VCL2 21 0 PULSE(0 1 600U 0 0 300U 1M) ; non-overlapping

\* VCL1 20 0 PULSE(0 1 100U 0 0 200U 1M) ; 1kHz square wave

\* VCL2 21 0 PULSE(0 1 400U 0 0 500U 1M) ; non-overlapping

.IC V(4,5)=-1 V(6,7)=-1 V(8,9)=-1 v(2,3)=2.7 ; initial bias conditions

E1 3 0 1 2 1E7 ; amplifier

RIN 100 1 22k ; input filter

.PARAM CF=1

CIN 1 0 {CF} ; filter capacitor

.STEP PARAM CF LIST 0.1UF 0.22UF 0.33uF 0.47UF

R1 2 4 1k ; Integration time constant

C1 3 2 1uF

C2 4 5 1uF ; hold capacitor

C3 6 7 1uF ; sample capacitor

C4 8 9 1uF ; feedback filter capacitor

R2 10 8 100 ; feedback filter resistor

R3 11 9 100 ; feedback filter resistor

L1 3 12 500UH ; coil

RE1 12 10 5 ; exaggerated end effect of Rref

RE2 11 0 5 ; exaggerated end effect of Rref

RREF 10 11 50 ; 50 ohm reference resistor

SW1 6 4 20 0 sno ; normally open switch

SW2 7 5 20 0 sno ; normally open switch

SW3 8 6 21 0 sno ; normally open switch

SW4 9 7 21 0 sno ; normally open switch

.PROBE

.END

## AD1175K

### FEATURES

- High Resolution: 22 Bits
- Wide Dynamic Range: 133 dB
- Low Nonlinearity:
  - Integral:  $\pm 0.5$  ppm max
  - Differential:  $\pm 0.5$  LSB max
- High Stability:
  - Gain:  $\pm 1$  ppm/ $^{\circ}$ C max
  - Zero:  $\pm 0.5$  mV/ $^{\circ}$ C max
  - INL:  $\pm 0.01$  ppm/ $^{\circ}$ C
  - DNL:  $\pm 0.0025$  ppm/ $^{\circ}$ C
- High Throughput Rate: 20 Conversions/Second
- Microprocessor Compatible Interface
- Compact Modular Package

### APPLICATIONS

- Data Acquisition Systems
- Scientific Instruments
- Medical Instruments
- Weighing Systems
- Automatic Test Equipment
- Test and Measurement Equipment

### GENERAL DESCRIPTION

The AD1175 is a very high resolution integrating A/D converter intended for applications that require the highest possible accuracy without sacrificing conversion speed, board space or modest pricing. This converter provides the performance of large benchtop or rack mount instruments in a compact, modular package.

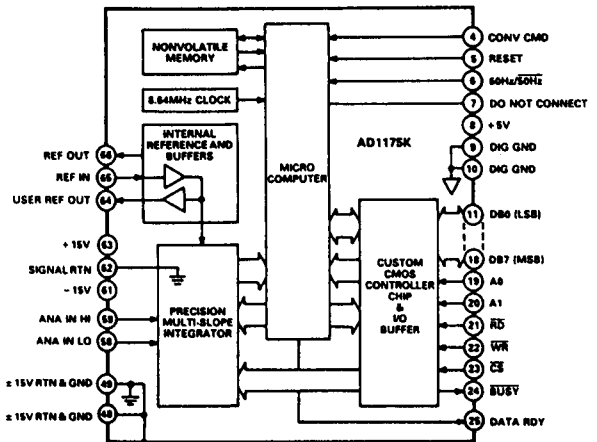
The AD1175 utilizes an auto-zeroed, multislope, integrating principle that features 22-bit resolution with extremely low nonlinearity (Integral:  $\pm 0.5$  ppm max and Differential:  $\pm 0.5$  LSB max). Temperature stability is specified at  $\pm 0.5$  ppm/ $^{\circ}$ C maximum for gain (exclusive of reference),  $\pm 0.5$   $\mu$ V/ $^{\circ}$ C maximum for zero,  $\pm 0.01$  ppm/ $^{\circ}$ C for integral nonlinearity, and  $\pm 0.0025$  ppm/ $^{\circ}$ C for differential nonlinearity.

The integration time is user selectable for maximum, line frequency noise rejection at either 60 Hz or 50 Hz. The conversion rate is 20 or 16 per second respectively, which is many times faster than benchtop instruments of similar performance.

The nominal full-scale input range is  $\pm 5$  V; however, rated accuracy is specified for inputs up to 10% over nominal, yielding a total dynamic range of greater than 4.6 million to 1. The analog input is a high impedance, high CMRR, true differential input pair. The input low operates within  $\pm 100$  mV of analog ground and is used to sense signal low (at the source) to minimize ground loop problems.

The output of the AD1175 consists of four addressable 8-bit bytes (STATUS and 3 DATA) presented at an 8-bit tri-stated port with standard chip select.

### AD1175K FUNCTIONAL BLOCK DIAGRAM



Several modes of operation are available and allow writing to one of several addressable locations to program gain and offset, or to initiate a conversion.

The AD1175 requires no external components and operates from  $\pm 15$  V dc and +5 V dc power. All digital inputs and outputs are LSTTL compatible. The 3.7"  $\times$  5.2"  $\times$  0.53" metal case package provides excellent electrostatic and electromagnetic shielding.

### PRODUCT HIGHLIGHTS

1. The unparalleled dynamic range, accuracy, linearity and stability of the AD1175 represent a breakthrough for an A/D converter offering small size and modest cost. Only large, expensive benchtop meters offer similar performance.
2. The AD1175 converts approximately ten times as fast as digital meters with like performance.
3. The microprocessor interface of the AD1175 provides for straightforward operation, but with the features required for optimum system performance. Simple commands control offset adjust, gain adjust, external offset null and initiate conversions. The output bytes indicate input polarity, off-scale condition and a variety of additional status information.
4. The AD1175 is a complete A/D converter including a precision internal reference, clock and integration capacitor. Off-set and coarse gain adjust are bus controlled, while user accessible trim potentiometers allow fine gain adjust and  $\pm$  full scale balance adjust.
5. Conversions may be made using either the offset and coarse gain settings stored in internal nonvolatile memory, or new settings made via the bus. The nonvolatile memory may be updated on command with the new settings.

# SPECIFICATIONS (typical @ +25°C, V<sub>s</sub> = ±15 V, V<sub>D</sub> = +5 V unless otherwise specified)

Model	AD1175K
RESOLUTION	22-Bits +10% Overrange (4,600,000 Counts) min
DYNAMIC RANGE	133 dB
ACCURACY	
Integral Nonlinearity <sup>1</sup>	±0.5 ppm FSR <sup>2</sup> , max
Differential Nonlinearity (@ 22 Bits)	±0.5 LSB, max
Total Noise (Ref to Input, 95% Confidence)	5 μV p-p max
STABILITY	
Gain TC (Excluding Reference)	±1 ppm RDG/°C, max
Zero TC	±0.5 μV/°C, max
Integral Nonlinearity TC	±0.01 ppm FSR <sup>2</sup> /°C
Differential Nonlinearity TC	±0.0025 ppm FSR <sup>2</sup> /°C
POWER SUPPLY REJECTION RATIO (±15 V)	±5 ppm FSR <sup>2</sup> /V
WARMUP TIME	
Relative Accuracy (for Rated Performance)	15 Minutes
Full Rated Performance	45 Minutes

REFERENCE	
External Reference In	
For Rated Performance	+6.95 V ±2% <sup>3</sup>
Maximum Input (Operating Only)	+9.6 V
Reference Output	
Voltage	+6.95 ±2%
Output Resistance	250 Ω
Temperature Coefficient	±0.4 ppm/°C (±0.8 ppm/°C, max)
Drift with Time <sup>4</sup>	
1st 15 Days Operating	±1 ppm/Day
After 15 Days Operation	±25 ppm √1000 hrs., max
Noise, 0.01 Hz to 10 Hz (95% Confidence)	1 ppm p-p, max
User Reference Output	
Gain (Referred to Reference In)	1.000 to 1.012 <sup>5</sup>
Current	±2 mA, max
Stability: Temperature Coefficient	±1 μV/°C, max

THROUGHPUT RATE <sup>6</sup>	
@ Integrate Time of 1/30 sec (60 Hz)	20 conversions/sec
@ Integrate Time of 1/25 sec (50 Hz)	16 conversions/sec

ANALOG INPUT CHARACTERISTICS	
Voltage Range <sup>7,8</sup>	±5 V Bipolar
Max V <sub>INH</sub> (at Input Hi, Without Damage)	±12 V
Max V <sub>INL</sub> (at Input Lo, Without Damage)	±3 V
Max V <sub>INLR</sub> (Input Lo, for Rated Performance)	±100 mV
Input Resistance (Input Hi, or Input Lo)	1000 MΩ
Input Bias Current, Input Hi or Input Lo (+10°C to +50°C)	±10 nA, typ, ±40 nA max
Input Bandwidth <sup>9</sup>	
Small Signal	2.0 MHz
Large Signal	150 kHz
CMRR at dc to 60 Hz	80 dB, min

ADJUSTMENTS	
Offset (Programmable)	
Range	±75 mV
Resolution	1 LSB Steps
Gain-Coarse (Programmable) <sup>8</sup>	
Range	<4.7V to >5.6 V
Resolution	0.009% Steps
Gain-Fine Range <sup>5,8</sup>	±0.006% FS
Gain-Balance (± Full Scale) Range <sup>5</sup>	±0.005% FS

DIGITAL LEVELS	
Inputs	
Low	0.8 V max
High	2.0 V min
Outputs	
Low (@ 4 mA)	0.45 V max
High (@ 100 μA)	2.4 V min

POWER REQUIREMENTS	
Supply Voltages (for Rated Accuracy)	
±V <sub>s</sub>	±15 V (±0.3 V each)
+V <sub>D</sub>	+5 V (-0.2 V to +0.4 V)
Supply Current Drain @ ±15 V	
After Warm-Up	+55 mA, -70 mA
During Warm-Up	150 mA
@ +5 V	175 mA

ENVIRONMENTAL	
Rated Performance	10°C to +50°C, 70% RH
Operating	0 to +70°C
Storage	-25°C to +70°C

MECHANICAL	
Size	3.7" × 5.2" × 0.53" max
Shielding	Electrostatic, 6 Sides Electromagnetic, 5 Sides
Weight	170 grams

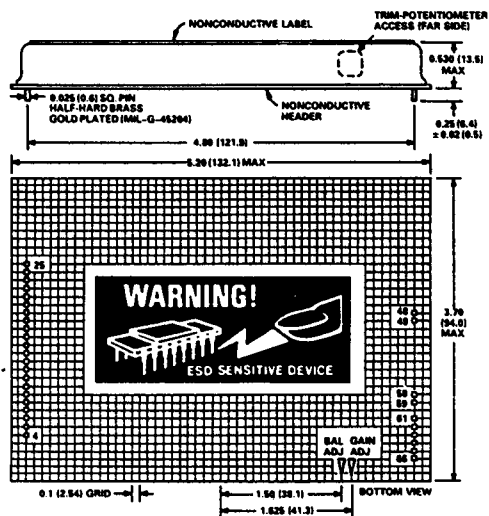
## NOTES

- Integral Nonlinearity is specified over the entire input span (NOMINAL FULL-SCALE +10% Overage). It is specified using the "End Point" definition, where the error is measured after removing the offset error and the gain errors at plus and minus full scale.
- FSR means Full Scale Range which = 10 volts.
- Single ended, ground referred.
- Average trend line.
- Adjustment is performed via user accessible 10-turn trim potentiometer.
- Integration Time is selectable to either 1/30 sec for 60 Hz rejection, or 1/25 sec for 50 Hz rejection.
- The Nominal Analog Input Voltage Range is ±5V, but the AD1175 may be calibrated for input voltages from ±4.7 V to ±5.6 V and maintain specified accuracy over the entire range, including a 10% on-scale overrange. Therefore, input voltages of up to ±6.16 V will be accurately converted when calibrated for ±5.6 V Nominal input.
- Converter section GAIN is digitally adjustable, via the data bus, in steps of 0.009% from <4.7 to >5.6V FS. A user accessible 10-turn trim potentiometer is also provided for fine GAIN adjust (±0.006% range).
- All units are factory calibrated for ±5 V Nominal Full Scale to within ±50 μV.
- Input Bandwidth specifications are for true integration without clipping.

Specifications subject to change without notice.

## OUTLINE DIMENSIONS

Dimensions shown in inches and (mm).



NOTE: SEE PAGE 3-161 FOR RECOMMENDED SOCKET.  
SEE PAGE 3-166 FOR EVALUATION BOARD.

## ASSEMBLY INSTRUCTIONS

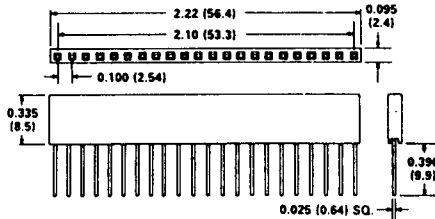
**CAUTION:** This module is not an embedded assembly and is not hermetically sealed. Do not subject to a solvent or water-wash process that would allow direct contact with free liquids or vapors. Entrapment of contaminants may occur, causing performance degradation and permanent damage. Install after any clean/wash process and then only spot clean by hand.

## PIN DESCRIPTIONS

PIN	SIGNAL	DESCRIPTION
4	CONV CMD	External Convert Command
5	RESET	Reset Internal Microcomputer Following Power-Up
6	60Hz/50Hz	When Set Low, Integration Time is 1/25 sec When Set High, Integration Time is 1/30 sec
7	DO NOT CONNECT	Used Only for Factory Test
8	+5V	Digital Power Supply
9, 10	DIG GND	Digital Ground (Both Pins are Tied Together Internally)
11-18	DB0-DB7	Bi-directional Data Bus (LSB-MSB)
19	A0	Address, Bit Zero
20	A1	Address, Bit One
21	RD	READ
22	WR	WRITE
23	CS	CHIP SELECT
24	BUSY	Digital Busy, Responding to a Bus Command
25	DATA RDY	DATA READY
48, 49	±15V RTN & GND	Analog Power Ground and Case (Tied Together Internally)
58	ANA IN LO	Analog Input, Low
59	ANA IN HI	Analog Input, High
61	-15V	Negative Analog Power Supply
62	SIGNAL RTN	Signal Return (Non-Current Carrying Ground)
63	+15V	Positive Analog Power Supply
64	USER REF OUT	Buffered Output of Reference at REF IN
65	REF IN	Reference Input, Normally Connected to REF OUT
66	REF OUT	Internal +6.95V Reference Output, Unbuffered



**SAMTEC Part Number SSQ-122-03-G-S (2 Each Required Per AD1175)**  
 Available direct from the manufacturer or through distributors.



### ARCHITECTURAL OVERVIEW

The AD1175 is a complete, precision analog-to-digital converter. It consists of three major elements: a linearized, auto-zeroed integrator, a single-chip microcomputer, and a custom CMOS controller/bus interface chip. (See Figure 1 AD1175 Functional Block Diagram.)

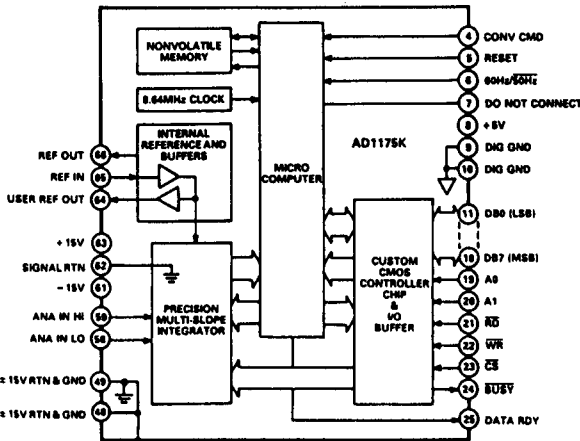


Figure 1. AD1175 Functional Block Diagram

The conversion process is similar to the classic dual-slope technique, where the input signal is integrated during a whole number of line cycles (for line noise rejection) and then a digital measurement is made of the time required for a known reference voltage to drive the integrator output back to zero (i.e., to zero charge). Since the process begins with zero charge in the integrator, and also ends there, we can express this function as follows:

$$\text{CHARGE IN} = \text{CHARGE OUT}$$

$$\text{WHERE CHARGE} = \int_0^t i \, dt = \frac{1}{R} \int_0^t v \, dt$$

$$\text{OR} \dots \frac{1}{R_{INT}} \int_0^{T_{SIG}} V_{SIG} \, dt = \frac{1}{R_{INT}} \int_0^{T_{REF}} V_{REF} \, dt$$

$$\text{OR} \dots \int_0^{T_{SIG}} V_{SIG} \, dt = V_{REF} \times T_{REF} \text{ (SINCE } V_{REF} = \text{CONSTANT)}$$

$$\text{OR} \dots \frac{\int_0^{T_{SIG}} V_{SIG} \, dt}{T_{SIG}} = \text{AVG. } [V_{SIG}] = \frac{V_{REF} \times T_{REF}}{T_{SIG}}$$

$$\text{HENCE} \dots \frac{\text{AVG. } [V_{SIG}]}{V_{REF}} = \frac{T_{REF}}{T_{SIG}} \left\{ \text{WHERE } T_{REF} \text{ IS MEASURED AND } V_{REF} \text{ \& } T_{SIG} \text{ ARE CONSTANT} \right.$$

*Principle of Dual-Slope Conversion*

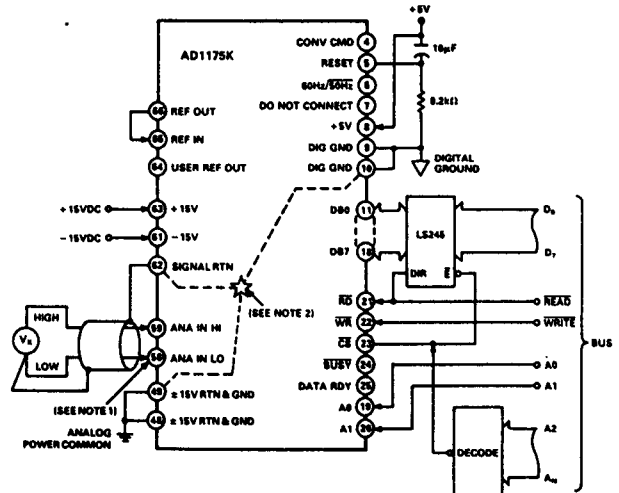
Therefore, the ratio of the signal measured (its average value) to the reference voltage, is equal to the ratio of the *measured time* (to force the integrator back to zero charge) to the signal integration time (which is held constant).

The AD1175 repeats the above sequence ten times during the first 33-1/3 milliseconds of each conversion for a 60 Hz integrate selection (40 milliseconds for a 50 Hz integrate selection). The 10 individual readings together with the result of a final, slow (about 6 ms) vernier reference integration are summed. The numeric result is then placed in the addressable output latches and DATA is indicated as AVAILABLE. During the next ten milliseconds, the integrator is reset and AUTO-ZERO nulls out offset errors in preparation for the next conversion.

The device status is indicated by the addressable STATUS byte (busy, converting, data available, etc.). DATA READY and BUSY are also indicated by logic levels at Pins 25 and 24, respectively.

### SIGNAL INPUT CONNECTIONS

The ANA IN HI and ANA IN LO pins comprise a true, high-impedance, high CMRR, differential input pair. ANA IN LO must be within ±100 mV of SIGNAL RTN (Pin 62). The ANA IN LO pin is used to remote sense the source low (ground) to minimize system ground related errors. Both HI AND LO SIGNALS MUST HAVE A BIAS CURRENT PATH BACK TO SIGNAL RTN. Figure 2 details the proper connections.



- NOTES**
- BOTH HIGH AND LOW SIGNALS MUST HAVE A BIAS CURRENT PATH BACK TO GROUND AT THE AD1175. "ANA IN LO" SHOULD REFERENCE TO GROUND (SIGNAL RTN) AT THE SIGNAL SOURCE, VIA A MINIMUM OF RESISTANCE.
  - "DIG GND" AND "± 15V RTN & GND" ARE STAR CONNECTED WITHIN THE CONVERTER, AND INTENDED TO BE SEPARATE OUTSIDE OF THE CONVERTER. HOWEVER, IF ± 15V AND +5V POWER SHARE A SINGLE COMMON RETURN, THEN THAT COMMON MUST BE CONNECTED TO THE "± 15V RTN & GND" PIN WHICH MUST BE CONNECTED VIA HEAVY COPPER TO THE "DIG GND" PIN. "SIGNAL RTN" (PIN 62) IS THE "NON-CURRENT CARRYING" GROUND, ONLY TO BE USED AS SHOWN AND AS GROUND REFERENCE FOR AN EXTERNALLY SUPPLIED REFERENCE SOURCE.

Figure 2. AD1175 Bus Driven Interface

Printed circuit board layout should insure that both analog inputs (Pins 58 and 59) are guarded by copper which is tied to SIGNAL RTN (Pin 62) on the front and back of the board.

Note that an offset error of up to one LSB per 120 Ω of source impedance can occur, due to input bias current, which may approach 20 nA at elevated temperatures.

## REFERENCE CONNECTIONS

A very stable  $6.95\text{ V} \pm 2\%$  internal reference is filtered and brought out to REF OUT (Pin 66) of the converter. This output should be tied to REF IN (Pin 65) to accomplish the specifications for initial absolute accuracy. REF OUT is a high impedance output and should not be loaded in any way other than by REF IN (Pin 65). A buffered version of the reference applied to REF IN, and that which is used by the converter, is available at USER REF OUT (Pin 64).

When making ratiometric measurements, where the source excitation is derived from the converter reference, use the reference signal present at USER REF OUT (Pin 64). The load applied to Pin 64 should not exceed two milliamps. If an external reference source is to be used, it should be applied to REF IN (Pin 65).

## POWER SUPPLIES AND GROUNDS

The power supply pins are all well bypassed internally to their respective common or ground pins. The converter is very tolerant of dc and low frequency noise ( $\leq 100\text{ s of Hz}$ ) on any of the supplies, as evidenced in the power supply rejection specifications. High frequency noise ( $\geq 1\text{ MHz}$ ) in excess of 10 mV on the  $\pm 15\text{ V}$  supplies could, however, degrade the converter's performance.

To avoid large, digital-rate, circulating ground currents, the system's analog supply common and that of the digital supply should be kept separate and then tied together at the converter by a heavy track (to supplement that which is internal to the converter) from  $\pm 15\text{ V RTN \& GND}$  (Pins 48 and 49) to DIG GND (Pins 9 & 10).

If the logic supply and analog supply share a single common, then that common should be brought to  $\pm 15\text{ V RTN \& GND}$  (Pins 48 and 49) and then from these pins a heavy track should be run to DIG GND (Pins 9 & 10).

## RESET (Pin 5; Input)

After power-up and before access may be made to the converter, a reset of the internal microcomputer must be accomplished. The RESET (Pin 5) may be driven from an external source, such as may exist in most computer-based systems, or it may be connected to a simple RC circuit which will automatically generate a reset sequence upon power-up. See Figure 2 for the recommended circuit.

When driven from an external source, RESET must be held high for a minimum of 3 microseconds, but must not terminate before the  $+5\text{ V}$  logic supply and the  $\pm 15\text{ V}$  analog supply have been stable ( $> +4.7\text{ V}$ , and  $> \pm 11\text{ V}$ ) for 300 microseconds.

## 60 Hz/ 50 Hz (Pin 6; Input)

Pin 6 of the module selects either 33-1/3 milliseconds or 40 milliseconds for the signal integration time. This input is internally pulled up to 5 V via 10 k $\Omega$  and may be left open for 60 Hz normal mode rejection. The pin should be connected to Digital Ground for operation in a 50 Hz line frequency environment.

## CONV CMD (Pin 4; Input)

A negative logic transition on this input causes a MODCON conversion to occur (see CALIBRATION section). A minimum hold time of 1.5  $\mu\text{s}$  is required at both the High and the Low states, to operate properly. The BUSY output (Pin 24) will not respond, and BUSY (Bit 0) of the STATUS word will not be indicated, but all other bits of the STATUS word will be active. DATA RDY (Pin 25) will occur per Figure 8.

This input is provided to allow externally triggered conversions which will use the temporarily programmed gain and offset values (or the start-up defaults if no changes have been made).

## DATA RDY (Pin 25; Output)

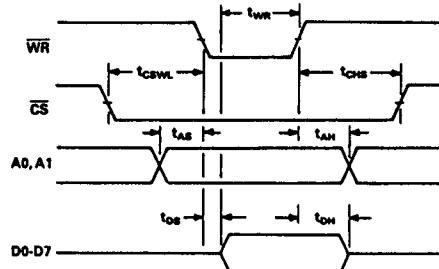
This signal will go to logic "1" when any conversion's new data has become stable in the output latches. It will remain high for the duration of the auto-zero phase (about 10 milliseconds) and go low at the end of that phase (at the end of BUSY).

## BUSY (Pin 24; Output)

When a COMMAND byte is written to the microprocessor compatible port, this line is set low and remains low for the duration of the converter's response to that command. It is the opposite state of the BUSY bit within the STATUS byte.

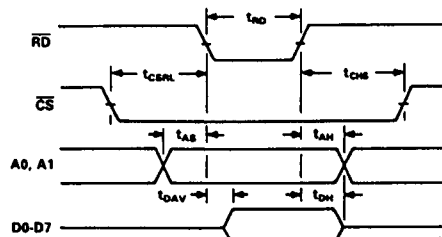
## THE BUS INTERFACE

The AD1175's 8-bit microprocessor-compatible interface consists of an 8-bit, latched, tri-stated, bidirectional port and its associated control lines: Chip Select (CS), READ (RD), WRITE (WR) and two address bits (A1 and A0). Timing requirements for the bus interface are shown in Figure 3, and the operation of the interface is shown in Figure 4.



PARAMETER	DESCRIPTION	MIN	MAX	UNITS
$t_{WR}$	WR Pulse Width	0.1	20	$\mu\text{s}$
$t_{CSWL}$	Chip Select to WR Low	0		ns
$t_{CSHL}$	Chip Select Hold Time	0		ns
$t_{AS}$	Address Setup Time	10		ns
$t_{AH}$	Address Hold Time	0		ns
$t_{DS}$	Data Setup Time	-	5	$\mu\text{s}$
$t_{DH}$	Data Hold Time	20		ns

Write Cycle Timing Requirements



PARAMETER	DESCRIPTION	MIN	MAX	UNITS
$t_{RD}$	RD Pulse Width	150		ns
$t_{CSRL}$	Chip Select to RD Low	0		ns
$t_{CSHL}$	Chip Select Hold Time	0		ns
$t_{AS}$	Address Setup Time	10		ns
$t_{AH}$	Address Hold Time	0		ns
$t_{DSV}$	Data Valid Time		100	ns
$t_{DH}$	Data Hold Time		90	ns

Read Cycle Timing Requirements

Figure 3. Interface Timing Requirements

	<u>CS</u>	<u>RD</u>	<u>WR</u>	A1	A0	FUNCTION
READ	L	L	H	H	H	High CONV Data Byte READ
	L	L	H	H	L	Mid CONV Data Byte READ
	L	L	H	L	H	Low CONV Data Byte READ
	L	L	L	L	L	STATUS READ
WRITE	L	H	L	H	H	Unused
	L	H	L	H	L	Unused
	L	H	L	L	H	PARAMETER WRITE
	L	H	L	L	L	COMMAND WRITE
	X	H	H	X	X	DEVICE NOT SELECTED
	H	X	X	X	X	

NOTE THAT X = DON'T CARE

Figure 4. Bus Control Functions

	BIT #													LSB				HEX
	23	22	21	20	19	18	17	16	15	14	13	5	4	3	2	1	0	
POS. OVERLOAD	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	FF,FF,FF
+ 1.25 × FULL SCALE	0	1	1	0	1	0	0	0	0	0	0	0	0	0	0	0	0	68,00,00
+ FULL SCALE	0	1	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	60,00,00
+ 1/2 SCALE	0	1	0	1	0	0	0	0	0	0	0	0	0	0	0	0	0	50,00,00
ZERO	0	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	40,00,00
- 1/2 SCALE	0	0	1	1	0	0	0	0	0	0	0	0	0	0	0	0	0	30,00,00
- FULL SCALE	0	0	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	20,00,00
- 1.25 × FULL SCALE	0	0	0	1	1	0	0	0	0	0	0	0	0	0	0	0	0	18,00,00
NEG. OVERLOAD	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	FF,FF,FF

Figure 5. Data Format

**OUTPUT DATA FORMAT**

The result of a conversion is made available in three 8-bit bytes (addressed as shown in Figure 4). The numeric result is presented as an offset binary number, where the offset value is equal to 2e22 (40,00,00 Hex), i.e., zero volts input yields this numerical output. Therefore, the nominal plus and minus full scale are 2e22 ± 2e21, or 60,00,00 Hex and 20,00,00 Hex, respectively. For inputs greater than approximately 1.3× nominal full scale, the converter will indicate an overload error (Bit 5 of the STATUS byte) and will also flag the occurrence by forcing all "1s" in the conversion result, i.e., FF,FF,FF Hex. Bit 23 (MSB) cannot be a "1" for any legitimate conversion result, so that bit is used to flag an overload. The data format is depicted in Figure 5.

**COMMAND BYTE**

The COMMAND BYTE allows eight different instructions to be given. Five of these will require that a parameter be loaded into the PARAMETER\* register prior to writing the command register. The commands are written at address 00 (ADDRESS lines A1 and A0, Pins 20 and 19, respectively) while a parameter is written to address 01. See Figure 4 for Bus Control Functions. Figure 8 details command timing requirements.

The commands are described below, preceded by an opcode name and the digital code (in hex). Figure 6 summarizes each command and its execution time.

**DEFCON [00]**

DEFault CONVersion initiates a conversion, using the gain and offset values which are stored in the nonvolatile memory (power-up defaults).

**MODCON [01]**

MODified CONVersion initiates a conversion using the gain and offset values which have been modified (since power-up) as in commands 02 through 07 below.

**NEWOS [02]**

NEW OffSet subtracts the result of the last conversion from all subsequent MODCON conversions, i.e., acquire a new system offset. The maximum range of this offset is 65,536 codes (= ±75 mV). Attempts to acquire an offset outside of this range will be ignored and BIT 5 and BIT 6 (Overload and command byte ERRor) will be set in the STATUS byte.

**INCROS [03]**

INCRease OffSet alters the offset (in LSBs) used by MODCON in the positive direction by a number between zero and 255 (decimal), which has already been written to PARAMETER\*.

\*The PARAMETER register retains the last word written to it. Any subsequent commands will repeatedly use that PARAMETER until it is updated.

This may be performed repeatedly until a maximum offset of +75 mV has been reached, as indicated by an Overload/BIT 5 response in the STATUS byte.

**DECROS [04]**

DECREase OffSet alters the offset (in LSBs) used by MODCON in the negative direction by a number between zero and 255 (decimal), which has already been written to PARAMETER\*. This may be performed repeatedly until a maximum offset of -75 mV has been reached, as indicated by an Overload/BIT 5 response in the STATUS byte.

**INCGAN [05]**

INCRease GAIIn by N×0.01%, where N (a decimal number between 0 and 255) has already been written to PARAMETER\*. This may be performed repeatedly until a maximum gain (<4.7 V full scale) has been reached, as indicated by an Overload/BIT 5 response in the STATUS byte. Further INCGAN commands will have no other effect.

**DECGAN [06]**

DECREase GAIIn by N×0.01, where N (a decimal number between 0 and 255) has already been written to PARAMETER\*. This may be performed repeatedly until a minimum gain (>5.6 V full scale) has been reached, as indicated by an Overload/BIT 5 response in the STATUS byte. Further DECGAN commands will have no other effect.

**UPDATE [07]**

Takes the current modified gain and offset values and writes them to nonvolatile memory as the new start-up defaults. To enable this function, decimal 165 (A5 in hex) must first be loaded into PARAMETER\* - failure to do so will result in an ERRor (BIT 6) response in the STATUS byte.

Note: Codes other than 00 through 07 will do nothing, except cause an ERRor (BIT 6) response in the STATUS byte.

MNEMONIC	FUNCTIONAL DESCRIPTION	EXECUTION TIME (APPROXIMATE)
DEFCON	Initiate a Conversion Using the Power-Up Default Offset and Gain	50ms
MODCON	Initiate a Conversion Using the Modified Offset and Gain Values	50ms
NEWOS	Subtract System Offset (Last Conv. Result) from All MODCON Conversions	120µs
INCROS	Increase the Offset Used by MODCON Conversions	110µs
DECROS	Decrease the Offset Used by MODCON Conversions	110µs
INCGAN	Increase the Gain Used by MODCON Conversions	135µs
DECGAN	Decrease the Gain Used by MODCON Conversions	135µs
UPDATE	Write Most Recent Modified Offset & Gain Values to Nonvolatile Memory	48ms

Figure 6. Synopsis of Commands

## THE STATUS BYTE

The STATUS byte contains eight bits of information about the current status of the AD1175. This byte may be examined by the host processor at any time. The individual bits in the status byte are assigned the following functions:

- BIT 0** The BUSY bit is always set when the COMMAND BYTE is written, and cleared when the initiated routine has terminated. BUSY is also indicated at BUSY (Pin 24) of the module.
- BIT 1** The CONVerTing bit is set when the converter is in the active process of converting and computation. It is initiated by writing DEFCON or MODCON to the COMMAND-BYTE, or by a negative transition at CONV CMD (Pin 4).
- BIT 2** The Data AVailable bit indicates that a new conversion is complete and the result is in the output latches. This bit sets to "1" at the conclusion of the converting process and remains "1" for the remainder of the minimum AUTO-ZERO time (about 10 milliseconds). It is reset to "0" at the end of BUSY.
- BIT 3** The MODified bit, when set to "1," means that modified gain and offset values are being used for the current conversion; i.e., a conversion initiated by MODCON or an external signal at CONV CMD (Pin 4).
- BIT 4** The VALue bit responds to COMMANDS 02 through 07 by setting to "1" at the end of BUSY, and remains until the next write to the COMMAND byte. This bit signals that a gain or offset value used by MODCON has been altered, or that the current MODCON gain and offset values have been loaded to nonvolatile memory as the new power-up defaults.
- BIT 5** The Overload bit will be set following any conversion where the integrator has been exposed to an overload voltage. Following commands 03 through 06, it indicates that a parameter (gain or offset) has been incremented to its maximum or minimum possible value (note that further attempts to increment that parameter will not cause an overflow or underflow). Also, following NEWOS (02) command, this bit implies that an attempt was made, and ignored, to acquire an offset outside of the allowable range of  $\pm 75$  mV.
- BIT 6** The ERRor bit indicates one of the following: 1. A COMMAND-BYTE was written which was not within the allowable range of 00 to 07. 2. An update (07) command was attempted without the KEY number (165 decimal) having first been written to PARAMETER at ADDRESS 01. 3. A NEWOS (02) command was attempted for a value outside the permissible range of  $\pm 32,768$  codes ( $> 75$  mV) from zero.
- BIT 7** The WaRMUP bit flags the three second time-out taken by the converter following RESET, to allow the reference and auto-zero circuits to settle. The converter will not convert during this time.

B7	B6	B5	B4	B3	B2	B1	B0
WRMUP	ERR	OL	VAL	MOD	DAV	CONV	BUSY

Figure 7. The Status Byte

## CALIBRATION

The AD1175 is factory calibrated for plus and minus full scale (2e21) to be within  $\pm 50 \mu\text{V}$  of five volts, absolute. Since the converter will operate within specifications for inputs up to ten percent over nominal full scale, those inputs between  $\pm 5.5$  V will be converted accurately. (See Figure 9 for typical linearity vs. input voltage.)

To correct for system offset voltage (particularly larger offset voltages – up to  $\pm 75$  mV) the NEWOS (03) command subtracts the result of the last conversion from all subsequent MODCON conversions. If source noise is a concern when making the offset adjustment, follow a single NEWOS command with multiple MODCON conversions, average the results and adjust offset incrementally using the INCROS (03) or DECROS (04) commands.

The INCGAN 05 and DECGAN 06 commands are the *coarse gain* increment and decrement controls, respectively. The minimum gain attainable will require greater than 5.6 V to achieve a full-scale output. At maximum gain, less than 4.7 V will be required to yield a full-scale indication. The user accessible GAIN ADJ potentiometer is the vernier, or *fine gain* trim (10 turns, with a total adjustment range of about  $\pm 0.006$  FS).

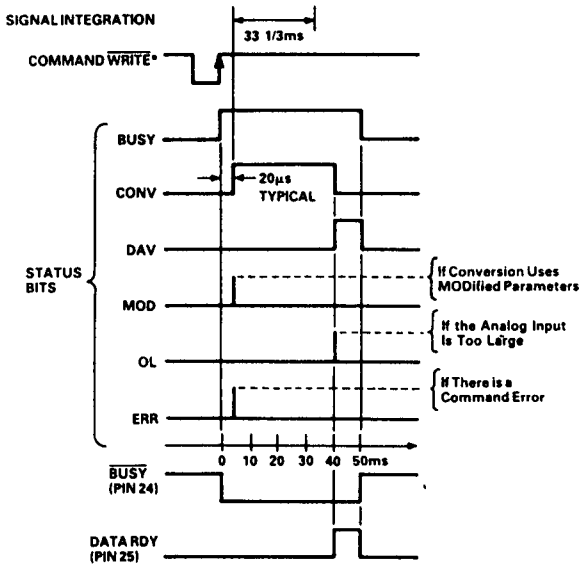
The modified offset and gain resulting from commands 02, 03, 04, 05 and 06 are used only when conversions are initiated by MODCON (command 01), or conversions triggered by a negative logic transition at the CONV CMD (Pin 4 of the converter). This pin requires a minimum hold time of 1.5  $\mu\text{s}$  at both the High and the Low states in order to operate properly.

The GAIN ADJ potentiometer changes the overall gain for both positive and negative inputs. The BAL ADJ potentiometer changes the gain for positive inputs only and allows setting of plus and minus full-scale tracking to within  $\pm 1$  ppm.

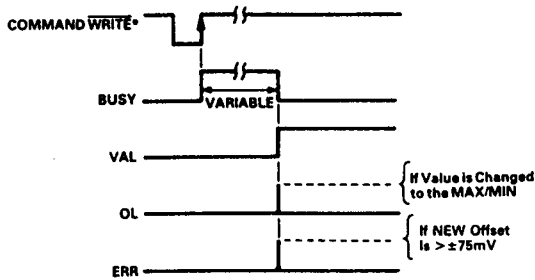
### To Calibrate the AD1175:

1. Attach a calibration source and set its output to zero volts.
2. Perform MODCON conversions and null out any observed offset (via external computation, or by executing one or more of the AD1175's offset controlling commands: INCROS, DECROS and NEWOS).
3. Set the GAIN ADJ potentiometer fully clockwise (10 turns, i.e., maximum gain).
4. Apply a negative full-scale calibration voltage ( $-4.7$  V to  $-5.6$  V).
5. Using the INCGAN or DECGAN command, coarse adjust the gain such that a subsequent MODCON conversion yields a result just larger than minus full scale. In other words, a subsequent DECGAN by 01 would just yield a result that is less than or equal to minus full scale.
6. Adjust the GAIN ADJ potentiometer to yield the precise value desired by turning counterclockwise and observing conversion results. When the correct gain is reached, rotate the potentiometer about 3 degrees in the opposite direction to remove the tension from its wiper.
7. Switch the polarity of the calibration source to positive.
8. Adjust the BAL ADJ potentiometer to yield the same gain as that achieved in Step 6 above.
9. Save the new offset value and coarse gain value, if you want them to become the power-up defaults, by performing UPDATE (Command 07).

Note: See the COMMAND BYTE section for details of command operation.

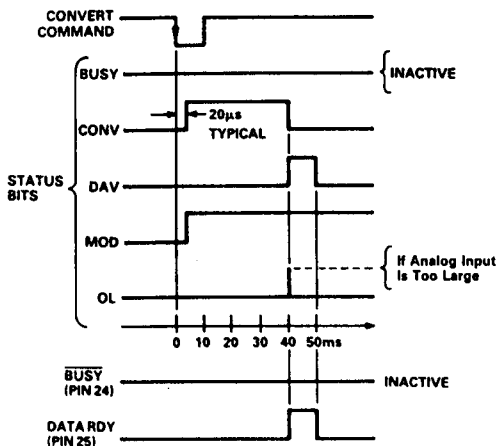


a. COMMAND BYTE Initiated Conversion



\*NOTE: COMMAND WRITE Always Causes Rewrite of the Entire STATUS Byte. For Example: If the Overload Bit (OL) is Set as the Result of a Conversion, It Will Remain Set in the STATUS Byte Until the Next COMMAND WRITE.

b. COMMAND BYTE Initiated Change to Gain and/or Offset



c. CONVERT COMMAND (Pin 4) Initiated Conversion

Figure 8. Command Timing Requirements

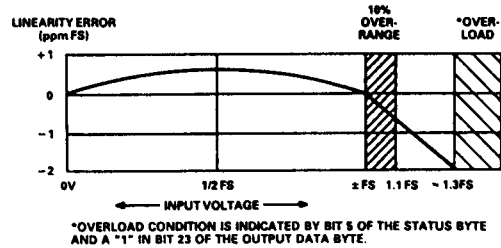


Figure 9. Typical Linearity Transfer Function

FACTORY TESTING

Each AD1175 converter is factory calibrated via test apparatus designed and constructed by Analog Devices. The heart of the test system is a digitally programmable voltage reference capable of sub-ppm accuracy and stability. Calibration of the test system is verified daily using the highest precision instruments commercially available, e.g., FLUKE\* model 720A Kelvin Varley voltage divider (accurate to within  $\pm 0.1$  ppm<sup>1</sup>) and model 732A dc secondary voltage standard (accurate to within  $\pm 1.5$  ppm of the international volt<sup>1</sup>).

IBM PC INTERFACE

Figure 10 is an example of an AD1175/IBM interface suitable for the IBM PC, XT or AT\*\* personal computers. In this case, the AD1175 is interfaced in the I/O space; a DIP switch controls the specific location of the AD1175 within the available address space.

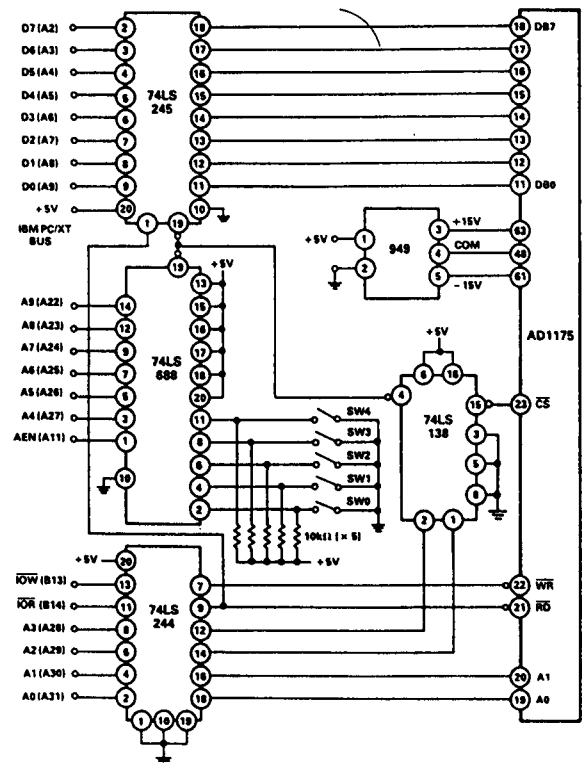


Figure 10. AD1175 to IBM PC/XT/AT Interface

\*FLUKE is a registered trademark of John Fluke Manufacturing Company, Inc.  
 \*\*IBM PC/XT/AT is a trademark of International Business Machines Corp.  
<sup>1</sup>Traceable to the NATIONAL BUREAU OF STANDARDS.

# AC5005

## ... an IBM PC/XT/AT Compatible Evaluation Board for the AD1175K

### INTERFACING TO AN 8051 MICROCONTROLLER

Figure 11 shows how the AD1175 may be interfaced to an 8051 microcontroller using a technique commonly called "byte banging," where the control lines and data bus of a device are manipulated under firmware control. This "byte banging" technique can be adapted to most microprocessors and is useful in situations where a conventional bus structure is either nonexistent or unavailable for use.<sup>1</sup>

The AD1175's data bus is connected to the 8051 using I/O lines P2.0 through P2.7. The address lines A0 and A1 are connected to I/O lines P1.0 and P1.1 respectively. The RD/ and WR/ lines are connected to P1.2 and P1.3. The CS/ line of the AD1175 is grounded when it is the only device connected to the 8051, but multiple AD1175s could easily be connected in the same way if each CS/ line were separately controlled.

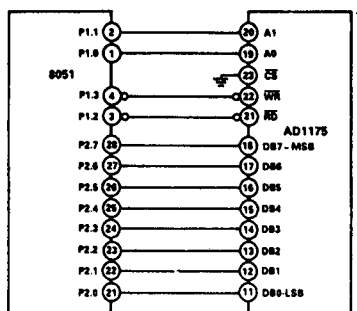


Figure 11. Simple AD1175 to 8051 Interface

To initialize the interface, first write "1"s to the port pins connected to the data bus and the RD/ and WR/ control lines. This puts the 8051 I/O lines into a lightly "pulled up" state, simulating a tri-stated condition on the bus to insure that neither RD/ nor WR/ are selected:

```
INIT:   SETB P1.2    ;DISABLE RD/
        SETB P1.3    ;AND WR/
        ;
        MOV P2, #OFFH ;SET P2 TO ALL ONES
        ;
```

To write a command to the AD1175, first set the state of the P1.1 and P1.0 lines for the address corresponding to the byte to be written to (00=COMMAND BYTE, 01=PARAMETER). Set the P2 port to the command data, then strobe the WR/ line by first clearing the P1.3 line and then setting it:

```
WRCMD: CLR P1.0    ;FIRST CLEAR A0 AND A1
        CLR P1.1    ;TO POINT TO CMD BYTE
        ;
        MOV P2, #00 ;00 IS THE OPCODE FOR
        ;           ;A DEFAULT MODE
        ;           ;CONVERSION
        ;
        CLR P1.3    ;STROBE THE WR/ LINE
        SETB P1.3   ;ONE TIME
        ;
        MOV P2, #OFFH ;SET DATA BUS TO
        ;           ;ALL ONES
```

To read a byte from the AD1175, first set the P1.0 and P1.1 lines to point to the address of the byte desired. Bring the RD/line low, reading the contents of P2. Return the RD/ line high:

```
RDSTAT: CLR P1.0    ;POINT TO STATUS BYTE
        CLR P1.1    ;
        ;
        CLR P1.2    ;BRING RD/ LINE LOW
        MOV A,P2    ;READ CONTENTS OF BUS
        SETB P1.2   ;RESTORE RD/ LINE HIGH
```

<sup>1</sup>Note that the 8051 microcontroller *does* contain a conventional bus structure; the "byte banging" interface shown here is presented as an example of an alternative technique.

### FEATURES

- Compatible to IBM PC/XT/AT\* or Equivalent
- Menu-Driven Demonstration Software
- Full Documentation
- Example Listings of BASIC Programs
- Schematic
- Assembly Drawing
- Complete Set of Tools to Evaluate the AD1175K 22-Bit Resolution Integrating A/D Converter

### APPLICATIONS

- Laboratory DVM
- Product Test and Measurement
- Analytical Instrumentation
- Material Analysis
- Seismic Analysis

### GENERAL DESCRIPTION

The AC5005 is an evaluation board for Analog Devices' AD1175K and is designed to plug directly into the backplane of an IBM PC/XT/AT and compatibles. The AC5005 is offered as a support tool to enable users to easily and quickly evaluate Analog Devices' AD1175K 22-bit multi-slope integrating A/D converter. The AC5005 comes with a demonstration program written in BASICA that completely exercises the functions of the AD1175K and emulates a 6 1/2 digit DVM. The onboard multiplexer allows selection via software from four differential analog input channels. A set of ten digital I/O lines are available to the user for control of lamps and actuators as well as to test switch positions. The AC5005 plugs directly into an IBM PC or compatible. Armed with an IBM PC and an AC5005 evaluation board, the user is ready to execute the demonstration program and evaluate the operation of the AD1175K.

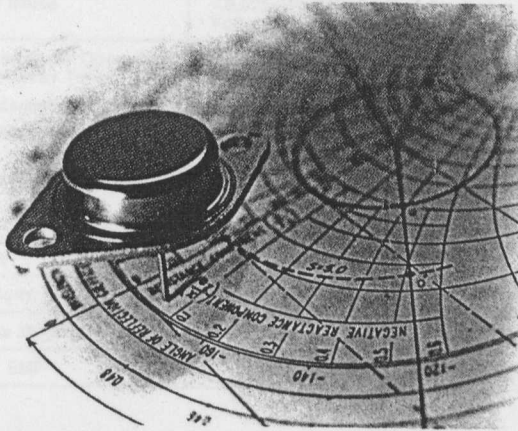
A user's guide provides the user with all the information required to put the AC5005/AD1175K pair into operation. The schematic of the AC5005 is provided as an example of how to interface the AD1175K to a computer bus. The AC5005 is very easy to configure. It has one set of DIP switches to select the board's base address and one set of jumpers to select either 50 Hz or 60 Hz line cycle. All the tools needed to evaluate the AD1175K come with the AC5005. There is even a short example program listing written in BASIC to demonstrate the ease of programming the AD1175K.

### PRODUCT HIGHLIGHTS

1. Plugs directly into IBM PC/XT/AT or compatibles.
2. Evaluates the AD1175K 22-bit multi-slope integrating A/D converter without having to build a breadboard or prototype.
3. Comes complete with software and programming examples to exercise all of the AD1175K's functions and emulate a 6 1/2 digit DVM.
4. AC5005 schematic and assembly drawing are provided to be used as examples of how to interface the AD1175K to a microprocessor bus.
5. Turnkey solution for laboratory measurement and analytical instrumentation.

\*IBM PC/XT/AT is a trademark of International Business Machines Corp.

### VISHAY MODELS VHP-3, VHP-4



The basic features of Vishay Bulk Metal® foil resistors such as tight resistance tolerance, fast response time, low TCR, and exceptional long-term stability are available for power-circuit applications. Non-inductive design, current sensing applications, deflection amplifiers, constant current power supplies, forced balance electronic scales, graphic display computers, character generation on CRT's, electron beam controls etc. The standard heat-sinking TO3-configuration case can be screw mouted directly on a metal chassis for maximum heat-transfer capability. All-welded construction ensures maximum reliability.

Hermetically-sealed metal case protects against environmental conditions and insures excellent long-term stability.

#### FEATURES

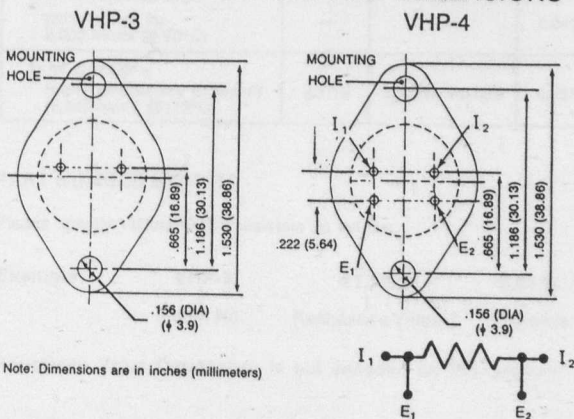
- Temperature Coefficient of Resistance — Nominal TCR<sup>3</sup>: +0.6ppm/°C (0°C to +25°C); -0.6ppm/°C (+25°C to +60°C); +2.2ppm/°C (-55°C to +25°C); -1.8ppm/°C (+25°C to +125°C)
- Standard TCR Spread from Nominal<sup>4</sup>: ±1.5 ppm/°C (0°C to +25°C and +25°C to +60°C); ±2.0ppm/°C (-55°C to +25°C and +25°C to +125°C)
- Maximum TCR Spread from Nominal<sup>5</sup>: ±2.5ppm/°C (0°C to +25°C and +25°C to +60°C) ±2.3ppm/°C (-55°C to +25°C and +25°C to +125°C)
- Selected TCR Tracking: 0.5ppm/°C
- Load-Life Stability:
  - 0.01% Maximum  $\Delta R$ , 3 watts on heat sink at 25°C.
  - 0.05% Maximum  $\Delta R$ , 10 watts on heat sink at 25°C.
  - For 3 watts, free air,  $\Delta R$ 's above not applicable.
- Shelf life stability 5ppm/year
- Power Rating:
  - 10 watts on heat sink at 25°C.
  - 3 watts, free air at 25°C.
- Resistance Tolerance (Initial Resistance Accuracy): ±0.01% tightest to ±5.0% loosest
- Resistance range: 0.05 $\Omega$  to 80K $\Omega$
- Current Noise: <0.025  $\mu V$  (RMS)/Volt of Applied Voltage
- Thermal EMF:
  - 0.5 V/°C (lead effect), 4  $\mu V$ /watt (power effect).
- Non-Inductive Design: Standard

Res. Range	VHP-3*	
	Tightest Resistance Tolerance <sup>1</sup>	TCR
50 $\Omega$ to <80K	± 0.01%	± 5 ppm/°C
25 $\Omega$ to <50 $\Omega$	± 0.02%	± 7 ppm/°C
10 $\Omega$ to <25 $\Omega$	± 0.05%	± 10 ppm/°C
5 $\Omega$ to <10 $\Omega$	± 0.1%	± 13 ppm/°C
2 $\Omega$ to <5 $\Omega$	± 0.25%	± 20 ppm/°C
1 $\Omega$ to <2 $\Omega$	± 0.5%	± 25 ppm/°C
0.5 $\Omega$ to <1 $\Omega$	± 1.0%	± 50 ppm/°C
0.25 $\Omega$ to <0.5 $\Omega$	± 2.0%	
0.1 $\Omega$ to <0.25 $\Omega$	± 5.0%	
0.05 $\Omega$ to <0.1 $\Omega$	N.A.	

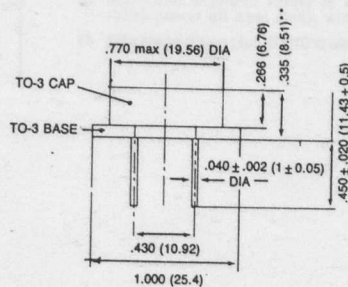
Res. Range	VHP-4†	
	Tightest Resistance Tolerance <sup>1</sup>	TCR
10 $\Omega$ to <500 $\Omega$	± 0.01%	± 5 ppm/°C
5 $\Omega$ to <10 $\Omega$	± 0.02%	± 6 ppm/°C
2 $\Omega$ to <5 $\Omega$	± 0.05%	± 8 ppm/°C
1 $\Omega$ to <2 $\Omega$	± 0.1%	± 10 ppm/°C
0.5 $\Omega$ to <1 $\Omega$	± 0.25%	± 15 ppm/°C
0.25 $\Omega$ to <0.5 $\Omega$	± 0.5%	± 20 ppm/°C
0.1 $\Omega$ to <0.25 $\Omega$	± 1.0%	± 25 ppm/°C
0.05 $\Omega$ to <0.1 $\Omega$	± 2.0%	± 30 ppm/°C

\*Weight = 15 gms. max. †VHP-4 available only up to 500 $\Omega$ .

#### STANDARD IMPRINTING AND DIMENSIONS

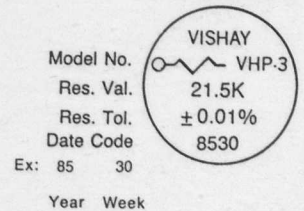


Note: Dimensions are in inches (millimeters)



\*\* .375 (9.53) — VHP-4

#### STANDARD MARKING ARRANGEMENT

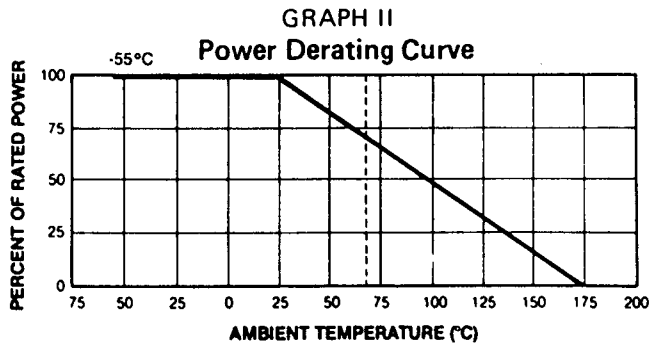


Case not active; insulators not required; mounting hardware not supplied.

"VHP-3" SPECIFICATIONS<sup>2</sup>/TABLE II

Stability Load-Life at 2000 Hours	0.05% Maximum $\Delta R$ under full rated power of 10 Watts at 25°C
Shelf-Life	0.0005% (5ppm) Maximum $\Delta R$ /Year
Power Rating at 25°C At Ambient Temperature (See Graph II)	10 Watts or 3 Amps <sup>6</sup> —Heat Sink <sup>7</sup> 3 Watts or 3 Amps <sup>6</sup> —Free Air
Current Noise	<0.025 $\mu$ V (RMS)/Volt of Applied Voltage (–32dB)
High-Frequency Operation Rise/Decay Time	1.0ns @ 1k $\Omega$
Inductance <sup>8</sup> (L)	0.1 $\mu$ H Maximum; 0.08 $\mu$ H Typical
Capacitance (C)	1.0pF Maximum; 0.5pF Typical
Voltage Coefficient	<.1ppm/V <sup>9</sup>
Operating Temperature Range	–55°C to +175°C
Hermeticity	10 <sup>-7</sup> Atmospheric cc/sec.
Maximum Working Voltage <sup>10</sup>	600V
Thermal EMF <sup>11</sup>	0.5 $\mu$ V/°C max. (lead effect) 4.0 $\mu$ V/watt (power effect)

VISHAY MODELS VHP-3, VHP-4



POWER RESISTOR ENVIRONMENTAL PERFORMANCE COMPARISON/TABLE III

Test	Method Para <sup>12</sup>	Mil-R-39009B Limits	VHP-3 Typical <sup>2</sup> Test Data <sup>10</sup>
TEST GROUP I Conditioning	4.7.2	±0.2% +0.05 $\Omega$	0.03%
TEST GROUP II Resistance Temperature Characteristic <sup>13</sup> (-55°C to +125°C)	4.7.4	<1 $\Omega$ ; ±100ppm/°C; 1 $\Omega$ to 19.6 $\Omega$ ; ±50ppm/°C; >20 $\Omega$ ; ±30ppm/°C	See Graph VI
Temperature <sup>14</sup> (2 hours @ 175°C)	4.7.5	±0.5% +0.05 $\Omega$	0.01%
Low-temperature Storage	4.7.17	±0.3% +0.05 $\Omega$	0.005%
DWV (750V @ atmos. press.)	4.7.6	±0.2% +0.05 $\Omega$	0.005%
Insulation Resistance	4.7.7	10 <sup>4</sup> M $\Omega$	>10 <sup>4</sup> M $\Omega$
Low-temperature Operation	4.7.8	±0.3% +0.05 $\Omega$	0.01%
Momentary overload <sup>15</sup> (5 sec. @ 750V rms)	4.7.9	±0.3% +0.05 $\Omega$	0.03%
Moisture Resistance	4.7.10	±0.5% +0.05 $\Omega$	0.02%
Terminal Strength	4.7.11	±0.2% +0.05 $\Omega$	0.005%
TEST GROUP III Shock - Medium Impact (Post-test DWV @ 750V)	4.7.12	±0.2% +0.05 $\Omega$	0.005%
Vibration - High-Frequency (Post-test DWV @ 750V)	4.7.13	±0.2% +0.05 $\Omega$	0.005%
TEST GROUP IV Life - 10 watts for 2,000 hours @ 25°C	4.7.14	±1.0% +0.05 $\Omega$	0.01%
(80% power for 2,000 hours @ 70°C)	—	—	0.04%
TEST GROUP V High-Temperature Exposure (2,000 hours @175°C)	4.7.15	±1.0% +0.05 $\Omega$	0.05%

NOTES

- Standard Resistance tolerances—±0.01%; ±0.02%; ±0.05%; ±0.1%; ±0.25%; ±0.5%; ±1.0%; ±2.0%; ±5.0% (±0.005% tolerance available on special order).
- Maximum is 1.0% A.Q.L. standard for all specifications except TCR. (For TCR information, see notes 3-7.)  
Typical is a designers reference which represents that 85% of the units supplied, over a long period of time, will be at least the figure shown or better.
- Vishay Nominal TCR is defined as the chord slopes of the relative resistance/temperature (RT) curve from 0°C to +25°C and +25°C to +60°C ("Instrument" Range); and from –55°C to +25°C and +25°C to +125°C ("Military" Range). These specifications and the definition of Nominal TCR apply to all resistance values including low-value resistors.
- Vishay Standard TCR Spread is defined as a designers reference which represents that at least 92% of the units, and 82% of the lots, supplied by Vishay will be within the stated band centered on the nominal curve. This definition of the Vishay Standard TCR Spread from Nominal applies to all resistance values. However, as the resistance value decreases below 60 $\Omega$ , the Vishay Standard TCR Spread from Nominal specification starts to increase. (See Graph VIII page 3).
- Vishay Maximum TCR Spread is defined as the 3 $\sigma$  (sigma) limit of a normal Gaussian distribution (99.73% of a production lot) which is within a band, centered on the nominal curve. This Vishay Maximum TCR Spread is no greater than ±2.5ppm/°C from nominal throughout the full temperature range. This definition of the Vishay Maximum TCR Spread from Nominal applies to all resistance values. However, as the resistance value decreases below 80 $\Omega$ , the Vishay maximum TCR Spread from Nominal specification starts to increase. (See Graph VIII page 3).
- Whichever is lower.
- Heat sink chassis dimensions and requirements per Mil-R-39009/1B:
 

	Inches	mm
L:	6.00	152.4
W:	4.00	101.6
H:	2.00	50.8
T:	0.04	1.0
- Inductance (L) due mainly to the leads.
- The resolution limit of existing test equipment (within the measurement capability of the equipment, or "essentially zero.")
- Not to exceed power rating of resistor.
- $\mu$ V/°C relates to EMF due to lead temperature difference and  $\mu$ V/watt due to power applied to the resistor.
- The VHP-3 test data as compared to Mil-R-39009 is shown for illustration purposes. Vishay test conditions that deviate from the Mil test method are noted within parentheses.
- Maximum specifications. See VHP-3 and VHP-4 Tabulation p. 12.
- Maximum ambient temperature rating is +175°C.
- Maximum overload rating is 15 Watts (5x rated power in free air; 1.5x rated power on heat sink), with applied voltage not to exceed 750V.
- $\Delta R$ 's are as shown plus .0001 $\Omega$  to allow for measurement errors at low resistance values.

PART NUMBER SYSTEM

Please specify Vishay VHP-3 resistors as follows:

Example:        VHP-3            21.5K            0.01%  
                         |                            |                            |  
                         Model No.       Resistance Value       Tolerance

Resistance Value Designation is not encoded on this product.